

AQ-G215

Generator protection device

Instruction manual



Table of contents

1 Document information	6
1.1 Version 2 revision notes	6
1.2 Version 1 revision notes	9
1.3 Safety information	10
1.4 Abbreviations	12
2 General	14
3 Device user interface	
3.1 Panel structure	
3.1.1 Local panel structure	
3.2 Mimic and main menu	
3.2.1 Basic configuration	
3.2.2 Navigation in the main configuration menus	
3.3 General menu	
3.4 Protection menu	
3.5 Control menu	
3.6 Communication menu	
3.7 Measurement menu	
3.8 Monitoring menu	
3.9 Configuring user levels and their passwords	
4 Functions	
4.1 Functions included in AQ-G215	
4.2 Measurements	
4.2.1 Current measurement and scaling	
4.2.2 Voltage measurement and scaling	
4.2.3 Power and energy calculation	
4.2.4 Frequency tracking and scaling	
4.4 Protection functions	
4.4.1 General properties of a protection function	
4.4.2 Non-directional overcurrent protection (I>; 50/51)	
4.4.3 Non-directional earth fault protection (IO>; 50N/51N)	
4.4.4 Directional overcurrent protection (Idir>; 67)	
4.4.5 Directional earth fault protection (I0dir>; 67)	
4.4.6 Negative sequence overcurrent/ phase current reversal/ current unbalance	
(12>; 46/46R/46L)	
4.4.7 Harmonic overcurrent protection (lh>; 50H/51H/68H)	
4.4.8 Circuit breaker failure protection (CBFP; 50BF/52BF)	
4.4.9 Low-impedance or high-impedance restricted earth fault/ cable end differen	
protection (I0d>; 87N)	
4.4.10 Overvoltage protection (U>; 59)	
4.4.11 Undervoltage protection (U<; 27)	
4.4.12 Neutral overvoltage protection (U0>; 59N)	
4.4.13 Sequence voltage protection (U1/U2>/<; 47/27P/59PN)	
4.4.14 Overfrequency and underfrequency protection (f>/<; 81O/81U)	
4.4.15 Rate-of-change of frequency (df/dt>/<; 81R)	
4.4.16 Power protection (P, Q, S>/<; 32)	211
4.4.17 100 % stator earth fault protection (U03rd<; 64S)	215
4.4.18 Underexcitation protection (Q<; 40)	
4.4.19 Underimpedance protection (Z<; 21U)	
4.4.20 Voltage-restrained overcurrent protection (Iv>; 51V)	
4.4.21 Volts-per-hertz overexcitation protection (V/Hz>; 24)	
4.4.22 Power factor protection (PF<; 55)	239

4.4.23 Machine thermal overload protection (TM>; 49M)	
4.4.24 Resistance temperature detectors (RTD)	
4.4.25 Programmable stage (PSx>/<; 99)	
4.4.26 Arc fault protection (IArc>/I0Arc>; 50Arc/50NArc)	
4.5 Control functions	299
4.5.1 Common signals	299
4.5.2 Setting group selection	300
4.5.3 Object control and monitoring	307
4.5.4 Indicator object monitoring	314
4.5.5 Vector jump (Δφ; 78)	315
4.5.6 Synchrocheck (ΔV/Δa/Δf; 25)	320
4.5.7 Milliampere output control	333
4.5.8 Programmable control switch	336
4.5.9 Analog input scaling curves	337
4.5.10 Logical outputs	340
4.5.11 Logical inputs	341
4.6 Monitoring functions	343
4.6.1 Current transformer supervision	343
4.6.2 Voltage transformer supervision (60)	352
4.6.3 Circuit breaker wear monitoring	
4.6.4 Current total harmonic distortion (THD)	362
4.6.5 Measurement recorder	
4.6.6 Fault register	372
4.6.7 Event logger	
4.6.8 Disturbance recorder (DR)	
5 Communication	
5.1 Connections menu	
5.2 Time synchronization	
5.2.1 Internal	
5.2.2 NTP	
5.3 Communication protocols	
5.3.1 IEC 61850	
5.3.1.1 GOOSE	
5.3.2 Modbus TCP and Modbus RTU	
5.3.3 IEC 103	
5.3.4 IEC 101/104	
5.3.5 SPA	
5.3.6 DNP3	
5.3.7 Modbus I/O	
5.4 Analog fault registers	
5.5 Real-time measurements to communication	
6 Connections and application examples	
6.1 Connections of AQ-G215	408
6.2 Application example and its connections	408
6.3 Two-phase, three-wire ARON input connection	409
6.4 Trip circuit supervision (95)	410
7 Construction and installation	414
7.1 Construction	
7.1 Constituction	
7.3 Current measurement module	
7.4 Voltage measurement module	
7.4 Voltage measurement module	
7.5.1 Digital input module (optional)	
7.5.2 Digital input module (optional)	
7.5.3 Milliampere output module (4x mA out & 1x mA in) (optional)	
7.5.4 Point sensor arc protection module (optional)	
7.0.7 1 01111 3011301 ato protection module (optional)	

7.5.5 RTD input module (optional)	428
7.5.6 Double RJ45 Ethernet & IRIG-B communication module (optional)	429
7.5.7 Double RJ45 Ethernet & IRIG-B communication module (optional)	
7.5.8 Double ST 100 Ethernet & IRIG-B communication module (optional)	
7.5.9 Double LC or RJ45 (HSR/PRP) Ethernet communication module (optional)	
7.5.10 Serial RS-232 communication module (optional)	
7.6 Dimensions and installation	434
8 Technical data	437
8.1 Hardware	437
8.1.1 Measurements	437
8.1.1.1 Current measurement	
8.1.1.2 Voltage measurement	438
8.1.1.3 Voltage memory	439
8.1.1.4 Power and energy measurement	
8.1.1.5 Frequency measurement	
8.1.2 CPU & Power supply	
8.1.2.1 Auxiliary voltage	
8.1.2.2 CPU communication ports	
8.1.2.3 CPU digital inputs	
8.1.2.4 CPU digital outputs	
8.1.3 Option cards	
8.1.3.1 Digital input module	
8.1.3.2 Digital output module	444
8.1.3.3 Milliampere output module (4 x mA out & 1 x mA in)	
8.1.3.4 Point sensor arc protection module	
8.1.3.6 Double RJ-45 Ethernet & IRIG-B communication module	
8.1.3.7 Double ST Ethernet & IRIG-B communication module	
8.1.3.8 Double LC (HSR/PRP) Ethernet communication module	
8.1.3.9 Double RJ-45 (HSR/PRP) Ethernet communication module	
8.1.3.10 RS-232 & serial fiber communication module	450
8.1.4 Display	
8.2 Functions	
8.2.1 Protection functions	
8.2.1.1 Non-directional overcurrent protection (I>; 50/51)	451
8.2.1.2 Non-directional earth fault protection (IO>; 50N/51N)	
8.2.1.3 Directional overcurrent protection (Idir>; 67)	
8.2.1.4 Directional earth fault protection (I0dir>; 67N/32N)	
8.2.1.5 Negative sequence overcurrent/ phase current reversal/ current unba	
protection (I2>; 46/46R/46L)	
8.2.1.6 Harmonic overcurrent protection (lh>; 50H/51H/68H)	
8.2.1.7 Circuit breaker failure protection (CBFP; 50BF/52BF)	
8.2.1.8 Low-impedance or high-impedance restricted earth fault/ cable end c	
protection (I0d>; 87N)	450
8.2.1.10 Undervoltage protection (U<; 27)	
8.2.1.11 Neutral overvoltage protection (U0>; 59N)	
8.2.1.12 Sequence voltage protection (U1/U2>/<; 47/27P/59NP)	
8.2.1.13 Overfrequency and underfrequency protection (f>/<; 810/81U)	
8.2.1.14 Rate-of-change of frequency protection (df/dt>/<; 81R)	
8.2.1.15 Power protection (P, Q, S>/<; 32)	
8.2.1.16 Machine thermal overload protection (TM>; 49M)	
8.2.1.17 Underimpedance protection (Z<; 21U)	
8.2.1.18 Voltage-restrained overcurrent protection (Iv>; 51V)	
8.2.1.19 100 % stator earth fault protection (U03rd>; 64S)	
8.2.1.20 Power factor protection (PF<; 55)	
8.2.1.21 Volts-per-hertz overexcitation protection (V/Hz>; 24)	
8 2 1 22 Underexcitation protection (Q<: 40)	470

8.2.1.23 Resistance temperature detectors (RTD)	471
8.2.1.24 Arc fault protection (IArc>/I0Arc>; 50Arc/50NArc) (optional)	
8.2.2 Control functions	472
8.2.2.1 Setting group selection	472
8.2.2.2 Object control and monitoring	472
8.2.2.3 Indicator object monitoring	473
8.2.2.4 Vector jump (Δφ; 78)	473
8.2.2.5 Synchrocheck (ΔV/Δa/Δf; 25)	474
8.2.3 Monitoring functions	
8.2.3.1 Current transformer supervision	
8.2.3.2 Voltage transformer supervision (60)	
8.2.3.3 Circuit breaker wear monitoring	477
8.2.3.4 Current total harmonic distortion	477
8.2.3.5 Event logger	478
8.2.3.6 Disturbance recorder	478
8.3 Tests and environmental	478
9 Ordering information	481
10 Contact and reference information	483

Disclaimer

Please read these instructions carefully before using the equipment or taking any other actions with respect to the equipment. Only trained and qualified persons are allowed to perform installation, operation, service or maintenance of the equipment. Such qualified persons have the responsibility to take all appropriate measures, including e.g. use of authentication, encryption, anti-virus programs, safe switching programs etc. necessary to ensure a safe and secure environment and usability of the equipment. The warranty granted to the equipment remains in force only provided that the instructions contained in this document have been strictly complied with.

Nothing contained in this document shall increase the liability or extend the warranty obligations of the manufacturer Arcteq Relays Ltd. The manufacturer expressly disclaims any and all liability for any damages and/or losses caused due to a failure to comply with the instructions contained herein or caused by persons who do not fulfil the aforementioned requirements. Furthermore, the manufacturer shall not be liable for possible errors in this document.

Please note that you must always comply with applicable local legislation and regulations. The manufacturer gives no warranties that the content of this document is in all respects in line with local laws and regulations and assumes no liability for such possible deviations.

You are advised to notify the manufacturer in case you become aware of any errors in this document or of defects in the equipment.

The manufacturer reserves the right to update or amend this document at any time.

Copyright

Copyright © Arcteq Relays Ltd. 2025. All rights reserved.

1 Document information

1.1 Version 2 revision notes

Table. 1.1 - 1. Version 2 revision notes

Revision	2.00					
Date	6.6.2019					
Changes	 New more consistent look. Improved descriptions generally in many chapters. Improved readability of a lot of drawings and images. Updated protection functions included in every manual. Every protection relay type now has connection drawing, application example drawing wifunction block diagram and application example with wiring. Added fault registers to Z< function description. Added General-menu description. 					
Revision	2.01					
Date	6.11.2019					
Changes	 - Added description for LED test and button test. - Complete rewrite of every chapter. - Improvements to many drawings and formula images. - Order codes revised. - Added double ST 100 Mbps Ethernet communication module and Double RJ45 10/100 Mbps Ethernet communication module descriptions 					
Revision	2.02					
Date	7.7.2020					
Changes	- A number of image descriptions improved.					
Revision	2.03					
Date	27.8.2020					

Changes	- Terminology consistency improved (e.g. binary inputs are now always called digital inputs). - Tech data modified to be more informative about what type of measurement inputs are used (phase currents/voltages), residual currents/voltages), what component of that measurement is available (RMS, TRMS, peak-to-peak) and possible calculated measurement values (powers, impedances, angles etc.). - Tech data updated: non-directional overcurrent - Tech data updated: non-directional earthfault - Tech data updated: current unbalance - Tech data updated: current unbalance - Tech data updated: overfrequency, underfrequency and rate-of-change-of-frequency. - Improvements to many drawings and formula images. - Improved and updated device user interface display images. - AQ-G215 Functions included list Added: Voltage memory, additional instance of underimpedance, vector jump protection, included recorder. - Added "32N" ANSI code to directional earth fault protection modes "unearthed" and "petersen coil grounded". - Added 6th harmonic to harmonic overcurrent protection function. - Fixed reset ratio of under- and overfrequency protection function from 103 % / 97 % to +/-20 mHz. - Fixed reset ratio of under- and overfrequency protection function from 20 mHz/s to 100 mHz/s. - Changed disturbance recorder maximum digital channel amount from 32 to 95. - Added residual current coarse and fine measurement data to disturbance recorder description. - HSO1 and HSO2 connection swapped in arc protection card (was way wrong before). - Updated IO1 and IO2 rated current range. - Added inches to Dimensions and installation chapter. - Added achied inches to Dimensions and installation chapter. - Added raising frames, wall mounting bracket, combiflex frame to order code. - Added onche to Dimensions and installation chapter. - Added parameter descriptions to General menu Device user interface chapter. - Added aparameter descriptions to General menu Device user interface chapter. - Added none to Configuring user levels and
Revision	2.04
_	
Date	8.6.2021
Changes	Increased the consistency in terminologyVarious image upgradesVisual update to the order codes
Revision	2.05
Date	22.6.2021

Changes	- Fixed phase current measurement continuous thermal withstand from 30A to 20A Fixed lots of timing errors written to registers table. "Prefault" is -200 ms from Start event, "Pretrigger" is -20 ms from trip (or start if fault doensn't progress to trip), "Fault" is start (or trip if fault doesn't progress to trip) Added event history technical data						
Revision	2.06						
Date	21.6.2022						
Changes	 Improved descriptions generally in many chapters. Improved readability of a lot of drawings and images. Order codes have been revised. Added additional instance of underimpedance protection. Added synchrocheck start check parameter description. Added new trip detections and fault types to measurement value recorder. Added user description parameter descriptions for digital inputs, digital outputs, logical inputs, logical outputs and GOOSE inputs. Arc point sensor HSO1 and HSO2 position fixed. Added spare part codes and compatibilities to option cards. 						
Revision	2.07						
Date	7.7.2022						
Changes	- Added THD voltage measurements.						
Revision	2.08						
Date	8.9.2022						
Changes	 - Added stage forcing parameter to function descriptions. - Fixes to "Real time signals to comm" description. - Added "Ethernet port" parameter description to IEC61850, IEC104 and Modbus TCP descriptions. - Removed "Measurement update interval" settings from Modbus description. No longer in use. - Renamed "System integration" chapter to "Communication" and restructured the chapters to be closer to how they are in the menus. - Added "Event logger" chapter. 						
Revision	2.09						
Date	14.3.2023						
Changes	 Updated the Arcteq logo on the cover page and refined the manual's visual look. Added the "Safety information" chapter and changed the notes throughout the document accordingly. Changed the "IED user interface" chapter's title to "Device user interface" and replaced all 'IED' terms with 'device' or 'unit'. Updated the rated values for the change-over CPU digital outputs in "Technical data". Added the maximum and minimum allowed tracking frequencies to the settings table of the "Frequency tracking and scaling" chapter (under "Measurements"). Updated the input impedance for the voltage measurement module in "Technical data". 						
Revision	2.10						
Date	19.6.2023						
Changes	- Updated order codes.						

Revision	2.11				
Date	29.11.2023				
Changes	 - Added the 5 ms update time in the measurement chapters. - Added spring lock cage options for connectors. See the "Ordering information" chapter. - Updated the contact address for technical support in the "Contact and reference information" chapter. 				
Revision	2.12				
Date	January 2024				
Changes	- Added "I2 meas / I2 set" and other read-only parameters to "I2> function" Added voltage input thresholds to "Voltage measurement and scaling" Added Chinese and Kazakh languages as language options in "General menu".				
Revision	2.13				
Date	September 2024				
Changes	- Corrected the number of devices that fit a 19 in rack in the "Dimensions and installation" chapter.				
Revision	2.14				
Date	June 2025				
Changes	- Updated the product and packaging weights Order code table updated.				

1.2 Version 1 revision notes

Table. 1.2 - 2. Version 1 revision notes

Revision	1.00					
Date	2.9.2014					
Changes	The first revision for AQ-G215.					
Revision	1.01					
Date	23.1.2014					
Changes	 Added the RTD & mA input module, the double LC 100Mb Ethernet card module, and the serial RS-232 & serial fiber module hardware descriptions. Added the sequence voltage function description. Order code updated. 					
Revision	1.02					
Date	23.4.2014					
Changes	Underexcitation text revised.					
Revision	1.03					
Date	12.1.2016					

Changes	Added the digital input operation description.					
Revision	1.04					
Date	30.5.2016					
Changes	Added the PCB and Terminal options to the order code.					
Revision	1.05					
Date	30.8.2016					
Changes	Added the password set-up guide (previously only in the AQtivate 200 user guide).					
Revision	1.06					
Date	9.2.2017					
Changes	 Added the programmable control switch, indicator object, and programmable stage descriptions. Order code updated. 					

1.3 Safety information

This document contains important instructions that should be saved for future use. Read the document carefully before installing, operating, servicing, or maintaining this equipment. Please read and follow all the instructions carefully to prevent accidents, injury and damage to property.

Additionally, this document may contain four (4) types of special messages to call the reader's attention to useful information as follows:



NOTICE!

"Notice" messages indicate relevant factors and conditions to the the concept discussed in the text, as well as to other relevant advice.



CAUTION!

"Caution" messages indicate a potentially hazardous situation which, if not avoided, could result in minor or moderate personal injury, in equipment/property damage, or software corruption.



WARNING!

"Warning" messages indicate a potentially hazardous situation which, if not avoided, **could** result in death or serious personal injury as well as serious damage to equipment/property.



DANGER!

"Danger" messages indicate an imminently hazardous situation which, if not avoided, will result in death or serious personal injury.

These symbols are added throughout the document to ensure all users' personal safety and to avoid unintentional damage to the equipment or connected devices.

Please note that although these warnings relate to direct damage to personnel and/or equipment, it should be understood that operating damaged equipment may also lead to further, indirect damage to personnel and/or equipment. Therefore, we expect any user to fully comply with these special messages.

1.4 Abbreviations

AI – Analog input

AR - Auto-recloser

ASDU – Application service data unit

AVR – Automatic voltage regulator

BCD - Binary-coded decimal

CB - Circuit breaker

CBFP - Circuit breaker failure protection

CLPU – Cold load pick-up

CPU - Central processing unit

CT – Current transformer

CTM - Current transformer module

CTS – Current transformer supervision

DG – Distributed generation

DHCP - Dynamic Host Configuration Protocol

DI – Digital input

DO – Digital output

DOL - Direct-on-line

DR - Disturbance recorder

DT – Definite time

FF – Fundamental frequency

FFT – Fast Fourier transform

FTP - File Transfer Protocol

GI – General interrogation

HMI – Human-machine interface

HR - Holding register

HV – High voltage

HW – Hardware

IDMT – Inverse definite minimum time

IGBT – Insulated-gate bipolar transistor

I/O – Input and output

IRIG-B – Inter-range instruction group, timecode B

LCD - Liquid-crystal display

LED – Light emitting diode

LV – Low voltage

NC - Normally closed

NO - Normally open

NTP - Network Time Protocol

RMS – Root mean square

RSTP – Rapid Spanning Tree Protocol

RTD – Resistance temperature detector

RTU – Remote terminal unit

SCADA – Supervisory control and data acquisition

SG - Setting group

SOTF - Switch-on-to-fault

SW - Software

THD – Total harmonic distortion

TRMS – True root mean square

VT – Voltage transformer

VTM – Voltage transformer module

VTS – Voltage transformer supervision

2 General

The AQ-G215 generator protection device is a member of the AQ 200 product line. The hardware and software are modular: the hardware modules are assembled and configured according to the application's I/O requirements and the software determines the available functions. This manual describes the specific application of the AQ-G215 generator protection device. For other AQ 200 and AQ 250 series products please consult their respective device manuals.

The AQ-G215 generator protection device is well-suited for machines requiring complete generator protections. It can be combined with AQ-T216 to protect larger machines requiring differential protection and greater protection redundancy. There are up to three (3) option card slots available for additional I/O or communication cards for more comprehensive monitoring and control applications. AQ-G215 communicates using various protocols including the IEC 61850 substation communication standard.

3 Device user interface

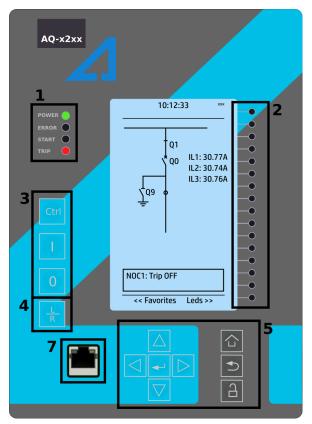
3.1 Panel structure

The user interface section of an AQ 200 or AQ 250 series device is divided into two user interface sections: one for the hardware and the other for the software. You can access the software interface either through the front panel or through the AQtivate 200 freeware software suite.

3.1.1 Local panel structure

The front panel of AQ 200 series devices have multiple LEDs, control buttons and a local RJ-45 Ethernet port for configuration. Each unit is also equipped with an RS-485 serial interface and an RJ-45 Ethernet interface on the back of the device.

Figure. 3.1.1 - 1. Local panel structure.



- 1. Four (4) default LEDs: "Power", "Error", "Start" (configurable) and "Trip" (configurable).
- 2. Sixteen (16) freely configurable LEDs with programmable legend texts.
- 3. Three (3) object control buttons: Choose the controllable object with the Ctrl button and control the breaker or other object with the I and O buttons.
- 4. The L/R button switches between the local and the remote control modes.
- 5. Eight (8) buttons for device local programming: the four navigation arrows and the **Enter** button in the middle, as well as the **Home**, the **Back** and the password activation buttons.
- 6. One (1) RJ-45 Ethernet port for device configuration.

When the unit is powered on, the green "Power" LED is lit. When the red "Error" LED is lit, the device has an internal (hardware or software) error that affects the operation of the unit. The activation of the yellow "Start" LED and the red "Trip" LED are based on the setting the user has put in place in the software.

The sixteen freely configurable LEDs are located on the right side of the display. Their activation and color (green or yellow) are based on the settings the user has put in place in the software.

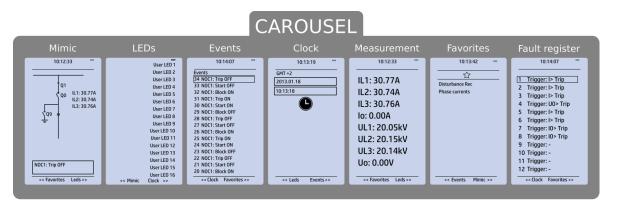
Holding the I (object control) button down for five seconds brings up the button test menu. It displays all the physical buttons on the front panel. Pressing any of the listed buttons marks them as tested. When all buttons are marked as having been tested, the device will return back to the default view.

3.2 Mimic and main menu

3.2.1 Basic configuration

The user interface is divided into seven (7) quick displays: "Mimic", "LEDs", "Events", "Clock", "Measurement", "Favorites" and "Fault register". The default quick display (as presented in the image below) is the mimic view; you can move through these menus by pressing the left and right arrow buttons. Please note that the available quick display carousel view might be different if you have changed the view with AQtivate's Carousel Designer tool.

Figure. 3.2.1 - 2. Basic navigation (general).





Home - Switch between MENU and CAROUSEL view

The Home button switches between the quick display carousel and the main display with the six (6) main configuration menus (*General, Protection, Control, Communication, Measurements* and *Monitoring*). Note that the available menus vary depending on the device type. You can select one of the menus by using the four navigation arrows and pressing Enter in the middle. The Back button takes you back one step. If you hold it down for three seconds, it takes you back to the main menu. You can also use it to reset the alarm LEDs you have set.

The password activation button (with the padlock icon) takes you to the password menu where you can enter the passwords for the various user levels (User, Operator, Configurator, and Super-user). See "Configuring user levels and their passwords" for more detail.

3.2.2 Navigation in the main configuration menus

All the settings in this device have been divided into the following six (6) main configuration menus:

- General
- Protection
- Control
- Communication
- Measurement
- · Monitoring.

They are presented in the image below. The available menus vary according to the device type.

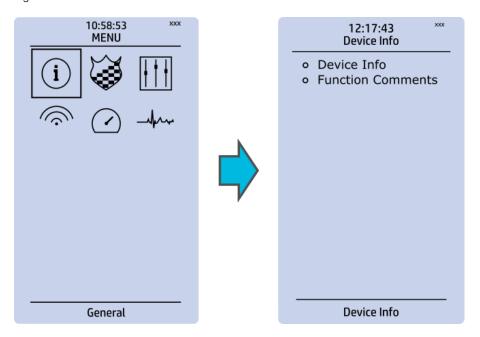
Figure. 3.2.2 - 3. Main configuration menus.



3.3 General menu

The *General* main menu is divided into two submenus: the *Device info* tab presents the information of the device, while the *Function comments* tab allows you to view all comments you have added to the functions.

Figure. 3.3 - 4. General menu structure.



Device info

Figure. 3.3 - 5. Device info.

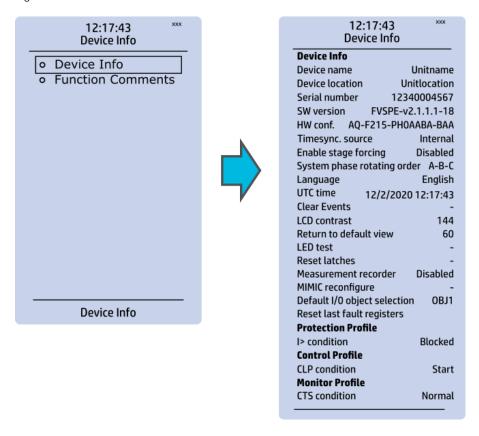


Table. 3.3 - 3. Parameters and indications in the *General* menu.

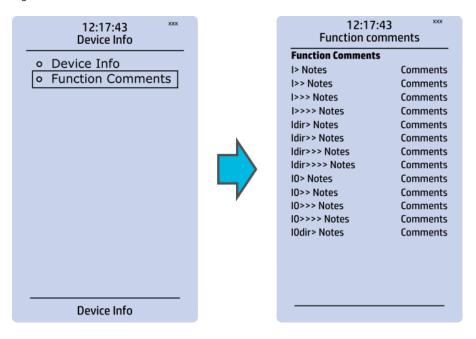
Name	Range	Step	Default	Description
Device name	-	-	Unitname	The file name uses these fields when loading
Device location	-	-	Unitlocation	the .aqs configuration file from the AQ-200 unit.
Serial number	-	-	-	Displays the unit's unique serial number. The serial number is also printed on the sticker located on the side of the unit.
Firmware version	-	-	-	Displays the software version (firmware) used by the unit. Upgradable by the user if a newer version is available.
Hardware configuration	-	-	-	Displays the hardware configuration of the unit. The hardware configuration is also printed on the sticker located on the side of the unit.
Time synchronization source	Internal External NTP External Serial IRIG-B	-	• Internal	If an external clock time synchronization source is available, the type is defined with this parameter. In the internal mode there is no external Timesync source. IRIG-B requires a serial fiber communication option card.
Enable stage forcing	Disabled Enabled	-	Disabled	When this parameter is enabled it is possible for the user to force the protection, control and monitoring functions to different statuses like START and TRIP. This is done in the function's <i>Info</i> page with the <i>Force status to</i> parameter.
System phase rotating order	• A-B-C • A-C-B	-	• A-B-C	Allows the user to switch the expected order in which the voltage and current phases are wired to the unit.
Language	 User defined English Finnish Chinese Spanish French German Russian Ukrainian Kazakh 	-	• English	Changes the language of the parameter descriptions in the HMI. If the language has been set to "Other" in the settings of the AQtivate 200 setting tool, AQtivate follows the value set into this parameter.
UTC time	-	-	-	Displays the UTC time used by the unit without time zone corrections.
Clear events	• - • Clear	-	• -	Clears the event history recorded in the device.
LCD Contrast	0255	1	120	Changes the contrast of the LCD display.

Name	Range	Step	Default	Description
Return to default view	03600 s	10 s	0 s	If the user navigates to a menu and gives no input after a period of time defined with this parameter, the unit automatically returns to the default view. If set to 0 s, this feature is not in use.
LED test	 Activated	-	• -	When activated, all LEDs are lit up. LEDs with multiple possible colors blink each color.
Reset latches	• - • Reset	-	• -	Resets the latched signals in the logic and the matrix. When a reset command is given, the parameter automatically returns back to "-".
Measurement recorder	Disabled Enabled	-	Disabled	Enables the measurement recorder tool, further configured in <i>Tools</i> → <i>Misc</i> → <i>Measurement recorder.</i>
Reconfigure mimic	- Reconfigure	-	• -	Reloads the mimic to the unit.
Reset last fault registers	-	-	-	Activation of input selected here resets the values in "Fault registers" view in carousel.
Protection/Control/ Monitor profile	-	-	-	Displays the status of all enabled functions.

Function comments

Function comments displays notes of each function that has been activated in the Protection, Control and Monitoring menu. Function notes can be edited by the user.

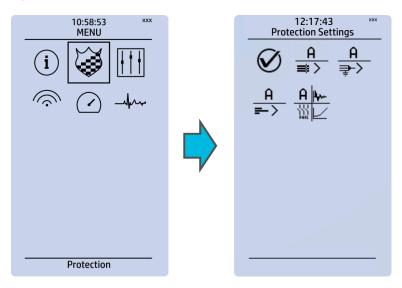
Figure. 3.3 - 6. Function comments.



3.4 Protection menu

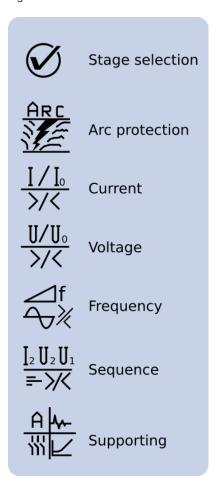
General

Figure. 3.4 - 7. Protection menu structure.



The *Protection* main menu includes the *Stage activation* submenu as well as the submenus for all the various protection functions, categorized under the following modules: "Arc protection", "Current", "Voltage", "Frequency", "Sequence" and "Supporting" (see the image below). The available functions depend on the device type in use.

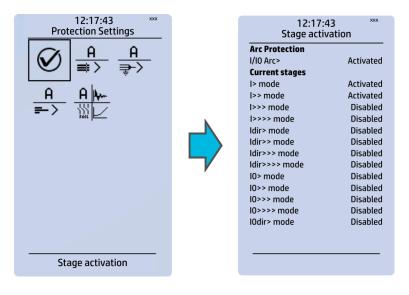
Figure. 3.4 - 8. Protection menu view.



Stage activation

You can activate the various protection stages in the *Stage activation* submenu (see the images below). Each protection stage and supporting function is disabled by default. When you activate one of the stages, its activated menu appears in the stage-specific submenu. For example, the I> (overcurrent) protection stage can be found in the "Current" module, whereas the U< (undervoltage) protection stage can be found in the "Voltage" module.

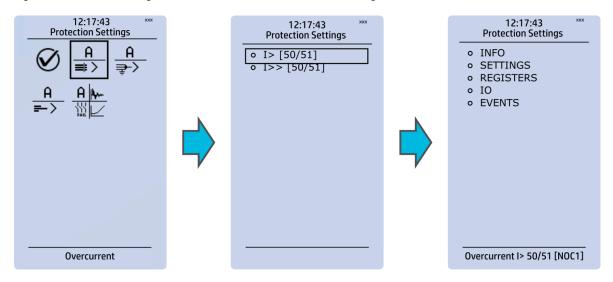
Figure. 3.4 - 9. Submenus for Stage activation.



Example of a protection stage and its use

Once a protection stage has been activated in the *Stage activation* submenu, you can open its own submenu. In the image series below, the user has activated three current stages. The user accesses the list of activated current stages through the "Current" module, and selects the I> stage for further inspection.

Figure. 3.4 - 10. Accessing the submenu of an individual activated stage.



Each protection stage and supporting function has five sections in their stage submenus: "Info", "Settings", "Registers", "I/O" and "Events".

Figure. 3.4 - 11. Info.

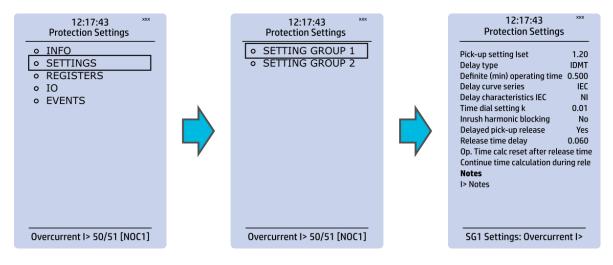
I> condition Normal Phases condition Normal Expected operating time 0.50 Time remaining to trip 0.50 Imeas/Iset at the moment 0.9 Measured magnitude RM Characteristics graphs Operating time Current pick-u Statistics I> starts I> trips I> blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings now in use Active setting group SG Pick-up setting Iset 1.2 Delay type Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	12:17:43 ×××	
I> Phases condition Normal Expected operating time 0.50 Time remaining to trip 0.50 Imeas/Iset at the moment 0.9 Measured magnitude RM Characteristics graphs	I> [50/51] mode	Activated
Expected operating time Time remaining to trip O.50 Imeas/Iset at the moment O.9 Measured magnitude Characteristics graphs Operating time Current pick-u Statistics I> starts I> trips I> blocks Clear statistics Measurements Select Primary Pha.curr.IL1 Pha.curr.IL2 Pha.curr.IL2 Pha.curr.IL3 Settings now in use Active Settings Settings now in use Active setting group Definite operating time delay Delayed Pick-up release Ye Release Time delay O.06 Op. Time calc reset after release time	I> condition	Normal
Time remaining to trip 0.50 Imeas/Iset at the moment 0.9 Measured magnitude RM Characteristics graphs Operating tim Current pick-u Statistics I> starts I> trips I> blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting Iset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	I> Phases condition	Normal
Imeas/Iset at the moment 0.9 Measured magnitude RM Characteristics graphs Operating tim Current pick-u Statistics I> starts I> trips I> blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active Setting group SG Pick-up setting Iset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	Expected operating	time 0.500
Measured magnitude RM Characteristics graphs Operating tim Current pick-u Statistics > starts > trips > blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting Iset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	Time remaining to t	rip 0.500
Characteristics graphs Operating tim Current pick-u Statistics > starts > trips > blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	Imeas/Iset at the m	oment 0.90
Operating tim Current pick-u Statistics > starts > trips > blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	Measured magnitud	le RMS
Current pick-u Statistics > starts > trips > blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release times Vereing Statistics Statistics Statistics Statistics Statistics Statistics Statistics Statistics Statistics Statistics Statistics Statistics Statistics	Characteristics gra	phs
Statistics > starts > trips > blocks - clear statistics - was presented by the presenting state by the presenting time delay presented by the presented by t	Θ /	Operating time
I> starts I> trips I> blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	Θ /	Current pick-up
I> trips I> blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	Statistics	
I> blocks Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	I> starts	1
Clear statistics Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	I> trips	1
Measurements Select Primary Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting Iset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	I> blocks	2
Select Primary. Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting Iset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release times	Clear statistics	
Pha.curr.IL1 19.5 Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	Measurements	
Pha.curr.IL2 19.5 Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	Select	Primary A
Pha.curr.IL3 19.5 Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time		19.54
Active Settings Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time		19.54
Settings now in use Active setting group SG Pick-up setting lset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time		19.54
Active setting group SG Pick-up setting Iset 1.2 Delay type Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time		
Pick-up setting Iset 1.2 Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time	•	
Delay type D Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time		
Definite operating time delay 0.04 Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release time		
Delayed Pick-up release Ye Release Time delay 0.06 Op. Time calc reset after release tir		DT
Release Time delay 0.06 Op. Time calc reset after release time		•
Op. Time calc reset after release time		
•	•	0.000
Continue time calculation during re	•	

The "Info" section offers many details concerning the function and its status:

- Function condition: indicates the stage's condition which can be Normal, Start, Trip, or Blocked.
- Expected operating time: Expected time delay from detecting a fault to tripping the breaker. This value can vary during a fault if an inverse curve time delay (IDMT) is used.
- Time remaining to trip: When a fault is detected this value counts down towards zero. When zero is reached, the function will trip.
- Imeas/Iset at the moment: Displays the ratio between the measured value and the pick-up level.
- Measured magnitude: In some functions it is possible to choose the monitored magnitude between Peak-to-peak, TRMS, or RMS (the default is RMS; the available magnitudes depend on the function).
- Characteristics graphs: opens graphs related to the protection function.
- Statistics: indicates the number of function starts, trips and blocks (can be cleared through "Clear statistics" "Clear").
- Measurements: displays the measurements carried out by the function.
- Active settings: displays the setting group that is currently in use and its settings (other setting groups can be set in the "Settings" section).

While the function is activated and disabled in the *Stage activation* submenu, you can disable the function through the "Info" section ("Function mode" at the top of the section).

Figure. 3.4 - 12. Settings.

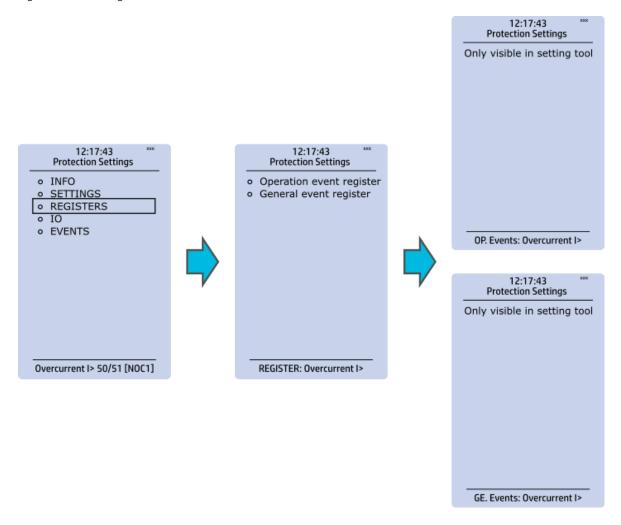


The stage settings vary depending on which protection function they are a part of. By default only one setting group of the eight available setting groups is activated. You can enable more groups in the $Control \rightarrow Setting groups$ menu, although they are set here in the "Settings" section.

Most protection functions follow the same structure:

- Pick-up setting: Defines the fault magnitude. Most functions pick-up value is in relation to the current transformer or voltage transformer nominal, but some functions use kW, ohm, Hz and other units. Voltage and current transformers nominal values can be set at *Measurement* → *Transformers*.
- Delay type and operating time delay settings are described in detail in <u>General properties of a protection function</u> chapter.

Figure. 3.4 - 13. Registers.

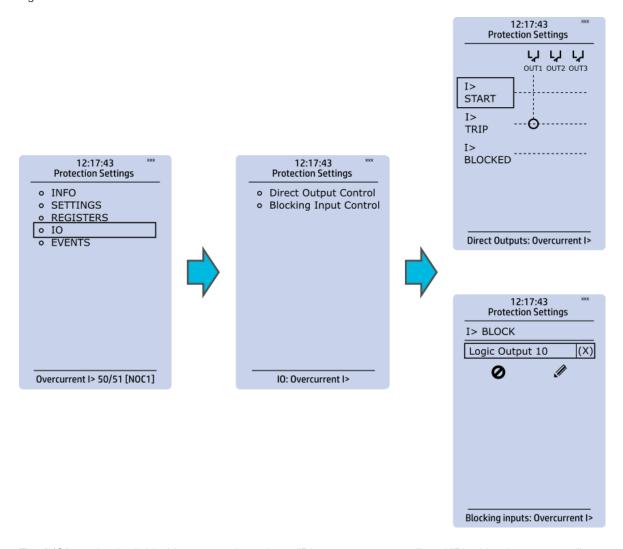


Register menu content is not available in the HMI. It can only be accessed with AQtivate setting tool. Stored in the "Registers" section you can find both "Operation event register" and "General event register".

"Operation event register" stores the function's specific fault data. There are twelve (12) registers, and each of them includes data like the pre-fault value, the fault value, the time stamp and the active group during the trigger. Data included in the register depend on the protection function. You can clear the the operation register by choosing "Clear registers" → "Clear".

"General event register" stores the event generated by the stage. These general event registers cannot be cleared.

Figure. 3.4 - 14. I/O.



The "I/O" section is divided into two subsections: "Direct output control" and "Blocking input control".

In "Direct output control" you can connect the stage's signals to physical outputs, either to an output relay or an LED (START or TRIP LEDs or one of the 16 user configurable LEDs). If the stage is blocked internally (DI or another signal), you can configure an output to indicate the stage that is blocked. A connection to an output can be either latched ("|x|") or non-latched ("|x").

"Blocking input control" allows you to block stages. The blocking can be done by using any of the following:

- · digital inputs
- logical inputs or outputs
- the START, TRIP or BLOCKED information of another protection stage
- object status information.

Figure. 3.4 - 15. Events.

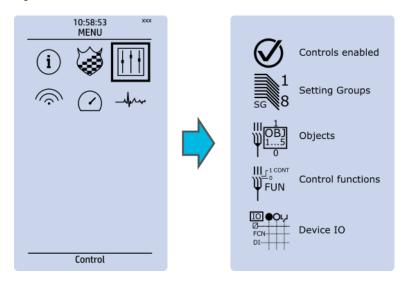


You can mask on and mask off the protection stage related events in "Event mask". By default events are masked off. You can activate the desired events by masking them ("x"). Remember to save your maskings by confirming the changes with the check mark icon. If you want to cancel the changes, select the strike-through circle to do so. Only masked events are recorded to event history (which can be accessed in the "Events" view in the user view section).

3.5 Control menu

Main menu

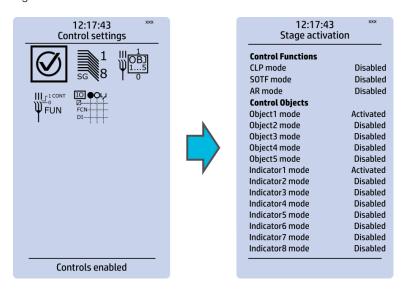
Figure. 3.5 - 16. Main menu structure.



The Control main menu includes submenus (see the image above) for enabling the various control functions and objects (Controls enabled), for enabling and controlling the setting groups (Setting groups), for configuring the objects (Objects), for setting the various control functions (Control functions), and for configuring the inputs and outputs (Device I/O). The available control functions depend on the model of the device in use.

Controls enabled

Figure. 3.5 - 17. Controls enabled submenu.

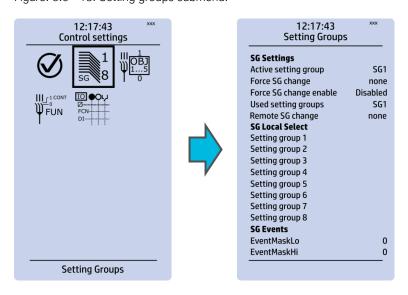


You can activate the selected control functions in the *Controls enabled* submenu. By default all the control functions are disabled. All activated functions can be viewed in the *Control functions* submenu (see the section "Control functions" below for more information).

In this submenu you can also activate and disable controllable objects. As with control functions, all objects are disabled by default. All activated objects can be viewed in the *Objects* submenu (see the section "Objects" below for more information).

Setting groups

Figure. 3.5 - 18. Setting groups submenu.



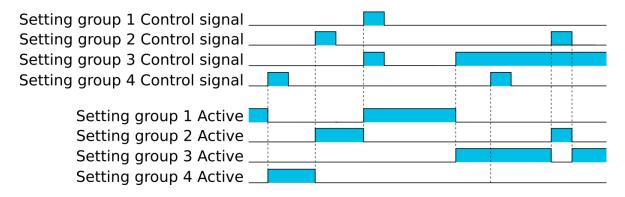
The Setting groups submenu displays all the information related to setting group changing, such as the following:

- Active setting group: displays the current active setting group (SG1...SG8).
- Force setting group change: this setting allows the activation of a setting group at will (please note that Force SG change enable must be "Enabled").

- Used setting groups: this setting allows the activation of setting groups SG1...SG8 (only one group is active by default).
- SG local select: selects the local control for the different setting groups (can use digital inputs, logical inputs or outputs, RTDs, object status information as well as stage starts, trips or blocks).
- Remote setting group change: When enabled it is possible to change the setting group manually through SCADA.
- SG events: event masking for setting groups (masks are OFF by default; please note that only masked events are recorded into the event history).

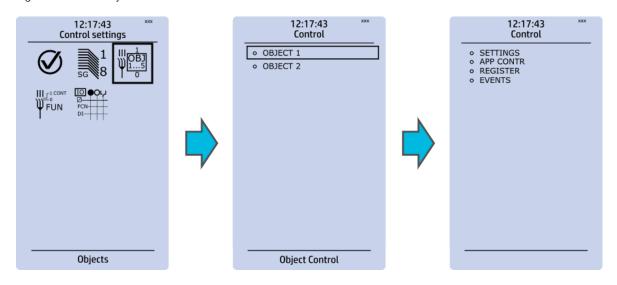
Setting group 1 (SG1) has the highest priority, while Setting group 8 (SG8) has the lowest priority. Setting groups can be controlled with pulses or with both pulses and static signals (see the image below).

Figure. 3.5 - 19. Example of setting group (SG) changing.



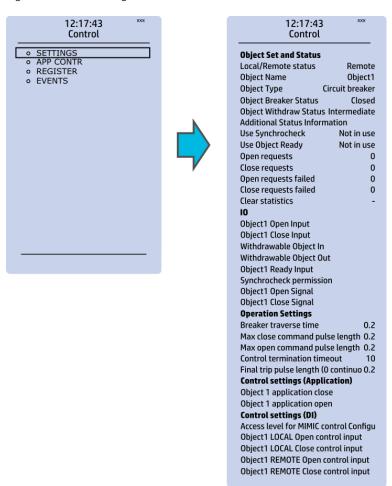
Objects

Figure. 3.5 - 20. Objects submenu.



Each activated object is visible in the *Objects* submenu. By default all objects are disabled unless specifically activated in the *Controls* → *Controls* enabled submenu. Each active object has four sections in their submenus: "Settings", "Application control" ("App contr"), "Registers" and "Events". These are described in further detail below.

Figure. 3.5 - 21. Settings section.



OBJECT SET AND STATUS

- Local/Remote status: control access may be set to Local or Remote (Local by default; please note that when local control is enabled, the object cannot be controlled through the bus and vice versa).
- Object name: the name of the object (objects are named "ObjectX" by default).
- Object type: selects the type of the object from Grounding disconnector, Motor-controlled disconnector, Circuit breaker and Withdrawable circuit breaker (Circuit breaker by default).
- Object x status: the status can be Bad, Closed, Open and Intermediate. The status "Intermediate" is the phase between "Open" and "Closed" where both status inputs are 0. The status "Bad" occurs when both status inputs of the object/cart are 1.
- Additional status information: gives feedback from the object on whether the opening and closing are allowed or blocked, whether the object is ready, and whether the synchronization status is ok.
- Use synchrocheck and Use Object ready: closing the object is forbidden when the sides are not synchronized or when the object is not ready to be closed.
- Open requests and Close requests: displays the statistics, i.e. the number of Open and Close requests.
- Open requests failed and Close requests failed: displays the statistics of Open and Close request failures. A request is considered to have failed when the object does not change its status as a result of that request.
- Clear statistics: statistics can be cleared by choosing "Clear statistics" and then "Clear".

<u>I/O</u>

- An object has both Open input and Close input signals which are used for indicating the status of the breaker on the HMI and in SCADA. Status can be indicated by any of the following: digital inputs, logical inputs or outputs.
- A withdrawable object has both In and Out inputs. The status can be indicated by any of the following: digital inputs, logical inputs or outputs.
- Both Object ready and Synchrocheck permission have status inputs. If either one is used, the input(s) must be active for the device to be able to give the "Object Close" command.
- Object open and Object close signals define which digital output is controlled.

OPERATION SETTINGS

- Breaker traverse time: determines how long a gap there can be between a status change from "Open" to "Closed" before an intermediate status is reported by the function.
- Max close/open command pulse length: defines the maximum length of "Open" and "Close" commands. If the status has changed before the maximum pulse length has elapsed, the pulse is cut short.
- Control termination timeout: If the status of the object does not change during the set time, an "Open/Close request failed" event is recorded.
- After the set delay, if the controlled object does not respond accordingly, the procedure is terminated and a fail message is issued.

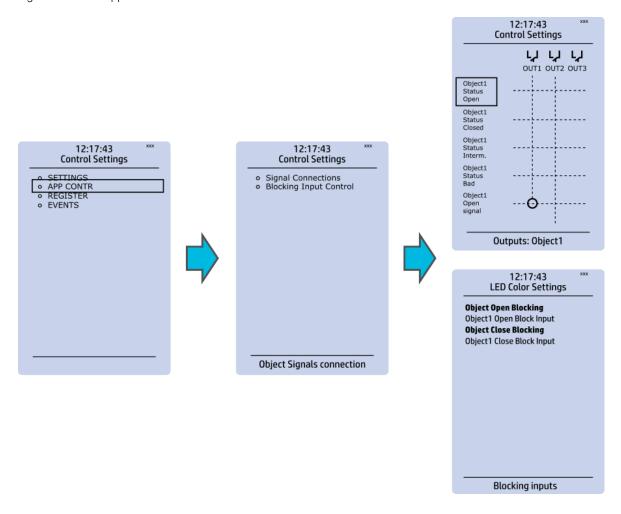
CONTROL SETTINGS (APPLICATION)

 Object application close and Object application open: a signal set to these points can be used to open and close the object. Controlling the object through this point does not follow the local/ remote status of the device.

CONTROL SETTINGS (DI)

- Access level for MIMIC control: determines the access level required to control the MIMIC (each level has its own password). By default, the access level is set to "Configurator".
- You can use digital inputs to control the object locally or remotely. Remote controlling via the bus is configured on the protocol level.

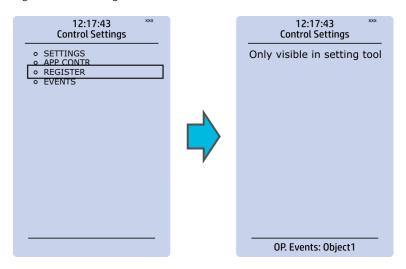
Figure. 3.5 - 22. Application control section.



You can connect object statuses directly to specific physical outputs in the "Signal connections" subsection ($Control \rightarrow Application \ control$). A status can be connected to output relays, as well as to user-configurable LEDs. A connection to an output can be either latched ("|x|") or non-latched ("x").

Object blocking is done in the "Blocking input control" subsection. It can be done by any of the following: digital inputs, logical inputs or outputs, object status information as well as stage starts, trips or blocks.

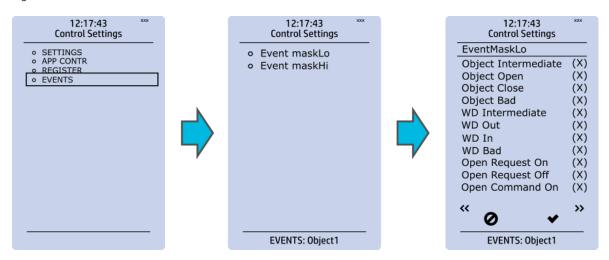
Figure. 3.5 - 23. Registers section.



The "Registers" section stores the function's specific fault data. There are twelve (12) registers, and each of them includes data such as opening and closing times, command types and request failures. The data included in the register depend on the protection function. You can clear the the operation register by choosing "Clear registers" → "Clear".

Please note that the content of the *Registers* section is not available in the HMI. It can only be accessed via the AQtivate setting tool.

Figure. 3.5 - 24. Events section.

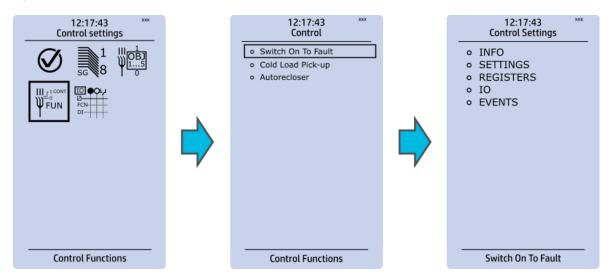


You can mask on and mask off events related to an object's stage in "Event mask". By default all events are masked off. You can activate the desired events by masking them ("x"). Please remember to save your maskings by confirming the changes with the check mark icon. If you want to cancel the changes, select the strike-through circle to do so. Only masked events are recorded to the event history (which can be accessed in the "Events" view in the user view section).

Control functions

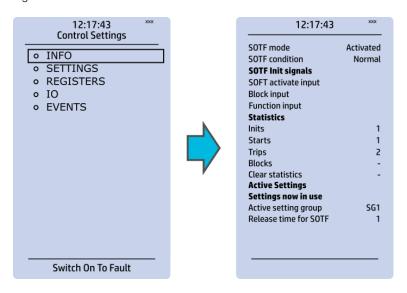
Once a control function has been activated in the $Controls \rightarrow Controls$ enabled submenu, its own submenu can be opened. In the image series below, the user has activated three control functions. The user accesses the list of activated control stages through the "Control functions" module, and selects the control function for further inspection.

Figure. 3.5 - 25. Control functions submenu.



Each control function that has been activated is listed in the *Control functions* submenu (see the middle image above). This submenu includes the following sections: "Info", "Settings", "Registers", "I/O" and "Events". The text below describes these in further detail.

Figure. 3.5 - 26. Info section.

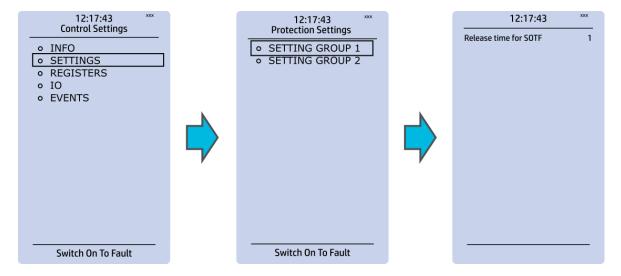


The "Info" section offers many details concerning the function and its status:

- Function condition: indicates the stage's condition which can be Normal, Start, Trip, or Blocked.
- Measured magnitude: In some functions it is possible to choose the monitored magnitude between Peak-to-peak, TRMS, or RMS (the default is RMS; the available magnitudes depend on the function).
- Statistics: indicates the number of function starts, trips and blocks (can be cleared through "Clear statistics" → "Clear").
- Measurements: displays the measurements carried out by the function.
- Active settings: displays the setting group that is currently in use and its settings (other setting groups can be set in the "Settings" section).

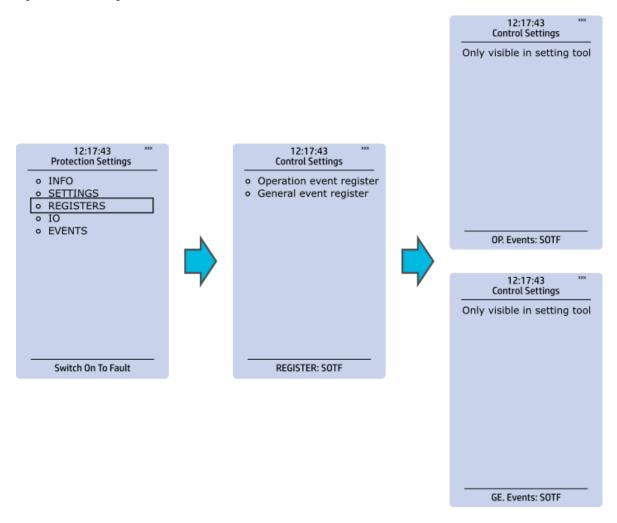
While the function is activated and disabled in the $Control \rightarrow Controls$ enabled submenu, you can disable the function through the "Info" section (the [function name] mode at the top of the section).

Figure. 3.5 - 27. Settings section.



The stage settings vary depending on which control function they are a part of. By default only one setting group of the eight available setting groups is activated. You can enable more groups in the $Control \rightarrow Setting groups$ menu, although they are set here in the "Settings" section.

Figure. 3.5 - 28. Registers section.

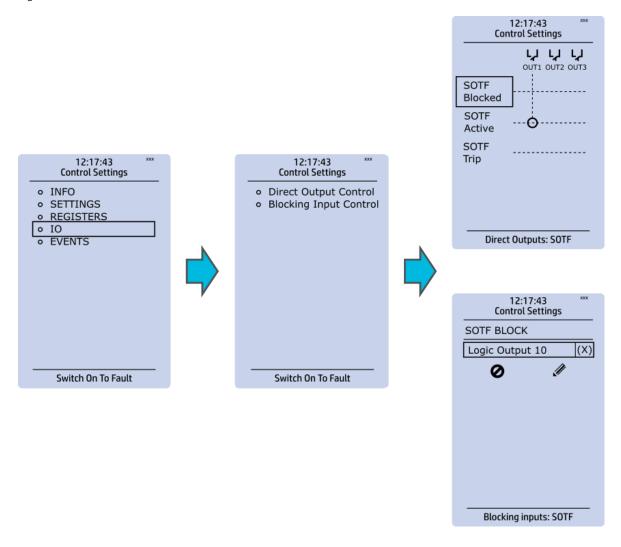


Please note that the content of the "Registers" section is not available in the HMI. It can only be accessed via the AQtivate setting tool. Stored in the "Registers" section you can find both "Operation event register" and "General event register".

"Operation event register" stores the function's specific operation data. There are twelve (12) registers, and each of them includes data like the pre-fault value, the fault value, the time stamp and the active group during the trigger. Data included in the register depend on the control function. You can clear the the operation register by choosing "Clear registers" \rightarrow "Clear".

"General event register" stores the event generated by the stage. These general event registers cannot be cleared.

Figure. 3.5 - 29. I/O section.



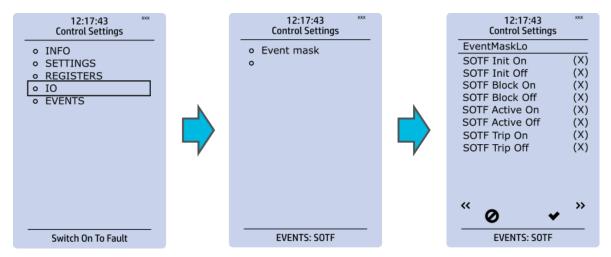
The "I/O" section is divided into two subsections: "Direct output control" and "Blocking input control".

In "Direct output control" you can connect the stage's signals to physical outputs, either to an output relay or an LED (START or TRIP LEDs or one of the 16 user configurable LEDs). If the stage is blocked internally (by a digital input or another signal), you can configure an output to indicate the stage that is blocked. A connection to an output can be either latched ("|x|") or non-latched ("x").

"Blocking input control" allows you to block stages. The blocking can be done by using any of the following:

- · digital inputs.
- logical inputs or outputs.
- the START, TRIP or BLOCKED information of another protection stage.
- · object status information.

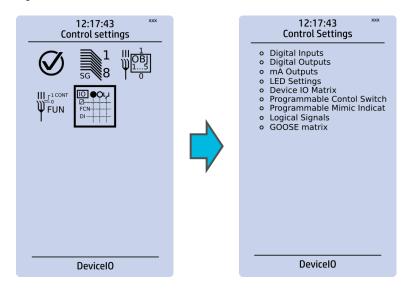
Figure. 3.5 - 30. Events section.



You can mask on and mask off events related to an object's stage in "Event mask". By default all events are masked off. You can activate the desired events by masking them ("x"). Please remember to save your maskings by confirming the changes with the check mark icon. If you want to cancel the changes, select the strike-through circle to do so. Only masked events are recorded to the event history (which can be accessed in the "Events" view in the user view section).

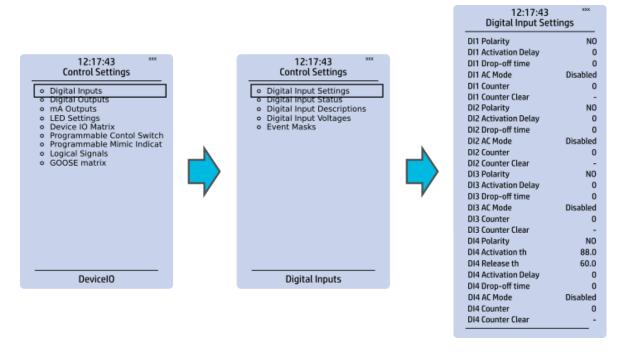
Device I/O

Figure. 3.5 - 31. Device I/O submenu.



The *Device I/O* submenu is divided into the following nine sections: "Digital inputs", "Digital outputs", "mA Outputs", "LED settings", "Device I/O matrix", "Programmable control switch", "Programmable Mimic Indicator", "Logic signals" and "GOOSE matrix". Please note that digital inputs, logic outputs, protection stage status signals (START, TRIP, BLOCKED, etc.) as well as object status signals can be connected to an output relay or to LEDs in the "Device I/O matrix" section.

Figure. 3.5 - 32. Digital input section.

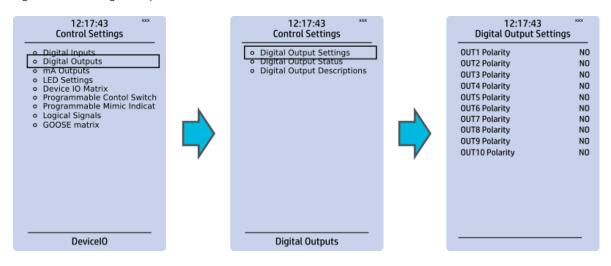


All settings related to digital inputs can be found in the "Digital inputs" section.

The "Digital inputs settings" subsection includes various settings for the inputs: the polarity selection determines whether the input is Normal Open (NO) or Normal Closed (NC) as well as the activation threshold voltage (16...200 V AC/DC, step 0.1 V) and release threshold voltage (10...200 V AC/DC, step 0.1 V) for each available input. There is also a setting to determine the wanted activation and release delay (0...1800 s, step 1 ms). Digital input activation and release threshold follow the measured peak value. The activation time of an input is 5...10 ms. The release time with DC is 5...10 ms, while with AC it is less than 25 ms. The first three digital inputs don't have activation and release threshold voltage settings as these have already been defined when the unit was ordered.

Digital input statuses can be checked from the corresponding subsection ("Digital input status"). The "Digital input descriptions" subsection displays the texts the user has written for each digital input. In the "Event masks" subsection you can determine which events are masked –and therefore recorded into the event history– and which are not.

Figure. 3.5 - 33. Digital outputs section.



All settings related to digital outputs can be found in the "Digital outputs" section.

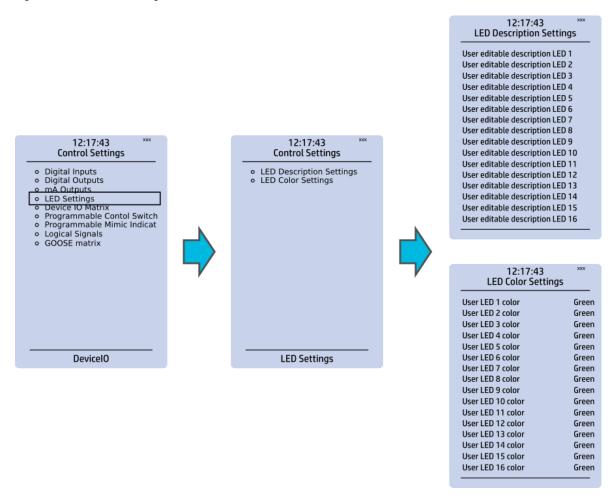
The "Digital outputs settings" subsection lets you select the polarity for each output; they can be either Normal Open (NO) or Normal Closed (NC). The default polarity is Normal Open. The operational delay of an output contact is approximately 5 ms. You can view the digital output statuses in the corresponding subsection ("Digital output status"). The "Digital output descriptions" subsection allows you to configure the description text for each output. All name changes affect the matrices as well as input—output selection lists.

NOTICE!



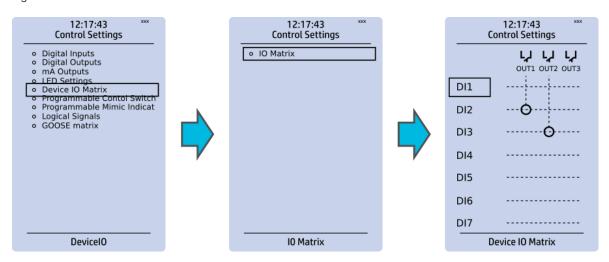
An NC signal goes to the default position (NO) if the device loses the auxiliary voltage or if the system is fully reset. However, an NC signal does not open during voltage or during System full reset. An NC output signal does not open during a Communication or Protection reset.

Figure. 3.5 - 34. LED settings section.



The "LED settings" section allows you to modify the individual label text attached to an LED ("LED description settings"); that label is visible in the LED quick displays and the matrices. You can also modify the color of the LED ("LED color settings") between green and yellow; by default all LEDs are green.

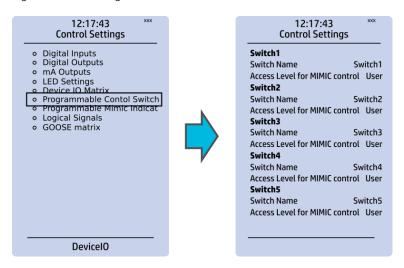
Figure. 3.5 - 35. Device I/O matrix section.



Through the "Device I/O matrix" section you can connect digital inputs, logical outputs, protection stage status signals (START, TRIP, BLOCKED, etc.), object status signals and many other binary signals to output relays, or to LEDs configured by the used. A connection can be latched ("|x|") or non-latched ("x"). Please note that a non-latched output is deactivated immediately when the triggering signal is disabled, while a latched signal stays active until the triggering signal deactivates and the latched function is manually cleared.

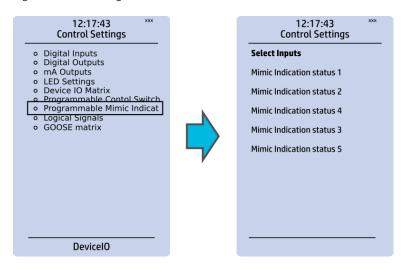
You can clear latched signals by entering the mimic display and the pressing the **Back** button on the panel.

Figure. 3.5 - 36. Programmable control switch section.



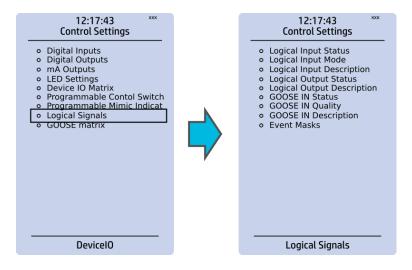
Programmable control switches (PCSs) are switches that can be used to control signals while in the mimic view. These signals can be used in a variety of situations, such as for controlling the logic program, for function blocking, etc. You can name each switch and set the access level to determine who can control the switch.

Figure. 3.5 - 37. Programmable mimic indicators section.



Programmable mimic indicators can be placed into the mimic to display a text based on the status of a given binary signal (digital input, logical signal, status of function start/tripped/blocked signals etc.). When configuring the mimic with the AQtivate 200 setting tool, it is possible to set a text to be shown when an input signal is ON and a separate text for when the signal is OFF.

Figure. 3.5 - 38. Logical signals section.



All AQ 200 series units have the following types of logical signals:

- 32 logical input signal status bits; the status of a bit is either 0 or 1.
- 32 logical output signal status bits; the status of a bit is either 0 or 1.
- 64 GOOSE input signal status bits; the status of a bit is either 0 or 1.
- 64 quality bits for GOOSE input signals; the status of a bit is either 0 or 1.

Logical input signals can be used when building a logic with the AQtivate 200 setting tool. The status of a logical input signal can be changed either from the mimic or through SCADA. By default logical inputs use "Hold" mode in which the status changes from 0 to 1 and from 1 to 0 only through user input. The mode of each input can be changed to "Pulse" in which a logical input's status changes from 0 to 1 through user input and then immediately back to 0.

Logical output signals can be used as the end result of a logic that has been built in the AQtivate 200 setting tool. The end result can then be connected to a digital output or a LED in the matrix, block functions and much more.

GOOSE inputs are mainly used for controlling purposes and in conjunction with the IEC 61850 communication protocol. There are 64 GOOSE inputs signal status bits, and their status can be either 0 or 1. "GOOSE IN quality" checks the quality of a GOOSE input message. There are 64 GOOSE input quality signals, and their status can be either 0 ("Good" or "Valid") or 1 ("Bad" or "Invalid"). Logical outputs can be used when building a programmable logic. Activating a logic gate does not create an event but when a logical output is connected to a logic gate it is possible to create an event from the gate's activation. All logical inputs and outputs have both ON and OFF events, and they can be masked on when necessary (they are masked off by default).

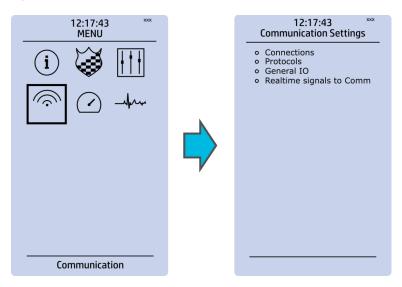
i

NOTICE!

Please refer to the "Communication" chapter for a more detailed description of the use of logical signals.

3.6 Communication menu

Figure. 3.6 - 39. Communication menu.

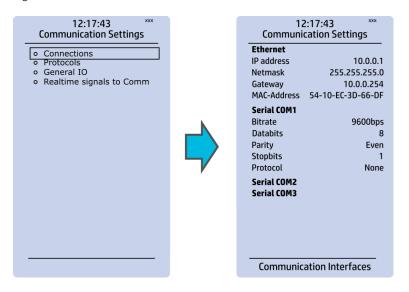


The Communication main menu includes four submenus (as seen in the figure above): Connections, Protocols, General IO and Realtime signals to Comm. All devices can be configured through the Ethernet connection in the back panel with the AQtivate 200 setting tool software. Connecting to AQtivate requires knowing the IP address of your device: this can be found in the Communication \rightarrow Connections submenu. As a standard, the devices support the following communication protocols:

- NTP
- IEC 61850
- Modbus/TCP
- Modbus/RTU
- IEC-103
- IEC -101/104
- SPA
- DNP3
- · ModbusIO.

Connections

Figure. 3.6 - 40. View of the Connections submenu.



The Connections submenu offers the following bits of information and settings:

ETHERNET

This section defines the IP settings for the Ethernet port in the back panel of the unit.

- IP address: the IP address of the device which can be set by the user (the default IP address depends on the device).
- · Network: the network subnet mask is entered here.
- Gateway: the gateway is configured only when communicating with devices in a separate subnet.
- MAC-Address: The unique MAC address of the device, which is <u>not</u> configurable by the user.

SERIAL COM

This section defines the basic settings of the RS-485 port in the back panel of the unit.

- Bitrate: displays the bitrate of the RS-485 serial communication interface (9600 bps as standard, although it can be changed to 19,200 bps or to 38,400 bps if an external device supports the faster speed).
- Databits, Parity and Stopbits: these can be set according to the connected external devices.
- Protocol: by default the device does not have any serial protocol activated, although IEC 103, Modbus I/O and Modbus/RTU can be used for communication.



NOTICE!

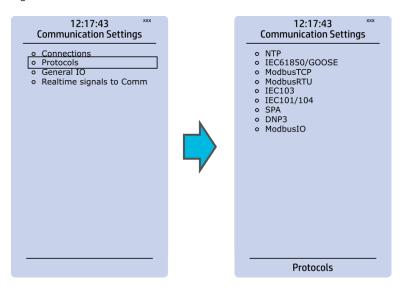
When communicating with a device via the front Ethernet port connection, the IP address is always 192.168.66.9.

SERIAL COM1 & COM2

SERIAL COM1 and SERIAL COM2 are reserved for serial communication option cards. They have the same settings as the RS-485 port.

Protocols

Figure. 3.6 - 41. View of the Protocols submenu.



The *Protocols* submenu offers access to the various communication protocol configuration menus. Some of the communication protocols use serial communication and some use Ethernet communication. Serial communication protocols can be used either with the RS-485 port that is in AQ 200 series units by default, or with a serial communication option card. Ethernet communication protocols can be used either with the RJ-45 port in the back of the unit or with an Ethernet communication option card.

The communication protocols are:

- NTP: this protocol is used for time synchronization over Ethernet, and can be used simultaneously with Ethernet-based communication protocols.
- IEC 61850: an Ethernet-based communication protocol.
- Modbus/TCP: an Ethernet-based communication protocol.
- Modbus/RTU: a serial communication protocol.
- IEC-103: a serial communication protocol.
- IEC-101/104: since the standards IEC 60870-5-101 and IEC 60870-5-104 are closely related, the IEC-101 protocol uses serial communication on the physical layer, whereas the IEC-104 protocol uses Ethernet communication.
- SPA: a serial communication protocol.
- DNP3: supports both serial and Ethernet communication.
- ModbusIO: used for connecting external devices like ADAM RTD measurement units.

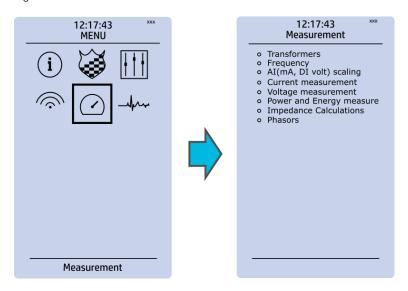


NOTICE!

Please refer to the "Communication" chapter for a more detailed text on the various communication options.

3.7 Measurement menu

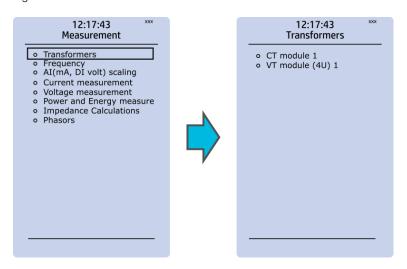
Figure. 3.7 - 42. Measurement section.



The *Measurement* menu includes the following submenus: *Transformers*, *Frequency*, *Current measurement*, *Voltage measurement*, *Power and energy measurement*, *Impedance calculations*, and *Phasors*. The available measurement submenus depends on the type of device in use. The ratio used by the current and voltage transformers is defined in the *Transformers* submenu, while the system nominal frequency is specified in the *Frequency* submenu. Other submenus are mainly for monitoring purposes.

Transformers

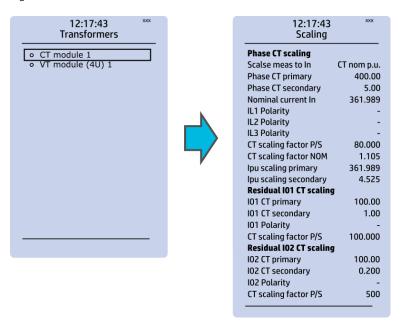
Figure. 3.7 - 43. Transformers section.



Transformers menu is used for setting up the measurement settings of available current transformer modules or voltage transformer modules. Some unit types have more than one CT or VT module. Some unit types like AQ-S214 do not have current or voltage transformers at all.

CT module

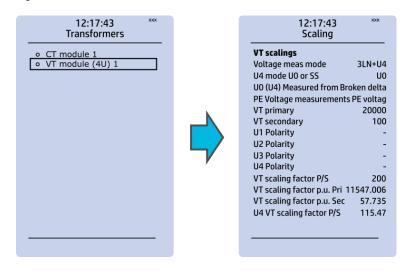
Figure. 3.7 - 44. CT module section.



The three main sections ("Phase CT scaling", "Residual I01 CT scaling" and "Residual I02 CT scaling") determine the ratio of the used transformers. Additionally, the nominal values are also determined in the *CT module* submenu. Sometimes a mistake in the wiring can cause the polarity to be changed; in such cases, you can invert the polarity of each phase current individually. The *CT module* submenu also displays additional information such as CT scaling factors and per-unit scaling factors.

VT module

Figure. 3.7 - 45. VT module section.

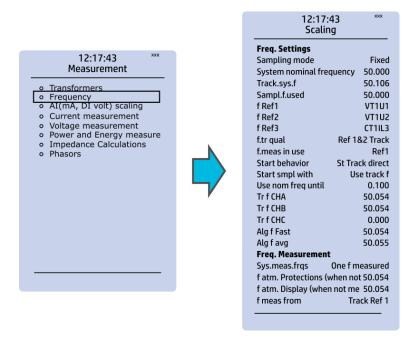


Voltage transformer settings include voltage measurement mode selection, voltage transformer nominal settings and voltage channel polarity switching. Voltage transformer setting defines what kind of voltages are connected to the VT module card. The voltages are: three line-to-line voltages, three line-to-neutral voltages, two line-to-line voltages leaving the third one free as additional voltage channel for neutral voltage or synchrochecking. U4 channel can be set to work as residual voltage mode or "SS" (system set) mode, which can be used for synchrochecking, synchronizing and other uses.

VT primary and secondary voltages must match with the connected voltage transformer in addition to the voltage measurement mode. These settings are then used for scaling the voltage channel input voltages to primary and per unit values as well as power and energy measurement values if current measurements are also available.

Frequency

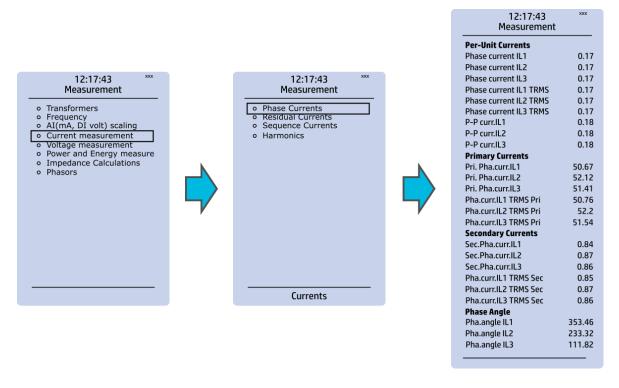
Figure. 3.7 - 46. Frequency submenu.



Frequency measurements use the fixed sampling mode as the default, and "System nominal frequency" should be set to the desired level. When "Sampling mode" is set to "Tracking", the device uses the measured frequency value as the system nominal frequency. There are three frequency reference channels: f Ref1, fRef2 and fRef3. With these parameters it is possible to set up three voltage or current channels to be used for frequency sampling. Parameter "f.meas in use" indicates which of the three channels are used for sampling if any.

Current measurement

Figure. 3.7 - 47. Current measurement submenu.



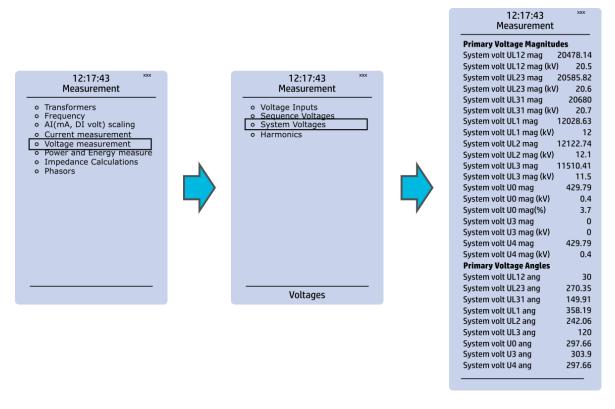
Current measurement submenu includes various individual measurements for each phase or phase-to-phase measurement.

The *Current measurement* submenu has been divided into four sections: "Phase currents", "Residual currents", "Sequence currents", and "Harmonics".

- "Phase currents" and "Residual currents" have been further divided into four subsections ("Per-unit currents", "Primary currents", "Secondary currents" and "Phase angle"), and they display the RMS, TRMS and peak-to-peak values, amplitude and power THD values as well as the angle of each measured component.
- "Sequence currents" has also been further divided into the four above-mentioned sections, and it calculates the positive, negative and zero sequence currents.
- "Harmonics" displays current harmonics up to the 31st harmonic for the three phase current (IL1, IL2, IL3) as well as the two residual currents (I01, I02); each component can be displayed as absolute or percentage values, and as primary or secondary amperages or in per-unit values.

Voltage measurement

Figure. 3.7 - 48. Voltage measurement submenu and System Voltages menu.



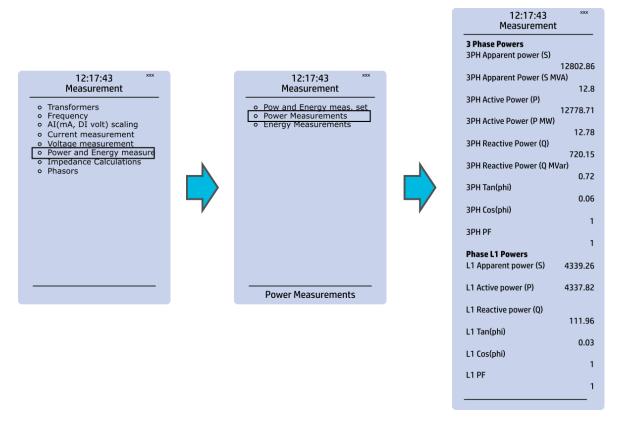
Voltage measurement submenu includes various individual measurements for each phase or phase-to-phase measurement.

The *Voltage measurement* submenu has been also divided into four sections: "Voltage inputs", "Sequence voltages", "System voltages", and "Harmonics".

- "Voltage inputs" displays the values of per-unit and secondary voltages as well as phase angles.
- "Sequence voltages" displays the per-unit, primary and secondary voltages as well as phase angles, and it calculates the positive, negative and zero sequence voltages.
- "System voltages" displays primary voltage magnitudes and primary voltage angles.
- "Harmonics" displays harmonics up to the 31st harmonic for all four voltages (U1, U2, U3, U4); each component can be displayed as absolute or percentage values, and as primary or secondary voltages or in per-unit values.

Power and energy measurement

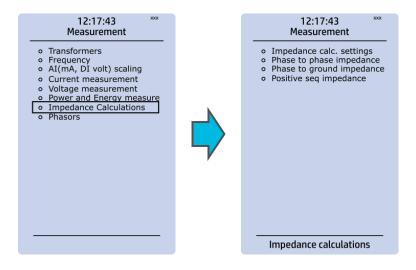
Figure. 3.7 - 49. Power and Energy measurement submenu.



The Power and energy measurement submenu includes three sections: "Power and energy measurement settings", "Power measurements" and "Energy measurements". As the name suggests, the first section determines the settings by which the power and energy calculations are made. In the settings you can also activate (and then set the parameters) for the Energy dose counter mode. "Power measurements" displays all three-phase powers as well as the powers of individual phases. "Energy measurements" displays the three-phase energy as well as the energies of the individual phases.

Impedance calculations

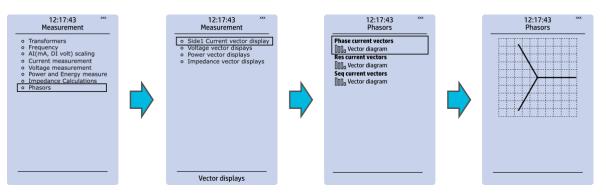
Figure. 3.7 - 50. Impedance calculations submenu.



The *Impedance calculations* submenu is divided into four sections: "Impedance calculation settings", "Phase-to-phase impedances", "Phase-to-earth impedances" and "Positive sequence impedance". You can activate impedance calculations in the first section. "Phase-to-phase impedances" display the resistances and reactances of the three phase-to-phase connections, both primary and secondary, as well as the primary and secondary impedances and impedance angles. "Phase-to-earth impedances" displays the resistances and reactances of the three phases as well the primary and secondary impedances and impedance angles. "Positive sequence impedance" displays the resistances and reactances (both primary and secondary) of the positive sequence as well as its primary and secondary impedances and the impedance angle.

Phasors

Figure. 3.7 - 51. Phasors submenu.

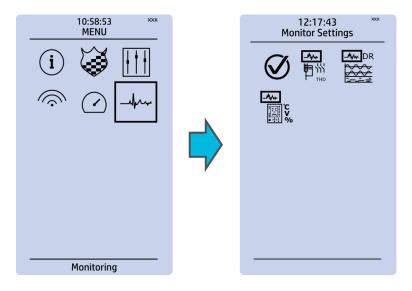


The *Phasors* submenu holds the vector displays for voltages and currents, as well as the various calculated components the device may have (e.g. power, impedance). Phasors are helpful when solving incorrect wiring issues.

3.8 Monitoring menu

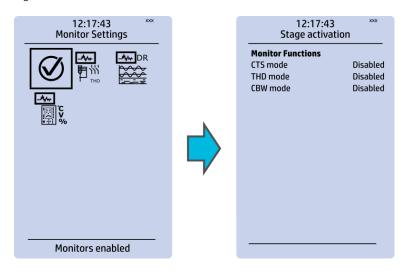
The *Monitoring* main menu includes submenus (see the image below) for enabling the various monitoring functions (*Monitors enabled*), setting the various monitoring functions (*Monitor functions*), controlling the disturbance recorder (*Disturbance REC*) and accessing the device diagnostics (*Device diagnostics*). The available monitoring functions depend on the type of the device in use.

Figure. 3.8 - 52. Monitoring menu view.



Monitors enabled

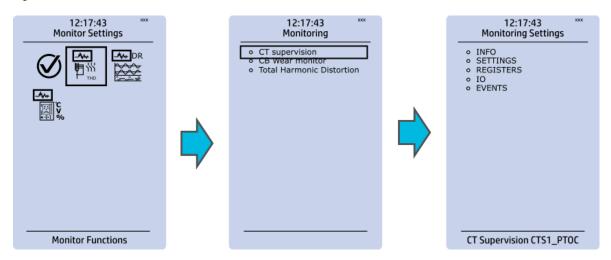
Figure. 3.8 - 53. Monitors enabled submenu.



You can activate the selected monitor functions in the *Monitors enabled* submenu. By default all the control functions are disabled. All activated functions can be viewed in the *Monitor functions* submenu (see the section "Monitor functions" below for more information).

Monitor functions

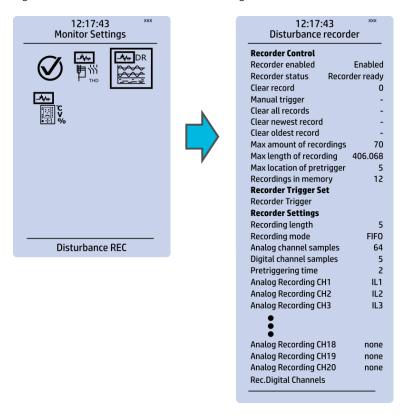
Figure. 3.8 - 54. Monitor function view.



Configuring monitor functions is very similar to configuring protection and control stages. They, too, have the five sections that display information ("Info"), set the parameters ("Settings"), show the inputs and outputs ("I/O") and present the events and registers ("Events" and "Registers").

Disturbance recorder

Figure. 3.8 - 55. Disturbance recorder settings.



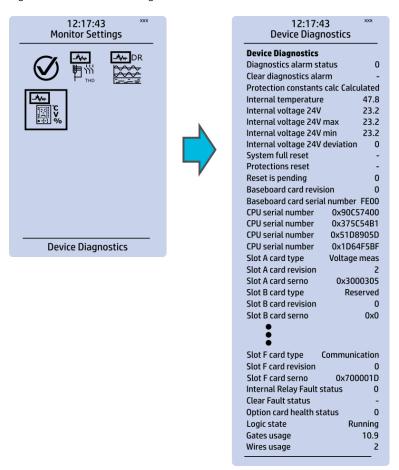
The *Disturbance recorder* submenu has the following settings:

- "Recorder enabled" enables or disables the recorder.
- "Recorder status" indicates the status of the recorder.
- "Clear record" records the chosen record in the memory.
- "Manual trigger" triggers the recorder when set to "Clear". Goes back to "-" when afterwards.
- "Clear all records", "Clear newest record" and "Clear oldest record" allows the clearing of all, the latest, or the oldest recording.
- "Max. amount of recordings" displays the maximum number of recordings; depends on the number of channels, the sample rate and the legnth of the file.
- "Max. length of recording" displays the maximum length of a single recording; depends on the number of chosen channels and the sample rate.
- "Recordings in memory" displays the number of recordings currently in the disturbance recorder's memory
- "Recorder trigger" shows which signals or other states has been selected to trigger the recording (digital input, logical input or output, signals of a stage, object position, etc.); by default nothing triggers the recorder.
- "Recording length" displays the length of a single recording and can be set between 0.1...1,800.0 seconds
- "Recording mode" can be selected to replace the oldest recording ("FIFO") or to keep the old recordings ("FILO").
- "Analog channel samples" determines the sample rate of analog channels, and it can be selected to be 8/16/32/62 samples per cycle.
- "Digital channel samples" displays the sample rate in a digital channel; this is a fixed 5 ms.
- "Pretriggering time" can be selected between 0.1...15.0 s.
- The device can record up to 20 (20) analog channels that can be selected from the twenty (20) available channels. Every measured current or voltage signal can be selected to be recorded.

- Enabling "Auto. get recordings" allows the device to automatically upload recordings to the designated FTP folder (which, in turn, allows any FTP client to read the recordings from the device's memory).
- "Rec. digital channels" is a long list of the possible digital channels that can be recorded (including primary and secondary amplitudes and currents, calculated signals, TRMS values, sequence components, inputs and outputs, etc.).

Device diagnostics

Figure. 3.8 - 56. Device diagnostics submenu.



The *Device Diagnostics* submenu gives a detailed feedback of the device's current condition. It also shows whether option cards have been installed correctly without problems. If you see something out of the ordinary in the *Device diagnostics* submenu and cannot reset it, please contact the closest representative of the manufacturer or the manufacturer of the device itself.

3.9 Configuring user levels and their passwords

As a factory default, no user level is locked with a password in a device. In order to activate the different user levels, click the **Lock** button in the device's HMI and set the desired passwords for the different user levels.

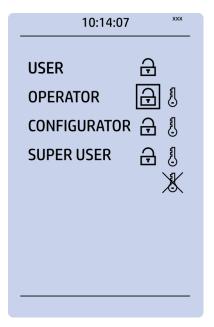


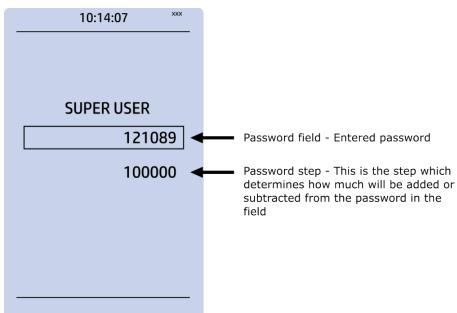
NOTICE!

Passwords can only be set locally in an HMI.

A number of stars are displayed in the upper right corner of the HMI; these indicate the current user level. The different user levels and their star indicators are as follows (also, see the image below for the HMI view):

- Super user (***)
- Configurator (**)
- Operator (*)
- User ()





You can set a new password for a user level by selecting the key icon next to the user level's name. After this you can lock the user level by pressing the **Return** key while the lock is selected. If you need to change the password, you can select the key icon again and give a new password. To remove the password, set the password to "0" (zero). Please note that in order to do this the user level whose password is being changed must be unlocked.

As mentioned above, the access level of the different user levels is indicated by the number of stars. The required access level to change a parameter is indicated with a star (*) symbol if such is required. As a general rule the access levels are divided as follows:

- *User:* Can view any menus and settings but cannot change any settings, nor operate breakers or other equipment.
- Operator: Can view any menus and settings but cannot change any settings BUT can operate breakers and other equipment.
- Configurator: Can change most settings such as basic protection pick-up levels or time delays, breaker control functions, signal descriptions etc. and can operate breakers and other equipment.
- Super user: Can change any setting and can operate breakers and other equipment.

i

NOTICE!

Any user level with a password automatically locks itself after half an hour (30 minutes) of inactivity.

4 Functions

4.1 Functions included in AQ-G215

The AQ-G215 generator protection device includes the following functions as well as the number of stages in those functions.

Table. 4.1 - 4. Protection functions of AQ-G215.

Name (number of stages)	IEC	ANSI	Description
NOC (4)	> >> >>> >>>	50/51	Non-directional overcurrent protection
DOC (4)	ldir> ldir>> ldir>>> ldir>>>	67	Directional overcurrent protection
NEF (4)	0> 0>> 0>>> 0>>>	50N/51N	Non-directional earth fault protection
DEF (4)	10dir> 10dir>> 10dir>>> 10dir>>>	67N/32N	Directional earth fault protection
OV (4)	U> U>> U>>> U>>>>	59	Overvoltage protection
UV (4)	U< U<< U<<< U<<<	27	Undervoltage protection
NOV (4)	U0> U0>> U0>>> U0>>>	59N	Neutral overvoltage protection
FRQV (8)	f> f>> f>>> f>>> f< f< f<< f<<	81O/81U	Overfrequency and underfrequency protection
ROCOF (8)	df/dt>/< (18)	81R	Rate-of-change of frequency

Name (number of stages)	IEC	ANSI	Description
CUB (4)	2> 2>> 2>> 2>>>	46/46R/46L	Negative sequence overcurrent/ phase current reversal/ current unbalance protection
VUB (4)	U1/U2>/< U1/U2>>/< U1/U2>>>/<< U1/ U2>>>/<<	47/27P/59PN	Sequence voltage protection
HOC (4)	h> h>> h>>> h>>>	50H/51H/68H	Harmonic overcurrent protection
CBFP (1)	CBFP	50BF/52BF	Circuit breaker failure protection
REFE (1)	I0d>	87N	Low-impedance or high-impedance restricted earth fault/cable end differential protection
TOLM (1)	TM>	49M	Machine thermal overload protection
SEF (1)	U03rd<	64S	100% stator earth fault protection
UEX (1)	Q<	40	Underexcitation protection
UIM (2)	Z< Z<<	21U	Underimpedance protection
VOC (1)	lv>	51	Voltage-restrained overcurrent protection
VHZ (1)	V/Hz>	24	Volts-per-hertz overexcitation protection
UPF (1)	PF<	55	Power factor protection
RTD (116)	-	-	RTD alarms (Resistance temperature detector)
PQS (4)	P, Q, S >/< P, Q, S >>/< P, Q, S >>>/<< P, Q, S >>>>/<<<	32	Power protection
PGS (1)	PGx>/<	99	Programmable stage
ARC (1)	IArc>/I0Arc>	50Arc/50NArc	Arc fault protection (optional)

Table. 4.1 - 5. Control functions of AQ-G215.

Name	IEC	ANSI	Description
SGS	-	-	Setting group selection (8 setting groups available)
OBJ	-	-	Object control and monitoring (5 objects available)

Name	IEC	ANSI	Description
CIN	-	-	Indicator object monitoring (5 indicators available)
VJP	Δφ	78	Vector jump
SYN	ΔV/Δa/Δf	25	Synchrocheck
PCS	-	-	Programmable control switch

Table. 4.1 - 6. Monitoring functions of AQ-G215.

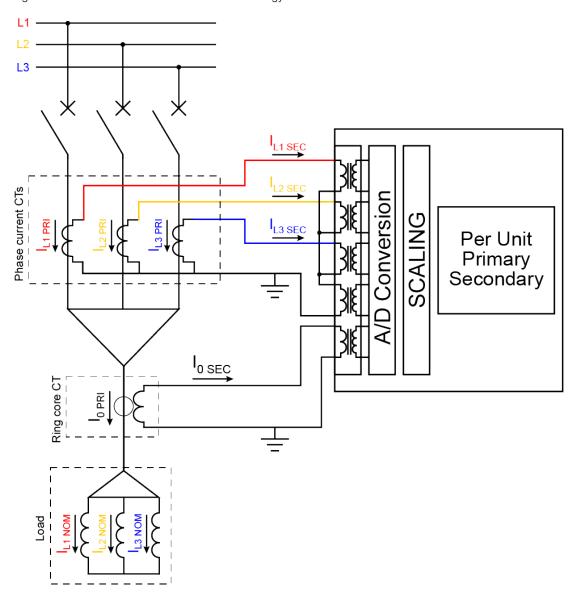
Name	IEC	ANSI	Description
CTS	-	-	Current transformer supervision
VTS	-	60	Voltage transformer supervision
DR	-	-	Disturbance recorder
CBW	-	-	Circuit breaker wear monitor
THD	-	-	Total harmonic distortion
RHC	-	-	Running hour counter
MREC	-	-	Measurement recorder
VREC	-	-	Fault register

4.2 Measurements

4.2.1 Current measurement and scaling

The current measurement module (CT module, or CTM) is used for measuring the currents from current transformers. The current measurements are updated every 5 milliseconds. The measured values are processed into the measurement database and they are used by measurement and protection functions. It is essential to understand the concept of current measurements to be able to get correct measurements.

Figure. 4.2.1 - 57. Current measurement terminology.



PRI: The primary current, i.e. the current which flows in the primary circuit and through the primary side of the current transformer.

SEC: The secondary current, i.e. the current which the current transformer transforms according to its ratios. This current is measured by the device.

NOM: The nominal primary current of the protected object.

For the measurements to be correct the user needs to ensure that the measurement signals are connected to the correct inputs, that the current direction is connected to the correct polarity, and that the scaling is set according to the nominal values of the current transformer.

The device calculates the scaling factors based on the set values of the CT primary, the CT secondary and the nominal current settings. The device measures the secondary current, the current output from the current transformer installed into application's primary circuit. The rated primary and secondary currents of the CT need to be set for the device to "know" the primary and per-unit values. With motors and other specific electrical apparatus protections, the motor's nominal current should be set for the values to be in per unit with regards to the apparatus nominal instead of the CT nominal. This is not always mandatory as some devices still require manual calculations for the correct settings; however, setting the motors nominal current makes motor protection much easier and more straightforward. In modern protection devices this scaling calculation is done internally after the current transformer's primary current, secondary current and motor nominal current are set.

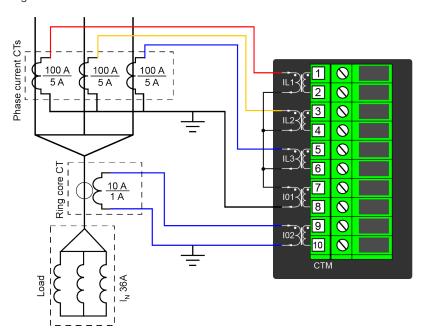
Normally, the primary current ratings for phase current transformers are 10 A, 12.5 A, 15 A, 20 A, 25 A, 30 A, 40 A, 50 A, 60 A and 75 A as well as their decimal multiples, while the secondary current ratings are 1 A and 5 A. Other, non-standard ratings can be directly connected as the scaling settings are flexible and have large ranges. For example, the ring core current transformer ratings may vary. Ring core current transformers are commonly used for sensitive earth fault protection and their rated secondary current may be as low as 0.2 A in some cases.

The following chapter is an example on how to set the scaling of the current measurements for the selected current transformer and system load.

Example of CT scaling

The following figure presents how CTs are connected to the device's measurement inputs. It also shows example CT ratings and nominal current of the load.

Figure. 4.2.1 - 58. Connections.



The following table presents the initial data of the connection.

Table. 4.2.1 - 7. Initial data.

Phase current CT:	Ring core CT in Input I02:	Load (nominal):
CT primary: 100 A CT secondary: 5 A	IOCT primary: 10 A IOCT secondary: 1 A	36 A

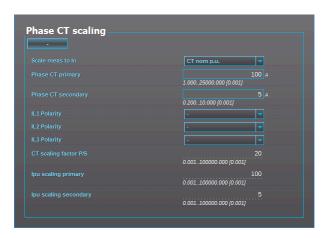
- The phase currents are connected to the I01 residual via a Holmgren connection.
- The starpoint of the phase current CT's secondary current is towards the line.

Phase CT scaling

Next, to scale the current to per-unit values, we have to select whether the basis of the phase CT scaling is the protected object's nominal current or the CT primary value.

If the CT values are chosen to be the basis for the per-unit scaling, the option "CT nom. p.u." is selected for the "Scale meas to In" setting (see the image below).

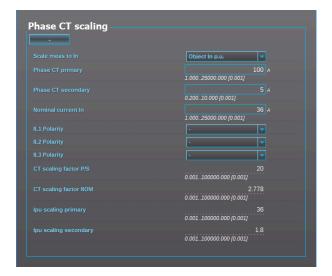
Figure. 4.2.1 - 59. Setting the phase current transformer scalings to CT nominal.



Once the setting have been sent to the device, device calculates the scaling factors and displays them for the user. The "CT scaling factor P/S" describes the ratio between the primary current and the secondary current. The per-unit scaling factors ("Ipu scaling") for both primary and secondary values are also displayed (in this case they are the set primary and secondary currents of the CT).

If the protected object's nominal current is chosen to be the basis for the per-unit scaling, the option "Object in p.u." is selected for the "Scale meas to In" setting (see the image below).

Figure. 4.2.1 - 60. Setting the phase current transformer scalings to the protected object's nominal current.



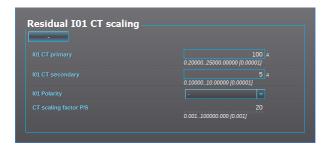
Once the measurement scaling is tied to the protected object's nominal current, the user must set the appropriate input for the "Nominal current In" setting. One can now see the differences between the two scaling options (CT nominal vs. object nominal). The "CT scaling factor P/S" is the direct ratio between the set CT current values, and the "CT scaling factor NOM" is now the ratio between the set CT primary and the nominal current. The "Ipu scaling primary" is now equal to the set nominal current, and the "Ipu scaling secondary" is the ratio between the nominal current and the "CT scaling factor P/S".

Residual 10 CT scaling

Next, we set the residual IO CT scalings according to how the phase current CTs and the ring core CT are connected to the module (see the Connections image at the <u>beginning of this chapter</u>).

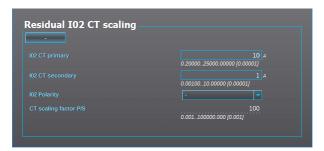
The phase current CTs are connected to the module via a Holmgren (summing) connection, which requires the use of coarse residual current measurement settings: the "I01 CT" settings are set according to the phase current CTs' ratings (100/5 A).

Figure. 4.2.1 - 61. Residual I01 CT scaling (coarse).



The ring core CT is connected to the CTM directly, which requires the use of sensitive residual current measurement settings: the "I02 CT" settings are set according to the ring core CT's ratings (10/1 A).

Figure. 4.2.1 - 62. Residual IO2 CT scaling (sensitive).



Displaying the scaling

Depending on whether the scaling was done based on the CT primary values or the protected object's nominal current, the measurements are displayed slightly differently. The first of the two images shows how the measurements are displayed when the CT primary values are the basis for the scaling; the second shows them when the protected object's nominal current is the basis for the scaling.

Figure. 4.2.1 - 63. Scalings display (based on the CT nominal).

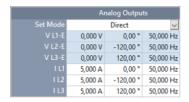
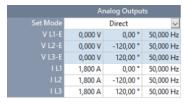




Figure. 4.2.1 - 64. Scalings display (based on the protected object's nominal current).



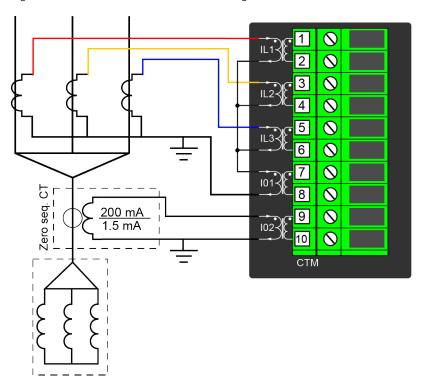


As the images above show, the scaling selection does not affect how primary and secondary currents are displayed (as actual values). The only effect is that the per-unit system in the device is scaled either to the CT nominal or to the object nominal, making the settings input straightforward.

Example of zero sequence CT scaling

Zero sequence CT scaling (ZCT scaling) is done when a zero sequence CT instead of a ring core CT is part of the measurement connection. In such a case the zero sequence CT should be connected to the I02 channel which has lower CT scaling ranges (see the image below).

Figure. 4.2.1 - 65. Connections of ZCT scaling.



Troubleshooting

When the measured current values differ from the expected current values, the following table offers possible solutions for the problems.



WARNING!

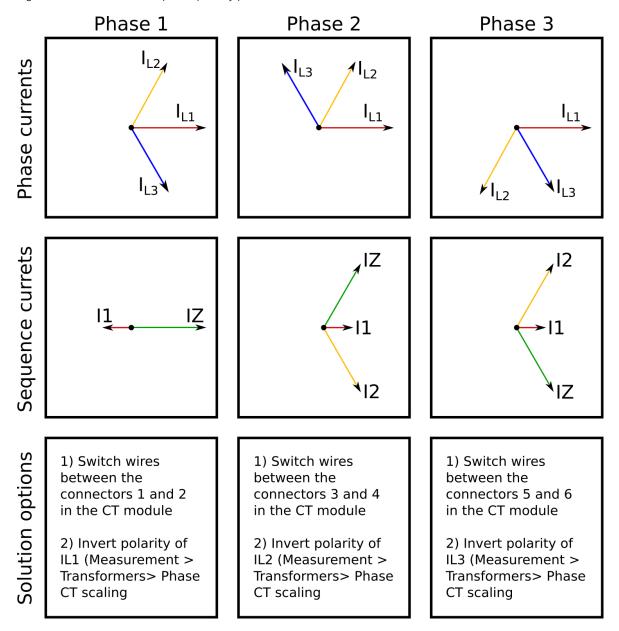
If you work with energized CTs, extreme caution needs to be taken when checking the connections! An opened CT secondary circuit may generate dangerously high voltages. A "buzzing" sound from the connector can indicate an open circuit.

Problem	Solution
The measured current amplitude in all phases does not match the injected current.	The scaling settings may be wrong, check that the settings match with the connected current transformer ($Measurement \rightarrow Transformers \rightarrow Phase\ CT\ scaling$). Also check that the "Scale meas. to In" is set accordingly. If possible, check the actual CTs and their ratings as there may have been a need to change the original plan.
The measured current amplitude does not match one of the measured phases./ The calculated I0 is measured even though it should not.	Check the wiring connections between the injection device or the CTs and the device.

Problem	Solution
The measured current amplitudes are OK but the angles are strange./ The phase unbalance protection trips immediately after activation./ The earth fault protection trips immediately after activation.	The phase currents are connected to the measurement module but the order or polarity of one or all phases is incorrect. In device settings, go to <i>Measurement</i> → <i>Phasors</i> and check the "Phase current vectors" diagram. When all connections are correct, the diagram (symmetric feeding) should look like this: L1

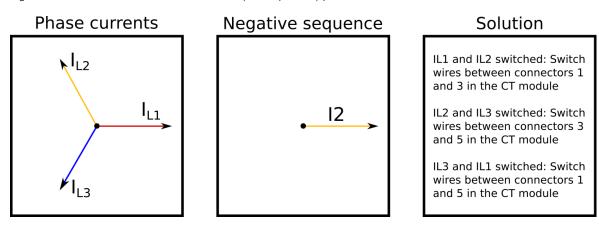
The following image presents the most common problems with phase polarity. Problems with phase polarity are easy to find because the vector diagram points towards the opposite polarity when a phase has been incorrectly connected.

Figure. 4.2.1 - 66. Common phase polarity problems.



The following image presents the most common problems with network rotation (mix phases). These problems can be difficult to find because the measurement result is always the same in the device. If two phases are mixed together, the network rotation always follows the pattern IL1-IL3-IL2 and the measured negative sequence current is therefore always 1.00 (in. p.u.).

Figure. 4.2.1 - 67. Common network rotation (mixed phases) problems.



Settings

Table. 4.2.1 - 8. Settings of the Phase CT scaling.

Name	Range	Step	Default	Description
Scale measurement to In	CT nom p.u. Dbject In p.u.	-	• CT nom p.u.	The selection of the reference used in the device's per- unit system scaling. Either the set phase current CT primary or the protected object's nominal current.
Phase CT primary	1.00025 000.000A	0.001	100.000	The rated primary current of the current transformer.
Phase CT secondary	0.20010.000A	0.001	5.000	The rated secondary current of the current transformer.
Nominal current In	1.00025 000.000A	0.001	100.000	The nominal current of the protected object. This setting is only visible if the option "Object In p.u." has been selected in the "Scale measurement to In" setting.
IL1 Polarity	• - • Invert	-	ŀ	The selection of the first current measurement channel's (IL1) polarity (direction). The default setting is for the positive current to flow from connector 1 to connector 2, with the secondary currents' starpoint pointing towards the line.
IL2 Polarity	• - • Invert	-	1	The selection of the second current measurement channel's (IL2) polarity (direction). The default setting is for the positive current to flow from connector 3 to connector 4, with the secondary currents' starpoint pointing towards the line.
IL3 Polarity	• - • Invert	-	-	The selection of the third current measurement channel's (IL3) polarity (direction). The default setting is for the positive current to flow from connector 5 to connector 6, with the secondary currents' starpoint pointing towards the line.
CT scaling factor P/S	-	-	-	A feedback value; the calculated scaling factor that is the ratio between the primary current and the secondary current.

Name	Range	Step	Default	Description
CT scaling factor NOM	-	-	-	A feedback value; the calculated scaling factor that is the ratio between the set primary current and the set nominal current. This parameter is only visible if the option "Object In p.u." has been selected in the "Scale measurement to In" setting.
lpu scaling primary	-	-	-	A feedback value; the scaling factor for the primary current's per-unit value.
lpu scaling secondary	-	-	-	A feedback value; the scaling factor for the secondary current's per-unit value.

Table. 4.2.1 - 9. Settings of the Residual IO1 CT scaling.

Name	Unit	Range	Step	Default	Description
I01 CT primary	Α	0.200 0025 000.000 00	0.000	100.000	The rated primary current of the current transformer.
I01 CT secondary	Α	0.100 0010.000 00	0.000 01	1.000 00	The rated secondary current of the current transformer.
I01 Polarity	-	• - • Invert	-	-	The selection of the coarse residual measurement channel's (I01) polarity (direction). The default setting is for the positive current to flow from connector 7 to connector 8.
CT scaling factor P/S	ı	-	-	-	A feedback value; the calculated scaling factor that is the ratio between the primary current and the secondary current.

Table. 4.2.1 - 10. Settings of the Residual IO2 CT scaling.

Name	Unit	Range	Step	Default	Description
I02 CT primary	А	0.200 0025 000.000 00	0.000 01	100.000	The rated primary current of the current transformer.
I02 CT secondary	А	0.001 0010.000 00	0.000 01	0.200 00	The rated secondary current of the current transformer.
I02 Polarity	-	• - • Invert	-	-	The selection of the sensitive residual measurement channel's (I02) polarity (direction). The default setting is for the positive current to flow from connector 9 to connector 10.
CT scaling factor P/S	-	-	-	-	A feedback value; the calculated scaling factor that is the ratio between the primary current and the secondary current.

Measurements

The following measurements are available in the measured current channels.

Table. 4.2.1 - 11. Per-unit phase current measurements.

Name	Unit	Range	Step	Description
Pha.curr.ILx	× In	0.0001 250.000	0.001	The current fundamental frequency component (in p.u.) from each of the phase current channels.
Pha.curr.ILx TRMS	× In	0.001 250.00	0.01	The TRMS current (inc. harmonics up to 31 st) measurement (in p.u.) from each of the phase current channels.
P-P curr.ILx	× In	0.00500.00	0.01	The peak-to-peak current measurement (in p.u.) from each of the phase current channels.

Table. 4.2.1 - 12. Primary phase current measurements.

Name	Unit	Range	Step	Description
Pri.Pha.curr.ILx	А	0.001 000 000.00	0.01	The primary current measurement fundamental frequency component from each of the phase current channels.
Pha.curr.ILx TRMS Pri	А	0.001 000 000.00	0.01	The primary TRMS current (inc. harmonics up to 31 st) measurement from each of the phase current channels.

Table. 4.2.1 - 13. Secondary phase current measurements.

Name	Unit	Range	Step	Description
Sec.Pha.curr.lLx	А	0.00300.00	0.01	The primary current measurement fundamental frequency component from each of the phase current channels.
Pha.curr.ILx TRMS Sec	А	0.00300.00	0.01	The primary TRMS current (inc. harmonics up to 31 st) measurement from each of the phase current channels.

Table. 4.2.1 - 14. Phase angle measurements.

Name	Unit	Range	Step	Description
Pha.angle ILx	deg	0.00360.00	0.01	The phase angle measurement from each of the three phase current inputs.

Table. 4.2.1 - 15. Per-unit residual current measurements.

Name	Unit	Range	Step	Description
Res.curr.l0x	× In	0.001 250.00	0.01	The current measurement fundamental frequency component (in p.u.) from the residual current channel I01 or I02.
Calculated I0	× In	0.001 250.00	0.01	The current measurement fundamental frequency component (in p.u.) from the calculated I0 current channel.
Res.curr.I0x TRMS	× In	0.001 250.00	0.01	The TRMS current (inc. harmonics up to 31 st) measurement (in p.u.) from the residual current channel l01 or l02.
P-P curr.I0x	× In	0.00500.00	0.01	The peak-to-peak current measurement (in p.u.) from the residual current channel I01 or I02.

Table. 4.2.1 - 16. Primary residual current measurements.

Name	Unit	Range	Step	Description
Pri.Res.curr.I0x	А	0.001 000 000.00	0.01	The primary current measurement fundamental frequency component from the residual current channel I01 or I02.
Pri.calc.I0	А	0.001 000 000.00	0.01	The primary current measurement fundamental frequency component from the calculated current channel I0.
Res.curr.I0x TRMS A 000		0.001 000 000.00	0.01	The TRMS current (inc. harmonics up to 31 st) measurement from the primary residual current channel l01 or l02.

Table. 4.2.1 - 17. Secondary residual current measurements.

Name	Unit	Range	Step	Description
Sec.Res.curr.I0x	А	0.00300.00	0.01	The secondary current measurement fundamental frequency component from the residual current channel I01 or I02.
Sec.calc.I0	А	0.00300.00	0.01	The secondary current measurement fundamental frequency component from the calculated current channel I0.
Res.curr.l0x TRMS Sec	Α	0.00300.00	0.01	The secondary TRMS current (inc. harmonics up to 31 st) measurement from the secondary residual current channel 101 or 102.

Table. 4.2.1 - 18. Residual phase angle measurements.

Name	Unit	Range	Step	Description
Res.curr.angle I0x	deg	0.00360.00	0.01	The residual current angle measurement from the I01 or I02 current input.
calc.I0 Pha.angle	deg	0.00360.00	0.01	The calculated residual current angle measurement.

Table. 4.2.1 - 19. Per-unit sequence current measurements.

Name	Unit	Range	Step	Description
Positive sequence current	× In	0.001 250.00	0.01	The measurement (in p.u.) from the calculated positive sequence current.
Negative sequence current	× In	0.001 250.00	0.01	The measurement (in p.u.) from the calculated negative sequence current.
Zero sequence current	× In	0.001 250.00	0.01	The measurement (in p.u.) from the calculated zero sequence current.

Table. 4.2.1 - 20. Primary sequence current measurements.

Name	Unit	Range	Step	Description
Pri.Positive sequence curr.	А	0.001 000 000.00	0.01	The primary measurement from the calculated positive sequence current.
Pri.Negative sequence curr.	А	0.001 000 000.00	0.01	The primary measurement from the calculated negative sequence current.
Pri.Zero sequence curr.	А	0.001 000 000.00	0.01	The primary measurement from the calculated zero sequence current.

Table. 4.2.1 - 21. Secondary sequence current measurements.

Name	Unit	Range	Step	Description
Sec.Positive sequence curr.	А	0.00300.00	0.01	The secondary measurement from the calculated positive sequence current.
Sec.Negative sequence curr	А	0.00300.00	0.01	The secondary measurement from the calculated negative sequence current.
Sec.Zero sequence curr.	А	0.00300.00	0.01	The secondary measurement from the calculated zero sequence current.

Table. 4.2.1 - 22. Sequence phase angle measurements.

Name	Unit	Range	Step	Description
Positive sequence curr.angle	deg	0.00360.00	0.01	The calculated positive sequence current angle.
Negative sequence curr.angle	deg	0.00360.00	0.01	The calculated negative sequence current angle.
Zero sequence curr.angle	deg	0.00360.00	0.01	The calculated zero sequence current angle.

Table. 4.2.1 - 23. Harmonic current measurements.

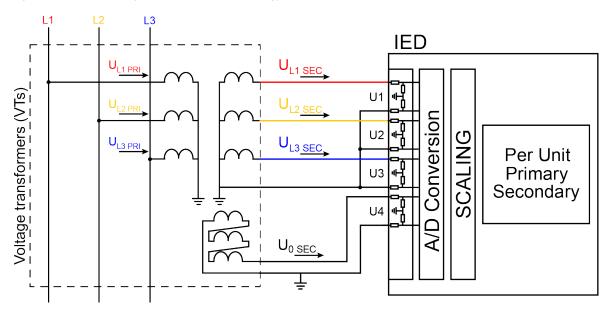
Name		Range	Step	Description
Harm Abs.or Perc.	-	PercentAbsolute	-	Defines whether the harmonics are calculated as percentage or absolute values.
Harmonics display	-	Per unit Primary A Secondary A	-	Defines how the harmonics are displayed: in p.u values, as primary current values, or as secondary current values.
lxx maximum harmonic	Α	0.00100 000.00	0.01	Displays the maximum harmonics value of the selected current input ILx or I0x.
lxx fundamental	Α	0.00100 000.00	0.01	Displays the current value of the fundamental frequency component (RMS) from the selected current input ILx or I0x.
lxx harmonics (2 nd 31 st harmonic)	А	0.00100 000.00	0.01	Displays the selected harmonic from the current input ILx or I0x.

Name		Range	Step	Description
Ixx Amplitude THD	%	0.000100.000	0.001	Amplitude ratio THD voltage. Recognized by IEC.
Ixx Power THD	%	0.000100.000	0.001	Power ratio THD voltage. Recognized by the IEEE.

4.2.2 Voltage measurement and scaling

The voltage measurement module (VT module, or VTM) is used for measuring the voltages from voltage transformers. The voltage measurements are updated every 5 milliseconds. The measured values are processed into the measurement database and they are used by measurement and protection functions. It is essential to understand the concept of voltage measurements to be able to get correct measurements.

Figure. 4.2.2 - 68. Voltage measurement terminology



PRI: The primary voltage, i.e. the voltage in the primary circuit which is connected to the primary side of the voltage transformer.

SEC: The secondary voltage, i.e. the voltage which the voltage transformer transforms according to the ratio. This voltage is measured by the device.

For the measurements to be correct the user needs to ensure that the measurement signals are connected to the correct inputs, that the voltage direction correct, and that the scaling is set correctly.

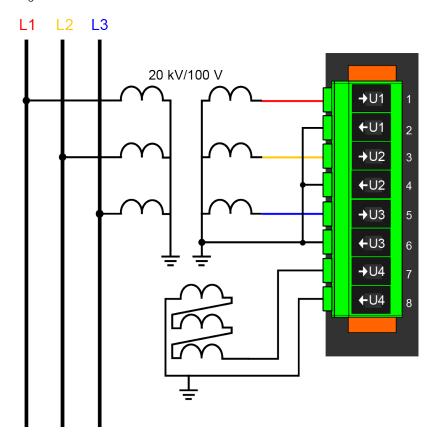
The device calculates the scaling factors based on the set VT primary, and secondary voltage values. The device measures secondary voltages, which are the voltage outputs from the VT installed into the application's primary circuit. The voltage can be measured directly from the system as well (up to 400 V nominal line to neutral voltage). When connecting voltage directly, measuring mode must be set to 3LN+U4 mode. The rated primary and secondary voltages of the VT need to be set for the device to "know" the primary and per-unit values. In modern protection devices this scaling calculation is done internally after the voltage transformer's primary and secondary voltages are set.

Normally, the primary line-to-line voltage rating for VTs is 400 V...60 kV, while the secondary voltage ratings are 100 V...210 V. Non-standard ratings can also be directly connected as the scaling settings are flexible and have large ranges.

Example of VT scaling

The following figure presents how VTs are connected to the device's measurement inputs. It also shows the VT ratings. In the figure below, three line-to-neutral voltages are connected along with the zero sequence voltage; therefore, the 3LN+U4 mode must be selected and the U4 channel must be set as U0. Other possible connections are presented later in this chapter.

Figure. 4.2.2 - 69. Connections.



The following table presents the initial data of the connection.

Table. 4.2.2 - 24. Initial data.

Phase voltage VT - VT primary: 20 000 V - VT secondary: 100 V	Zero sequence voltage VT - U4 VT primary: 20 000 V - U4 VT secondary: 100 V
- the zero sequence voltage is connected similarly to - in case wiring is incorrect, all polarities can be indiv	- , ,

Once the settings have been sent to the device, device calculates the scaling factors and displays them for the user. The "VT scaling factor P/S" describes the ratio between the primary voltage and the secondary voltage. The per-unit scaling factors ("VT scaling factor p.u.") for both primary and secondary values are also displayed.

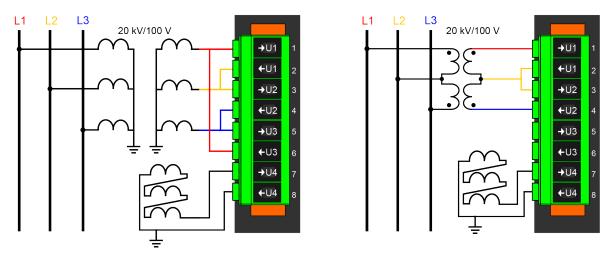
There are several different ways to use all four voltage channels. The voltage measurement modes are the following:

 3LN+U4 (three line-to-neutral voltages and U4 can be used for either zero sequence voltage or synchrochecking)

- 3LL+U4 (three line-to-line voltages and U4 can be used either for zero sequence voltage or synchrochecking)
- 2LL+U3+U4 (two line-to-line voltages and the U3 and the U4 channels can be used for synchrochecking, zero sequence voltage, or for both)

The 3LN+U0 is the most common voltage measurement mode. See below for example connections of voltage line-to-line measurement (3LL on the left, 2LL on the right).

Figure. 4.2.2 - 70. Example connections for voltage line-to-line measurement.



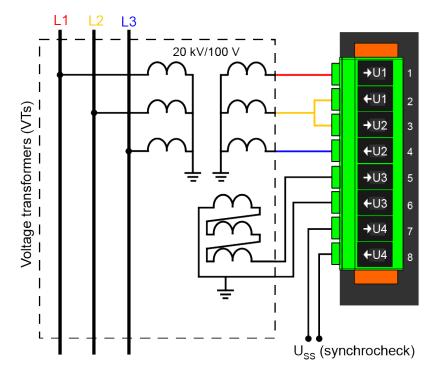
If only two line-to-line voltages are measured, the third one (U_{L31}) is calculated based on the U_{L12} and U_{L23} vectors. When measuring line-to-line voltages, the line-to-neutral voltages can also be calculated as long as the value of U0 is measured.

The voltage measurement channel U4 can be used to measure the zero sequence voltage (U0), the side 2 voltage of the circuit breaker (Synchrocheck), or for automatic voltage regulator function. If the 2LL+U3+U4 mode is selected, the third channel (U3) can be used for this purpose. Please note that U0 can only be measured by using a single channel.

In the image below is an example of 2LL+U0+SS, that is, two line-to-line measurements with the zero sequence voltage and voltage from side 2 for Synchrocheck. Since U0 is available, line-to-neutral voltages can be calculated.

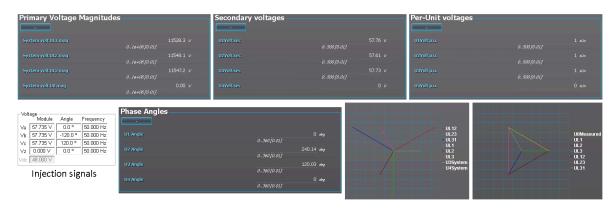
Figure. 4.2.2 - 71. 2LL+U0+SS settings and connections.





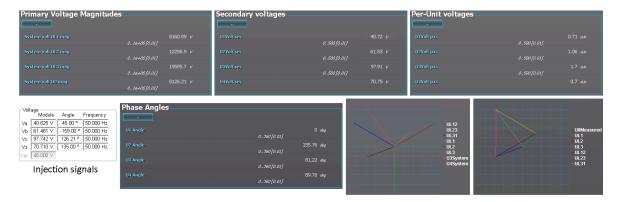
The image collection below presents the device's behavior when nominal voltage is injected into the device via secondary test equipment. The measurement mode is 3LN+U4 which means that the device is measuring line-to-neutral voltages. The VT scaling has been set to 20 000: 100 V. The U4 channel measures the zero sequence voltage which has the same ratio (20 000: 100 V).

Figure. 4.2.2 - 72. Measurement behavior when nominal voltage injected.



The image collection below presents the device's behavior when voltage is injected into the device via secondary test equipment during an earth fault. The measurement mode is 3LN+U4 which means that the device is measuring line-to-neutral voltages. The VT scaling has been set to 20 000: 100 V. The U4 channel measures the zero sequence voltage which has the same ratio (20 000: 100 V).

Figure. 4.2.2 - 73. Device behavior when voltage injected during an earth fault.



Troubleshooting

When the measured voltage values differ from the expected voltage values, the following table offers possible solutions for the problems.

Problem	Check / Resolution
The measured voltage amplitude in all phases does not match the injected voltage.	The scaling settings or the voltage measurement mode may be wrong, check that the settings match with the connected voltage transformer (Measurement → Transformers → VT Module).
The measured voltage amplitude does not match one of the measured phases./ The calculated U0 is measured even though it should not.	Check the wiring connections between the injection device or the VTs and the device.
The measured voltage amplitudes are OK but the angles are strange./ The voltage unbalance protection trips immediately after activation./ The earth fault protection trips immediately after it is activated and voltage calculated.	The voltages are connected to the measurement module but the order or polarity of one or all phases is incorrect. In device settings, go to <i>Measurement</i> → <i>Phasors</i> and check the "System voltage vectors" diagram. When all connections are correct, the diagram (symmetric feeding) should look like this: UL12 UL23 UL31 UL1 UL2 UL3 U.31 UL3 USSystem U4System

Alternative

Settings

Table. 4.2.2 - 25. Settings of the VT scaling.

Name	Range	Step	Default	Description
Voltage measurement mode	• 3LN+U4 • 3LL+U4 • 2LL+U3+U4	-	3LN+U4	The device's voltage wiring method. The voltages are scaled according the set voltage measurement mode.
U3 mode U0 or SS	Not Used U0	-	Not	The voltage channel U3 can be used to measure zero sequence voltage (U0) or the Synchrocheck voltage (SS). If neither is needed, the (default) option "Not Used" should be active. This setting is only valid if the "2LL+U3+U4" mode is selected.
U4 mode U0 or SS	• SS		Used	The voltage channel U4 can be used to measure zero sequence voltage (U0) or the Synchrocheck voltage (SS). If neither is needed, the (default) option "Not Used" should be active.
U0 (U3) Measured from	Broken Delta Neutral point Open delta	-	Broken delta	Defines how the secondary voltage is scaled to the primary. "Broken Delta" is the most common mode. Does not affect how protection operates, it only affects the displayed primary voltages. This parameter is visible when the "U4 mode U0 or SS" has been set to the "U0" mode. Example with scaling 20000/100 for Uo and injection 10V secondary: • Broken delta: 1155V (10%) • Neutral point: 2000 V (17.34%) • Open delta: 667V (5.78%)
U0 (U4) Measured from				Defines how the secondary voltage is scaled to the primary. "Broken Delta" is the most common mode. Does not affect how protection operates, it only affects the displayed primary voltages. This parameter is visible when the "U4 mode U0 or SS" has been set to the "U0" mode. Example with scaling 20000/100 for Uo and injection 10V secondary: • Broken delta: 1155V (10%) • Neutral point: 2000 V (17.34%) • Open delta: 667V (5.78%)
Set input voltage thresholds	• No • Yes	-	Yes	If this parameter is enabled, it is possible to set minimum voltage required for voltage measurement to start.
U1 input threshold				
U2 input threshold	0.1050.00	0.01 V _{sec}	1.00 V _{sec}	Sets the lowest voltage the channel is allowed to measure.
U3 input threshold	V _{sec}			
U4 input threshold				

Name	Range	Step	Default	Description
Voltage memory	DisabledActivated	-	Disabled	Activates the voltage memory. The "Voltage memory" chapter describes the function in more detail.
P-E Voltage measurements	No P-E voltages available P-E Voltages calculated P-E Voltages measured	-	-	Indicates whether or not phase-to-earth voltages are available. Also indicates whether P-E voltages are measured from the voltage channels directly or if they are calculated from measured line-to-line and zero sequence voltages.
VT primary	1.01 000 000.0V	0.1V	20 000.0V	The rated primary voltage of the voltage transformer.
VT secondary	0.2400.0V	0.1V	100.0V	The rated secondary voltage of the voltage transformer.
U3 Res/SS VT primary	1.01 000 000V	0.1V	20 000.0V	The primary nominal voltage of the connected U0 or SS VT. This setting is only valid if the "2LL+U3+U4" mode is selected.
U3 Res/SS VT secondary	0.2400.0V	0.1V	100.0V	The secondary nominal voltage of the connected U0 or SS VT. This setting is only valid if the "2LL+U3+U4" mode is selected.
U4 Res/SS VT primary	1.01 000 000.0V	0.1V	20 000.0V	The primary nominal voltage of the connected U0 or SS VT.
U4 Res/SS VT secondary	0.2400.0V	0.1V	100.0V	The secondary nominal voltage of the connected U0 or SS VT.
U1 Polarity	• - • Invert		-	The selection of the first voltage measurement channel's (U1) polarity (direction). The default setting is for the positive voltage to flow from connector 1 to connector 2, with the secondary voltage's starpoint pointing towards the line.
U2 Polarity		-		The selection of the second voltage measurement channel's (U2) polarity (direction). The default setting is for the positive voltage to flow from connector 3 to connector 4, with the secondary voltage's starpoint pointing towards the line.
U3 Polarity				The selection of the third voltage measurement channel's (U3) polarity (direction). The default setting is for the positive voltage to flow from connector 5 to connector 6, with the secondary voltage's starpoint pointing towards the line.
U4 Polarity				The selection of the fourth voltage measurement channel's (U4) polarity (direction). The default setting is for the positive voltage to flow from connector 7 to connector 8, with the secondary voltage's starpoint pointing towards the line.

Table. 4.2.2 - 26. Read-only parameters of the VT scaling.

Name	Description
VT scaling factor P/S	The calculated scaling factor that is the ratio between the primary voltage and the secondary voltage.
VT scaling factor p.u. Pri	The scaling factor for the primary voltage's per-unit value.
VT scaling factor p.u. Sec	The scaling factor for the secondary voltage's per-unit value.
U3 VT scaling factor P/S U0/SS	The scaling factor that is the ratio between the U3 channel's primary and secondary voltages. This setting is only valid if the "2LL+U3+U4" mode is selected.
U3 scaling factor p.u. Pri	Scaling factor for the primary voltage's per-unit value. This setting is only valid if the "2LL+U3+U4" mode is selected.
U3 scaling factor p.u. Sec	Scaling factor for the secondary voltage's per-unit value. This setting is only valid if the "2LL+U3+U4" mode is selected.
U4 VT scaling factor P/S U0/SS	Scaling factor that is the ration between the U4 channel's primary and secondary voltages. This setting is only valid is the "2LL+U3+U4" mode is selected.
U4 scaling factor p.u. Pri	Scaling factor for the primary voltage's per-unit value. This setting is only valid if the "2LL+U3+U4" mode is selected.
U4 scaling factor p.u. Sec	Scaling factor for the secondary voltage's per-unit value. This setting is only valid if the "2LL+U3+U4" mode is selected.

Measurements

The following measurements are available in the measured voltage channels.

Table. 4.2.2 - 27. Per-unit voltage measurements.

Name	Range	Step	Description
UxVolt p.u.	0.00500.00xU _N	0.01xU _N	The voltage measurement fundamental frequency component (in p.u.) from each of the voltage channels.
UxVolt TRMS p.u.	0.00500.00xU _N	0.01xU _N	The TRMS voltage (inc. harmonics up to 31 st) measurement (in p.u.) from each of the voltage channels.

Table. 4.2.2 - 28. Secondary voltage measurements.

Name	Range	Step	Description
Ux Volt sec	0.00500.00V	0.01V	The secondary voltage measurement fundamental frequency component from each of the voltage channels.
UxVolt TRMS sec	0.00500.00V	0.01V	The secondary TRMS voltage (inc. harmonics up to 31 st) measurement from each of the voltage channels.

Table. 4.2.2 - 29. Voltage phase angle measurements.

Name	Range	Step	Description
Ux Angle	0.00360.00°	0.01°	The phase angle measurement from each of the four voltage inputs.

Table. 4.2.2 - 30. Per-unit sequence voltage measurements.

Name	Range	Step	Description
Pos.seq.Volt.p.u.	0.00500.00×U _N	0.01xU _N	The measurement (in p.u.) from the calculated positive sequence voltage.
Neg.seq.Volt.p.u.	0.00500.00xU _N	0.01xU _N	The measurement (in p.u.) from the calculated negative sequence voltage.
Zero.seq.Volt.p.u.	0.00500.00xU _N	0.01xU _N	The measurement (in p.u.) from the calculated zero sequence voltage.

Table. 4.2.2 - 31. Primary sequence voltage measurements.

Name	Range	Step	Description
Pos.seq.Volt.pri	0.001 000 000.00V	0.01V	The primary measurement from the calculated positive sequence voltage.
Neg.seq.Volt.pri	0.001 000 000.00V	0.01V	The primary measurement from the calculated negative sequence voltage.
Zero.seq.Volt.pri	0.001 000 000.00V	0.01V	The primary measurement from the calculated zero sequence voltage.

Table. 4.2.2 - 32. Secondary sequence voltage measurements.

Name	Range	Step	Description
Pos.seq.Volt.sec	0.004 800.00V	0.01V	The secondary measurement from the calculated positive sequence voltage.
Neg.seq.Volt.sec	0.004 800.00V	0.01V	The secondary measurement from the calculated negative sequence voltage.
Zero.seq.Volt.sec	0.004 800.00V	0.01V	The secondary measurement from the calculated zero sequence voltage.

Table. 4.2.2 - 33. Sequence voltage angle measurements.

Name	Range	Step	Description
Pos.seq.Volt.Angle	0.00360.00°	0.01°	The calculated positive sequence voltage angle.
Neg.seq.Volt.Angle	0.00360.00°	0.01°	The calculated negative sequence voltage angle.
Zero.seq.Volt.Angle	0.00360.00°	0.01°	The calculated zero sequence voltage angle.

Table. 4.2.2 - 34. System primary voltage measurements.

Name	Range	Step	Description
System volt UL12 mag	0.001 000 000.00V	0.01V	The primary line-to-line UL12 voltage fundamental frequency component (measured or calculated). You can also select the row where the unit for this is kV.
System volt UL23 mag	0.001 000 000.00V	0.01V	The primary line-to-line UL23 voltage fundamental frequency component (measured or calculated). You can also select the row where the unit for this is kV.
System volt UL31 mag	0.001 000 000.00V	0.01V	The primary line-to-line UL31 voltage fundamental frequency component (measured or calculated). You can also select the row where the unit for this is kV.
System volt UL1 mag	0.001 000 000.00V	0.01V	The primary line-to-neutral UL1 voltage fundamental frequency component (measured or calculated). You can also select the row where the unit for this is kV.
System volt UL2 mag	0.001 000 000.00V	0.01V	The primary line-to-neutral UL2 voltage fundamental frequency component (measured or calculated). You can also select the row where the unit for this is kV.
System volt UL3 mag	0.001 000 000.00V	0.01V	The primary line-to-neutral UL3 voltage fundamental frequency component (measured or calculated). You can also select the row where the unit for this is kV.
System volt U0 mag	0.001 000 000.00V	0.01V	The primary zero sequence U0 voltage fundamental frequency component (measured or calculated). You can also select the row where the unit for this is kV. There is also a row where the unit is %.
System volt U3 mag	0.001 000 000.00V	0.01V	The primary measured Synchrocheck voltage fundamental frequency component (SS). This magnitude is displayed only when the "2LL+U3+U4" mode is selected and both U3 and U4 are in use. You can also select the row where the unit for this is kV.
System volt U4 mag	0.001 000 000.00V	0.01V	The primary measured Synchrocheck voltage fundamental frequency component (SS). This magnitude is displayed only when the "2LL+U3+U4" mode is selected and both U3 and U4 are in use. You can also select the row where the unit for this is kV.

Table. 4.2.2 - 35. Primary system voltage angles.

Name	Range	Step	Description
System volt UL12 ang	0.00360.00°	0.01°	The primary line-to-line angle UL12 (measured or calculated).
System volt UL23 ang	0.00360.00°	0.01°	The primary line-to-line angle UL23 (measured or calculated).

Name	Range	Step	Description
System volt UL31 ang	0.00360.00°	0.01°	The primary line-to-line angle UL23 (measured or calculated).
System volt UL1 ang	0.00360.00°	0.01°	The primary line-to-neutral angle UL1 (measured or calculated).
System volt UL2 ang	0.00360.00°	0.01°	The primary line-to-neutral angle UL2 (measured or calculated).
System volt UL3 ang	0.00360.00°	0.01°	The primary line-to-neutral angle UL3 (measured or calculated).
System volt U0 ang	0.00360.00°	0.01°	The primary zero sequence angle U0 (measured or calculated).
System volt U3 ang	0.00360.00°	0.01°	The primary measured Synchrocheck angle SS. This magnitude is only valid when the "2LL+U3+U4" mode is selected and both U3 and U4 are in use.
System volt U4 ang	0.00360.00°	0.01°	The primary measured Synchrocheck angle SS. This magnitude is displayed only when the "2LL+U3+U4" mode is selected and both U3 and U4 are in use.

Table. 4.2.2 - 36. Harmonic voltage measurements.

Name	Range	Step	Description
Harm Abs.or Perc.	PercentAbsolute	-	Defines whether the harmonics are calculated as percentages or absolute values.
Harmonics display	Per unit Primary V Secondary V	-	Defines how the harmonics are displayed: in p.u. values, as primary voltage values, or as secondary voltage values.
UxMaxH	0.00100 000.00V	0.01V	Displays the maximum harmonics value of the selected voltage input Ux.
Ux Fund	0.00100 000.00V	0.01V	Displays the voltage value of the fundamental frequency component of the selected voltage input Ux.
Ux harmonics (2 nd 31 st harmonic)	0.00100 000.00V	0.01V	Displays the selected harmonic from the voltage input Ux.
Ux Amplitude THD	0.000100.000V	0.001V	Amplitude ratio THD voltage. Recognized by IEC.
Ux Power THD	0.000100.000V	0.001V	Power ratio THD voltage. Recognized by the IEEE.

Voltage memory

Some protection functions (such as directional overcurrent) use the device's measured current and voltage to determine whether the electrical network fault appears to be inside the protected area. The determination is made by comparing the angle between the operating quantity (zone/tripping area) and the actual measured quantity. The function then produces an output when the required terms are met.

In close-in faults the system voltage on the secondary side may fall down to a few volts or close to nothing. In such cases, when the measured voltage is absent, the fault direction cannot be solved. As a backup, non-directional protection can be used for tripping, but in such cases the selectivity of the network will be reduced. However, an angle memory for voltage can be used to prevent this from happening. An adjustable voltage level with pre-fault voltage angles can be used as a reference for fault direction and/or distance. The reference can be set manually for duration. Configurable voltage memory enables even time-delayed backup tripping to be initiated.

The user can activate voltage memory (and find all related settings) by following this path in device settings: $Measurement \rightarrow Transformers \rightarrow VT \ Module \ (3U/4U) \ 1 \rightarrow Voltage \ memory$ ("Activated"/"Disabled").

The activation of voltage memory depends of following criteria:

- 1. All used line-to-line or line-to-neutral voltages need to be below the set value for the "VMEM activation voltage" parameter.
- 2. At least one phase current must be above the set value for the "Measured current condition 3I>" parameter. This setting limit is <u>optional</u>.

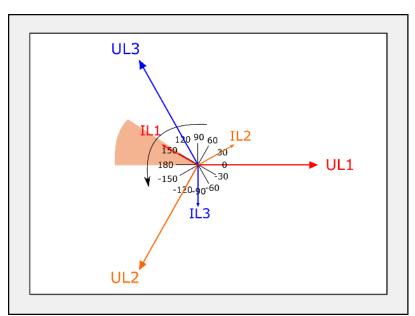
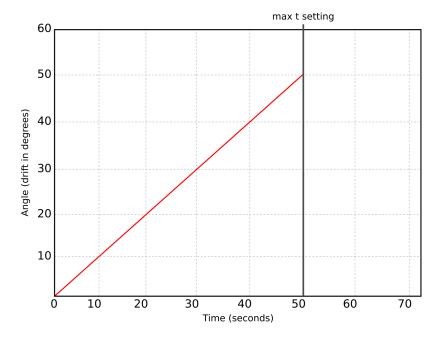


Figure. 4.2.2 - 74. Directional overcurrent characteristics.

Voltage memory activates when the above-mentioned criteria are met. Voltage memory uses the "VMEM activation voltage" parameter as voltage amplitude even when the actual measured voltage has decreased below it or close to zero. The angle used by this function is the one captured the moment before the fault occurred and voltage memory was activated. When voltage memory is activated, the output "Voltage memory on" signal is activated. This signal can be found in the device's I/O matrix.

While voltage memory is active, voltages are absent and therefore angle measurement is not possible. Healthy state angles (before a fault) are used during a fault. This is why a drift between the assumed voltage angle and the actual measured phase current angle takes place. While voltage memory is used, the angle of phase currents drifts approximately one degree for each passing second (see the graph below).

Figure. 4.2.2 - 75. Voltage angle drift.



The blocking signal for voltage memory can be found among other stage-related settings in the tab VT *Module (3U/4U) 1.* The blocking signal is checked in the beginning of each program cycle.

VMEM activation voltage and Measured current condition 3I>

When the voltage memory function is enabled, it activates when all line voltages drop below the "VMEM activation voltage" threshold limit. When "Measured current condition 3I>" is used, activation cannot be based on just the voltage. Therefore, at least one of the three-phase currents must also rise above the set current pick-up setting.

VMEM max active time

Voltage memory can be active for a specific period of time, set in "VMAX active time". It can be anything between 0.02...50.00 seconds. The function supports the definite time (DT) delay type. It depends on the application for how long the memory should be used. During massive bolted faults, the fault should be cleared and the breaker opened as soon as possible; therefore, a short operating time for voltage memory is usually applied. A typical delay for voltage memory is between 0.5...1.0 s. When the operating time passes and voltage memory is no longer used, the protection function goes to the unidirectional mode to secure a safe tripping. The memory uses longer operating times when a backup protection is applied.

Forced CT f tracking on VMEM

While fixed frequency tracking is used, all protection stage-based sampling (apart from frequency protection) is based on a set fixed frequency such as 50 Hz or 60 Hz. When the frequency drops massively during a fault while angle memory is in use, it is also possible that the frequency of the system starts to fluctuate. In such cases, if current sampling of used protection stages is based on 50/60 Hz, there could be an error in current magnitude and in angle measurement. To minimize these errors, it is recommended that the frequency is measured and protection-based sampling from the current is performed while voltages are gone.

When the "Forced CT f tracking" parameter is activated and voltages are gone, the frequency from the selected current-based reference channel 3 (the current from IL3) is used for current sampling. This eliminates any possible measurement errors in the fixed frequency mode.

For example, let us say a 500 A current is measured on the primary side while the <u>fixed</u> frequency is set to 50 Hz. This results in the frequency dropping to 46 Hz, while the actual current measurement would be 460 A. Therefore, the system would have an error of 40 A.

Table. 4.2.2 - 37. Voltage memory parameters.

Name	Range	Step	Default	Description
Voltage memory	DisabledActivated	-	Enabled	Enables or activates voltage memory function.
VMEM activation voltage	0.1050.00 %Un	0.01 %Un	15.00 %Un	Voltage threshold for activating voltage memory. When all voltage measurements are under this setting value, voltage memory is activated.
VMEM max active time	0.02050.000 s	0.005 s	15.000 s	Maximum duration for voltage memory. After the time set in this parameter has passed, voltage memory is reset.
Enable forced CT f tracting on VMEM	DisabledActivated	-	Disabled	When in use, frequency tracking is forced to "reference 3" when no voltage can be measured. If this parameter is used, frequency reference 3 should be set to "IL3".
Forced CT tracking status	DisabledActivated	-	-	Displays the current status of the "forced CT tracking".
Measured current condition 3I>	DisabledActivated	-	Disabled	Enables or activates current condition monitoring. When in use, at least one of the phase currents must rise above a set value for the voltage memory to activate.
Minimum current for VMEM	0.0150.00 xln	0.01 xln	1.00 xln	Minimum required current for current condition.
Current condition status	DisabledActivated	-	-	Displays the current monitoring status.

Table. 4.2.2 - 38. Voltage memory event messages.

Event block name	Event names
M1VT1	Voltage memory enabled
M1VT1	Voltage memory disabled
M1VT1	Voltage low detected ON
M1VT1	Voltage low detected OFF
M1VT1	Current high detected ON
M1VT1	Current high detected OFF

Event block name	Event names
M1VT1	Frequency tracked from CT ON
M1VT1	Frequency tracked from CT OFF
M1VT1	Using Voltage memory ON
M1VT1	Using Voltage memory OFF
M1VT1	Voltage memory blocked ON
M1VT1	Voltage memory blocked OFF

4.2.3 Power and energy calculation

Power is divided into three magnitudes: apparent power (S), active power (P) and reactive power (Q). Energy measurement calculates magnitudes for active and reactive energy. Energy can flow to the forward direction (exported) or to the reverse direction (imported).

If a unit has more than one CT measurement module, the user can choose which module's current measurement is used by the power calculation. The power and energy measurements are updated every 5 milliseconds.

Line-to-neutral voltages available

Power is calculated from line-to-neutral voltages and phase currents. If line-to-line voltages are connected, the device can calculate line-to-neutral voltages based on the measured zero sequence voltage. The following equations apply for power calculations with the line-to-neutral mode and the line-to-line voltage mode (with U0 connected and measured):

Figure. 4.2.3 - 76. Three-phase power (S) calculation.

$$S_{L1} = U_{L1} \times I_{L1}$$

$$S_{L2} = U_{L2} \times I_{L2}$$

$$S_{L3} = U_{L3} \times I_{L3}$$

$$S = S_{L1} + S_{L2} + S_{L3}$$

Figure. 4.2.3 - 77. Three-phase active power (P) calculation.

$$P_{L1} = U_{L1} \times I_{L1} \cos \varphi$$

$$P_{L2} = U_{L2} \times I_{L2} \cos \varphi$$

$$P_{L3} = U_{L3} \times I_{L3} \cos \varphi$$

$$P = P_{L1} + P_{L2} + P_{L3}$$

In these equations, phi (ϕ) is the angle difference between voltage and current.

Figure. 4.2.3 - 78. Three-phase reactive power (Q) calculation.

$$Q_{L1} = U_{L1} \times I_{L1} \sin \varphi$$

$$Q_{L2} = U_{L2} \times I_{L2} \sin \varphi$$

$$Q_{L3} = U_{L3} \times I_{L3} \sin \varphi$$

$$Q = Q_{L1} + Q_{L2} + Q_{L3}$$

Active power can be to the forward or the reverse direction. The direction of active power can be indicated with the power factor (Cos (ϕ) , or Cosine phi), which is calculated according the following formula:

$$3PH \ Cos(phi) = {}^{P}/_{S}$$

$$L1 \ Cos(phi) = {}^{P_{L1}}/_{S_{L1}}$$

$$L2 \ Cos(phi) = {}^{P_{L2}}/_{S_{L2}}$$

$$L3 \ Cos(phi) = {}^{P_{L3}}/_{S_{L3}}$$

The direction of reactive power is divided into four quadrants. Reactive power may be inductive or capacitive on both forward and reverse directions. Reactive power quadrant can be indicated with Tan (ϕ) (tangent phi), which is calculated according the following formula:

$$3PH \ Tan(phi) = \frac{Q}{P}$$

$$L1 \ Tan(phi) = \frac{Q_{L1}}{P_{L1}}$$

$$L2 \ Tan(phi) = \frac{Q_{L2}}{P_{L2}}$$

$$L3 \ Tan(phi) = \frac{Q_{L3}}{P_{L3}}$$

$$P = \frac{Q_{(ind)}}{Q>0}$$

$$Q>0$$

$$Q>0$$

$$Cap - ind + cosfi + PF - II I I$$

$$Q<0$$

$$Q<0$$

$$Q<0$$

$$Q<0$$

$$ind - cosfi - Cosfi + PF - Cosfi + PF - Cosfi - Cosfi + P$$

Power factor calculation is done similarly to the Cosine phi calculation but the polarity is defined by the reactive power direction. Therefore, the power factor is calculated with the following formula:

$$3PH PF = {}^{P}/_{S} * {}^{Q}/_{|Q|}$$

$$L1 PF = {}^{P_{L1}}/_{S_{L1}} * {}^{Q_{L1}}/_{|Q_{L1}|}$$

$$L2 PF = {}^{P_{L2}}/_{S_{L2}} * {}^{Q_{L2}}/_{|Q_{L2}|}$$

$$L3 PF = {}^{P_{L3}}/_{S_{L3}} * {}^{Q_{L3}}/_{|Q_{L3}|}$$

Only line-to-line voltages available

If the line-to-line voltages are measured but the zero sequence voltage is not measured or is not otherwise known, the three-phase power calculation is based on Aron's theorem:

$$\begin{split} S &= U_{23} \times I_{L1} \cos(30) + U_{31} \times I_{L2} \cos(30) \\ P &= U_{23} \times I_{L1} \cos(30 - \varphi) + U_{31} \times I_{L2} \cos(30 + \varphi) \\ Q &= U_{23} \times I_{L1} + \sin(30 - \varphi) + U_{31} \times I_{L2} \sin(30 + \varphi) \end{split}$$

Both $cos(\phi)$ and $tan(\phi)$ are calculated in the same way as in the line-to-neutral mode.

Troubleshooting

Check the "Troubleshooting" section in chapters "Current measurement and scaling" and "Voltage measurement and scaling" for more information. Most power and energy measurement problems are usually related to the same issues (i.e. wiring errors, wrong measurement modes, faulty frequency settings, etc.).

Settings

Table. 4.2.3 - 39. Power and energy measurement settings

Name	Range	Step	Default	Description
3ph active energy measurement	Disabled Enabled	-	Disabled	Enables/disables the active energy measurement.
3ph reactive energy measurement	Disabled Enabled	-	Disabled	Enables/disables the reactive and apparent energy measurement.
3ph energy megas or kilos	Mega Kilo	-	Mega	Defines whether energy is measured with the prefix 'kilo' (10 ³) or 'mega' (10 ⁶).
Edit energy values	DisabledEnabled	-	Disabled	When this parameter is enabled it is possible to manually edit exported and imported active energy values. NOTICE! "E 3ph M or k" parameter has to be set to "kilo" for this feature to function.
Invert imp/ exp energy directions	Not inverted Inverted	-	Not inverted	Inverts the direction of imported and exported energy without affecting the direction of power calculation.
Nominal power kVA	0.10500000.00kVA	0.01kVA	100kVA	Defines the nominal power of the protected object.
PQ Quadrant	UndefinedQ1 Fwd IndQ2 Rev CapQ3 Rev IndQ4 Fwd Cap	-	Undefined	Indicates what the power PQ quadrant is at that moment.

Name	Range	Step	Default	Description
VA Quadrant	UndefinedQ1 Fwd Cap AVQ2 Rev Ind AVQ3 Rev Cap VAQ4 Fwd Ind VA	-	Undefined	Indicates what the power VA quadrant is at that moment.
Reset energy calculators ("Reset 3ph Energies")	• - • Reset	-	-	Resets the memory of the three-phase energy calculators. Goes automatically back to the "-" state after the reset is finished.
Phase active energy measurement	DisabledEnabled	-	Disabled	Enables/disables the active energy per phase measurement.
Phase reactive energy measurement	DisabledEnabled	-	Disabled	Enables/disables the reactive energy per phase measurement.
Phase energies megas or kilos	Mega Kilo	-	Mega	Defines whether energy (per phase) is measured with the prefix 'kilo' (10 ³) or 'mega' (10 ⁶).
Reset energy calculators (per phase) ("Reset E per phase")	• - • Reset	-	-	Resets the memory of the indivisual phase energy calculator. Goes automatically back to the "-" state after the reset is finished.

Table. 4.2.3 - 40. Energy Dose Counter 1 settings

Name	Range	Step	Default	Description
Energy dose counter mode	Disabled Activated	-	Disabled	Enables/disables energy dose counters generally.
Clear pulse counter	• - • Clear	-	-	Resets the "DC 14 Pulses sent" counters back to zero.
DC 14 enable	Disabled Enabled	-	Disabled	Enables/disables the energy dose counter 14 individually.
DC 14 Input signal select	 3PH.Fwd.Act.EP 3PH.Rev.Avt.EP 3PH.Fwd.React.EQ.CAP 3PH.Fwd.React.EQ.IND 3PH.Rev.React.EQ.CAP 3PH.Rev.React.EQ.IND 	-	3PH.Fwd.Act.EP	Selects whether the energy is active or reactive, whether the direction of the energy is forward of reverse, and whether reactive energy is inductive or capacitive.
DC 14 Input signal	-1 × 10 ⁶ 1 × 10 ⁶	0.01	-	The total amount of energy consumed.

Name	Range	Step	Default	Description
DC 14 Pulse magnitude	01800kW/var	0.005kW/ var	1kW/Var	The set pulse size. An energy pulse is given every time the set magnitude is exceeded.
DC 14 Pulse length	01800s	0.005s	1s	The total length of a control pulse.
DC14 Pulses sent	04 294 967 295	1	-	Indicates the total number of pulses sent.

Table. 4.2.3 - 41. DC 1...4 Pulse out settings

Name	Range	Step	Default	Description
DC 14 Pulse out	OUT1OUTx	-	None selected	The selection of the controlled physical outputs.

Power measurements

The following power calculations are available when the voltage and the current cards are available.

Table. 4.2.3 - 42. Three-phase power calculations.

Name	Range	Step	Description
3PH Apparent power (S)	-1x10 ⁶ 1x10 ⁶ kVA	0.001kVA	The total three-phase apparent power in kilo-volt-ampere
3PH Active power (P)	-1x10 ⁶ 1x10 ⁶ kW	0.001kW	The total three-phase active power in kilowatts
3PH Reactive power (Q)	-1x10 ⁶ 1x10 ⁶ kVar	0.001kVar	The total three-phase reactive power in kilovars
3PH Apparent power (S MVA)	-1x10 ⁵ 1x10 ⁵ MVA	0.001MVA	The total three-phase apparent power in megawatts
3PH Active power (P MW)	-1x10 ⁵ 1x10 ⁵ MW	0.001MW	The total three-phase active power in mewatts
3PH Reactive power (QMVar)	-1x10 ⁵ 1x10 ⁵ MVar	0.001MVar	The total three-phase active power in megavars
3PH Tan(phi)	-1x10 ⁶ 1x10 ⁶	0.001	The direction of three-phase active power
3PH Cos(phi)	-1x10 ⁶ 1x10 ⁶	0.001	The direction of three-phase reactive power
3PH Power factor	-1x10 ⁶ 1x10 ⁶	0.0001	The three-phase power factor

Table. 4.2.3 - 43. Single-phase power calculations (L1...L3).

Name	Unit	Range	Step	Description
Lx Apparent power (S)	kVA	-1x10 ⁶ 1x10 ⁶	0.001	The apparent power of Phase Lx in kilo-volt-amperes

Name	Unit	Range	Step	Description
Lx Active power (P)	kW	-1x10 ⁶ 1x10 ⁶	0.001	The active power of Phase Lx in kilowatts
Lx Reactive power (Q)	kVar	-1x10 ⁶ 1x10 ⁶	0.001	The reactive power of Phase Lx kilovars
Lx Tan(phi)	-	-1x10 ⁶ 1x10 ⁶	0.001	The direction of Phase Lx's active power
Lx Cos(phi)	-	-1x10 ⁶ 1x10 ⁶	0.001	The direction of Phase Lx's reactive power
Lx Power factor	-	-1x10 ⁶ 1x10 ⁶	0.0001	The power factor of Phase Lx

Energy measurements

The following energy calculations are available when the voltage and the current cards are available. Please note that the unit prefix is determined by the user's selection between 'kilo' and 'mega' in "Three-phase energy prefix ("E 3ph M or k")" under the general "Power and energy measurement settings".

Table. 4.2.3 - 44. Three-phase energy calculations.

Name	Range	Step	Description
Exported Active Energy (P) (kWh or MWh)	-1x10 ⁹ 1x10 ⁹	1	The total amount of exported active energy.
Imported Active Energy (P) (kWh or MWh)	-1x10 ⁹ 1x10 ⁹	1	The total amount of imported active energy.
Active Energy (P) Export/Import balance (kWh or MWh)	-1x10 ⁹ 1x10 ⁹	1	The sum of imported and exported active energy.
Exported (Q) while Export (P) (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The total amount of exported reactive energy while active power is exported.
Imported (Q) while Export (P). (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	Total amount of imported reactive energy while active energy is exported.
Reactive energy (Q) balance while export (P) (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The sum of imported and exported reactive capacitive energy while active power is exported.
Exported (Q) while Import (P) (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The total amount of exported reactive energy while active energy is imported.
Imported (Q) while Import (P) (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The total amount of imported reactive energy while active energy is imported.
Reactive energy (Q) balance while Import (P) (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The sum of imported and exported reactive energy while active energy is imported.
Apparent Energy (S) while Export (P) (kVAh or MVAh)	-1x10 ⁹ 1x10 ⁹	1	The total amount of exported apparent energy while active energy is exported.
Apparent Energy (S) while Import (P) (kVAh or MVAh)	-1x10 ⁹ 1x10 ⁹	1	The total amount of exported apparent energy while active energy is imported.
Apparent Energy (S) Net	-1x10 ⁹ 1x10 ⁹	1	Total amount of apparent energy.
Real Energy (P) Net	-1x10 ⁹ 1x10 ⁹	1	The sum of active energy supply and demand.

Name	Range	Step	Description
Reactive Energy (Q) Net	-1x10 ⁹ 1x10 ⁹	1	The sum of reactive energy supply and demand.
Real Energy (P) Supply	-1x10 ⁹ 1x10 ⁹	1	Total amount of active energy supplied. Default supply direction towards busbar.
Reactive Energy (Q) Supply	-1x10 ⁹ 1x10 ⁹	1	Total reactive energy supplied. Default supply direction towards busbar.
Real Energy (P) Demand	-1x10 ⁹ 1x10 ⁹	1	Total amount of active energy demand. Default demand direction from busbar.
Reactive Energy (Q) Demand	-1x10 ⁹ 1x10 ⁹	1	Total amount of reactive energy demand. Default demand direction from busbar.

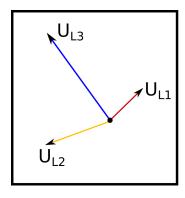
Table. 4.2.3 - 45. Single-phase energy calculations (L1...L3).

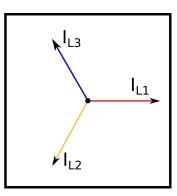
Name	Range	Step	Description
Export Active Energy Lx (kWh or MWh)	-1x10 ⁹ 1x10 ⁹	1	The exported active energy of the phase.
Import Active Energy (kWh or MWh)	-1x10 ⁹ 1x10 ⁹	1	The imported active energy of the phase.
Active Energy (P) Export/Import balance (kWh or MWh)	-1x10 ⁹ 1x10 ⁹	1	The sum of the phase's imported and exported active energy.
Exported (Q) while Export (P) Lx (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The exported reactive energy of the phase while active energy is exported.
Imported (Q) while Export (P) Lx (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The imported reactive energy of the phase while active energy is exported.
Reactive Energy (Q) balance while Export (P) Lx (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The sum of the phase's imported and exported reactive energy while active energy is exported.
Exported (Q) while Import (P) Lx (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The exported reactive energy of the phase while active energy is imported.
Imported (Q) while Import (P) Lx (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The imported reactive energy of the phase while active energy is imported.
Reactive energy (Q) balance while Import (P) Lx (kVarh or MVarh)	-1x10 ⁹ 1x10 ⁹	1	The sum of the phase's imported and exported reactive energy while active energy is imported.
Apparent Energy (S) while Export (P) Lx	-1x10 ⁹ 1x10 ⁹	1	The apparent energy of the phase while active energy is exported.
Apparent Energy (S) while Import (P) Lx	-1x10 ⁹ 1x10 ⁹	1	The apparent energy of the phase while active energy is imported.

Calculation examples

Here is an example of power calculation. Both wiring methods (line-to-line and line-to-neutral) are checked with the same signal injection. The voltage scaling is set to $20\ 000:100\ V$ and the current scaling is set to $1000:5\ A$.

Voltages (line-to-neutral):	Currents:
U _{L1} = 40.825 V, 45.00°	I _{L1} = 2.5 A, 0.00°
U _{L2} = 61.481 V, -159.90°	I _{L2} = 2.5 A, -120.00°
U _{L3} = 97.742 V, 126.21°	I _{L3} = 2.5 A, 120.00°





$$S_{L1} = U_{L1} \times I_{L1} = 40.825 \, \mathrm{V} \times 2.5 \, \mathrm{A} = 102 \, \mathrm{VA}$$
 (secondary) 4.08 MVA (primary)

$$P_{L1} = U_{L1} \times I_{L1} \cos \varphi = 40.825 \text{ V} \times 2.5 \text{ A} \cos(45^{\circ} - 0^{\circ}) = 72.2 \text{ W (secondary)}$$
 2.89 MW (primary)

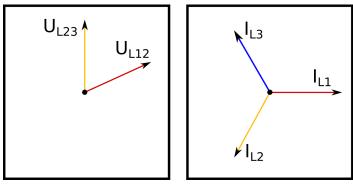
$$Q_{L1} = U_{L1} \times I_{L1} \sin \varphi = 40.825 \text{ V} \times 2.5 \text{ A} \sin(45^{\circ} - 0^{\circ}) = 72.2 \text{ var (secondary) } 2.89 \text{ MVar (primary)}$$

$$L1 \ Tan(phi) = \frac{Q_{L1}}{P_{L1}} = \frac{2.89}{2.89} = \frac{1.00}{1.00} \qquad \qquad L1 \ Cos(phi) = \frac{P_{L1}}{S_{L1}} = \frac{2.89}{4.08} = \frac{0.71}{1.00} = \frac{1.00}{1.00} = \frac{$$

$$L1 Cos(phi) = \frac{P_{L1}}{S_{L1}} = \frac{2.89}{4.08} = 0.71$$

Name	Value	Name	Value	Name	Value	Name	Value
L1 (S)	4.08 MVA	L2 (S)	6.15 MVA	L3 (S)	9.77 MVA	3PH (S)	20.00 MVA
L1 (P)	2.89 MW	L2 (P)	4.72 MW	L3 (P)	9.71 MW	3PH (P)	17.32 MW
L1 (Q)	2.89 Mvar	L2 (Q)	-3.94 Mvar	L3 (Q)	1.06 Mvar	3PH (Q)	0.01 Mvar
L1 Tan	1.00	L2 Tan	-0.83	L3 Tan	0.11	3PH Tan	0.00
L1 Cos	0.71	L2 Cos	0.77	L3 Cos	0.99	3PH Cos	0.87

Voltages (line-to-line):	Currents:
U _{L12} = 100.00 V, 30.00°	I _{L1} = 2.5 A, 0.00°
U _{L23} = 100.00 V, -90.00°	I _{L2} = 2.5 A, -120.00°
	I _{L3} = 2.5 A, 120.00°



$$S = U_{12} \times I_{L1} + U_{23} \times I_{L2}$$

$$S = 100 \text{ V} \times 2.5 \text{ A} + 100 \text{ V} \times 2.5 \text{ A} = 500 \text{ VA (sec) } 20.00 \text{ MVA (pri)}$$

$$P = U_{12} \times I_{L1} \cos(-\varphi) + U_{23} \times I_{L2} \cos(\varphi)$$

$$P = 100 \text{ V} \times 2.5 \text{ A} \cos(-30^{\circ} - 0^{\circ}) + 100 \text{ V} \times 2.5 \text{ A} \cos(270^{\circ} - 240^{\circ}) = 433 \text{ W (sec) } 17.32 \text{ MW (pri)}$$

$$Q = U_{12} \times I_{L1} + \sin(-\varphi) + U_{23} \times I_{L2} \sin(\varphi)$$

$$Q = 100 \text{ V} \times 2.5 \text{ A} \sin(-30^{\circ} - 0^{\circ}) + 100 \text{ V} \times 2.5 \text{ A} \sin(270^{\circ} - 240^{\circ}) = 0 \text{ var (sec) } 0 \text{ Mvar (pri)}$$

$$3PH Tan(phi) = \frac{Q}{P} = \frac{0.01}{17.32} = 0.00$$

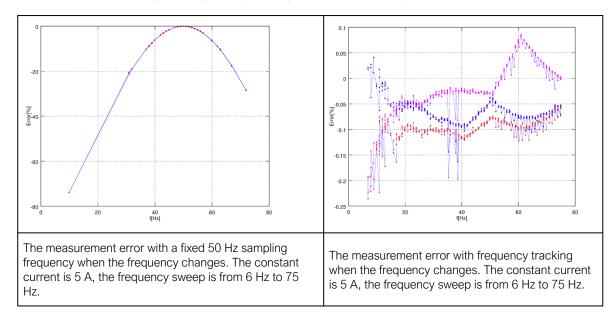
$$3PH Cos(phi) = \frac{P}{S} = \frac{17.32}{20.00} = 0.87$$

Name	Values
3PH (S)	20.00 MVA
3PH (P)	17.32 MW
3PH (Q)	0.00 Mvar
3PH Tan	0.00
3PH Cos	0.87

4.2.4 Frequency tracking and scaling

Measurement sampling can be set to the frequency tracking mode or to the fixed userdefined frequency sampling mode. The benefit of frequency tracking is that the measurements are within a pre-defined accuracy range even when the fundamental frequency of the power system changes.

Table. 4.2.4 - 46. Frequency tracking effect (FF changes from 6 Hz to 75 Hz).



As the figures above show, the sampling frequency has a major effect on the device's measurement accuracy. If the sampling is not tracked to the system frequency, for example a 10 Hz difference between the measured and the set system frequency can give a measurement error of over 5 %. The figures also show that when the frequency is tracked and the sampling is adjusted according to the detected system frequency, the measurement accuracy has an approximate error of 0.1...- 0.2 % error in the whole frequency range.

AQ -200 series devices have a measurement accuracy that is independent of the system frequency. This has been achieved by adjusting the sample rate of the measurement channels according to the measured system frequency; this way the FFT calculation always has a whole power cycle in the buffer. The measurement accuracy is further improved by Arcteq's patented calibration algorithms that calibrate the analog channels against eight (8) system frequency points for both magnitude and angle. This frequency-dependent correction compensates the frequency dependencies in the used, non-linear measurement hardware and improves the measurement accuracy significantly. Combined, these two methods give an accurate measurement result that is independent of the system frequency.

Troubleshooting

When the measured current, voltage or frequency values differ from the expected values, the following table offers possible solutions for the problems.

Problem	Check / Resolution
The measured current or voltage amplitude is lower than it should be./ The values are "jumping" and are not stable.	The set system frequency may be wrong. Please check that the frequency settings match the local system frequency, or change the measurement mode to "Tracking" ($Measurement \rightarrow Frequency \rightarrow$ "Sampling mode") so the device adjusts the frequency itself.
The frequency readings are wrong.	In Tracking mode the device may interpret the frequency incorrectly if no current is injected into the CT (or voltage into the VT). Please check the frequency measurement settings ($Measurement \rightarrow Frequency$).

Settings

Table. 4.2.4 - 47. Settings of the frequency tracking.

Name	Range	Step	Default	Description
Sampling mode	Fixed Tracking	-	Fixed	Defines which measurement sampling mode is in use: the fixed user-defined frequency, or the tracked system frequency.
Max. tracking frequency allowed (+Nom freq.)	0.00175.000 Hz	0.001 Hz	0.001 Hz	Defines the upper limit for the deviation from the system nominal frequency to be tracked. If the frequency increases more than allowed from the nominal value, the tracking is discarded and the value of the nominal frequency will be used.
System nominal frequency	7.00075.000Hz	0.001Hz	50Hz	The user-defined system nominal frequency that is used when the "Sampling mode" setting has been set to "Fixed".
Min. tracking frequency allowed (–Nom freq.)	0.00175.000 Hz	0.001 Hz	0.001 Hz	Defines the lower limit for the deviation from the system nomnal frequency to be tracked. If the frequency decreases more than allowed from the nominal value, the tracking is discarded and the value of the nominal frequency will be used.
Tracked system frequency	0.00075.000Hz	0.001Hz	-	Displays the rough measured system frequency.
Sampling frequency in use	0.00075.000Hz	0.001Hz	-	Displays the tracking frequency that is in use at that moment.
Frequency reference 1	NoneCT1IL1CT2IL1VT1U1VT2U1	-	CT1IL1	The first reference source for frequency tracking.
Frequency reference 2	NoneCT1IL2CT2IL2VT1U2VT2U2	-	CT1IL2	The second reference source for frequency tracking.
Frequency reference 3	NoneCT1IL3CT2IL3VT1U3VT2U3	-	CT1IL3	The third reference source for frequency tracking.

Name	Range	Step	Default	Description
Frequency tracking quality	No trackable channels Reference 1 trackable Reference 2 trackable References 1 & 2 trackable Reference 3 trackable Reference 1 & 3 trackable Reference 1 & 3 trackable All references trackable All references	-	-	Defines the frequency tracker quality. If the measured current (or voltage) amplitude is below the threshold, the channel tracking quality is 0 and cannot be used for frequency tracking. If all channels' magnitudes are below the threshold, there are no trackable channels.
Frequency measurement in use	No track chRef1Ref2Ref3	-	-	Indicates which reference is used at the moment for frequency tracking.
Start behavior	Start tracking immediately First nominal or tracked	-	Start tracking immediately	Defines the how the tracking starts. Tracking can start immediately, or there can be a set delay time between the receiving of the first trackable channel and the start of the tracking.
Start sampling with	Use track frequency Use nom frequency	-	Use track frequency	Defines the start of the sampling. Sampling can begin with a previously tracked frequency, or with a user-set nominal frequency.
Use nominal frequency until	01800.000s	0.005s	0.100s	Defines how long the nominal frequency is used after the tracking has started. This setting is only valid when the "Sampling mode" setting is set to "Tracking" and when the "Start behavior" is set to "First nominal or tracked".
Tracked f channel A	0.00075.000Hz	0.001Hz	-	Displays the rough value of the tracked frequency in Channel A.
Tracked f channel B	0.00075.000Hz	0.001Hz	-	Displays the rough value of the tracked frequency in Channel B.
Tracked f channel C	0.00075.000Hz	0.001Hz	-	Displays the rough value of the tracked frequency in Channel C.
System measured frequency	One f measured Two f measured Three f measured	-	-	Displays the amount of frequencies that are measured.
f.atm. Protections	0.00075.000Hz	0.001Hz	-	Frequency measurement value used by protection functions. When frequency is not measurable this value returns to value set to "System nominal frequency" parameter.

Name	Range	Step	Default	Description
f.atm. Display	0.00075.000Hz	0.001Hz	-	Frequency measurement value used in display. When frequency is not measurable this value is "0 Hz".
f measurement from	 Not measurable Avg Ref 1 Avg Ref 2 Avg Ref 3 Track Ref 1 Track Ref 2 Track Ref 3 Fast Ref 1 Fast Ref 2 Fast Ref 2 Fast Ref 3 	-	-	Displays which reference is used for frequency measurement.
SS1.meas.frqs	0.00075.000Hz	0.001Hz	-	Displays frequency used by "system set" channel
SS2.meas.frqs	0.0007 3.000112	0.001112		1 and 2.
SS1f meas.from	Not measurableFast Ref U3Fast Ref U4	-	-	Displays which voltage channel frequency reference is used by "system set" voltage channel.
SS2f meas.from	Not measurable Fast Ref U4	-	-	Displays if U4 channel frequency reference is measurable or not when the channel has been set to "system set" mode.

4.3 General menu

The *General* menu consists of basic settings and indications of the device. Additionally, the all activated functions and their status are displayed in the *Protection*, *Control* and *Monitor* profiles.

Table. 4.3 - 48. The *General* menu read-only parameters

Name	Description
Serial number	The unique serial number identification of the unit.
Firmware version	The firmware software version of the unit.
Hardware configuration	The order code identification of the unit.
System phase rotating order at the moment	The selected system phase rotating order. Can be changed with parameter "System phase rotating order".
UTC time	The UTC time value which the device's clock uses.

Table. 4.3 - 49. Parameters and indications in the *General* menu.

Name	Range	Default	Description
Device name	-	Unitname	The file name uses these fields when loading the .aqs configuration file from the AQ-200 unit.

Name	Range	Default	Description
Device location	-	Unitlocation	
Time synchronization source	Internal External NTP External Serial IRIG-B	Internal	If an external clock time synchronization source is available, the type is defined with this parameter. In the internal mode there is no external Timesync source. IRIG-B requires a serial fiber communication option card.
Enable stage forcing	Disabled Enabled	Disabled	When this parameter is enabled it is possible for the user to force the protection, control and monitoring functions to different statuses like START and TRIP. This is done in the function's <i>Info</i> page with the <i>Force status to</i> parameter.
System phase rotating order	• A-B-C • A-C-B	A-B-C	Allows the user to switch the expected order in which the phase measurements are wired to the unit.
Language	 User defined English Finnish Chinese Spanish French German Russian Ukrainian Kazakh 	English	Changes the language of the parameter descriptions in the HMI. If the language has been set to "Other" in the settings of the AQtivate setting tool, AQtivate follows the value set into this parameter.
AQtivate ethernet port	All COM A Double Ethernet card	All	If the device has a double Ethernet option card it is possible to choose which ports are available for connecting with AQtivate software.
Clear events	• - • Clear	-	Clears the event history recorded in the AQ-200 device.
LCD Contrast	0255	120	Changes the contrast of the LCD display.
Return to default view	03600s	0s	If the user navigates to a menu and gives no input after a period of time defined with this parameter, the unit automatically returns to the default view. If set to 0 s, this feature is not in use.
LED test	- Activated	-	When activated, all LEDs are lit up. LEDs with multiple possible colors blink each color.
Reset latches	• - • Reset	-	Resets the latched signals in the logic and the matrix. When a reset command is given, the parameter automatically returns back to "-".
Measurement recorder	DisabledEnabled	Disabled	Enables the measurement recorder tool, further configured in $Tools \rightarrow Misc \rightarrow Measurement\ recorder.$

Name	Range	Default	Description
I/0 default object selection	 OBJ1 OBJ2 OBJ3 OBJ4 OBJ5 OBJ6 OBJ7 OBJ8 OBJ9 OBJ10 	OBJ1	"I" and "0" push buttons on the front panel of the device have an indication LED. This parameter defines which objects' status push buttons follow when lighting up the LEDs.
Reconfigure mimic	- Reconfigure	-	Reloads the mimic to the unit.

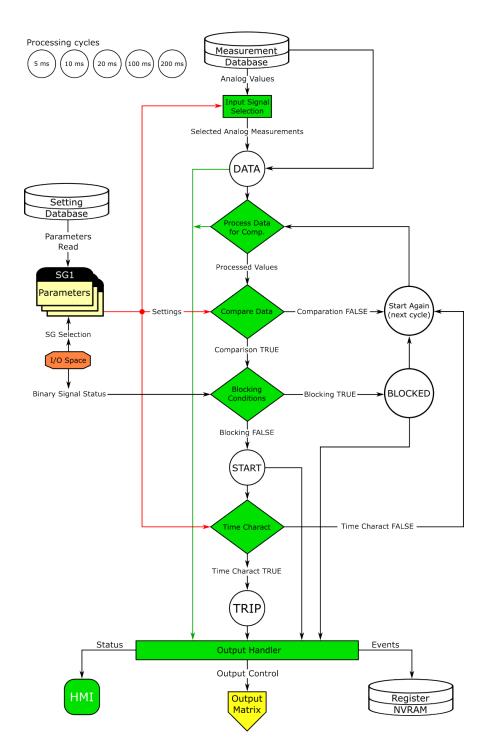
Table. 4.3 - 50. General menu logical inputs.

Name	Description
Reset last fault registers	Signal set to this point can be used for resetting latest recorded fault register.

4.4 Protection functions

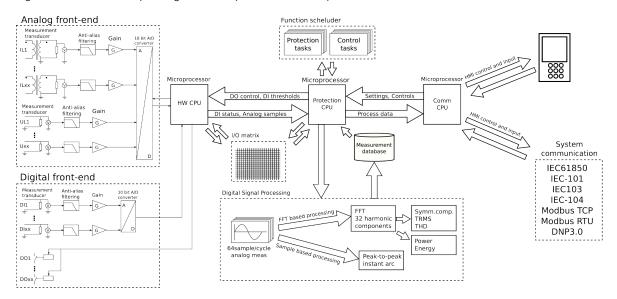
4.4.1 General properties of a protection function

The following flowchart describes the basic structure of any protection function. The basic structure is composed of analog measurement values being compared to the pick-up values and operating time delay characteristics.



The protection function is run in a completely digital environment with a protection CPU microprocessor which also processes the analog signals transformed into the digital form.

Figure. 4.4.1 - 79. Principle diagram of the protection device platform.



In the following chapters the common functionalities of protection functions are described. If a protection function deviates from this basic structure, the difference is described in the corresponding chapter of the manual.

Pick-up

The X_{set} parameter defines the pick-up level of the function, and this in turn defines the maximum or minimum allowed measured magnitude (in per unit, absolute or percentage value) before the function takes action. The function constantly calculates the ratio between the pick-up parameter set by the user and the measured magnitude (X_m). The reset ratio of 97 % is built into the function and is always relative to the X_{set} value. If a function's pick-up characteristics vary from this description, they are defined in the function section in the manual.

Figure. 4.4.1 - 80. Pick up and reset.

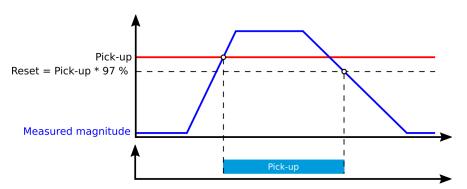
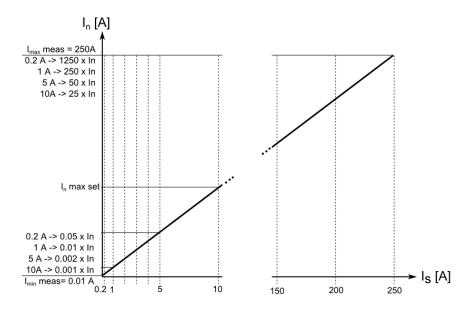


Figure. 4.4.1 - 81. Measurement range in relation to the nominal current.



The I_n magnitude refers to the user set nominal current which can range from 0.2...10 A, typically 0.2 A, 1A or 5 A. With its own current measurement card, the device will measure secondary currents from 0.001 A up to 250 A. To this relation the pick-up setting in secondary amperes will vary.

Function blocking

The blocking signals are checked in the beginning of each program cycle. A blocking signal is received from the blocking matrix for the function dedicated input. If the blocking signal is not active when the pick-up element is activated, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when pick-up element is activated, a BLOCKED signal is generated and the function will not process the situation further. Blocking signal will reset an active START signal and the release time characteristics are processed similarly to when the pick-up element is reset.

The blocking of the function causes a time stamped blocking event with information of the startup current values and its fault type to be issued.

The blocking inputs users can set are binary signals from the system. The blocking input signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics

Three basic modes are available for delaying function operation:

- Instant operation: activates the trip signal simultaneously with the start signal with no additional time delay.
- Definite time operation (DT): activates the trip signal after a user-defined time delay regardless of themagnitude of the measured value(s) as long as the pick-up element is active.
- Inverse definite minimum time (IDMT): activates the trip signal after a time which is in relation to the set pick-up value and the measured value.

Both IEC and IEEE/ANSI standard characteristics as well as user settable parameters are available for the IDMT operation. Please note that in the IDMT mode *Definite (minimum)operating time delay* also determines the minimum time for protection tripping (see the figure below). If this function is not desired the parameter should be set to 0 seconds.

Figure. 4.4.1 - 82. Operating time delay: Definite (minimum) operating time delay and the minimum for tripping.

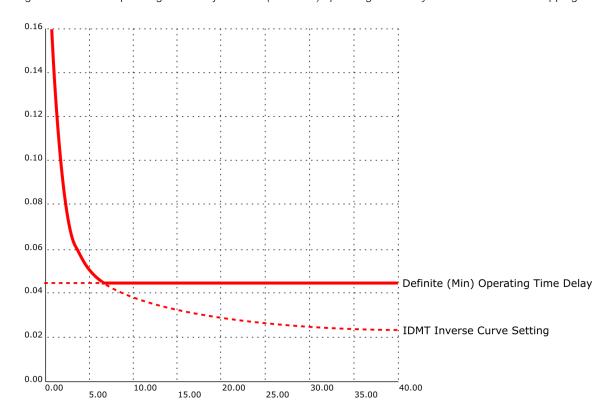


Table. 4.4.1 - 51. Operating time characteristics setting parameters (general).

Name	Range	Step	Default	Description
Delay type	• DT • IDMT	-	DT	Selects the delay type for the time counter. The selection is made between "Inverse definite minimum time" (IDMT) and "Definite time operation" (DT) characteristics.
Definite (minimum) operating time delay	0.0001800.000s	0.005s	When the "Delay type" parameter is set to "I parameter acts as the expected operating to protection function. When set to 0 s, the stage operates instants without any additional delay. When the para to 0.0051800 s, the stage operates as included delayed. When the "Delay type" parameter has been "IDMT", this parameter can be used to determinimum operating time for the protection of Example of this is presented in the figure above.	
Delay curve series	• IEC • IEEE	-	IEC	Selects whether the delay curve series for an IDMT operation follows either IEC or IEEE/ANSI standard defined characteristics. This setting is active and visible when the "Delay type" parameter is set to "IDMT".

Name	Range	Step	Default	Description
Delay characteristics IEC	• NI • EI • VI • LTI • Param	-	NI	Selects the IEC standard delay characteristics. The options include the following: Normally Inverse ("NI"), Extremely Inverse ("EI"), Very Inverse ("VI") and Long Time Inverse ("LTI") characteristics. Additionally, the "Param" option allows the tuning of the constants A and B which then allows the setting of characteristics following the same formula as the IEC curves mentioned here. This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay curve series" parameter is set to "IEC".
Delay characteristics IEEE	ANSI NI ANSI VI ANSI EI ANSI LTI IEEE MI IEEE EI Param	-	ANSI NI	Selects the IEEE and ANSI standard delay characteristics. The options for ANSI include the following: Normal Inverse ("ANSI NI"), Very Inverse ("ANSI VI"), Extremely inverse ("ANSI EI"), Long time inverse ("ANSI LTI") characteristics. IEEE: Moderately Inverse ("IEEE MI"), Very Inverse ("IEEE VI"), Extremely Inverse ("IEEE EI") characteristics. Additionally, the "Param" option allows the tuning of the constants A, B and C which then allows the setting of characteristics following the same formula as the IEEE curves mentioned here. This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay curve series" parameter is set to "IEEE".
Time dial setting k	0.0125.00s	0.01s	0.05s	Defines the time dial/multiplier setting for IDMT characteristics. This setting is active and visible when the "Delay type" parameter is set to "IDMT".
А	0.0000250.0000	0.0001	0.0860	Defines the Constant A for IEC/IEEE characteristics. This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay characteristic" parameter is set to "Param".
В	0.0000250.0000	0.0001	0.1850	Defines the Constant B for IEC/IEEE characteristics. This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay characteristic" parameter is set to "Param".
С	0.0000250.0000	0.0001	0.0200	Defines the Constant C for IEEE characteristics. This setting is active and visible when the "Delay type" parameter is set to "IDMT" and the "Delay characteristic" parameter is set to "Param".

Figure. 4.4.1 - 83. Inverse definite minimum time formulas for IEC and IEEE standards.

IEC	IEEE/ANSI						
$t = \frac{kA}{\left(\frac{I_m}{I_{set}}\right)^B}$	$t = k \left(\frac{A}{\left(\frac{I_m}{I_{set}} \right)^C - 1} + B \right)$						
t = Operating delay (s)	t = Operating delay (s)						
k = Time dial setting	k = Time dial setting						
I_m = Measured maximum current			I_m = Measured maximum current				
I_{set} = Pick-up setting			I_{set} = Pick-up setting				
A = Operating characteristics	constant		A = Operating characteristics constant				
B = Operating characteristics constant			B = Operating characteristics constant				
C. L. L. L. I.			C = Operating characteristics constant Standard delays ANSI constants				
Standard delays IEC constants Type A B			Type	A	В	С	
Normally Inverse (NI)	0.14	0,02	Normally Inverse (NI)	8,934	0.1797	2,094	
Extremely Inverse (EI)	80	2	Very Inverse (VI)	3,922	0,0982	2	
Very Inverse (VI)	13,5	1	Extremely Inverse (EI)	5,64	0,02434	2	
Long Time Inverse (LTI)	120	1	Long Time Inverse (LTI)	5,614	2,186	1	
			Standard delays IEEE co	1			
			Туре	A	В	С	
			Moderately Inverse (MI)	0,0515	0,114	0,02	
			Very Inverse (VI)	19,61	0,491	2	
			Extremely Inverse (EI)	28,2	0,1217	2	

Non-standard delay characteristics

In addition to the previously mentioned delay characteristics, some functions also have delay characteristics that deviate from the IEC or IEEE standards. These functions are the following:

- · non-directional overcurrent stages
- · non-directional earth fault stages
- · directional overcurrent stages
- · directional earth fault stages.

The setting parameters and their ranges are documented in the chapters of the respective function blocks.

Table. 4.4.1 - 52. Inverse definite minimum time formulas for nonstandard characteristics.

RI-type	RD-type			
Used for getting the time grading with mechanical relays.	Mostly used in earth fault protection which grants selective tripping even in non-directional protection.			
$t = \frac{k}{0.339 - 0.236 * \frac{I_{set}}{I_m}}$	$t = 5.8 - 1.35 * \ln\left(\frac{I_m}{k * I_{set}}\right)$			
 t = Operation delay (s) k = Time dial setting I_m = Measured maximum current I_{set} = Pick-up setting 	 t = Operation delay (s) k = Time dial setting I_m = Measured maximum current I_{set} = Pick-up setting 			

•

NOTICE!

When using RD-type and "k" has been set lower than 0.3 calculated operation time can be lower than 0 seconds with some measurement values. In these cases operation time will be instant.

When using the release delay option where the operating time counter is calculating the operating time during the release time, the function will not trip if the input signal is not activated again during the release time counting.

The behavior of the stages with different release time configurations are presented in the figures below.

Table. 4.4.1 - 53. Setting parameters for reset time characteristics.

Name	Range	Step	Default	Description
Delayed pick-up release	• No • Yes	-	Yes	Resetting characteristics selection (either time-delayed or instant) after the pick-up element is released. If set to "Yes", the START signal is reset after a set release time delay.
Release time delay	0.000150.000s	0.005s	0.06s	Resetting time. The time allowed between pick-ups if the pick-up has not led into a trip operation. If the "Delayed pick-up release" setting is set to "Yes", the START signal is held on for the duration of the timer.
Op.Time calculation reset after release time	• No • Yes	-	Yes	Operating timer resetting characteristics selection. When set to "Yes", the operating time counter is reset after a set release time if the pick-up element is not activated during this time. When set to "No", the operating time counter is reset directly after the pick-up element is reset.
Continue time calculation during release time	• No • Yes	-	No	Time calculation characteristics selection. If set to "Yes", the operating time counter continues until a set release time even if the pick-up element is reset.

Figure. 4.4.1 - 84. No delayed pick-up release.

Delayed pick-up release: Disabled

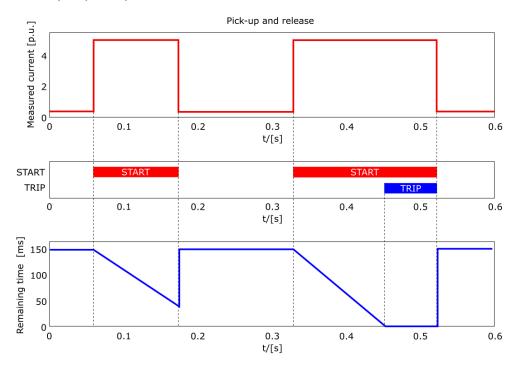


Figure. 4.4.1 - 85. Delayed pick-up release, delay counter is reset at signal drop-off.

Delayed pick-up release: Enabled

Op.time calc reset after release time: Disabled

Continue time calculation during release time: Disabled

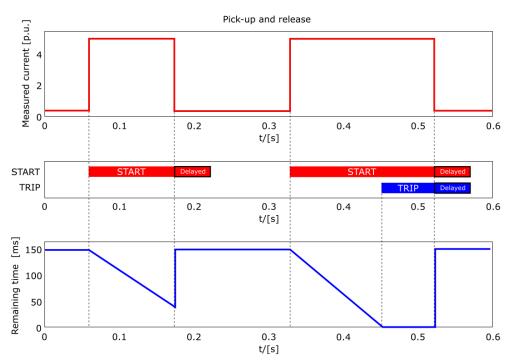


Figure. 4.4.1 - 86. Delayed pick-up release, delay counter value is held during the release time.

Delayed pick-up release: Enabled Op.time calc reset after release time: Enabled Continue time calculation during release time: Disabled

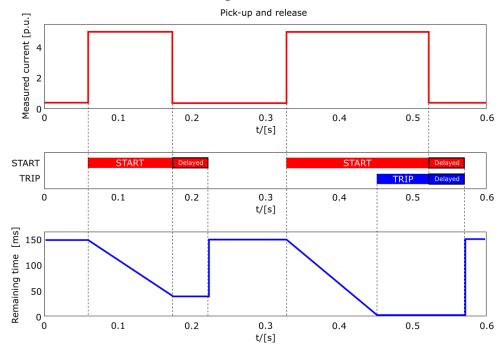
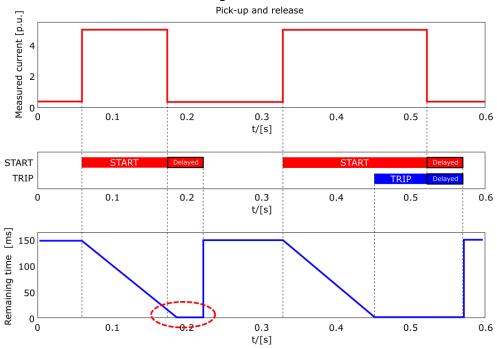


Figure. 4.4.1 - 87. Delayed pick-up release, delay counter value is decreasing during the release time.

Delayed pick-up release: Enabled
Op.time calc reset after release time: Enabled

Continue time calculation during release time: Enabled



Stage forcing

It is possible to test the logic, event processing and the operation of the device's logic by controlling the state of the protection functions manually without injecting any current into the device with stage forcing. To enable *Stage forcing* set the *Enable stage forcing* to ENABLED in the *General* menu. After this it is possible to control the status of a protection function (Normal, Start, Trip, Blocked etc.) in the *Info* page of the function.

NOTICE!

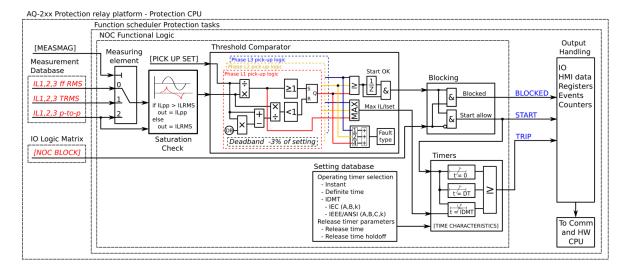


When *Stage forcing* is enabled protection functions will also change state through user input. Injected currents/voltages also affect the behavior of the device. Regardless, it is recommended to disable *Stage Forcing* after testing has ended.

4.4.2 Non-directional overcurrent protection (I>; 50/51)

The non-directional overcurrent function is used for instant and time-delayed overcurrent and short-circuit protection. The function is used for one-phase, two-phase or three-phase overcurrent and short circuit protection. The function offers four (4) independent stages. The operating decisions are based on phase current magnitude, constantly measured by the function.

Figure. 4.4.2 - 88. Simplified function block diagram of the I> function.



Measured input

The function block uses phase current measurement values. The user can select the monitored magnitude to be equal either to RMS values (fundamental frequency component), to TRMS values from the whole harmonic specter of 32 components, or to peak-to-peak values.

Table. 4.4.2 - 54. Measurement inputs of the I> function.

Signal	Description
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current measurement
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current measurement
I _{L3} RMS	Fundamental frequency component of phase L3 (C) current measurement
I _{L1} TRMS	TRMS measurement of phase L1 (A) current

Signal	Description		
I _{L2} TRMS	TRMS measurement of phase L2 (B) current		
I _{L3} TRMS	TRMS measurement of phase L3 (C) current		
I _{L1} PP	Peak-to-peak measurement of phase L1 (A) current		
I _{L2} PP	Peak-to-peak measurement of phase L2 (B) current		
I _{L3} PP	Peak-to-peak measurement of phase L3 (C) current		

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.2 - 55. General settings of the function.

Name	Range	Default	Description
Setting control from comm bus	DisabledAllowed	Disabled	Activating this parameter allows changing the pick-up level of the protection stage via SCADA.
I> force status to	Normal Start Trip Blocked Start A Start B Start C Trip A Trip B Trip C Start AB Start BC Start CA Start CA Trip AB Trip AB Trip C	• Normal	Force the status of the function. Visible only when <i>Enable</i> stage forcing parameter is enabled in <i>General</i> menu.
Measured magnitude	RMSTRMSPeak-to-peak	• RMS	Defines which available measured magnitude is used by the function.

Pick-up settings

The I_{set} setting parameter controls the pick-up of the I> function. This defines the maximum allowed measured current before action from the function. The function constantly calculates the ratio between the I_{set} and the measured magnitude (I_m) for each of the three phases. The reset ratio of 97 % is built into the function and is always relative to the I_{set} value. The setting value is common for all measured phases, and when the I_m exceeds the I_{set} value (in single, dual or all phases) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.2 - 56. Pick-up settings.

Name	Range	Step	Default	Description
I _{set}	0.1050.00×I _n	0.01×I _n	1.20×I _n	Pick-up setting

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.2 - 57. Information displayed by the function.

Name	Range	Step	Description
l> condition	NormalStartTripBlocked	-	Displays status of the protection function.
I> phases condition	 Normal Start A Start B Start C Trip A Trip B Trip C Start AB Start BC Start BC Start ABC Trip AB Trip BC Trip AB Trip CA Trip ABC 	-	Displays the status of phases individually.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured highest phase current value. If the measured current changes during a fault, the expected operating time changes accordingly.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
I _{meas} /I _{set} at the moment	0.001250.00	0.01	The ratio between the highest measured phase current and the pick-up value.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. Additionally, the function includes an internal inrush harmonic blocking option which is applied according to the parameters set by the user. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

Table. 4.4.2 - 58. Internal inrush harmonic blocking settings.

Name	Range	Step	Default	Description
Inrush harmonic blocking (internal-only trip)	No Yes	-	• No	Enables and disables the 2 nd harmonic blocking.
2 nd harmonic blocking limit (lharm/lfund) 0.1050.00%l _{fund}		0.01%l _{fund}	0.01%l _{fund}	Defines the limit of the 2 nd harmonic blocking.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT) and inverse definite minimum time delay (IDMT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The non-directional overcurrent function (abbreviated "NOC" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's output can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

Table. 4.4.2 - 59. Event messages.

Event block name	Event names
NOC1NOC4	Start ON
NOC1NOC4	Start OFF
NOC1NOC4	Trip ON
NOC1NOC4	Trip OFF
NOC1NOC4	Block ON

Event block name	Event names
NOC1NOC4	Block OFF
NOC1NOC4	Phase A Start ON
NOC1NOC4	Phase A Start OFF
NOC1NOC4	Phase B Start ON
NOC1NOC4	Phase B Start OFF
NOC1NOC4	Phase C Start ON
NOC1NOC4	Phase C Start OFF
NOC1NOC4	Phase A Trip ON
NOC1NOC4	Phase A Trip OFF
NOC1NOC4	Phase B Trip ON
NOC1NOC4	Phase B Trip OFF
NOC1NOC4	Phase C Trip ON
NOC1NOC4	Phase C Trip OFF

The function registers its operation into the last twelve (12) time-stamped registers; this information is available for all provided instances separately. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

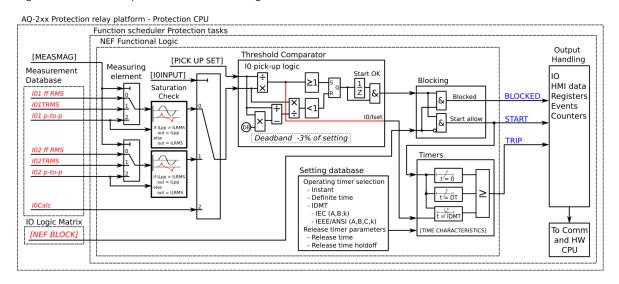
Table. 4.4.2 - 60. Register content.

Name	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	L1-EL1-L2-L3
Pre-trigger current	Start/Trip -20ms current
Fault current	Start/Trip current
Pre-fault current	Start -200ms current
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active.

4.4.3 Non-directional earth fault protection (I0>; 50N/51N)

The non-directional earth fault function is used for instant and time-delayed earth fault protection. The number of stages in the function depend on the device model. The operating characteristics are based on the selected neutral current magnitude which the function measures constantly.

Figure. 4.4.3 - 89. Simplified function block diagram of the IO> fucntion.



Measured input

The function block uses residual current measurement values. The available analog measurement channels are l_{01} and l_{02} (residual current measurement) and l_{0Calc} (residual current calculated from phase current). The user can select the monitored magnitude to be equal either to RMS values (fundamental frequency component), to TRMS values from the whole harmonic specter of 32 components, or to peak-to-peak values.

Table. 4.4.3 - 61. Measurement inputs of the IO> function.

Signal	Description	
I ₀₁ RMS	Fundamental frequency component of coarse residual current measurement input I01	
I ₀₁ TRMS	TRMS measurement of coarse residual current measurement input I01	
I ₀₁ PP	Peak-to-peak measurement of coarse residual current measurement input I01	
I ₀₂ RMS	Fundamental frequency component of sensitive residual current measurement input I02	
I ₀₂ TRMS	TRMS measurement of coarse sensitive current measurement input I02	
I ₀₂ PP	Peak-to-peak measurement of sensitive residual current measurement input I02	
I ₀ Calc	Fundamental frequency component of the calculated zero sequence current calculated from the three phase currents	

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.3 - 62. General settings of the function.

Name	Range	Default	Description
Setting control from comm bus	DisabledAllowed	Disabled	Activating this parameter permits changing the pick-up level of the protection stage via SCADA.
IO> force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when Enable stage forcing parameter is enabled in General menu.
Measured magnitude	RMSTRMSPeak-to-peak	RMS	Defines which available measured magnitude is used by the function. This parameter is available when "Input selection" has been set to "I01" or "I02".
Input selection	• I01 • I02 • I0Calc	101	Defines which measured residual current is used by the function.

Pick-up settings

The IO_{set} setting parameter controls the the pick-up of the IO> function. This defines the maximum allowed measured current before action from the function. The function constantly calculates the ratio between the IO_{set} and the measured magnitude (I_m) for each of the three phases. The reset ratio of 97% is built into the function and is always relative to the IO_{set} value. The setting value is common for all measured phases. When the I_m exceeds the IO_{set} value (in single, dual or all phases) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.4.3 - 63. Pick-up settings.

Name	Range	Step	Default	Description
I0 _{set}	0.000140.00 × I _n	0.0001 × I _n	1.20 × I _n	Pick-up setting

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.3 - 64. Information displayed by the function.

Name	Range	Step	Description
I0> condition	NormalStartTripBlocked	-	Displays status of the protection function.

Name	Range	Step	Description	
Detected 10 angle	-360.00360.00 deg	0.01 deg	Angle of IO against reference. If phase voltages are available, positive sequence voltage angle is used as reference. If voltage are not available, positive sequence current angle is used as reference.	
Detected fault type	• - • A-G-R • B-G-F • C-G-R • A-G-F • B-G-R • C-G-F	-	Displays the detected fault type and direction of previous fault. "A/B/C" stand for one of the three phases. "G" stands for "ground". "F" stands for "forward" direction and "R" stands for "reverse" direction.	
Expected operating time	-1800.0001800.000 s	0.005 s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured current value. If the measured current changes during a fault, the expected operating time changes accordingly.	
Time remaining to trip	0.0001800.000 s	0.005 s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.	
I _{meas} /I _{set} at the moment	0.001250.00	0.01	The ratio between the measured current and the pick-up value.	

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. Additionally, the function includes an internal inrush harmonic blocking option which is applied according to the parameters set by the user. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

Table. 4.4.3 - 65. Internal inrush harmonic blocking settings.

Name Range		Step	Default	Description
Inrush harmonic blocking (internal-only trip)	No Yes	-	No	2 nd harmonic blocking enable/disable
2 nd harmonic block limit (lharm/ lfund)	0.1050.00%l _{fund}	0.01%l _{fund}	0.01%lfund	2 nd harmonic blocking limit

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT) and inverse definite minimum time delay (IDMT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The non-directional earth fault function (abbreviated "NEF" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.3 - 66. Event messages.

Event block name	Event names
NEF1NEF4	Start ON
NEF1NEF4	Start OFF
NEF1NEF4	Trip ON
NEF1NEF4	Trip OFF
NEF1NEF4	Block ON
NEF1NEF4	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

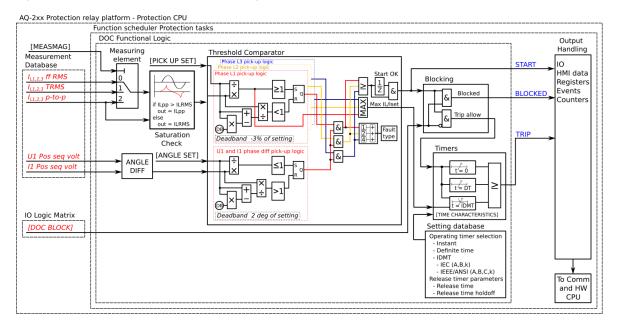
Table. 4.4.3 - 67. Register content.

Name	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	A-G-RC-G-F
Pre-trigger current	Start/Trip -20ms current
Fault current	Start/Trip current
Pre-fault current	Start -200ms current
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active.

4.4.4 Directional overcurrent protection (Idir>; 67)

The directional overcurrent function is used for instant and time-delayed overcurrent and short-circuits. A device with both voltage and current protection modules can have four (4) available stages of the function (ldir>, ldir>>>, ldir>>>). The operating decisions are based on phase current magnitudes which the function constantly measures.

Figure. 4.4.4 - 90. Simplified function block diagram of the Idir> function.



Measured input

The function block uses phase current and voltage measurement values. The user can select the monitored current magnitude to be equal either to RMS values (fundamental frequency component), to TRMS values from the whole harmonic specter of 32 components, or to peak-to-peak values.

The fault current angle is based on the comparison between the positive sequence voltage U_1 and the positive sequence current I_1 . If the positive sequence voltage is not available (three line-to-line voltages but no U_0), the voltage angle is based on a faulty phase line-to-line voltage. If the voltage drops below 1 V in the secondary side during a fault, the voltage memory is used for 0.5 seconds. After that the reference angle of voltage is forced to 0° .

Table. 4.4.4 - 68. Measurement inputs of the Idir> function.

Signal	Description
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current measurement
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current measurement
I _{L3} RMS	Fundamental frequency component of phase L3 (C) current measurement
I _{L1} TRMS	TRMS measurement of phase L1 (A) current
I _{L2} TRMS	TRMS measurement of phase L2 (B) current
I _{L3} TRMS	TRMS measurement of phase L3 (C) current

Signal	Description
I _{L1} PP	Peak-to-peak measurement of phase L1 (A) current
I _{L2} PP	Peak-to-peak measurement of phase L2 (B) current
I _{L3} PP	Peak-to-peak measurement of phase L3 (C) current
U ₁ RMS	Fundamental frequency component of U ₁ /V voltage measurement
U ₂ RMS	Fundamental frequency component of U ₂ /V voltage measurement
U ₃ RMS	Fundamental frequency component of U ₃ /V voltage measurement
U ₄ RMS	Fundamental frequency component of U ₄ /V voltage measurement

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.4 - 69. General settings of the function.

Name	Range	Default	Description
Idir> force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Measured magnitude	RMSTRMSPeak- to-peak	RMS	Defines which available measured magnitude is used by the function.

Pick-up settings

The I_{set} setting parameter controls the pick-up of the I> function. This defines the maximum allowed measured current before action from the function. The function constantly calculates the ratio between the I_{set} and the measured magnitude (I_m) for each of the three phases. The reset ratio of 97 % is built into the function and is always relative to the I_{set} value. The setting value is common for all measured phases, and when the I_m exceeds the I_{set} value (in single, dual or all phases) it triggers the pick-up operation of the function.

The trip characteristic can be set to directional or non-directional. In the non-directional mode only the pick-up value of the positive sequence current magnitude must be fulfilled in order for the function to trip. In the directional mode the fault must also be in the monitored direction to fulfill the terms to trip. By default, the tripping area is $\pm 88^{\circ}$ (176°). The reference angle is based on the calculated positive sequence voltage U_1 angle. If the U_1 voltage is not available and only line-to-line voltages are measured, the reference angle is based on a healthy line-to-line voltage. During a short-circuit the reference angle is based on impedance calculation.

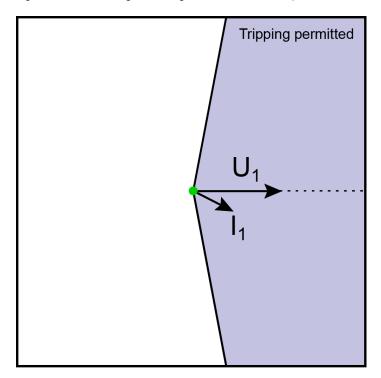
If the voltage drops below 1 V in the secondary side, the angle memory is used for 0.5 seconds. The angle memory forces the reference angle to be equal to the value measured or calculated before the fault. The angle memory captures the measured voltage angle 100 ms before the fault starts. After 0.5 seconds the angle memory is no longer used, and the reference angle is forced to 0°. The inbuilt reset ratio for the tripping area angle is 2°.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.4 - 70. Pick-up settings.

Name	Range	Step	Default	Description
Characteristic direction	Directional Non- directional	-	Directional	Switches between directional and non-directional overcurrent mode.
Operating sector size (+ / -)	±1.0170.0°	0.1°	±88°	Pick-up area size in degrees.
Operating sector center	-180.0180.0°	0.1°	0°	Turns the operating sector
Pick-up setting I _{set}	0.1040.00×In	0.01×I _n	1.20×I _n	Pick-up setting

Figure. 4.4.4 - 91. Angle tracking of the Idir> function (3LN/3LL + U₀ mode).



Please note in the picture above that the tripping area is linked to the angle of the positive sequence voltage U_1 . The angle of the positive sequence current I_1 is compared to U_1 angle, and if the fault is in the correct direction, it is possible to perform a trip when the amplitude of I_{L1} , I_{L2} or I_{L3} increases above the pick-up limit.

If the 3LL mode is used without the U_0 measurement in a single-phase fault situation, the voltage reference comes from the healthy phase and the current reference from the faulty phase. In a short-circuit the angle comes from impedance calculation.

Figure. 4.4.4 - 92. Operation sector area when the sector center has been set to -45 degrees.

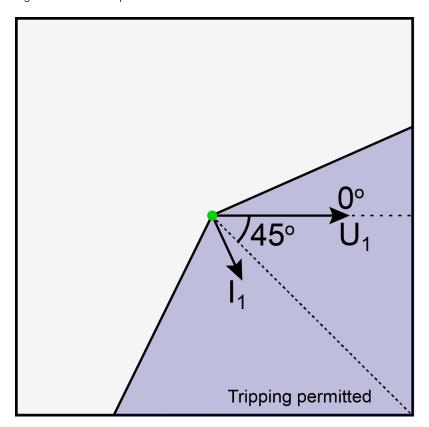
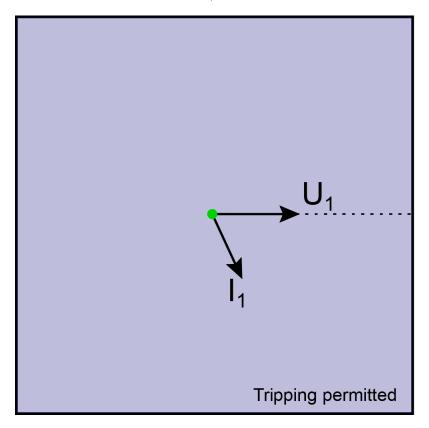


Figure. 4.4.4 - 93. When Idir> function has been set to "Non-directional" the function works basically just like a traditional non-directional overcurrent protection function.



Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.4 - 71. Information displayed by the function.

Name	Range	Step	Description	
Operating angle now	-360.00360.00deg	0.01deg	The positive sequence current angle in relation to the positive sequence voltage.	
Expected operating time	0.0001800.00s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the highest measured phase current value. If the measured current changes during a fault, the expected operating time changes accordingly.	
Time remaining to trip	-1800.0001800.00s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.	
I _{meas} /I _{set} at the moment	0.001250.00I _m /I _{set}	0.01I _m /I _{set}	The ratio between the highest measured phase current and the pick-up value.	

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. Additionally, the function includes an internal inrush harmonic blocking option which is applied according to the parameters set by the user. When the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

Table. 4.4.4 - 72. Internal inrush harmonic blocking settings.

Name	Range	Step	Default	Description
Inrush harmonic blocking (internal-only trip)	No Yes	-	No	Enables and disables the 2 nd harmonic blocking.
2 nd harmonic blocking limit (lharm/lfund)	0.1050.00%lfund	0.01%lfund	0.01%lfund	The 2 nd harmonic blocking limit.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, time characteristics are reset and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT) and inverse definite minimum time delay (IDMT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The directional overcurrent function (abbreviated "DOC" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.4 - 73. Event messages.

Event block name	Event names
DOC1DOC4	Start ON
DOC1DOC4	Start OFF
DOC1DOC4	Trip ON
DOC1DOC4	Trip OFF
DOC1DOC4	Block ON
DOC1DOC4	Block OFF
DOC1DOC4	No voltage, Blocking ON
DOC1DOC4	Voltage measurable, Blocking OFF
DOC1DOC4	Measuring live angle ON
DOC1DOC4	Measuring live angle OFF
DOC1DOC4	Using voltmem ON
DOC1DOC4	Using voltmem OFF

The function registers its operation into the last twelve (12) time-stamped registers; this information is available for all provided instances separately. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.4 - 74. Register content.

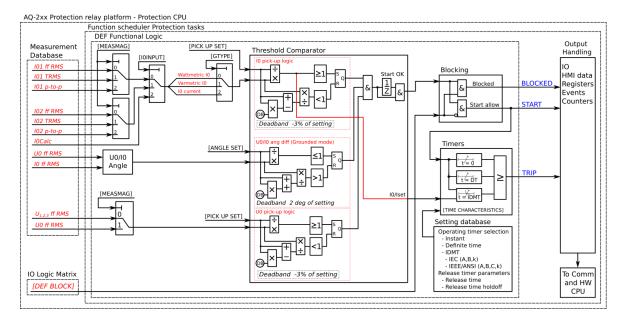
Register name	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name

Register name	Description
Fault type	L1-EL1-L2-L3
Pre-trigger current	Start/Trip -20ms current
Fault current	Start/Trip current
Pre-fault current	Start -200ms averages
Trip time remaining	0s1800s
Setting group in use	Setting group 18 active
Operating angle	0250°

4.4.5 Directional earth fault protection (I0dir>; 67N/32N)

The directional earth fault function is used for instant and time-delayed earth fault protection. A device with both voltage and current protection modules can have four (4) stages in the function (I0dir>, I0dir>>>, I0dir>>>). The operating decisions are based on selected neutral current and voltage magnitudes which the function constantly measures.

Figure. 4.4.5 - 94. Simplified function block diagram of the IOdir> function.



Measured input

The function block uses residual current measurement values and neutral voltage measurement values. The available residual current measurement channels are l_{01} and l_{02} (residual current measurement) and l_{02} (residual current calculated from phase current). The user can select the monitored current magnitude to be equal either to RMS values (fundamental frequency component), to TRMS values from the whole harmonic specter of 32 components, or to peak-to-peak values.

The fault current angle is based on comparing the neutral voltage U_0 angle to the residual current I_0 angle. Both I_0 and U_0 must be above the squelch limit to be able to detect the angle. The squelch limit for the I_0 current is $0.01 \times I_0$ and for the U_0 voltage $0.01 \times U_0$.

Table. 4.4.5 - 75. Measurement inputs of the IOdir> function.

Signal	Description
I ₀₁ RMS	Fundamental frequency component of coarse residual current measurement input I01
I ₀₁ TRMS	TRMS measurement of coarse residual current measurement input I01
I ₀₁ PP	Peak-to-peak measurement of coarse residual current measurement input I01
I ₀₂ RMS	Fundamental frequency component of sensitive residual current measurement input I02
I ₀₂ TRMS	TRMS measurement of coarse sensitive current measurement input I02
I ₀₂ PP	Peak-to-peak measurement of sensitive residual current measurement input I02
I _{0Calc}	Fundamental frequency component of residual current calculated from the three phase currents
U ₀ RMS	Fundamental frequency component of zero sequence voltage measurement input U0
U _{0Calc}	Fundamental frequency component of of the zero sequence voltage calculated from the three phase voltages

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.5 - 76. General settings of the function.

Name	Range	Default	Description
IOdir> force status to	 Normal Start Trip Blocked Unearthed Start Unearthed Trip Compensated Start Compensated Trip 	Normal	Force the status of the function. Visible only when <i>Enable stage</i> forcing parameter is enabled in <i>General</i> menu.
U0 directional reference	• U0 • -U0	U0	If the connected neutral voltage polarity is opposite to the connected residual current, this parameter can swap the angle reference.
U0> Meas input select	SelectU0CalculatedU3 InputU4 Input	Select	Defines which available neutral voltage measurement is used. Available neutral voltages depend on measurement settings (Measurements → Transformers → VT module).
Measured magnitude	• RMS • TRMS • Peak-to-peak	RMS	Defines which available measured magnitude is used by the function. This parameter is available when "Input selection" has been set to "I01" or "I02".

Name	Range	Default	Description
Input selection	• 101 • 102 • 10Calc	101	Defines which measured residual current is used by the function.

Pick-up settings

The the pick-up of the IOdir function is controlled by the IOset setting parameter and the IOset setting parameter. The former defines the maximum allowed measured current, while the latter defines the maximum allowed measured voltage and checks the angle difference before action from the function. The function constantly calculates the ratio between the IOset and the IOset and the measured magnitudes (Imand Imand Ima

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

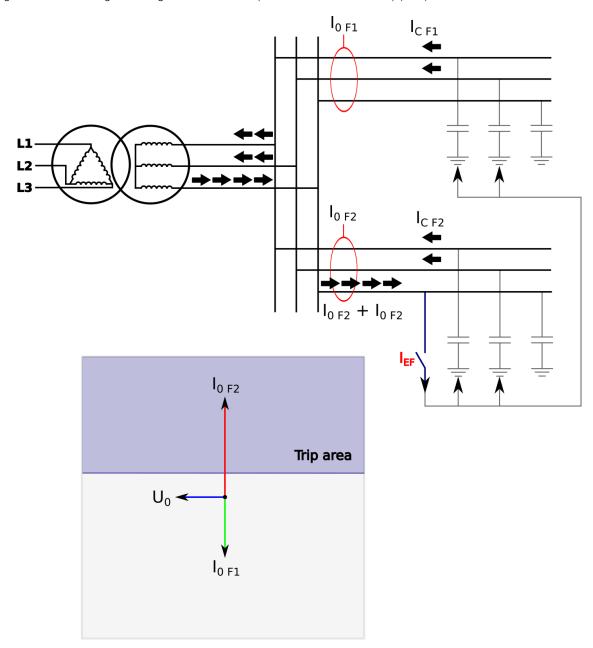
Table. 4.4.5 - 77. Pick-up settings.

Name	Range	Step	Default	Description
Grounding type	Unearthed [32N Var] Petersen coil GND [32N Watt] Grounded [67N] IOCos & IOsin broad range with MCD [32N Var/ Watt]	-	Unearthed Network grounding method	
Pick-up setting 10 _{set} >				
Comp. pick-up setting I0 _{set} (I0Cosfi)>	0.00540.00×I _n	0.001×I _n	1.20×I _n	Current pick-up setting. If broadrange mode is selected, unearthed and compensated networks have separate pick-up settings.
Unearth. pick- up setting I0 _{set} (I0Sinfi)>				
Pick-up setting U0 _{set} >				
Comp. pick-up setting U0 _{set} (I0Cosfi)>	175%U _n	0.01%U _n	20%U _n	Voltage pick-up setting. If broadrange mode is selected, unearthed and compensated networks have separate pick-up settings.
Unearth. pick- up setting U0 _{set} (I0Sinfi)>				

Name	Range	Step	Default	Description
Multi-criteria detection	Not usedUsed	-	Not used	Activation of detecting healthy or unhealthy feeder by analyzing symmetrical components of currents and voltages. Visible when broadrange mode is used.
Unearthed/ Compensated border angle	-45.090°	0.1°	45°	Dividing the angle between unearthed and compensated tripping (see description later in this document). Visible when earthing type is set to $10_{Cos} \& 10_{Sin}$ broad range mode.
Resistive (IOCosfi) mode IO angle blinder.	-90.00.0°	0.1°	-90°	I0 angle blinder. Used in broadrange and Petersen coil grounded mode. Not in use when set to zero.
Tripping area size (+ / -)	±45.0135.0°	0.1°	±88°	Defines the tripping area sector size in grounded network mode.
Tripping area center	-360.00360.00	0.1°	0.0°	Turns the tripping area in grounded network mode.

Unearthed network

Figure. 4.4.5 - 95. Angle tracking of IOdir> function (unearthed network model) (32N)



When the unearthed (capacitive) network mode is chosen, the function expects the fault current to be lagging zero sequence voltage by 90 degrees. Healthy phases of healthy feeders produce capacitive current during earth fault just like a faulty feeder but the current is floating towards the busbar and through an incoming feeder transformer or a earthing transformer and into a faulty feeder. Healthy feeders do not trip since capacitive current is floating to the opposite direction and selective tripping can be ensured.

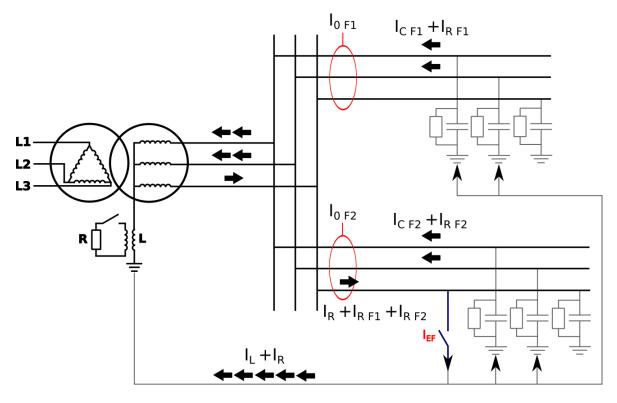
The amplitude of the fault current depends on the capacitance of the network. The outgoing feeders are the sources for capacitive currents. The bigger the network the greater the capacitive current during a fault. Each outgoing feeder produces capacitance according to the zero sequence capacitive reactance of the line (ohms per kilometer). It is normal that in cable networks fault currents are higher than in overhead lines.

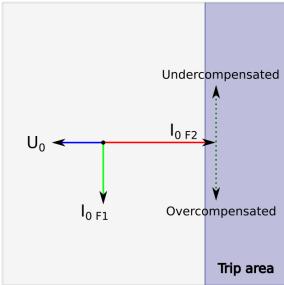
The resistance of the fault affects the size of the voltage drop during a fault. In direct earth fault the zero sequence voltage amplitude is equal to the system's line-to-earth voltage. In direct earth fault the voltage of a faulty phase drops close to zero and healthy phase voltages increase to the amplitude of line-to-line voltages.

Petersen coil earthed (Compensated) network (32N)

There are many benefits to a Petersen coil earthed network. The amount of automatic reclosing is highly decreased and the maintenance of the breakers is therefore diminished. Arc faults die on their own, and cables and equipment suffer less damage. In emergency situations a line with an earth fault can be used for a specific time.

Figure. 4.4.5 - 96. Angle tracking of IOdir> function (Petersen coil earthed network model).



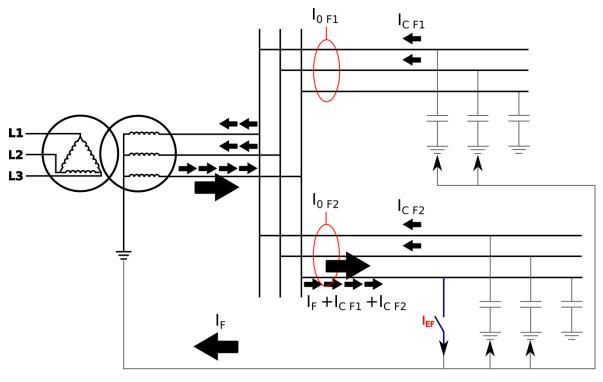


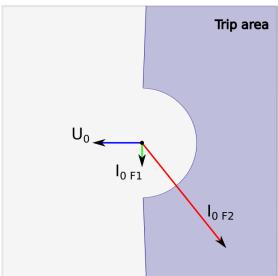
When the Petersen coil earthed (compensated) network mode is chosen, the function expects the fault current to be in the opposite direction to the zero sequence voltage. Healthy phases of both healthy and faulty feeders produce a capacitive current similar to the unearthed network. The inductance of the Petersen coil compensates the capacitive current and therefore the residual current in a fault location is close to zero. The size of the inductance is chosen according to the prospective earth fault current of the network. The desired compensation grade is achieved when the K factor is close to 1.0 and the network is fully compensated. The network is overcompensated when the K factor is greater than 1.0, and undercompensated when the K factor is smaller than 1.0.

The inductance connected to the star point of an incoming feeder transformer or -as in most cases- to a earthing transformer compensates the capacitance of the network; however, this prevents the capacitive fault current to be measured. The fault detection is handled by connecting the resistance in parallel with the inductance. This resistance includes the amplitude of the fault current. In undercompensated or overcompensated situations the resistive component does not change during the fault; therefore, selective tripping is ensured even when the network is slightly undercompensated or overcompensated.

Directly earthed or small impedance network (67N)

Figure. 4.4.5 - 97. Angle tracking of IOdir> function (directly earthed or small impedance network).





In a directly earthed network the amplitude of a single-phase fault current is similar to the amplitude of a short-circuit current. Directly earthed or small impedance network schemes are normal in transmission, distribution and industry.

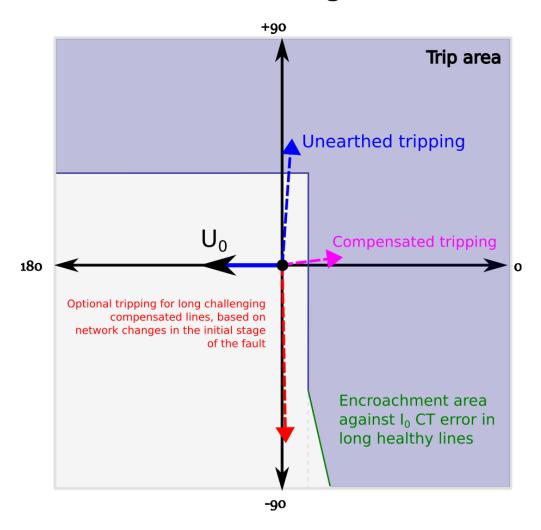
The phase angle setting of the tripping area is adjustable as is the base direction of the area (angle offset).

Broad range mode with multi-criteria detection for unearthed and compensated networks

When detecting earth faults in compensated long-distance cables and overhead lines, it is in some cases difficult to distinguish between a healthy and a faulty feeder. Merely measuring the angle and the magnitude of residual voltage and currents is not always enough, as changes in symmetrical components of phase currents and voltages are also needed. Additionally, when protecting feeders from earth faults, two modes are used depending on the network status (unearthed or compensated). When changing between these two statuses the setting group must be changed, and especially with distributed compensation the change may be difficult or impossible to arrange. Finally, in a compensated network protection relays with traditional algorithms may sporadically detect an earth fault in a long healthy feeder due to CT errors. For all these reasons, Arcteq has developed an improved alternative to these traditional directional earth fault protections.

Figure. 4.4.5 - 98. Angle tracking of the IOdir> function (broad range mode).

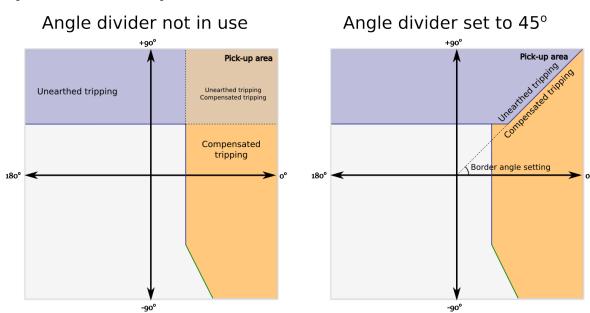
New broadrange mode



The new broad range mode is capable of detecting an earth fault directionally in both unearthed and compensated networks not only by combining the two stages together but by using a new multi-criteria detection. This optional additional tripping condition for compensated networks uses Arcteq's patented, high-resolution intermittent earth fault algorithm with added symmetrical component calculation of phase currents and voltages. If this mode is activated, the alarming criteria is comprised of a measured residual current in the fourth quadrant and the symmetrical components of voltages and currents detecting a fault. No extra parameterization is required compared to the traditional method. The multi-criteria algorithm can be tested with COMTRADE files supplied by Arcteq. The function requires a connection of three-phase currents, residual current and residual voltage to operate correctly.

To avoid unnecessary alarms the user can add an encroachment area against I0 CT errors in compensated long healthy lines.

Figure. 4.4.5 - 99. Effect of angle divider when in use and when disabled.



To receive a more accurate indication as to whether the fault was in a compensated or an unearthed network the angle divider can divide the area which would otherwise be overlapped between the two network models. By default the setting is 45 degrees. When the divider is disabled the angle is set to zero degrees.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.5 - 78. Information displayed by the function.

Name	Range	Step	Description
I0dir> condition	NormalStartTripBlocked	-	Displays the status of the protection function.

Name	Range	Step	Description
U0> Measuring now	No U0 avail!U0CalcU3 InputU4 Input	-	Displays which voltage channel is used by the function. If no voltage channel has been selected the function defaults to calculated residual voltage if line-to-neutral voltages have been connected to device. If no channel is set to "U0" mode and line-to-line voltages are connected, no residual voltage is available and "No U0 avail!" will be displayed.
U0> Pick-up setting	0.01 000 000V	0.1V	The required residual voltage on the primary side for the function to trip.
Detected U0/ I0 angle (fi)	-360.00360.00deg	0.01deg	The angle in degrees between the monitored residual voltage and the current.
I0 Magnitude	0.000250.000×I0 _n	0.001×I0 _n	The per-unit-value of the monitored residual current.
I0 Wattmetric I0xCos(fi)	-250.000250.000×I0n	0.001×I0 _n	The wattmetric per-unit-value of the monitored residual current.
I0 Varmetric I0xSin(fi)	-250.000250.000×I0n	0.001×I0 _n	The varmetric per-unit-value of the monitored residual current.
I0 direction now	 Undefined Forward Reverse	-	The detected direction of the residual current.
I0 meas/ I0 set now	-250.000250.000×I0 _n	0.001×I0 _n	The ratio between the monitored residual current and the pick-up value.
U0 measurement now	0.000500.000%U0n	0.001%U0 _n	The measured voltage in the chosen voltage channel.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured current value. If the measured current changes during a fault, the expected operating time changes accordingly.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. Additionally, the function includes an internal inrush harmonic blocking option which is applied according to the parameters set by the user. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

Table. 4.4.5 - 79. Internal inrush harmonic blocking settings.

Name	Range	Step	Default	Description
Inrush harmonic blocking (internal-only trip)	NoYes	-	No	Enables and disables the 2 nd harmonic blocking.

Name	Range	Step	Default	Description
2 nd harmonic blocking limit (lharm/lfund)	0.1050.00%l _{fund}	0.01%l _{fund}	0.01%l _{fund}	The 2 nd harmonic blocking limit.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT) and inverse definite minimum time delay (IDMT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".



NOTICE!

IDMT settings are not available in broadrange mode.

Table. 4.4.5 - 80. Time delay settings specific to the directional earth fault function.

Name	Range	Step	Default	Description
Delay type of broad range characteristics	Common time Separate time for I0Cosfi and I0Sinfi	-	Common time	If broadrange mode is selected, it is possible to set separate time delay for earth faults in grounded networks and Petersen coil compensated networks.
Definite operating time delay (Compensated)	0.0001800.000	0.005 s 0.04	0.040 s	Time delays for compensated and unearthed earth faults when "Delay type of broad range characteristics" has been set to "Separate".
Definite operating time delay (Unearthed)	s		0.040 S	

Events and registers

The directional overcurrent function (abbreviated "DEF" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.5 - 81. Event messages.

Event block name	Event name
DEF1DEF4	Start ON
DEF1DEF4	Start OFF
DEF1DEF4	Trip ON
DEF1DEF4	Trip OFF
DEF1DEF4	Block ON
DEF1DEF4	Block OFF
DEF1DEF4	IOCosfi Start ON
DEF1DEF4	IOCosfi Start OFF
DEF1DEF4	I0Sinfi Start ON
DEF1DEF4	IOSinfi Start OFF
DEF1DEF4	IOCosfi Trip ON
DEF1DEF4	IOCosfi Trip OFF
DEF1DEF4	IOSinfi Trip ON
DEF1DEF4	IOSinfi Trip OFF

The function registers its operation into the last twelve (12) time-stamped registers; this information is available for all provided instances separately. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.5 - 82. Register content.

Register	Description	
Event	Event name	
Date and time	dd.mm.yyyy hh:mm:ss.mss	
I ₀ pre-triggering current	Start/Trip -20ms current	
Io fault current	Start/Trip current	
Fault capacitive I ₀	Start/Trip capacitive current	
Fault resistive I ₀	Start/Trip resistive current	
Fault U ₀ (%)	Start/Trip voltage (percentage of nominal)	
Fault U ₀ (V)	Start/Trip voltage (in Volts)	
I ₀ fault angle	0360°	
Trip time remaining	0 ms1800s	

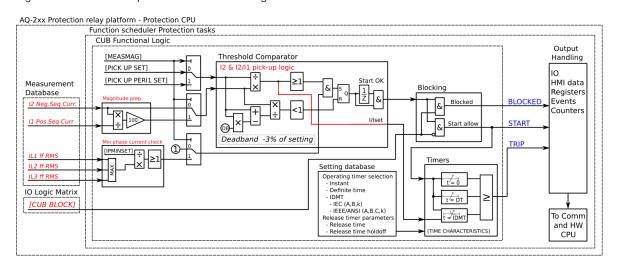
Register	Description
Setting group in use	Setting group 18 active
Network GND	Unearthed, Petersen coil earthed, Earthed network
I ₀ pre-fault current	Start -200ms current

4.4.6 Negative sequence overcurrent/ phase current reversal/ current unbalance protection (I2>; 46/46R/46L)

The current unbalance function is used for instant and time-delayed unbalanced network protection and for detecting broken conductors. The number of stages in the function depends on the device model. The operating decisions are based on negative and positive sequence current magnitudes which the function constantly measures. In the broken conductor mode (I2/I1) the minimum allowed loading current is also monitored in the phase current magnitudes.

There are two possible operating modes available: the I2 mode monitors the negative sequence current, while the I2/I1 mode monitors the ratio between the negative sequence current and the positive sequence current. The device calculates the symmetrical component magnitudes in use from the phase current inputs I_{L1} , I_{L2} and I_{L3} . The zero sequence current is also recorded into the registers as well as the angles of the positive, negative and zero sequence currents in order to better verify any fault cases.

Figure. 4.4.6 - 100. Simplified function block diagram of the I2> function.



Measured input

The function block uses positive and negative sequence currents calculated from the phase current measurement channels. In the broken conductor mode (I2/I1) the function also uses fundamental frequency component of all phase currents to check the minimum current. Zero sequence and component sequence angles are used for fault registering and for fault analysis processing.

Table. 4.4.6 - 83. Measurement inputs of the I2> function.

Signal	Description			
I1	Positive sequence current magnitude			
12	Negative sequence current magnitude			

Signal	Description			
IZ	Zero sequence current magnitude			
I1 ANG	Positive sequence current angle			
I2 ANG	Negative sequence current angle			
IZ ANG	Zero sequence current angle			
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current measurement			
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current measurement			
IL3RMS	Fundamental frequency component of phase L3 (C) current measurement			

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.6 - 84. General settings of the function.

Name	Range	Default	Description	
I2> force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.	
Measured magnitude	• I2pu • I2/I1	I2pu	Defines whether the ratio between the positive and the negative sequence currents are supervised or whether only the negative sequence is used in detecting unbalance.	

Pick-up settings

The setting parameters $I2_{set}$ and $I2/I1_{set}$ control the the pick-up of the I2> function. They define the maximum allowed measured negative sequence current or the negative/positive sequence current ratio before action from the function. The function constantly calculates the ratio between the I_{set} and the measured magnitude (I_m). The reset ratio of 97 % is built into the function and is always relative to the I_{xset} value. The reset ratio is the same for both modes.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.4.6 - 85. Pick-up settings.

Name	Range Step		Default	Description
I2set	0.0140.00×I _n	0.01×I _n	0.2×I _n	Pick-up setting for I2 mode
12/I1set	1200%	0.01%	20%	Pick-up setting for I2/I1 mode

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.6 - 86. Information displayed by the function.

Name	Range	Description	
I2> condition	Normal Start Trip Blocked	Displays the status of the protection function.	
I2> I2I1 relation	0.00100 000.00	Ratio between the negative sequence current and positive sequence current.	
I2 meas / I2 set	0.00100 000.00	Ratio between measured negative sequence current and the pick-up value.	
Expected operating time	0.0001800.000s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured highest phase current value. If the measured current changes during a fault, the expected operating time changes accordingly.	
Time remaining to trip	-1800.0001800.000s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.	

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

The operating timers' behavior during a function can be set for TRIP signal and also for the release of the function in case the pick-up element is reset before the trip time has been reached. There are three basic operating modes available for the function:

- Instant operation: gives the TRIP signal with no additional time delay simultaneously with the start signal.
- Definite time operation (DT): gives the TRIP signal after a user-defined time delay regardless of the measured current as long as the current is above or below the *i_{set}* value and thus the pick-up element is active (independent time characteristics).
- Inverse definite minimum time (IDMT): gives the TRIP signal after a time which is in relation to the set pick-up value *l_{set}* and the measured current *l_m* (dependent time characteristics).

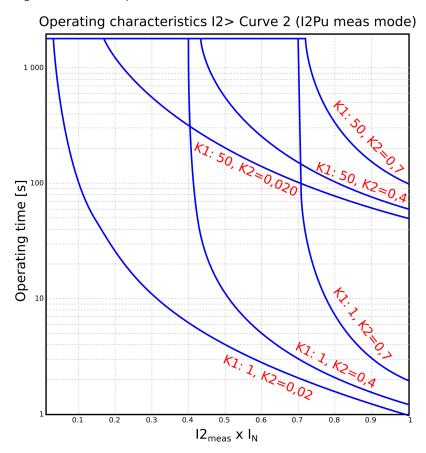
Both IEC and IEEE/ANSI standard characteristics as well as user settable parameters are available for the IDMT operation.

Unique to the current unbalance protection is the availability of the "Curve2" delay which follows the formula below:

$$t = \frac{k}{{I_{2meas}}^2 - {I_{set}}^2}$$

- t = Operating time
- *I_{2meas}* = Calculated negative sequence
- *k* = Constant k value (user settable delay multiplier)
- *I_{set}*= Pick-up setting of the function

Figure. 4.4.6 - 101. Operation characteristics curve for I2> Curve2.



For a more detailed description on the time characteristics and their setting parameters, please refer to the "General properties of a protection function" chapter and its "Operating time characteristics" section.

Events and registers

The current unbalance function (abbreviated "CUB" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.6 - 87. Event messages.

Event block name	Event names
CUB1CUB4	Start ON
CUB1CUB4	Start OFF
CUB1CUB4	Trip ON
CUB1CUB4	Trip OFF
CUB1CUB4	Block ON
CUB1CUB4	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

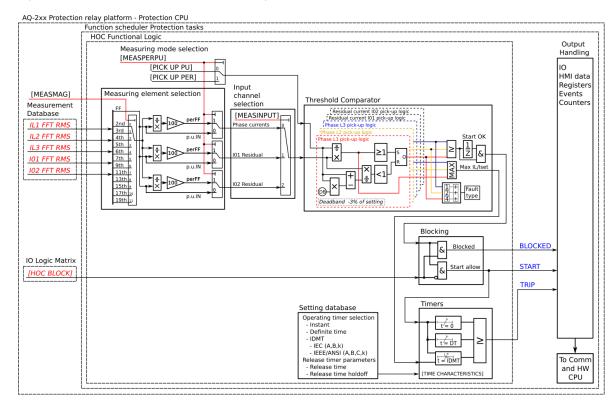
Table. 4.4.6 - 88. Register content.

Register	Description
Event	Event name
Date and time	dd.mm.yyyy hh:mm:ss.mss
Pre-trigger current	Start/Trip -20ms current
Fault current	Start/Trip current
Pre-fault current	Start -200ms current
Fault currents	I1, I2, IZ mag. and ang.
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.7 Harmonic overcurrent protection (Ih>; 50H/51H/68H)

The harmonic overcurrent function is used for non-directional instant and time-delayed overcurrent detection and clearing. The number of stages in the function depends on the device model. The function constantly measures the selected harmonic component of the selected measurement channels, the value being either absolute value or relative to the RMS value.

Figure. 4.4.7 - 102. Simplified function block diagram of the lh> function.



Measured input

The function block uses analog current measurement values from phase or residual currents. Each measurement input of the function block uses RMS (fundamental frequency component) values and harmonic components of the selected current input. The user can select the monitored magnitude to be equal to the per-unit RMS values of the harmonic component, or to the harmonic component percentage content compared to the RMS values.

Table. 4.4.7 - 89. Measurement inputs of the Ih> function.

Signal	Description
I _{L1} FFT	The magnitudes (RMS) of phase L1 (A) current components: - Fundamental - 2 nd harmonic - 3 rd harmonic - 4 th harmonic - 5 th harmonic - 6 th harmonic - 7 th harmonic - 9 th harmonic - 11 th harmonic - 13 th harmonic - 15 th harmonic - 15 th harmonic - 15 th harmonic - 17 th harmonic - 19 th harmonic

Signal	Description
l _{L2} FFT	The magnitudes (RMS) of phase L2 (B) current components: - Fundamental - 2 nd harmonic - 3 rd harmonic - 4 th harmonic - 5 th harmonic - 6 th harmonic - 7 th harmonic - 11 th harmonic - 13 th harmonic - 15 th harmonic - 15 th harmonic - 15 th harmonic - 19 th harmonic - 19 th harmonic
l _{L3} FFT	The magnitudes (RMS) of phase L3 (C) current components: - Fundamental - 2 nd harmonic - 3 rd harmonic - 4 th harmonic - 5 th harmonic - 6 th harmonic - 7 th harmonic - 9 th harmonic - 11 th harmonic - 13 th harmonic - 15 th harmonic - 15 th harmonic - 17 th harmonic - 17 th harmonic - 19 th harmonic
I ₀₁ FFT	The magnitudes (RMS) of residual I0 ₁ current components: - Fundamental - 2 nd harmonic - 3 rd harmonic - 4 th harmonic - 5 th harmonic - 6 th harmonic - 7 th harmonic - 9 th harmonic - 11 th harmonic - 13 th harmonic - 15 th harmonic - 15 th harmonic - 17 th harmonic - 17 th harmonic - 19 th harmonic.

Signal	Description
lo ₂ FFT	The magnitudes (RMS) of residual I02 current components: - Fundamental - 2 nd harmonic - 3 rd harmonic - 4 th harmonic - 5 th harmonic - 6 th harmonic - 7 th harmonic - 9 th harmonic - 11 th harmonic - 11 th harmonic - 13 th harmonic - 15 th harmonic - 15 th harmonic - 15 th harmonic - 19 th harmonic

General settings

The function can be set to monitor the ratio between the measured harmonic and either the measured fundamental component or the per unit value of the harmonic current. The user must select the correct measurement input.

Table. 4.4.7 - 90. Operating mode selection settings.

Name	Range	Default	Description
Ih> force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage</i> forcing parameter is enabled in <i>General</i> menu.

Name	Range	Default	Description
Harmonic selection	 2nd harmonic 3rd harmonic 4th harmonic 5th harmonic 6th harmonic 7th harmonic 9th harmonic 11th harmonic 15th harmonic 15th harmonic 17th harmonic 17th harmonic 19th harmonic 19th harmonic 	2 nd harmonic	Selection of the monitored harmonic component.
Per unit or relative	• × I _n • Ih/IL	× I _n	Selection of the monitored harmonic mode. Either directly per unit x $I_{\it n}$ or in relation to the fundamental frequency magnitude.
Measurement input	• IL1/IL2/ IL3 • I01 • I02	IL1/IL2/ IL3	Selection of the measurement input (either phase current or residual current).

Pick-up settings

The setting parameter Ih_{set} per unit or Ih/IL (depending on the selected operating mode) controls the pick-up of the lh> function. This defines the maximum allowed measured current before action from the function. The function constantly calculates the ratio between the Ih_{set} per unitor Ih/IL and the measured magnitude (I_m) for each of the three phases. The reset ratio of 97 % is built into the function and is always relative to the Ih_{set} per unit or Ih/ILvalue. The setting value is common for all measured phases, and when the I_m exceeds the I_{set} value (in single, dual or all phases) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.4.7 - 91. Pick-up settings.

Name	Range	Step	Default	Description
lh _{set} pu	0.052.00×I _n	0.01×I _n	0.20×I _n	Pick-up setting (per unit monitoring)

Name	Range	Step	Default	Description
lh/IL	5.00200.00%	0.01%	20.00%	Pick-up setting (percentage monitoring)

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.7 - 92. Information displayed by the function.

Name	Range	Step	Description
lh> condition	NormalStartTripBlocked	-	Displays the status of the protection function.
Ih meas/ Ih set now	0.00100000.00I _m /I _{set}	0.01I _m /I _{set}	The ratio between the monitored residual current and the pick-up value.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured voltage value. If the measured voltage changes during a fault, the expected operating time changes accordingly.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT) and inverse definite minimum time delay (IDMT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The harmonic overcurrent function (abbreviated "HOC" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The START signal can be used to block other stages; if the situation lasts longer, the TRIP signal can be used on other actions as time-delayed. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.7 - 93. Event description.

Event block name	Event names
HOC1HOC4	Start ON
HOC1HOC4	Start OFF
HOC1HOC4	Trip ON
HOC1HOC4	Trip OFF
HOC1HOC4	Block ON
HOC1HOC4	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.7 - 94. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	L1-GL1-L2-L3
Pre-trigger current	Start/Trip -20ms current
Fault current	Start/Trip current
Pre-fault current	Start -200ms current
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.8 Circuit breaker failure protection (CBFP; 50BF/52BF)

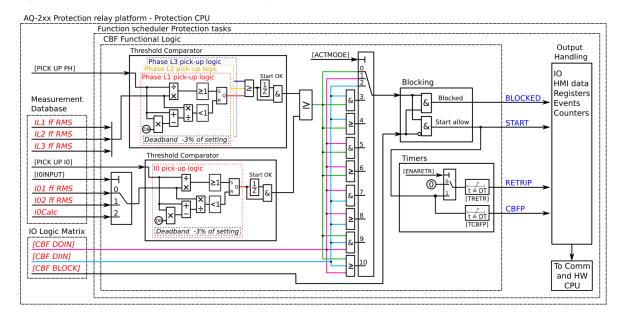
The circuit breaker failure protection function is used for monitoring the circuit breaker operation after it has received a TRIP signal. The function can also be used to retrip a failing breaker; if the retrip fails, an incoming feeder circuit breaker can be tripped by using the function's CBFP output. The retrip functionality can be disabled if the breaker does not have two trip coils.

The function can be triggered by the following:

- · overcurrent (phase and residual)
- · digital output monitor
- · digital signal
- any combination of the above-mentioned triggers.

In the current-dependent mode the function constantly measures phase current magnitudes and the selected residual current. In the signal-dependent mode any of the device's binary signals (trips, starts, logical signals etc.) can be used to trigger the function. In the digital output-dependent mode the function monitors the status of the selected output relay control signal.

Figure. 4.4.8 - 103. Simplified function block diagram of the CBFP function.



Measured input

The function block uses fundamental frequency component of phase current and residual current measurement values. The user can select I01, I02 or the calculated I0 for the residual current measurement.

Table. 4.4.8 - 95. Measurement inputs of the CBFP function.

Signal	Description	
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current measurement	
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current measurement	
I _{L3} RMS	Fundamental frequency component of phase L3 (C) current measurement	
I ₀₁ RMS	Fundamental frequency component of residual input I ₀₁ measurement	

Signal	Description	
I ₀₂ RMS	Fundamental frequency component of residual input I ₀₂ measurement	
I0Calc	Calculated residual current from the phase current inputs	

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.8 - 96. CBFP monitoring signal definitions.

Name	Description
Signal in monitor	Defines which TRIP events of the used protection functions trigger the CBFP countdown. For the CBFP function to monitor the signals selected here, the "Operation mode selection" parameter must be set to a mode that includes signals (e.g. "Signals only", "Signals or DO", "Current and signals and DO").
Trip monitor	Defines which output relay of the used protection functions trigger the CBFP countdown. For the CBFP function to monitor the output relays selected here, the "Operation mode selection" parameter must be set to a mode that includes digital outputs (e.g. "DO only", "Current and DO", "Current or signals or DO").

Table. 4.4.8 - 97. General settings of the function.

Name	Range	Default	Description
CBFP force status to	NormalStartReTripCBFPBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Pick-up settings

The setting parameters I_{set} and IO_{set} control the pick-up and the activation of the current-dependent CBFP function. They define the minimum allowed measured current before action from the function. The function constantly calculates the ratio between the I_{set} or the IO_{set} and the measured magnitude (I_m) for each of the three phases and the selected residual current input. The reset ratio of 97 % is built into the function and is always relative to the I_{set} value. The setting value is common for all measured phases. When the I_m exceeds the I_{set} value (in single, dual or all phases) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.8 - 98. Operating mode and input signals selection.

Name	Range	Step	Default	Description
lOInput	Not in useI01I02I0Calc	-	Not in use	Selects the residual current monitoring source, which can be either from the two separate residual measurements (I01 and I02) or from the phase current's calculated residual current.
Actmode	Current only DO only Signals only Current and DO Current and signals Current or signals Signals and DO Signals or DO Current or DO Current or signals Current or signals Current or DO Current or DO Current or DO or signals Current and DO and Signals	-	Current only	Selects the operating mode. The mode can be dependent on current measurement, binary signal status, output relay status ("DO"), or a combination of the three.

Table. 4.4.8 - 99. Pick-up settings.

Name	Range	Step	Default	Description
I _{set}	0.0140.00×I _n	0.01×I _n	0.20×I _n	The pick-up threshold for the phase current measurement. This setting limit defines the upper limit for the phase current pick-up element.
10 _{set}	0.00540.000×In	0.001×I _n	1.200×I _n	The pick-up threshold for the residual current measurement. This setting limit defines the upper limit for the phase current pick-up element.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.8 - 100. Information displayed by the function.

Name	Range	Description
CBFP condition	NormalStartReTripCBFP OnBlocked	Displays status of the protection function.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics

The operating timers' behavior during a function can be set depending on the application. The same pick-up signal starts both timers. When retrip is used the time grading should be set as follows: the sum of specific times (i.e. the retrip time, the expected operating time, and the pick-up conditions' release time) is shorter the set CBFP time. This way, when retripping another breaker coil clears the fault, any unnecessary function triggers are avoided.

The following table presents the setting parameters for the function's operating time characteristics.

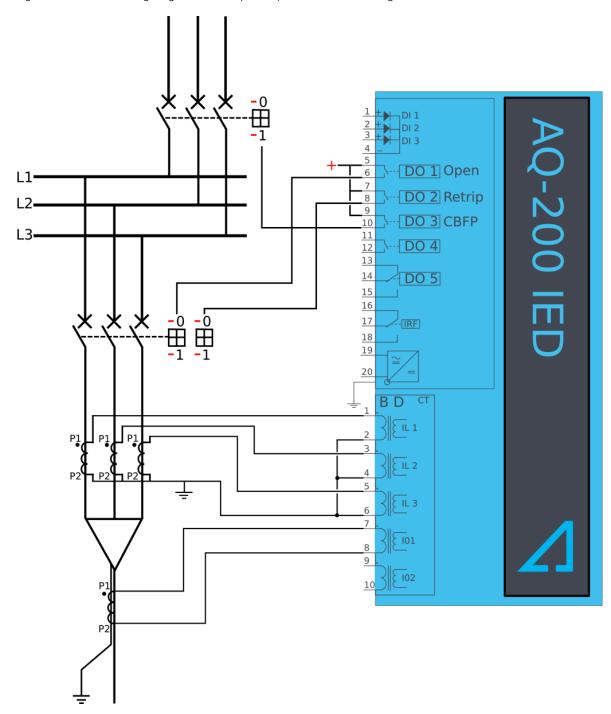
Table. 4.4.8 - 101. Setting parameters for operating time characteristics.

Name	Range	Step	Default	Description
Retrip	NoYes	-	Yes	Retrip enabled or disabled. When the retrip is disabled, the output will not be visible and the TRetr setting parameter will not be available.
Retrip time delay	0.0001800.000s	0.005s	0.100s	Retrip start the timer. This setting defines how long the starting condition has to last before a RETRIP signal is activated.
CBFP	0.0001800.000s	0.005s	0.200s	CBFP starts the timer. This setting defines how long the starting condition has to last before the CBFP signal is activated.

The following figures present some typical cases of the CBFP function.

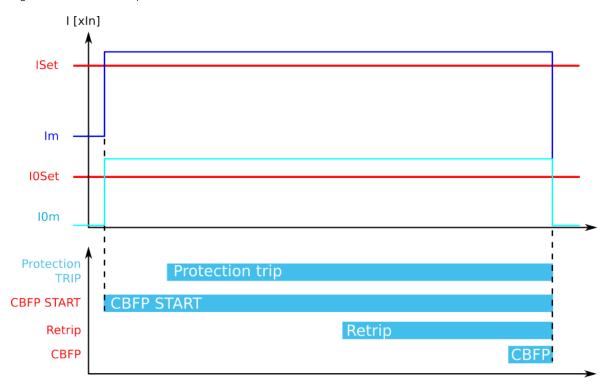
Trip, Retrip and CBFP in the device configuration

Figure. 4.4.8 - 104. Wiring diagram when Trip, Retrip and CBFP are configured to the device.



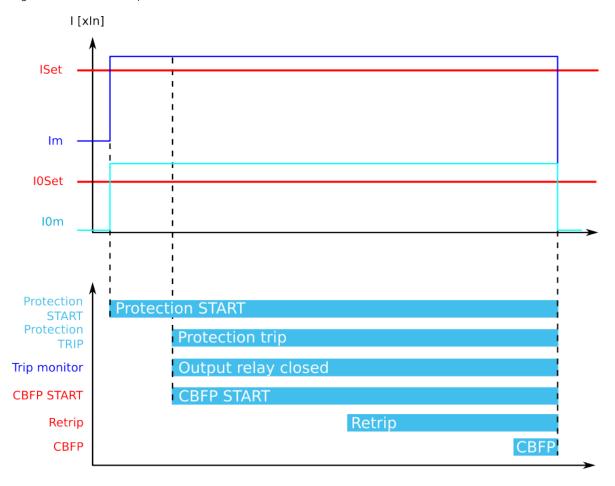
The retrip functionality can be used in applications whose circuit breaker has a retrip or a redundant trip coil available. The TRIP signal is normally wired to the breaker's trip coil from the device's trip output. The retrip is wired from its own device output contact in parallel with the circuit breaker's redundant trip coil. The CBFP signal is normally wired from its device output contact to the incoming feeder circuit breaker. Below are a few operational cases regarding the various applications.

Figure. 4.4.8 - 105. Retrip and CBFP when "Current" is the selected criterion.



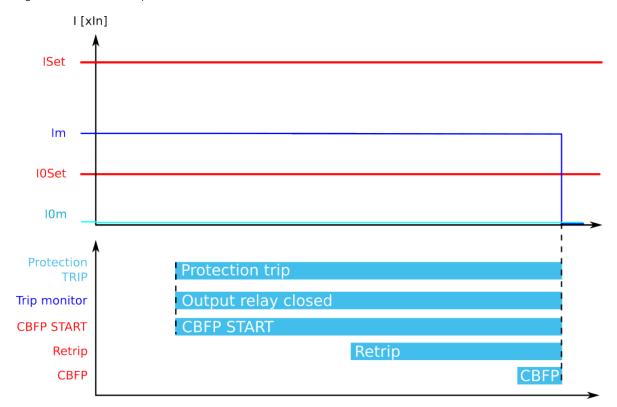
When the current threshold setting of I_{set} and/or IO_{set} is exceeded, the current-based protection is activated and the counters for RETRIP and CBFP start calculating the set operating time. The tripping of the primary protection stage is not monitored in this configuration. Therefore, if the current is not reduced below the setting limit, a RETRIP signal is sent to the redundant trip coil. If the current is not reduced within the set time limit, the function also sends a CBFP signal to the incoming feeder breaker. If the primary protection function clears the fault, both counters (RETRIP and CBFP) are reset as soon as the measured current is below the threshold settings.





When the current threshold setting of *I_{set}* and/or *IO_{set}* is exceeded, the current-based protection is activated. At the same time, the counters for RETRIP and CBFP are halted until the monitored output contact is controlled (that is, until the primary protection operates). When the tripping signal reaches the primary protection stage, the RETRIP and CBFP counters start calculating the set operating time. The tripping of the primary protection stage is constantly monitored in this configuration. If the current is not reduced below the setting limit or the primary stage tripping signal is not reset, a RETRIP signal is sent to the redundant trip coil. If the retripping fails and the current is not reduced below the setting limit or the primary stage tripping signal is not reset, the function also sends a CBFP signal to the incoming feeder circuit breaker. If the primary protection function clears the fault, both counters (RETRIP and CBFP) are reset as soon as the measured current is below the threshold settings or the tripping signal is reset. This configuration allows the CBFP to be controlled with current-based functions alone, and other function trips can be excluded from the CBFP functionality.

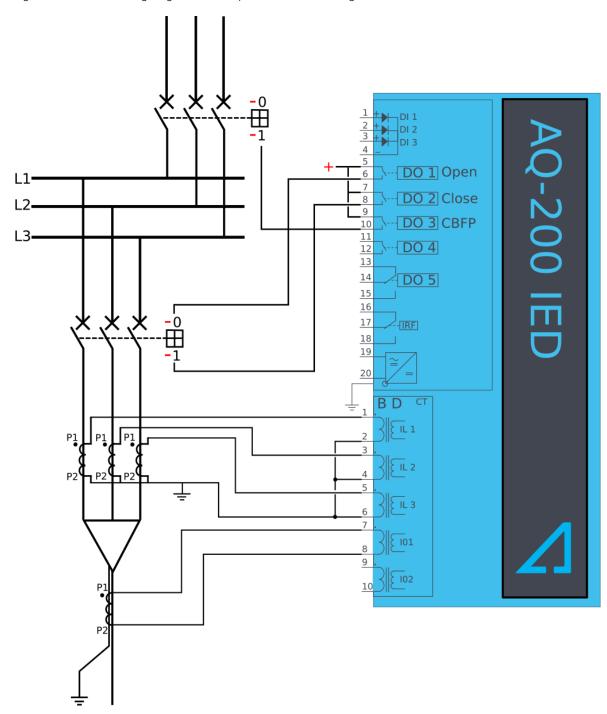
Figure. 4.4.8 - 107. Retrip and CBFP when "Current or DO" is the selected criterion.



When the current threshold setting of *I*_{set} and/or *I*0_{set} is exceeded, or the TRIP signal reaches the primary protection stage, the function starts counting down towards the RETRIP and CBFP signals. The tripping of the primary protection stage is constantly monitored in this configuration regardless of the current's status. The pick-up of the CBFP is active unless the current is reduced below the setting limit and the primary stage tripping signal is reset. If either of these conditions is met (i.e. the current is above the limit or the signal is active) for the duration of the set RETRIP time delay, a RETRIP signal is sent to the redundant trip coil. If either of the conditions is active for the duration of the set CBFP time delay, a CBFP signal is sent to the incoming feeder circuit breaker. If the primary protection function clears the fault, both counters (RETRIP and CBFP) are reset as soon as the measured current is below the threshold settings and the tripping signal is reset. This configuration allows the CBFP to be controlled with current-based functions alone, with added security from current monitoring. Other function trips can also be included in the CBFP functionality.

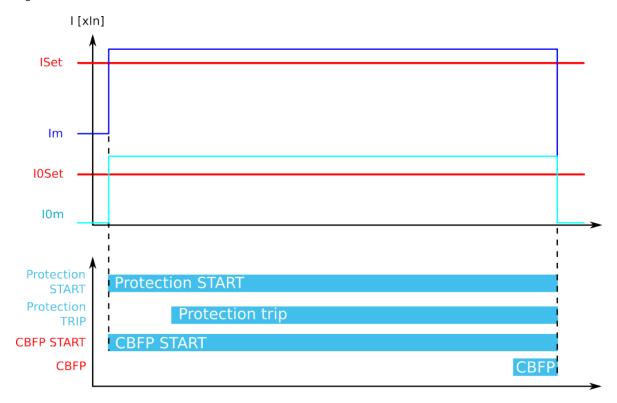
Trip and CBFP in the device configuration

Figure. 4.4.8 - 108. Wiring diagram when Trip and CBFP are configured to the device.



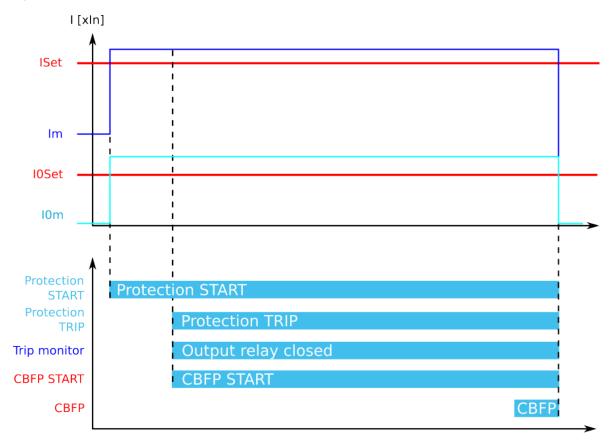
Probably the most common application is when the device's trip output controls the circuit breaker trip coil, while one dedicated CBFP contact controls the CBFP function. Below are a few operational cases regarding the various applications and settings of the CBFP function.

Figure. 4.4.8 - 109. CBFP when "Current" is the selected criterion.



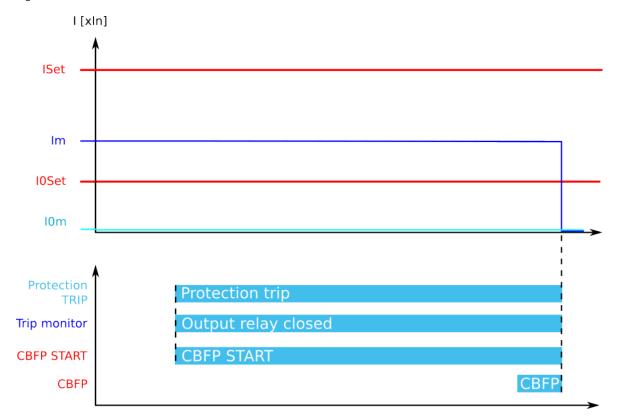
When the current threshold setting of I_{Set} and/or I_{Oset} is exceeded, the current-based protection is activated and the counter for CBFP starts calculating the set operating time. The tripping of the primary protection stage is not monitored in this configuration. Therefore, if the current is not reduced below the setting limit, a CBFP signal is sent to the incoming feeder circuit breaker. If the primary protection function clears the fault, the counter for CBFP resets as soon as the measured current is below the threshold settings.





When the current threshold setting of *I_{set}* and/or *IO_{set}* is exceeded, the current-based protection is activated. At the same time, the counter for CBFP is halted until the monitored output contact is controlled (that is, until the primary protection operates). When the tripping signal reaches the primary protection stage, the CBFP counter starts calculating the set operating time. The tripping of the primary protection stage is constantly monitored in this configuration. If the current is not reduced below the setting limit or the primary stage tripping signal is not reset, a CBFP signal is sent to the incoming feeder circuit breaker. The time delay counter for CBFP is reset as soon as the measured current is below the threshold settings or the tripping signal is reset. This configuration allows the CBFP to be controlled by current-based functions alone, and other function trips can be excluded from the CBFP functionality.

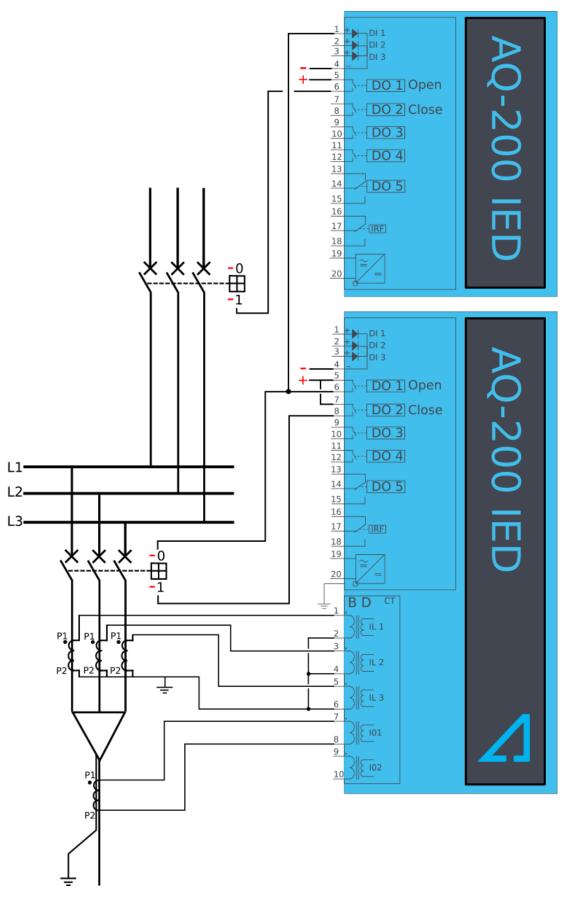
Figure. 4.4.8 - 111. CBFP when "Current or DO" is the selected criterion.



When the current threshold setting of I_{Set} and/or IO_{Set} is exceeded, or the TRIP signal reaches the primary protection stage, the function starts counting down towards the CBFP signal. The tripping of the primary protection stage is constantly monitored in this configuration regardless of the current's status. The pick-up of the CBFP is active unless the current is reduced below the setting limit and the primary stage tripping signal is reset. If either of these conditions is met (i.e. the current is above the limit or the signal is active) for the duration of the set CBFP time delay, a CBFP signal is sent to the incoming feeder circuit breaker. The time delay counter for CBFP is reset as soon as the measured current is below the threshold settings and the tripping signal is reset. This configuration allows the CBFP to be controlled by current-based functions alone, with added security from current monitoring. Other function trips can also be included to the CBFP functionality.

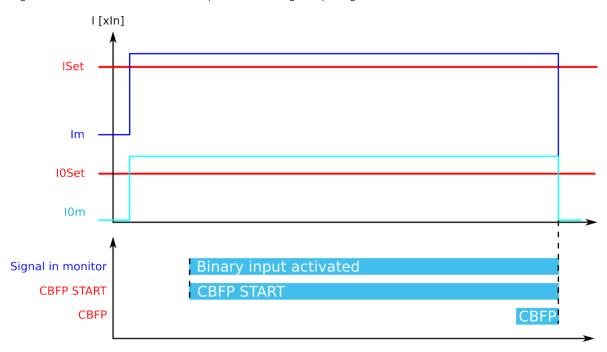
Device configuration as a dedicated CBFP unit

Figure. 4.4.8 - 112. Wiring diagram when the device is configured as a dedicated CBFP unit.



Some applications require a dedicated circuit breaker protection unit. When the CBFP function is configured to operate with a digital input signal, it can be used in these applications. When a device is used for this purpose, the tripping signal is wired to the device's digital input and the device's own TRIP signal is used only for the CBFP purpose. In this application's incoming feeder the RETRIP and CBFP signals are also available with different sets of requirements. The RETRIP signal can be used for tripping the section's feeder breaker and the CBFP signal for tripping the incoming feeder. The following example does not use retripping and the CBFP signal is used as the incoming feeder trip from the outgoing breaker trip signal. The TRIP signal can also be transported between different devices by using GOOSE messages.

Figure. 4.4.8 - 113. Dedicated CBFP operation from digital input signal.



In this mode the CBFP operates only from a digital input signal. Both current and output relay monitoring can be used. The counter for the CBFP signal begins when the digital input is activated. If the counter is active until the CBFP counter is used, the device issues a CBFP command to the incoming feeder circuit breaker. In this application the device tripping signals from all outgoing feeders can be connected to one, dedicated CBFP device which operates either on current-based protection or on all possible faults' CBFP protection.

Events and registers

The circuit breaker failure protection function (abbreviated "CBF" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counters for RETRIP, CBFP, CBFP START and BLOCKED events.

Table. 4.4.8 - 102. Event messages.

Event block name	Event names
CBF1	Start ON
CBF1	Start OFF

Event block name	Event names
CBF1	Retrip ON
CBF1	Retrip OFF
CBF1	CBFP ON
CBF1	CBFP OFF
CBF1	Block ON
CBF1	Block OFF
CBF1	DO monitor ON
CBF1	DO monitor OFF
CBF1	Signal ON
CBF1	Signal OFF
CBF1	Phase current ON
CBF1	Phase current OFF
CBF1	Res current ON
CBF1	Res current OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for ACTIVATED, BLOCKED, etc. The table below presents the structure of the function's register content.

Table. 4.4.8 - 103. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Max phase current	Highest phase current
Residual current	I01, I02 channel or calculated residual current
Time to RETR	Time remaining to retrip activation
Time to CBFP	Time remaining to CBFP activation
Setting group in use	Setting group 18 active

4.4.9 Low-impedance or high-impedance restricted earth fault/ cable end differential protection (I0d>; 87N)

The low-impedance or high-impedance restricted earth fault function is used for residual differential current measurement for transformers. This function can also be used as the cable end differential function. The operating principle is low-impedance differential protection with bias characteristics the user can set. A differential current is calculated with the sum of the phase currents and the selected residual current input. In cable end differential mode the function provides natural measurement unbalance compensation for higher operating sensitivity in monitoring cable end faults.

The restricted earth fault function constantly monitors phase currents and selected residual current instant values as well as calculated bias current and differential current magnitudes.

AQ-2xx Protection relay platform - Protection CPU Function scheduler Protection tasks REF Functional Logic Output [PU IN] Measurement [CED MODE] [PRISECF] Database IL1 ff RM. Blocking HMI data & Registers Counters [REF MODE] MAG PICKUP] [I01PRISECF] [I02PRISECF 102 ff RMS I01 Ang To Comm IO Logic Matrix and HW CPU

Figure. 4.4.9 - 114. Simplified function block diagram of the I0d> function.

Measured input

The function block uses fundamental frequency component of phase current and resisual current measurement values. Both calculated residual currents and measured residual currents are always used. The user can select either I_{01} or I_{02} for residual current measurement.

Please note that when the function is in cable end differential mode, the difference is only calculated when the measured I_0 current is available.

Table. 4.4.9 - 104. Me	easurement inputs	of the I0d> function.
------------------------	-------------------	-----------------------

Signal	Description
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current measurement
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current measurement
I _{L3} RMS	Fundamental frequency component of phase L3 (C) current measurement
I ₀₁ RMS	Fundamental frequency component of residual input I01 measurement
I ₀₂ RMS	Fundamental frequency component of residual input I02 measurement
I _{L1} Ang	Angle of phase L1 (A) current

Signal	Description
I _{L2} Ang	Angle of phase L2 (B) current
I _{L3} Ang	Angle of phase L3 (C) current
I ₀₁ Ang	Angle of residual input I01
I ₀₂ Ang	Angle of residual input I02

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.9 - 105. General settings.

Name	Range	Default	Description
I0d> force status to	NormalTripBlocked	Normal	Force the status of the function. Visible only when Enable stage forcing parameter is enabled in General menu.
Restricted earth fault (REF) or Cable End Differential	• REF • CED	REF	Selection of the operating characteristics. If REF is selected, the function operates with normal accuracies. If CED is selected, the natural unbalance created by the phase current CT:s can be compensated for more sensitive operation. The default setting is REF.
Compenstate natural unbalance	• - • Comp	-	When activated while the line is energized, the currently present calculated residual current is compensated to 0. This compensation only has an effect in the CED mode.

Operating characteristics

The current-dependent pick-up and activation of the function are controlled by setting parameters, which define the current calculating method used as well as the operating characteristics.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.9 - 106. Pick-up settings.

Name	Range	Step	Default Description	
10 Input	• 101 • 102	-	I01	Selection of the used residual current measurement input.
I0 Direction	Add Subtract	-	Add	Differential current calculation mode. This matches the directions of the calculated and measured residual currents to the application. The default setting (Add) means that IOCalc + I01 or IOCalc + I02 in a through fault yields no differential current. See figures below for connection examples.

Name	Range	Step	Default	Description
Bias current calculation	Residual current (310 + 10Calc)/2 Maximum (Phase and 10 max)	-	Residual current	Selection of the bias current calculation. Differential characteristics biasing can use either the calculated residual current averages or the maximum of all measured currents. The residual current mode is more sensitive while the maximum current is coarser.
I0d> pick- up	0.0150.00% (of I _n)	0.01%	10%	Setting for basic sensitivity of the differential characteristics.
Turnpoint 1	0.0150.00×I _n	0.01×I _n	1.00×I _n	Setting for first turn point in the bias axe of the differential characteristics.
Slope 1	0.01150.00%	0.01%	10.00%	Setting for the first slope of the differential characteristics.
Turnpoint 2	0.0150.00×In	0.01×I _n	3.00×I _n	Setting for second turn point in the bias axe of the differential characteristics.
Slope 2	0.01250.00%	0.01%	40.00%	Setting for the second slope of the differential characteristics.

Figure. 4.4.9 - 115. "IO direction" parameter must be set to "Subtract" when current transformers are facing the same direction.

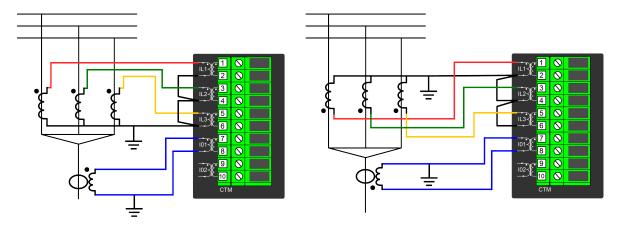
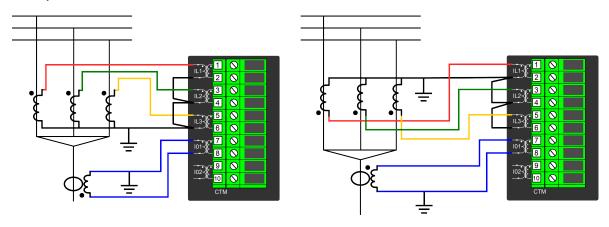
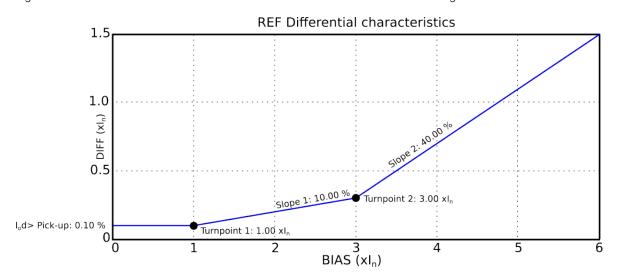


Figure. 4.4.9 - 116. "IO direction" parameter must be set to "Add" when current transformers are facing each other or away from each other.



The following figure presents the differential characteristics with default settings.

Figure. 4.4.9 - 117. Differential characteristics for the I0d> function with default settings.



The equations for the differential characteristics are the following:

Figure. 4.4.9 - 118. Differential current (the calculation is based on user-selected inputs and direction).

$$\begin{split} I_{Diff+I01} &= \left(\overline{IL1} + \overline{IL2} + \overline{IL3}\right) + \overline{I01} \\ I_{Diff-I01} &= \left(\overline{IL1} + \overline{IL2} + \overline{IL3}\right) - \overline{I01} \\ I_{Diff+I02} &= \left(\overline{IL1} + \overline{IL2} + \overline{IL3}\right) + \overline{I02} \\ I_{Diff-I02} &= \left(\overline{IL1} + \overline{IL2} + \overline{IL3}\right) - \overline{I02} \end{split}$$

Figure. 4.4.9 - 119. Bias current (the calculation is based on the user-selected mode).

$$\begin{split} I_{Bias\;average\;I01} &= \frac{\left|\overline{IL1} + \overline{IL2} + \overline{IL3}\right| + \left|\overline{I01}\right|}{2} \\ I_{Bias\;average\;I02} &= \frac{\left|\overline{IL1} + \overline{IL2} + \overline{IL3}\right| + \left|\overline{I02}\right|}{2} \\ I_{Bias\;\max{I01}} &= MAX(\left|IL1\right|, \left|IL2\right|, \left|IL3\right|, \left|I01\right|) \\ I_{Bias\;\max{I01}} &= MAX(\left|IL1\right|, \left|IL2\right|, \left|IL3\right|, \left|I02\right|) \end{split}$$

Figure. 4.4.9 - 120. Characteristics settings.

$$\begin{split} Diff_{bias < TP1} &= I0_{d>pick-up} \\ Diff_{biasTP1...TP2} &= SL1 \times (Ix-TP1) + I0_{d>pick-up} \\ \\ Diff_{bias>TP2} &= SL2 \times (Ix-TP2) + SL1 \times (TP2-TP1) + I0_{d>pick-up} \end{split}$$

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.9 - 107. Information displayed by the function.

Name	Range	Description	
I0d> condition	Normal Trip Blocked	Displays the status of the protection function.	

Function blocking

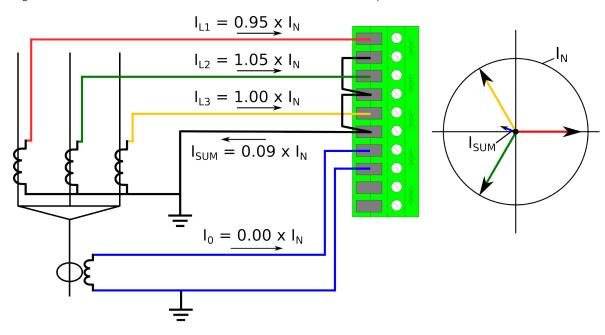
The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a TRIP signal is generated and the function proceeds to the time characteristics calculation.

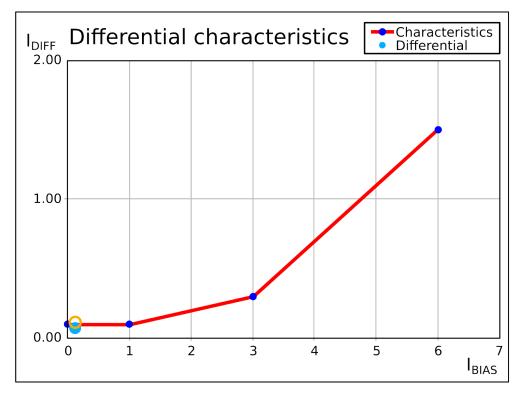
If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the TRIP function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

The following figures present some typical applications for this function.

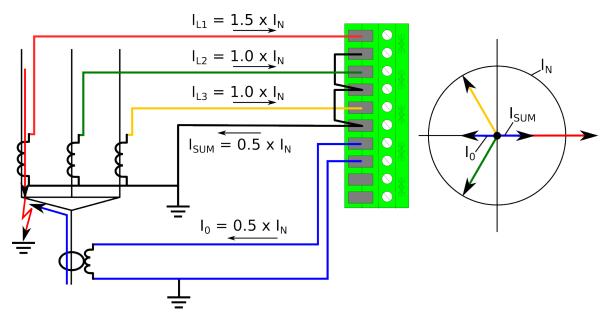
Figure. 4.4.9 - 121. Cable end differential with natural unbalance in the phase current measurement.

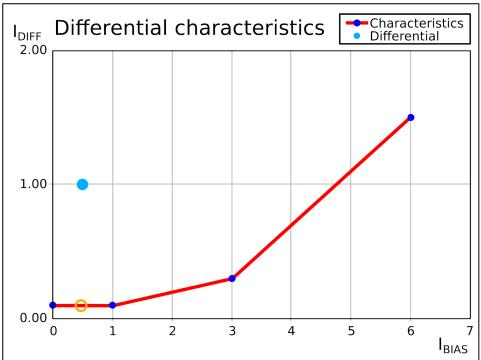




When calculating residual current from the phase currents, the natural unbalance can be around 10 % while the used CTs are still within the promised 5P class (which is probably the most common CT accuracy class). When the current natural unbalance is compensated in this situation, the differential settings may be set to be more sensitive and the natural unbalance does not, therefore, affect the calculation.

Figure. 4.4.9 - 122. Cable end differential when a fault occurs.

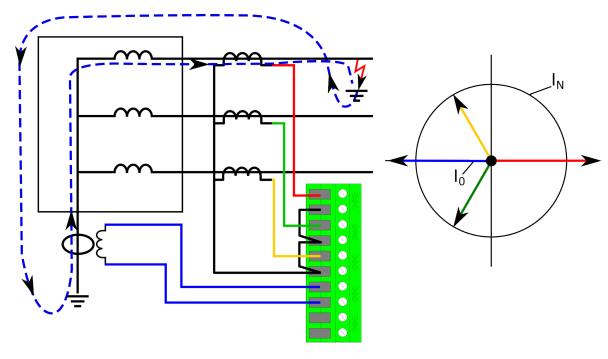


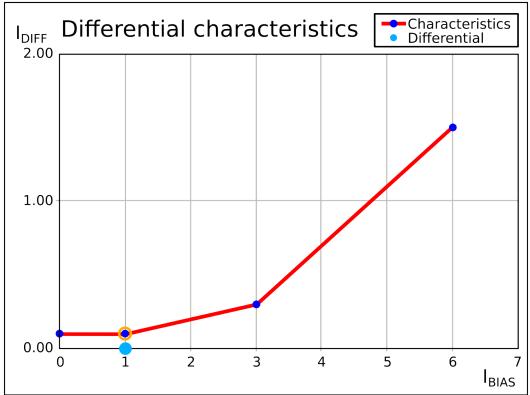


If a starting fault occurs in the cable end, the CED mode catches the difference between the ingoing and the outgoing residual currents. The resulting signal can be used for alarming or tripping purposes for the feeder with the failing cable end. The user can freely change both the settings and the sensitivity of the algorithm.

Restricted earth fault protection is usually used in the Y winding of a power transformer. This function is needed to prevent the main differential protection from being tripped by faults occurring outside the protection area; in some cases, the function has to be disabled or its sensitivity limited to catch earth faults inside the protection area. For this purpose, the restricted earth fault function is stable since it only monitors the side it is wired to, and compares the calculated and measured residual currents. During an outside earth fault the circulating residual current in the faulty phase winding does not cause a trip because the comparison of the measured starpoint current and the calculated residual current differential is close to zero.

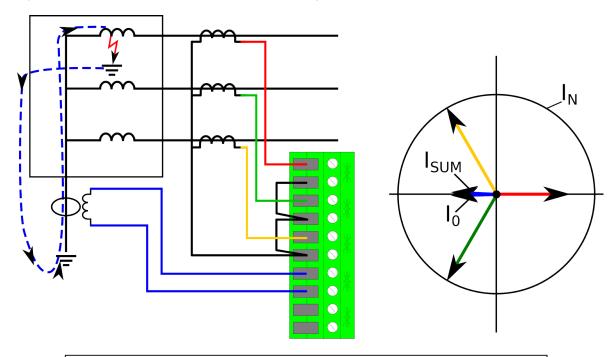
Figure. 4.4.9 - 123. Restricted earth fault outside a Y winding transformer.

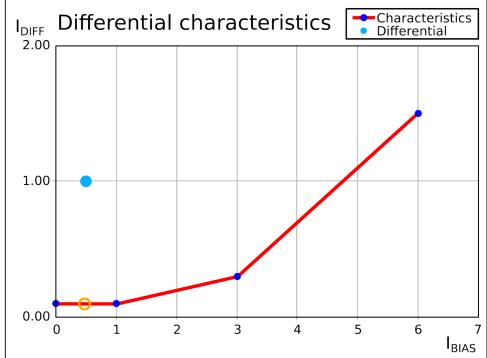




If the fault is located inside of the transformer and thus inside of the protection area, the function catches the fault with high sensitivity. Since the measured residual current now flows in the opposite direction than in the outside fault situation, the measured differential current is high.

Figure. 4.4.9 - 124. Restricted earth fault inside a Y winding transformer.





Events and registers

The restricted earth fault function (abbreviated "REF" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the TRIP and BLOCKED events.

Table. 4.4.9 - 108. Event messages.

Event block name	Event names
REF1	I0d> (87N) Trip ON
REF1	I0d> (87N) Trip OFF
REF1	I0d> (87N) Block ON
REF1	I0d> (87N) Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for ACTIVATED, BLOCKED, etc. The table below presents the structure of the function's register content.

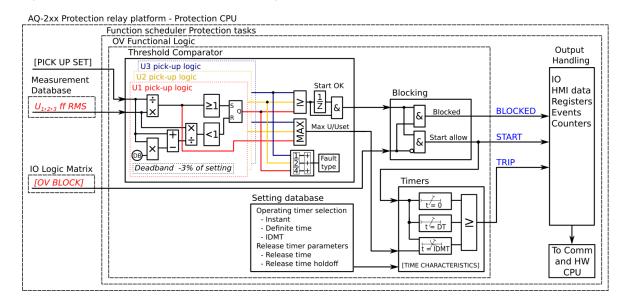
Table. 4.4.9 - 109. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Trigger currents	BiascurrentDiffcurrentCharacteristics diff
Maximum trigger currents	Biascurrent max Diffcurrent max Characteristics diff max
Residual currents	I0Calc I0 meas
Setting group in use	Setting group 18 active

4.4.10 Overvoltage protection (U>; 59)

The overvoltage function is used for instant and time-delayed overvoltage protection. Devices with a voltage protection module has four (4) available stages of the function (U>, U>>, U>>>, U>>>>). The function constantly measures phase voltage magnitudes or line-to-line magnitudes.

Figure. 4.4.10 - 125. Simplified function block diagram of the U> function.



Measured input

The function block uses fundamental frequency component of line-to-line or line-to-neutral (as the user selects). If the protection is based on line-to-line voltage, overvoltage protection is not affected by earth faults in isolated or compensated networks.

Table. 4.4.10 - 110. Measurement input of the U> function.

Signal	Description	
U _{L12} RMS	Fundamental frequency component of U _{L12} /V voltage measurement	
U _{L23} RMS	Fundamental frequency component of U _{L23} /V voltage measurement	
U _{L31} RMS	Fundamental frequency component of U _{L31} /V voltage measurement	
U _{L1} RMS	Fundamental frequency component of U _{L1} /V voltage measurement	
U _{L2} RMS	Fundamental frequency component of U _{L2} /V voltage measurement	
U _{L3} RMS	Fundamental frequency component of UL3/V voltage measurement	

Table. 4.4.10 - 111. Measured magnitude selection settings.

Name	Range	Default	Description
Measured magnitude	 P-P voltages P-E voltages U3 input (2LL-U3SS) U4 input (SS) 	P-P voltages	Selection of phase-to-phase or phase-to-earth voltages. Additionally, the U3 or U4 input can be assigned as the voltage channel to be supervised.

Figure. 4.4.10 - 126. Selectable measurement magnitudes with 3LN+U4 VT connection.

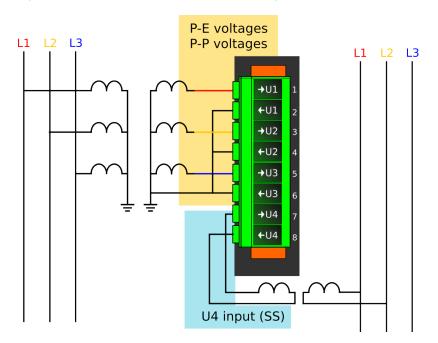


Figure. 4.4.10 - 127. Selectable measurement magnitudes with 3LL+U4 VT connection (P-E voltages not available without residual voltage).

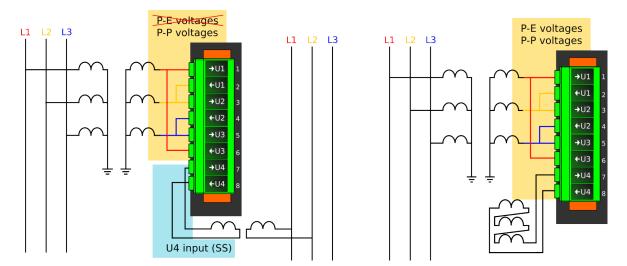
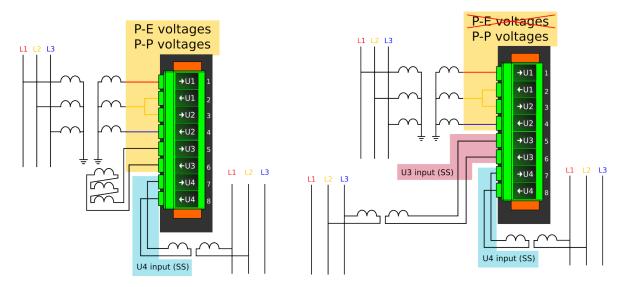


Figure. 4.4.10 - 128. Selectable measurement magnitudes with 2LL+U3+U4 VT connection (P-E voltages not available without residual voltage).



P-P Voltages and *P-E Voltages* selections follow phase-to-neutral or phase-to-phase voltages in the first three voltage channels (or two first voltage channels in the 2LL+U3+U4 mode). *U4 input* selection follows the voltage in Channel 4. *U3Input* selection only follows the voltage in Channel 3 if the 2LL+U3+U4 mode is in use.

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.10 - 112. General settings of the function.

Name	Range	Default	Description
U> force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Pick-up settings

The U_{set} setting parameter controls the pick-up of the U> function. This defines the maximum allowed measured voltage before action from the function. The function constantly calculates the ratio between the U_{set} and the measured magnitude (U_m) for each of the three voltages. The reset ratio of 97 % is built into the function and is always relative to the U_{set} value. The setting value is common for all measured amplitudes, and when the U_m exceeds the U_{set} value (in single, dual or all voltages) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.4.10 - 113. Pick-up settings.

Name	Range	Step	Default	Description
Operation mode	1 voltage2 voltages3 voltages	-	1 voltage	Pick-up criteria selection
U _{set}	50.00150.00%U _n	0.01%U _n	105%U _n	Pick-up setting

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.10 - 114. Information displayed by the function.

Name	Range	Step	Description
U< pick- up setting	0.01 000 000.0V	0.1V	The primary voltage required for tripping. The displayed pick-up voltage level depends on the pick-up setting and the voltage transformer settings.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured voltage value. If the measured voltage changes during a fault, the expected operating time changes accordingly.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
UA(B) meas/Uset at the moment	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between U _A or U _{AB} voltage and the pick-up value.
UB(c) meas/Uset at the moment	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between UB or UBC voltage and the pick-up value.
UC(A) meas/Uset at the moment	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between U _C or U _{CA} voltage and the pick-up value.
U _{meas} /U _{set} at the moment	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between the measured voltage and the pick-up value.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

The operating timers' behavior during a function can be set for TRIP signal and also for the release of the function in case the pick-up element is reset before the trip time has been reached. There are three basic operating modes available for the function:

- Instant operation: gives the TRIP signal with no additional time delay simultaneously with the START signal.
- Definite time operation (DT): gives the TRIP signal after a user-defined time delay regardless of the measured voltage as long as the voltage is above the *U*_{set} value and thus the pick-up element is active (independent time characteristics).
- Inverse definite minimum time (IDMT): gives the TRIP signal after a time which is in relation to the set pick-up voltage U_{set} and the measured voltage U_m (dependent time characteristics).

The IDMT function follows this formula:

$$t = \frac{k}{\left(\frac{Um}{Us}\right)^a - 1}$$

Where:

- *t* = operating time
- k = time dial setting
- *U_m* = measured voltage
- U_S = pick-up setting
- a = IDMT Multiplier setting

The following table presents the setting parameters for the function's time characteristics.

Table. 4.4.10 - 115. Setting parameters for operating time characteristics.

Name	Range	Step	Default	Description
Delay type	• DT • IDMT	-	DT	Selection of the delay type time counter. The selection possibilities are dependent (IDMT, Inverse Definite Minimum Time) and independent (DT, Definite Time) characteristics.
Definite operating time delay	0.000800.000s	0.005s	0.040s	Definite time operating delay. The setting is active and visible when DT is the selected delay type. When set to 0.000 s, the stage operates as instant stage without added delay. When the parameter is set to 0.0051800 s, the stage operates as independent delayed.
Time dial setting k	0.0160.00s	0.01s	0.05s	This setting is active and visible when IDMT is the selected delay type. Time dial/multiplier setting for IDMT characteristics.

Name	Range	Step	Default	Description
IDMT Multiplier	0.0125.00s	0.01s	1.00s	This setting is active and visible when IDMT is the selected delay type. IDMT time multiplier in the U _m /U _{set} power.

Table. 4.4.10 - 116. Setting parameters for reset time characteristics.

Name	Range	Step	Default	Description
Release time delay	0.000150.000s	0.005s	0.06s	Resetting time. The time allowed between pick-ups if the pick-up has not led to a trip operation. During this time the START signal is held on for the timers if the delayed pick-up release is active.
Delayed pick-up release	• No • Yes	-	Yes	Resetting characteristics selection either as time-delayed or as instant after the pick-up element is released. If activated the START signal is reset after the set release time delay.
Time calc reset after release time	• No • Yes	-	Yes	Operating timer resetting characteristics selection. When active, the operating time counter is reset after a set release time if the pick-up element is not activated during this time. When disabled, the operating time counter is reset directly after the pick-up element is reset.
Continue time calculation during release time	• No • Yes	-	No	Time calculation characteristics selection. If activated, the operating time counter is continuing until a set release time has passed even if the pick-up element is reset.

Events and registers

The overvoltage function (abbreviated "OV" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.10 - 117. Event messages.

Event block name	Event names
OV1OV4	Start ON
OV1OV4	Start OFF
OV1OV4	Trip ON
OV1OV4	Trip OFF
OV1OV4	Block ON

Event block name	Event names
OV1OV4	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers; this information is available for all provided instances separately. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

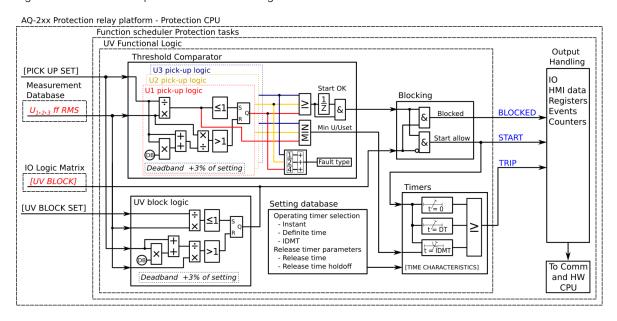
Table. 4.4.10 - 118. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	L1-GL1-L2-L3
Pre-trigger voltage	Start/Trip -20ms voltage
Pre-fault voltage	Start -200ms voltage
Trip time remaining	0 ms1800s
Used SG	Setting group 18 active

4.4.11 Undervoltage protection (U<; 27)

The undervoltage function is used for instant and time-delayed undervoltage protection. Devices with a voltage protection module has four (4) available stages of the function (U>, U>>, U>>>, U>>>). The function constantly measures phase voltage magnitudes or line-to-line voltage magnitudes. Undervoltage protection has two blocking stages: internal blocking (based on voltage measurement and low voltage), or external blocking (e.g. during voltage transformer fuse failure).

Figure. 4.4.11 - 129. Simplified function block diagram of the U< function.



Measured input

The function block uses fundamental frequency component of line-to-line or line-to-neutral (as the user selects). If the protection is based on line-to-line voltage, undervoltage protection is not affected by earth faults in isolated or compensated networks.

Table. 4.4.11 - 119. Measurement input of the U> function.

Signal	Description
U _{L12} RMS	Fundamental frequency component of U _{L12} /V voltage measurement
U _{L23} RMS	Fundamental frequency component of U _{L23} /V voltage measurement
U _{L31} RMS	Fundamental frequency component of U _{L31} /V voltage measurement
U _{L1} RMS	Fundamental frequency component of U _{L1} /V voltage measurement
U _{L2} RMS	Fundamental frequency component of U _{L2} /V voltage measurement
U _{L3} RMS	Fundamental frequency component of UL3/V voltage measurement

Table. 4.4.11 - 120. Measured magnitude selection settings.

Name	Range	Default	Description
Measured magnitude	 P-P voltages P-E voltages U3 input (2LL-U3SS) U4 input (SS) 	P-P voltages	Selection of P-P or P-E voltages. Additionally, the U3 or U4 input can be assigned as the voltage channel to be supervised.

Figure. 4.4.11 - 130. Selectable measurement magnitudes with 3LN+U4 VT connection.

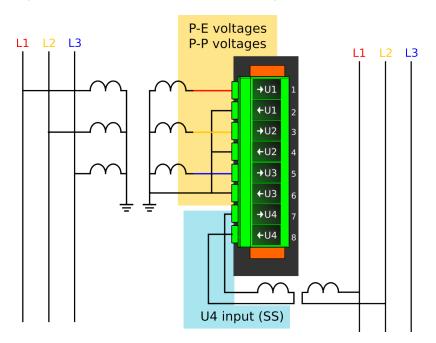


Figure. 4.4.11 - 131. Selectable measurement magnitudes with 3LL+U4 VT connection (P-E voltages not available without residual voltage).

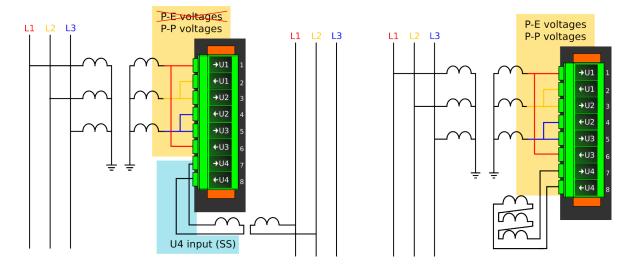
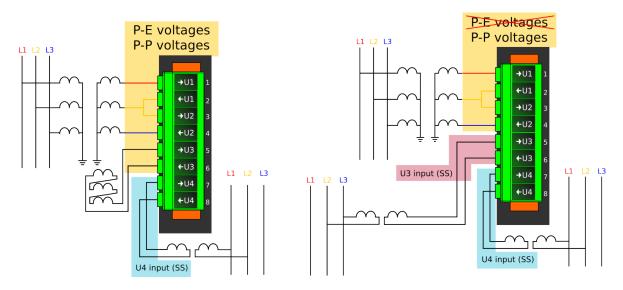


Figure. 4.4.11 - 132. Selectable measurement magnitudes with 2LL+U4 VT connection (P-E voltages not available without residual voltage).



P-P Voltages and *P-E Voltages* selections follow phase-to-neutral or phase-to-phase voltages in the first three voltage channels (or two first voltage channels in the 2LL+U3+U4 mode). *U4 input* selection follows the voltage in Channel 4. *U3Input* selection only follows the voltage in Channel 3 if the 2LL+U3+U4 mode is in use.

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.11 - 121. General settings of the function.

Name	Range	Default	Description
U< force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Pick-up settings

The U_{set} setting parameter controls the pick-up of the U< function. This defines the minimum allowed measured voltage before action from the function. The function constantly calculates the ratio between the U_{set} and the measured magnitude (U_m) for each of the three voltages. The reset ratio of 103 % is built into the function and is always relative to the U_{set} value. The setting value is common for all measured amplitudes, and when the U_m exceeds the U_{set} value (in single, dual or all voltages) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.4.11 - 122. Pick-up settings.

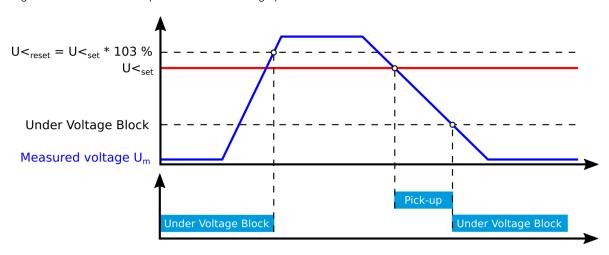
Name	Range	Step	Default	Description
U _{set}	0.00120.00%U _n	0.01%U _n	60%U _n	Pick-up setting

Name	Range	Step	Default	Description
U Block setting	0.00100.00%Un	0.01%U _n	10%U _n	Block setting. If set to zero, blocking is not in use. The operation is explained in the next chapter.

Using Block setting to prevent nuisance trips

It is recommended to use the *Block setting* parameter to prevent the device from tripping in a situation where the network is de-energized. When the measured voltage drops below the set value, the device does not give a tripping signal. If the measured voltage has dropped below the *Block setting* parameter, the blocking continues until all of the line voltages have increased above the U< pick-up setting. Please see the image below for a visualization of this function. If the block level is set to zero (0), blocking is not in use.

Figure. 4.4.11 - 133. Example of the block setting operation.



Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.11 - 123. Information displayed by the function.

Name	Range	Step	Description
U< pick- up setting	0.01 000 000.0V	0.1V	The primary voltage required for tripping. The displayed pick-up voltage level depends on the pick-up setting and the voltage transformer settings.
U< block setting	0.01 000 000.0V	0.1V	The primary voltage level required for trip blocking. If the measured voltage is below this value, the network is considered de-energized and the function will not trip. To deactivate the blocking the measured voltage must exceed the pick-up setting value.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured voltage value. If the measured voltage changes during a fault, the expected operating time changes accordingly.

Name	Range	Step	Description
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
UA(B) meas/Uset at the moment	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between U _A or U _{AB} voltage and the pick-up value.
UB(c) meas/Uset at the moment	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between UB or UBC voltage and the pick-up value.
UC(A) meas/Uset at the moment	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between U_{C} or U_{CA} voltage and the pick-up value.
U _{meas} /U _{set} at the moment	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between the lowest measured phase or line voltage and the pick-up value.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

The operating timers' behavior during a function can be set for TRIP signal and also for the release of the function in case the pick-up element is reset before the trip time has been reached. There are three basic operating modes available for the function:

- Instant operation: gives the TRIP signal with no additional time delay simultaneously with the START signal.
- Definite time operation (DT): gives the TRIP signal after a user-defined time delay regardless of the measured voltage as long as the voltage is above the *U*_{set} value and thus the pick-up element is active (independent time characteristics).
- Inverse definite minimum time (IDMT): gives the TRIP signal after a time which is in relation to the set pick-up voltage U_{set} and the measured voltage U_m (dependent time characteristics).

The IDMT function follows this formula:

$$t = \frac{k}{1 - \left(\frac{Um}{Us}\right)^a}$$

Where:

- *t* = operating time
- k = time dial setting
- *U_m* = measured voltage
- U_S = pick-up setting
- a = IDMT multiplier setting

The following table presents the setting parameters for the function's time characteristics.

Table. 4.4.11 - 124. Setting parameters for operating time characteristics.

Name	Range	Step	Default	Description
Delay type	• DT • IDMT	-	DT	Selection of the delay type time counter. The selection possibilities are dependent (IDMT, Inverse Definite Minimum Time) and independent (DT, Definite Time) characteristics.
Definite operating time delay	0.0001800.000s	0.005s	0.040s	Definite time operating delay. This setting is active and visible when DT is the selected delay type. When set to 0.000 s, the stage operates as instant stage without added delay. When the parameter is set to 0.0051800 s, the stage operates as independent delayed.
Time dial setting k	0.0160.00s	0.01s	0.05s	This setting is active and visible when IDMT is the selected delay type. Time dial/multiplier setting for IDMT characteristics.
IDMT Multiplier	0.0125.00s	0.01s	1.00s	This setting is active and visible when IDMT is the selected delay type. IDMT time multiplier in the U _m /U _{set} power.

Table. 4.4.11 - 125. Setting parameters for reset time characteristics.

Name	Range	Step	Default	Description
Release time delay	0.000150.000s	0.005s	0.06s	Resetting time. The time allowed between pick-ups if the pick-up has not led to a trip operation. During this time the START signal is held on for the timers if the delayed pick-up release is active.
Delayed pick-up release	• No • Yes	-	Yes	Resetting characteristics selection, either time-delayed or instant after the pick-up element is released. If activated, the START signal is reset after a set release time delay.
Time calc reset after release time	• No • Yes	-	Yes	Operating timer resetting characteristics selection. When actived, the operating time counter is reset after a set release time if the pick-up element is not activated during this time. When disabled, the operating time counter is reset directly after the pick-up element reset.

Name	Range	Step	Default	Description
Continue time calculation during release time	• No • Yes	-	No	Time calculation characteristics selection. If activated, the operating time counter continues until a set release time even when the pick-up element is reset.

Events and registers

The undervoltage function (abbreviated "UV" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.11 - 126. Event messages.

Event block name	Event names
UV1UV4	Start ON
UV1UV4	Start OFF
UV1UV4	Trip ON
UV1UV4	Trip OFF
UV1UV4	Block ON
UV1UV4	Block OFF
UV1UV4	Undervoltage Block ON
UV1UV4	Undervoltage Block OFF

The function registers its operation into the last twelve (12) time-stamped registers; this information is available for all provided instances separately. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.11 - 127. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	AA-B-C
Pre-trigger voltage	Start/Trip -20ms voltage

Register	Description
Fault voltage	Start/Trip voltage
Pre-fault voltage	Start -200ms voltage
Trip time remaining	0 ms1800s
Used SG	Setting group 18 active

4.4.12 Neutral overvoltage protection (U0>; 59N)

The neutral overvoltage function is used for non-directional instant and time-delayed earth fault protection.

Below is the formula for symmetric component calculation (and therefore to zero sequence voltage calculation).

$$U0 = 1/3(U_{L1} + U_{L2} + U_{L3})$$

 $U_{L1...3}$ = Line to neutral voltages

Below are some examples of zero sequence calculation.

Figure. 4.4.12 - 134. Normal situation.

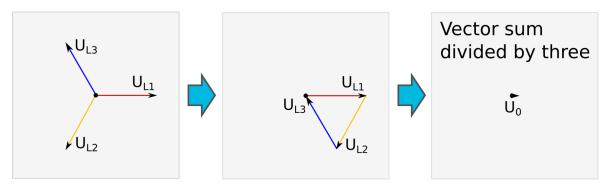


Figure. 4.4.12 - 135. Earth fault in isolated network.

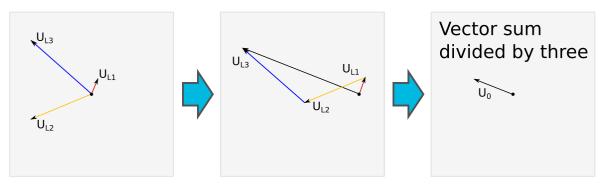


Figure. 4.4.12 - 136. Close-distance short-circuit between phases 1 and 3.

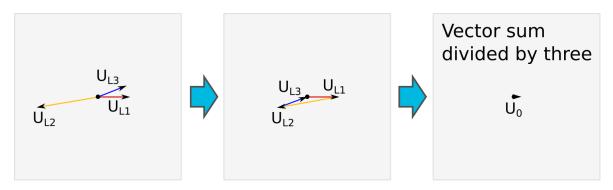
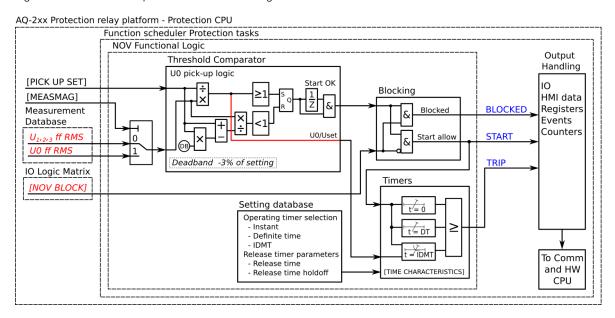


Figure. 4.4.12 - 137. Simplified function block diagram of the U0> function.



Measured input

The function block uses phase-to-neutral voltage magnitudes or calculated zero sequence component (as the user selects). Neutral overvoltage protection is scaled to line-to-line RMS level. When the line-to-line voltage of a system is 100 V in the secondary side, the earth fault is 100 % of the U_n and the calculated zero sequence voltage reaches $100/\sqrt{3}$ V = 57.74 V.

The selection of the used measurement channel is made with a setting parameter.

Table. 4.4.12 - 128. Measurement inputs of the U0> function.

Signal	Description
U ₀ RMS	Fundamental frequency component of U0/V voltage measurement
U _{L1} RMS	Fundamental frequency component of U _{L1} /V voltage measurement
U _{L2} RMS	Fundamental frequency component of U _{L2} /V voltage measurement
U _{L3} RMS	Fundamental frequency component of U _{L3} /V voltage measurement

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.12 - 129. General settings of the function.

Name	Range	Default	Description
U0> force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
U0> meas input select	SelectU0CalcU3 InputU4 Input	Select	Defines which available measured magnitude is used by the function. U0Calc calculates the voltage from phase voltages. Please note that U3 Input and U4 Input selections are available only if the channel has been set to U0 mode at <i>Measurements</i> → <i>Transformers</i> → <i>VT module</i> .

Pick-up settings

The U_{set} setting parameter controls the pick-up of the U0> function. This defines the maximum allowed measured voltage before action from the function. The function constantly calculates the ratio between the U_{set} and the measured magnitude (U_m) for neutral voltage. The reset ratio of 97 % is built into the function and is always relative to the U_{set} value. The setting value is common for all measured amplitudes, and when the U_m exceeds the U_{set} value it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.4.12 - 130. Pick-up settings.

Name	Range	Step	Default	Description
Pick-up setting U0set>	1.0099.00%U _n	0.01%U _n	20.00%U _n	Pick-up setting

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Name	Range	Step	Description
U0> Measuring now	No U0 avail!U0CalcU3 InputU4 Input	-	Displays which voltage channel is used by the function. If no voltage channel has been selected the function defaults to calculated residual voltage if line-to-neutral voltages have been connected to device. If no channel is set to "U0" mode and line-to-line voltages are connected, no residual voltage is available and "No U0 avail!" will be displayed.

Name	Range	Step	Description
U0> Pick- up setting	0.01 000 000.0V	0.1V	Primary voltage required for tripping. The displayed pick-up voltage level depends on the chosen U0 measurement input selection, on the pick-up settings and on the voltage transformer settings.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured voltage value. If the measured voltage changes during a fault, the expected operating time changes accordingly.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
U _{meas} /U _{set} at the moment	0.001250.00	0.01	The ratio between the measured or calculated neutral voltage and the pick-up value.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

The operating timers' behavior during a function can be set for TRIP signal and also for the release of the function in case the pick-up element is reset before the trip time has been reached. There are three basic operating modes available for the function:

- Instant operation: gives the TRIP signal with no additional time delay simultaneously with the START signal.
- Definite time operation (DT): gives the TRIP signal after a user-defined time delay regardless of the measured or calculated voltage as long as the voltage is above the *U*_{set} value and thus the pick-up element is active (independent time characteristics).
- Inverse definite minimum time (IDMT): gives the TRIP signal after a time which is in relation to the set pick-up voltage U_{set} and the measured voltage U_m (dependent time characteristics).

The IDMT function follows this formula:

$$t = \frac{k}{\left(\frac{Um}{Us}\right)^a - 1}$$

Where:

- *t* = operating time
- *k* = time dial setting
- *U_m* = measured voltage
- U_S = pick-up setting
- *a* = IDMT multiplier setting

The following table presents the setting parameters for the function's time characteristics.

Table. 4.4.12 - 131. Setting parameters for operating time characteristics.

Name	Range	Step	Default	Description
Delay type	DT IDMT	-	DT	Selection of the delay type time counter. The selection possibilities are dependent (IDMT, Inverse Definite Minimum Time) and independent (DT, Definite Time) characteristics.
Definite operating time delay	0.0001800.000s	0.005s	0.040s	Definite time operating delay. The setting is active and visible when DT is the selected delay type. When set to 0.000 s, the stage operates as instant without added delay. When the parameter is set to 0.0051800 s, the stage operates as independent delayed.
Time dial setting k	0.0160.00s	0.01s	0.05s	The setting is active and visible when IDMT is the selected delay type. Time dial/multiplier setting for IDMT characteristics.
IDMT Multiplier	0.0125.00s	0.01s	1.00s	The setting is active and visible when IDMT is the selected delay type. IDMT time multiplier in the U _m /U _{set} power.

Table. 4.4.12 - 132. Setting parameters for reset time characteristics.

Name	Range	Step	Default	Description
Release time delay	0.000150.000s	0.005s	0.06s	Resetting time. Time allowed between pick-ups if the pick-up has not led to a trip operation. During this time the START signal is held on for the timers if the delayed pick-up release is active.
Delayed pick-up release	• No • Yes	-	Yes	Resetting characteristics selection either as time-delayed or as instant after the pick-up element is released. If activated, the START signal is reset after a set release time delay.
Time calc reset after release time	• No • Yes	-	Yes	Operating timer resetting characteristics selection. When active, the operating time counter is reset after a set release time if the pick-up element is not activated during this time. When disabled, the operating time counter is reset directly after the pick-up element reset.
Continue time calculation during release time	• No • Yes	-	No	Time calculation characteristics selection. If activated, the operating time counter continues until a set release time has passed even if the pick-up element is reset.

The user can reset characteristics through the application. The default setting is a 60 ms delay; the time calculation is held during the release time.

In the release delay option the operating time counter calculates the operating time during the release. When using this option the function does not trip if the input signal is not re-activated while the release time count is on-going.

Events and registers

The neutral overvoltage function (abbreviated "NOV" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.12 - 133. Event messages.

Event block name	Event names
NOV1NOV4	Start ON
NOV1NOV4	Start OFF
NOV1NOV4	Trip ON
NOV1NOV4	Trip OFF
NOV1NOV4	Block ON
NOV1NOV4	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers; this information is available for all provided instances separately. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.12 - 134. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	L1-GL1-L2-L3
Pre-trigger voltage	Start/Trip -20ms voltage
Fault voltage	Start/Trip voltage
Pre-fault voltage	Start -200ms voltage
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.13 Sequence voltage protection (U1/U2>/<; 47/27P/59PN)

The sequence voltage function is used for instant and time-delayed voltage protection. It has positive and negative sequence protection for both overvoltage and undervoltage (the user selects the needed function). The user can select the voltage used. Sequence voltage is based on the system's line-to-line voltage level. Protection stages can be set to protect against either undervoltage or overvoltage.

Positive sequence voltage calculation

Below is the formula for symmetric component calculation (and therefore to positive sequence voltage calculation).

$$U1 = \frac{1}{3} (U_{L1} + aU_{L2} + a^2U_{L3})$$

 $a = 1\angle 120^\circ$
 $a^2 = 1\angle 240^\circ$
 $U_{L1...3} = Line to neutral voltages$

In what follows are three examples of positive sequence calculation (positive sequence component vector).

Figure. 4.4.13 - 138. Normal situation.

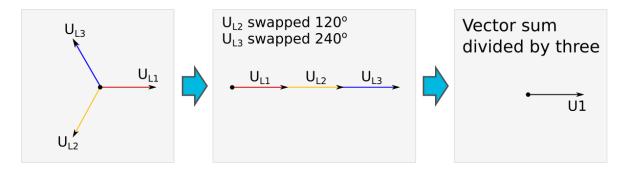


Figure. 4.4.13 - 139. Earth fault in an isolated network.

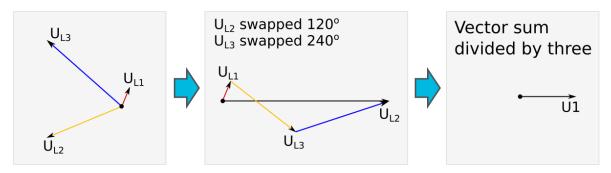
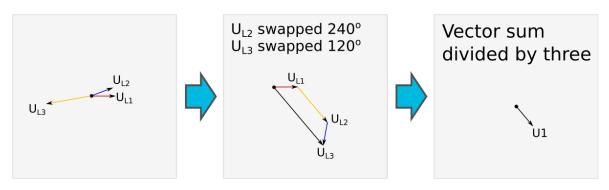


Figure. 4.4.13 - 140. Close-distance short-circuit between phases 1 and 3.



Negative sequence voltage calculation

Below is the formula for symmetric component calculation (and therefore to negative sequence voltage calculation).

$$U2 = \frac{1}{3} (U_{L1} + a^2 U_{L2} + a U_{L3})$$

 $a = 1 \angle 120^\circ$
 $a^2 = 1 \angle 240^\circ$
 $U_{L1...3} = Line to neutral voltages$

In what follows are three examples of negative sequence calculation (negative sequence component vector).

Figure. 4.4.13 - 141. Normal situation.

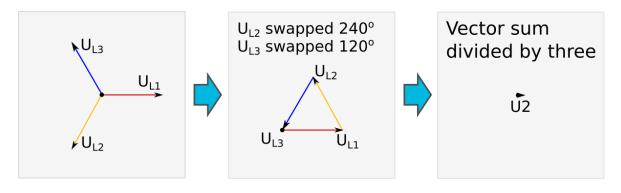


Figure. 4.4.13 - 142. Earth fault in isolated network.

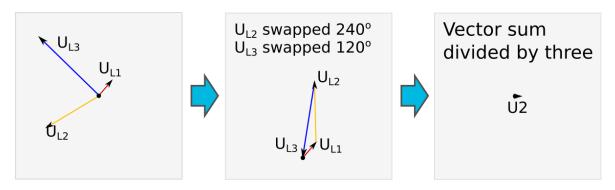


Figure. 4.4.13 - 143. Close-distance short-circuit between phases 1 and 3.

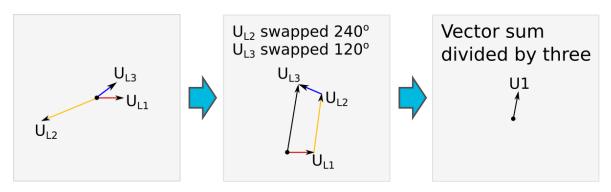
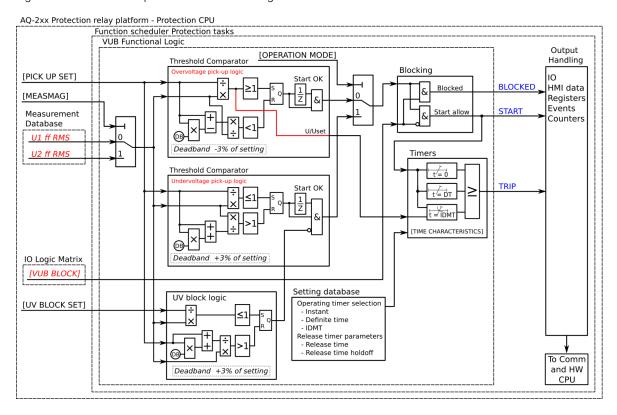


Figure. 4.4.13 - 144. Simplified function block diagram of the U1/U2>/< function.



Measured input

The function block uses fundamental frequency component of phase-to-phase, phase-to-neutral and zero sequence voltage measurements. The user can select the monitored magnitude to be either positive sequence voltage or negative sequence voltage values.

Table. 4.4.13 - 135. Measurement inputs of the U1/U2>/< function.

Signal	Description
U ₁ RMS	Fundamental frequency component of U ₁ /V voltage channel
U ₂ RMS	Fundamental frequency component of U ₂ /V voltage channel
U ₃ RMS	Fundamental frequency component of U ₃ /V voltage channel
U4RMS	Fundamental frequency component of U4/V voltage channel

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.13 - 136. General settings of the function.

Name	Range	Default	Description
U1/2 >/< force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Measured magnitude	 U1 Positive sequence voltage U2 Negative sequence voltage 	U1 Positive sequence voltage	Selects which calculated voltage is supervised.

Pick-up settings

The U_{set} setting parameter controls the pick-up of the U1/U2>/< function. This defines the maximum or minimum allowed calculated U1 or U2 voltage before action from the function. The function constantly calculates the ratio between the U_{set} and the calculated U1 or U2 magnitude (U_c). The monitored voltage is chosen in the *Info* page with the parameter *Measured magnitude*. The reset ratio of 97 % in overvoltage applications is built into the function and is always relative to the U_{set} value. The reset ratio of 103 % in undervoltage applications is built into the function and is always relative to the U_{set} value. When the U_c goes above or below the U_{set} value it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

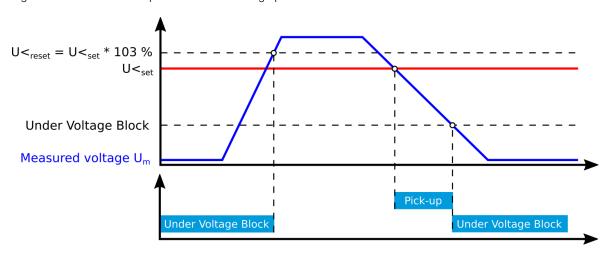
Table. 4.4.13 - 137. Pick-up settings.

Name	Range	Step	Default	Description
Pick- up terms	Over >Under	-	Over>	Selects whether the function picks-up when the monitored voltage is under or over the set pick-up value.
U _{set}	5.00150.00%Un	0.01%U _n	105%U _n	Pick-up setting
U _{blk}	0.0080.00%U _n	0.01%U _n	5%Un	Undervoltage blocking (visible when the pick-up term is Under<)

Using Block setting to prevent nuisance trips

It is recommended to use the *Under block setting U_{blk}* parameter when Under< is the chosen tripping condition to prevent the function from tripping in a situation where the network is de-energized. When the measured voltage drops below the set value, the function does not give a tripping signal. If the measured voltage has dropped below the *Under block setting U_{blk}* parameter, the blocking continues until all of the line voltages have increased above the U< pick-up setting. Please see the image below for a visualization of this function. If the block level is set to zero (0), blocking is not in use.

Figure. 4.4.13 - 145. Example of the block setting operation.



Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.13 - 138. Information displayed by the function.

Name	Range	Step	Description
U1/2 >/< Pick-up setting	0.01 000 000.0V	0.1V	The primary voltage required for tripping. The displayed pick-up voltage level depends on the pick-up setting and the voltage transformer settings.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured voltage value. If the measured voltage changes during a fault, the expected operating time changes accordingly.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
U _{meas} /U _{set} at the moment	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between the measured voltage and the pick-up value.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

The operating timers' behavior during a function can be set for TRIP signal and also for the release of the function in case the pick-up element is reset before the trip time has been reached. There are three basic operating modes available for the function:

- · Instant operation: gives the TRIP signal with no additional time delay simultaneously with the START signal.
- · Definite time operation (DT): gives the TRIP signal after a user-defined time delay regardless of the measured or calculated voltage as long as the voltage is above the Uset value and thus the pickup element is active (independent time characteristics).
- Inverse definite minimum time (IDMT): gives the TRIP signal after a time which is in relation to the set pick-up voltage U_{set} and the measured voltage U_m (dependent time characteristics).

The IDMT function follows one of the following formulas:

Overvoltage

Undervoltage

$$t = \frac{k}{\left(\frac{Um}{Us}\right)^{a} - 1} \qquad t = \frac{k}{1 - \left(\frac{Um}{Us}\right)^{a}}$$

$$t = \frac{k}{1 - \left(\frac{Um}{Us}\right)^a}$$

Where:

- t = operating time
- k = time dial setting
- *U_m* = measured voltage
- *U_s* = pick-up setting
- a = IDMT multiplier setting

The following table presents the setting parameters for the function's time characteristics.

Table. 4.4.13 - 139. Setting parameters for operating time characteristics.

Name	Range	Step	Default	Description
Delay type	• DT • IDMT	-	DT	Selection of the delay type time counter. The selection possibilities are dependent (IDMT, Inverse Definite Minimum Time) and independent (DT, Definite Time) characteristics.
Definite operating time delay	0.0001800.000s	0.005s	0.040s	Definite time operating delay. The setting is active and visible when DT is the selected delay type. When set to 0.000 s, the stage operates as instant without added delay. When the parameter is set to 0.0051800 s, the stage operates as independent delayed.
Time dial setting k	0.0160.00s	0.01s	0.05s	The setting is active and visible when IDMT is the selected delay type. Time dial/multiplier setting for IDMT characteristics.
IDMT Multiplier	0.0125.00s	0.01s	1.00s	The setting is active and visible when IDMT is the selected delay type. IDMT time multiplier in the U _m /U _{set} power.

Table. 4.4.13 - 140. Setting parameters for reset time characteristics.

Name	Range	Step	Default	Description
Release time delay	0.000150.000s	0.005s	0.06s	Resetting time. Time allowed between pick-ups if the pick-up has not led to a trip operation. During this time the START signal is held on for the timers if the delayed pick-up release is active.
Delayed pick-up release	• No • Yes	-	Yes	Resetting characteristics selection either as time-delayed or as instant after the pick-up element is released. If activated, the START signal is reset after a set release time delay.
Time calc reset after release time	• No • Yes	-	Yes	Operating timer resetting characteristics selection. When active, the operating time counter is reset after a set release time if the pick-up element is not activated during this time. When disabled, the operating time counter is reset directly after the pick-up element reset.
Continue time calculation during release time	• No • Yes	-	No	Time calculation characteristics selection. If activated, the operating time counter continues until a set release time has passed even if the pick-up element is reset.

The user can reset characteristics through the application. The default setting is a 60 ms delay; the time calculation is held during the release time.

In the release delay option the operating time counter calculates the operating time during the release. When using this option the function does not trip if the input signal is not re-activated while the release time count is on-going.

Events and registers

The sequence voltage function (abbreviated "VUB" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.13 - 141. Event messages.

Event block name	Event names
VUB1VUB4	Start ON
VUB1VUB4	Start OFF
VUB1VUB4	Trip ON
VUB1VUB4	Trip OFF
VUB1VUB4	Block ON
VUB1VUB4	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers; this information is available for all provided instances separately. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.13 - 142. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Pre-trigger voltage	Start/Trip -20ms voltage
Fault voltage	Start/Trip voltage
Pre-fault voltage	Start -200ms voltage
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.14 Overfrequency and underfrequency protection (f>/<; 81O/81U)

The frequency protection function can be used both in overfrequency and in underfrequency situations, and it has four (4) stages for both. Frequency protection can be applied to protect feeder, bus, transformer, motor and generator applications. The difference between the generated power and the load demand can cause the frequency to drop below or rise above the allowed level. When the consumption is larger than the generated power, the frequency may drop. When more power is generated than is consumed, overfrequency can occur.

In generator applications too big a load or a malfunction in the power controller can cause the frequency to decrease. Underfrequency causes damage to turbine wings through vibration as well as heating due to increased iron losses, dropped cooling efficieny and over-magnetization in step-up transformers. Overfrequency protection prevents the generator from running too fast which can cause damage to the generator turbine.

Underfrequency and overfrequency protection can be used as an indicator of an accidental island operation in distributed generation and in some consumers (as it is unlikely that the consumed and generated power are the same). Overfrequency is also often used to control power generation to keep the system's frequency consistent.

Each stage can be activated and deactivated individually. After the f>/< mode has been activated ($Protection \rightarrow Stage\ activation \rightarrow Frequency\ stages$), the user can activate and deactivate the individual stages at will ($Protection \rightarrow Frequency \rightarrow Frequency\ protection\ f >/< \rightarrow INFO \rightarrow Stage\ operational\ setup$).

Figure. 4.4.14 - 146. Simplified function block diagram of the f> function.

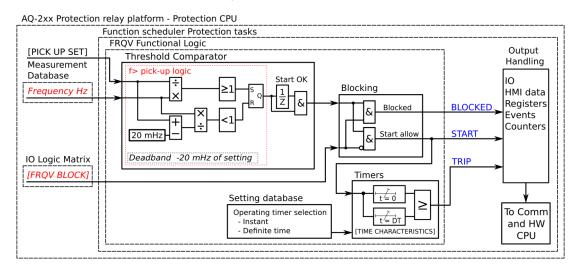
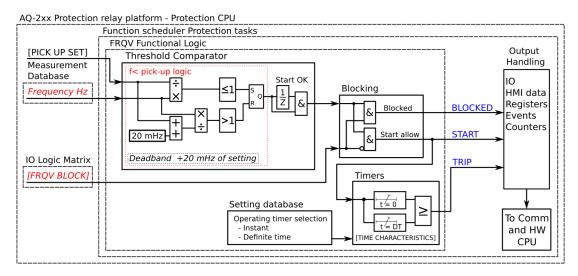


Figure. 4.4.14 - 147. Simplified function block diagram of the f< function.



Measured input

The frequency protection function compares the measured frequency to the pick-up setting (given in Hz). There are three (3) frequency references available. Please refer to "Frequency tracking and scaling" chapter for a detailed description of frequency tracking.

Table. 4.4.14 - 143. Measurement inputs of the f>/< function.

Signals	Description
Frequency reference 1	Primary frequency reference
Frequency reference 2	Secondary frequency reference
Frequency reference 3	Tertiary frequency reference

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.14 - 144. General settings of the function.

Name	Range	Default	Description
f> enable f>> enable f>>> enable f>>>> enable f< enable f<< enable f<<< enable f<<< enable	• No • Yes	No	Enables or disables the stage.
f> force status to f>> force status to f>> force status to f>>> force status to f>>>> force status to f< force status to f< force status to f<< force status to f<< force status to f<< force status to f<<< force status to f<<<< force status to f<<<< force status to f<<<< force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Pick-up settings

The f_{set} >, f_{set} >>, etc.setting parameters control the pick-up of each stage of the f>/< function. They define the maximum or minimum allowed measured frequency before action from the function. The function constantly calculates the ratio between the pick-up setting and the measured frequency. The reset ratio of 20mHz is built into the function and is always relative to the pick-up value.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.14 - 145. Pick-up settings.

Name	Range	Step	Default	Description
f> used in setting group	No Yes	-	No	Enables or disables the protection stage in the setting group.
fset>	10.0080.00Hz	0.01Hz	51Hz	Pick-up setting
fset<	5.0075.00Hz	0.01Hz	49Hz	Pick-up setting
f< undervoltage block	0.00120.00%Un	0.01%Un	0.00%Un	Block setting. If set to zero, blocking is not in use. When the measured voltage drops below the set value, the operation of the functions is blocked.

Operating time characteristics for trip and reset

This function supports definite time delay (DT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.14 - 146. Information displayed by the function.

Name	Range	Step	Description
fcondition	NormalStartTripBlocked	-	Displays the status of the protection function.
f meas / f set	0.00020.000fm/fset	0.001f _m /f _{set}	The ratio between the measured frequency and the pick-up value.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Events and registers

The frequency function (abbreviated "FRQV" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

Table. 4.4.14 - 147. Event messages.

Event block name	Event names
FRQV1	f>/< Start ON
FRQV1	f>/< Start OFF
FRQV1	f>/< Trip ON
FRQV1	f>/< Trip OFF
FRQV1	f>/< Blocked ON
FRQV1	f>/< Blocked OFF

The function registers its operation into the last twelve (12) time-stamped registers. The table below presents the structure of the function's register content.

Table. 4.4.14 - 148. Register content.

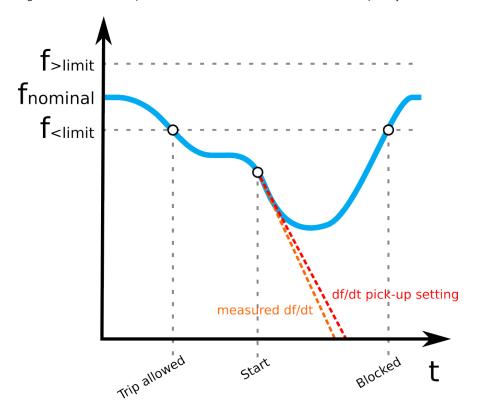
Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
f Pre-trig (Hz)	Start/Trip -20ms frequency
f Fault (Hz)	Fault frequency
Setting group in use	Setting group 18 active

4.4.15 Rate-of-change of frequency (df/dt>/<; 81R)

The rate-of-change of frequency function is used to detect fast drops or increases in frequency. If the load changes fast this function detects and clears the frequency-based faults faster than conventional underfrequency and overfrequency protections. One of the most common causes for the frequency to deviate from its nominal value is an unbalance between the generated power and the load demand. If the unbalance is big the frequency changes rapidly.

The rate-of-change of frequency protection can also be applied to detect a loss of mains situation. Loss of mains is a situation where a part of the network (incorporating generation) loses its connection with the rest of the system (i.e. becomes an islanded network). A generator that is not disconnected from the network can cause safety hazards. A generator can also be automatically reconnected to the network, which can cause damage to the generator and the network.

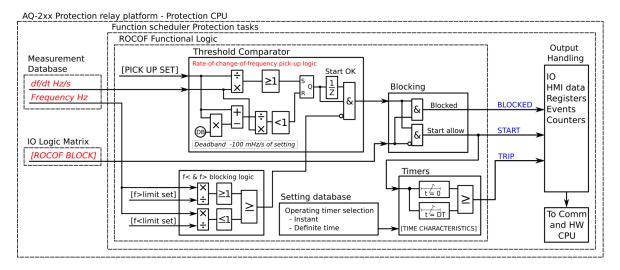
Figure. 4.4.15 - 148. Operation of the df/dt>/< function when the frequency starts but doesn't trip.



The figure above presents an example of the df/dt>/< function's operation when the frequency is decreasing. If the f<_{limit} and/or f>_{limit} is activated, the function does not trip no matter how fast the measured frequency changes if it's over the f<_{limit} or under f>_{limit}. As can be seen in the figure above, when the frequency decreases under the f<_{limit},tripping is allowed although the change of frequency is not yet fast enough for the function to trip. Later the frequency makes a fast dip and as a result the change of frequency is faster than the set pick-up value which then causes the function to operate.

Each stage can be activated and deactivated individually. After the f>/< mode has been activated ($Protection \rightarrow Stage\ activation \rightarrow Frequency\ stages$), the user can activate and deactivate the individual stages at will ($Protection \rightarrow Frequency \rightarrow Frequency\ protection\ f >/< \rightarrow INFO \rightarrow Stage\ operational\ setup$).

Figure. 4.4.15 - 149. Simplified function block diagram of the df/dt>/< function.



Measured input

The rate-of-change of frequency protection function compares the measured df/dt>/< ratio to the pick-up setting (given in Hz/s). There are three (3) frequency references available. Please refer to "Frequency tracking and scaling" chapter for a detailed description of frequency tracking.

Table. 4.4.15 - 149. Measurement inputs of the df/dt>/< function.

Signals	Description
Frequency reference 1	Primary frequency reference
Frequency reference 2	Secondary frequency reference
Frequency reference 3	Tertiary frequency reference

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.15 - 150. General settings of the function.

Name	Range	Step	Default	Description
Max allowed df/ dt rate	0.1050.00 Hz/s	0.10 Hz/s	20 Hz/s	If df/dt rate exceeds this setting, the function is blocked.
df/dt >/< (18) enable	• No • Yes	-	No	Enables or disables the stage.
df/dt >/< (18) force status to	NormalStartTripBlocked	-	Normal	Force the status of the function. Visible only when <i>Enable</i> stage forcing parameter is enabled in <i>General</i> menu.

Pick-up and time delay

The df/dt>/<(1) pick-up, df/dt>/<(2) pick-up, etc. setting parameters control the pick-up of each stage of the df/dt>/< function. They define the maximum or minimum allowed change of frequency before action from the function. The function constantly calculates the ratio between the pick-up setting and the measured df/dt>/<. The reset ratio of +/- 100 mHz/s is built into the function and is always relative to the pick-up value. The f>/< limit value is used to block the funtion from operating near the nominal frequency.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.4.15 - 151. Pick-up settings.

Name	Range	Step	Default	Description
df/dt>/< (18) used in setting group	• No • Yes	-	No	Enables the protection stage in setting group.
df/dt>/< (18) operating mode	RisingFallingBoth	-	Rising	Defines the operation mode of the protection stage. In "Rising" mode df/dt function can trip only from increasing frequency. In "Falling" mode df/dt function can trip only from decreasing frequency. "Both" allows df/dt to trip from both.
df/dt>/< (18) frequency limit	Not used Use f limit	-	Not used	Displays if frequency limits are used or not.
df/dt>/< (18) pick-up	0.0110.00Hz/s	0.01Hz/s	0.2Hz/s	Pick-up setting.
df/dt>/< (18) f< limit	7.0065.00Hz/s	0.01Hz/s	49.95Hz/s	Underfrequency limit. Tripping is permitted when measured frequency is under this value. This parameter is visible only when operation mode is set to "Falling" or "Both".
df/dt>/< (18) f> limit	10.0070.00Hz/s	0.01Hz/s	51Hz/s	Overfrequency limit. Tripping is permitted if measured frequency is above this value. This parameter is visible only when operation mode is set to "Rising" or "Both".

Operating time characteristics for trip and reset

This function supports definite time delay (DT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.15 - 152. Information displayed by the function.

Name	Range	Step	Description
Measured df/ dt	0.00020.000Hz/s	0.001Hz/s	Rate-of-change-of-frequency at the moment.
df/dt >/< (18) condition	NormalStartTripBlocked	-	Displays the status of the protection function.

Name	Range	Step	Description
df/dt >/< (18) df/dt meas / df/dt set	0.00020.000p.u.	0.005p.u.	The ratio between the rate-of-change-of-frequency and the pick-up value.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Events and registers

The rate-of-change of frequency function (abbreviated "DFT" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs are can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

Table. 4.4.15 - 153. Event messages.

Event block name	Event names
DFT1	df/dt>/< (18) Start ON
DFT1	df/dt>/< (18) Start OFF
DFT1	df/dt>/< (18) Trip ON
DFT1	df/dt>/< (18) Trip OFF
DFT1	df/dt>/< (18) Blocked ON
DFT1	df/dt>/< (18) Blocked OFF

The function registers its operation into the last twelve (12) time-stamped registers. The table below presents the structure of the function's register content.

Table. 4.4.15 - 154. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
df/dt>/< Pre-trig (Hz/s)	Start/Trip –20ms df/dt>/<
f Pre-trig (Hz)	Start/Trip –20ms frequency
df/dt>/< Fault (Hz/s)	Fault df/dt>/<
f Fault (Hz)	Fault frequency
Setting group in use	Setting group 18 active

4.4.16 Power protection (P, Q, S>/<; 32)

The power protection function is for instant and time-delayed, three-phase overpower or underpower protection (active, reactive, or apparent). The user can select the operating mode with parameter settings.

Figure. 4.4.16 - 150. PQ diagram of the pick-up areas in various modes.

Selected three phase power

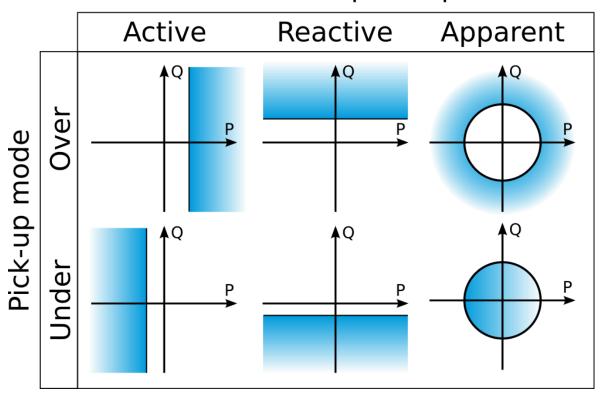
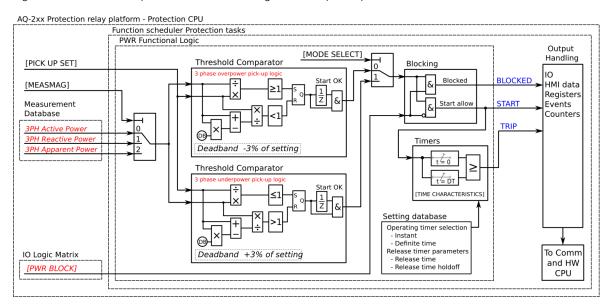


Figure. 4.4.16 - 151. Simplified function block diagram of the power protection function.



Measured input

The function block uses three phase currents and line-to-neutral or line-to-line voltages to calculate active, reactive or apparent power (as the uset chooses). Please refer to "Power and energy calculation" chapter for a detailed description of power calculation.

Table. 4.4.16 - 155. Measurement inputs of the P> function.

Signal	Description	
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current measurement	
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current measurement	
I _{L3} RMS	Fundamental frequency component of phase L3 (C) current measurement	
U ₁ RMS	Fundamental frequency component of U ₁ /V voltage measurement	
U ₂ RMS	Fundamental frequency component of U ₂ /V voltage measurement	
U ₃ RMS	Fundamental frequency component of U ₃ /V voltage measurement	
U4RMS	Fundamental frequency component of U4/V voltage measurement	

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.16 - 156. General settings of the function.

Name	Range	Default	Description
PQS>/< force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Pick-up settings

The PQS>/< setting parameter controls the pick-up of the power protection function. This defines the maximum or minimum allowed measured three-phase power (active, reactive, or apparent) before action from the function. The function constantly calculates the ratio between the PQS>/< and the measured power magnitude. The reset ratios of 97 % (pick-up mode "Over") and 103 % (pick-up mode "Under") are built into the function and is always relative to the pick-up value.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.16 - 157. Pick-up settings.

Name	Range	Step	Default	Description
Measured magnitude	P3PHQ3PHS3PH	-	РЗРН	Defines which three phase power is used: Active, reactive or apparent power.
Nominal MVA reference	Set manuallyUse Gen nom MVAUse Trafo nom MVA	-	Set manually	Defines whether the used nominal power is set manually or if transformer or generator status monitoring function defines the nominal power automatically.
Set nominal MVA	0.00011000.0000MVA	0.0001MVA	10MVA	Nominal MVA used by the function. This parameter is visible only when "Nominal MVA reference" parameter is set to "Set manually"
Pick-up mode	> Over< Under	-	Over	Defines whether the function operates in underpower or overpower protection mode.
Pick-up	-500.000500.000%	0.005%	0%	Pick-up setting. Related to the nominal power set by the user.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.16 - 158. Information displayed by the function.

Name	Range	Step	Description
PQS>/< condition	Normal Start Trip Blocked	-	Displays the status of the protection function.

Name	Range	Step	Description
Nominal MVA used	0.0001800.000MVA	0.001MVA	Displays the nominal power used by the function. This parameter is displayed if "Nominal MVA reference" parameter has been set to "Use Gen nom MVA" or "Use Trafo nom MVA".
Pick-up setting	-1800.0001800.000MVA	0.001MVA	Pick-up setting used at the moment by the function. Value of this parameter can change if setting group has been changed.
Measurement now	-1800.0001800.000MVA	0.001MVA	Measured active, reactive or apparent power at the moment.
Meas/Set at the moment	-1250.001250.00p.u.	0.01p.u.	Ratio between the measured power and pick-up setting.
Meas/Nom at the moment	-1250.001250.00p.u.	0.01p.u.	Ratio between the measured power and used nominal power value.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The power protection function (abbreviated "PWR" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's output can be used for direct I/O controlling and user logic programming. The function also a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers four (4) independent stages; the events are segregated for each stage operation.

Table. 4.4.16 - 159. Event messages.

Event block name	Event names
PWR1PWR4	Start ON
PWR1PWR4	Start OFF
PWR1PWR4	Trip ON
PWR1PWR4	Trip OFF
PWR1PWR4	Block ON
PWR1PWR4	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.16 - 160. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Pre-trigger power	Start/Trip -20ms power
Fault power	Start/Trip power
Pre-fault power	Start -200ms power
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.17 100 % stator earth fault protection (U03rd<; 64S)

When using conventional neutral overvoltage protection function (U0>; 59N) even in the best case scenario at least 5 % of the stator remains outside the function's range. The 100 % stator earth fault protection function (also known as neutral 3rd harmonic overvoltage protection) is used to detect earth faults near the neutral point. When an Earth fault occurs near the neutral point, it does not produce enough neutral voltage for a conventional neutral overvoltage protection to detect the fault. Generators induce some of the 3rd harmonic neutral voltage; when there is an earth fault near the neutral point, this function detects the drop in the 3rd harmonic neutral voltage and trips the breaker. If the 3rd harmonic neutral voltage induced by the generator is high enough, the whole stator can be protected by combining the neutral overvoltage and the 100 % stator earth fault protection functions.

The figure below demonstrates the overlapping range of the neutral overvoltage and the 100 % stator earth fault protection function.

Figure. 4.4.17 - 152. Overlapping demonstration.

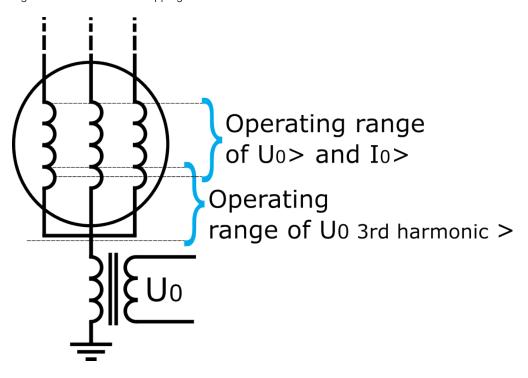
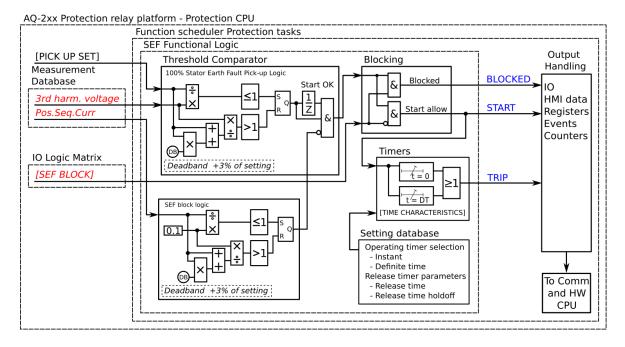


Figure. 4.4.17 - 153. Simplified function block diagram of the U03rd> function.



Measured input

The function block uses 3rd harmonic voltage value of the user selected voltage channel. The function uses fundamental frequency component of phase currents to calculated positive sequence current.

Table. 4.4.17 - 161. Measurement inputs of the U03rd> function.

Signal	Description
3 rd harmonic neutral voltage (U3)	3 rd harmonic of U ₃ voltage channel
3 rd harmonic neutral voltage (U4)	3 rd harmonic of U ₄ voltage channel
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current measurement
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current measurement
IL3RMS	Fundamental frequency component of phase L3 (C) current measurement

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.17 - 162. General settings of the function.

Name	Range	Default	Description
U03rd< force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Pick-up settings

The function has an inbuilt low-current blocking feature to prevent faulty trips. It is set by the *Low current blocking 11< set* parameter. If this parameter is set above zero (0), the measured positive sequence current must be above the set limit for the function to trip.

The *Pick-up setting U03h< set* setting parameter controls the pick-up of the 100 % stator earth fault protection function. This defines the minimum allowed measured neutral 3^{rd} harmonic voltage before action from the function. The function constantly calculates the ratio between the U_{set} < and the measured magnitude. The reset ratio of 103 % is built into the function and is always relative to the U_{set} < value.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.17 - 163. Pick-up settings.

Name	Range	Step	Default	Description
U _{0 3rd} meas input select	U3 inputU4 inputSelect	-	Select	Voltage input must be selected if both U3 and U4 have been set to "U0" mode.
Uset<	1.00100.00%U _n	0.01%U _n	20%U _n	Pick-up setting
I1< block	0.00100.00xl _n	0.01xl _n	0%U _n	If the measured positive sequence current is below this value, tripping is not allowed. $0 \times I_n$ setting disables block.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.17 - 164. Information displayed by the function.

Name	Range	Step	Description
U _{0 3rd} < condition	NormalStartTripBlocked	-	Displays the status of the protection function.
U _{0 3rd} < measuring now	No U0 avail!U3 inputU4 input	-	Displays used voltage measurement channel. If both U3 and U4 channels have been set to "U0" mode the used input channel must be selected with "U03rd< meas input select" parameter.
U _{03rd} < pick-up setting	0.01 000 000V	0.1V	Displays the pick-up setting currently used in volts.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
U _{meas} /U _{set}	0.001250.00U _m /U _{set}	0.01U _m /U _{set}	The ratio between the measured third harmonic residual voltage and the pick-up value.
Measured U _{0 3rd} harm (%)	0.001250.00%U _{0n}	0.01%U _{0n}	Measured third harmonic residual voltage in relation to voltage transformer nominal.
Measured U _{0 3rd} harm (Pri)	0.001250.00V	0.01V	Measured third harmonic residual voltage on the primary side of voltage transformer.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a ALARM or TRIP signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

The operating timers' behavior during a function can be set for TRIP signal and also for the release of the function in case the pick-up element is reset before the trip time has been reached. There are three basic operating modes available for the function:

- Instant operation: gives the TRIP signal with no additional time delay simultaneously with the START signal.
- Definite time operation (DT): gives the TRIP signal after a user-defined time delay regardless of the measured or calculated voltage as long as the voltage is above the *U*_{set} value and thus the pick-up element is active (independent time characteristics).
- Inverse definite minimum time (IDMT): gives the TRIP signal after a time which is in relation to the set pick-up voltage U_{set} and the measured voltage U_m (dependent time characteristics).

The IDMT function follows this formula:

$$t = \frac{k}{\left(\left(\frac{Um}{Us}\right) - 1\right)^a}$$

Where:

- t = operating time
- *k* = time dial setting
- *U_m* = measured voltage
- U_S = pick-up setting
- a = IDMT multiplier setting

The following table presents the setting parameters for the function's time characteristics.

Table. 4.4.17 - 165. Setting parameters for operating time characteristics.

Name	Range	Step	Default	Description
Delay type	• DT • IDMT	ı	DT	Selection of the delay type time counter. The selection possibilities are dependent (IDMT, Inverse Definite Minimum Time) and independent (DT, Definite Time) characteristics.
Definite operating time delay	0.0001800.000s	0.005s	0.040s	Definite time operating delay. The setting is active and visible when DT is the selected delay type. When set to 0.000 s, the stage operates as instant without added delay. When the parameter is set to 0.0051800 s, the stage operates as independent delayed.
Time dial setting k	0.0160.00s	0.01s	0.05s	The setting is active and visible when IDMT is the selected delay type. Time dial/multiplier setting for IDMT characteristics.
IDMT Multiplier	0.0125.00s	0.01s	1.00s	The setting is active and visible when IDMT is the selected delay type. IDMT time multiplier in the U _m /U _{set} power.

Table. 4.4.17 - 166. Setting parameters for reset time characteristics.

Name	Range	Step	Default	Description
Release time delay	0.000150.000s	0.005s	0.06s	Resetting time. Time allowed between pick-ups if the pick-up has not led to a trip operation. During this time the START signal is held on for the timers if the delayed pick-up release is active.
Delayed pick-up release	• No • Yes	-	Yes	Resetting characteristics selection either as time-delayed or as instant after the pick-up element is released. If activated, the START signal is reset after a set release time delay.
Time calc reset after release time	• No • Yes	-	Yes	Operating timer resetting characteristics selection. When active, the operating time counter is reset after a set release time if the pick-up element is not activated during this time. When disabled, the operating time counter is reset directly after the pick-up element reset.
Continue time calculation during release time	• No • Yes	-	No	Time calculation characteristics selection. If activated, the operating time counter continues until a set release time has passed even if the pick-up element is reset.

The user can reset characteristics through the application. The default setting is a 60 ms delay; the time calculation is held during the release time.

In the release delay option the operating time counter calculates the operating time during the release. When using this option the function does not trip if the input signal is not re-activated while the release time count is on-going.

Events and registers

The 100 % stator earth fault protection function (abbreviated "SEF" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

Table. 4.4.17 - 167. Event messages.

Event block name	Event names
SEF1	Start ON
SEF1	Start OFF
SEF1	Trip ON
SEF1	Trip OFF
SEF1	Block ON
SEF1	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.17 - 168. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Pre-trigger voltage	Start/Trip -20ms impedance
Fault voltage	Start/Trip voltage
Pre-fault voltage	Start -200ms voltage
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.18 Underexcitation protection (Q<; 40)

Synchronous machines require a certain amount of excitation to stay stable. If the excitation drops too low a synchronous machine can drop out of step. One way for the function to sense underexcitation is by measuring reactive power. When the generator induces capacitive power, the value of reactive power is negative (and thus the excitation current can be low enough for the synchronous machine to drop out of step). Underexcitation protection supervises capacitive power and picks up when the set kvar value is exceeded.

The image below presents the two modes of underexcitation and their protection areas. The Fixed mode is depicted on the left, the P-dependent mode on the right.

Figure. 4.4.18 - 154. Underexcitation modes.

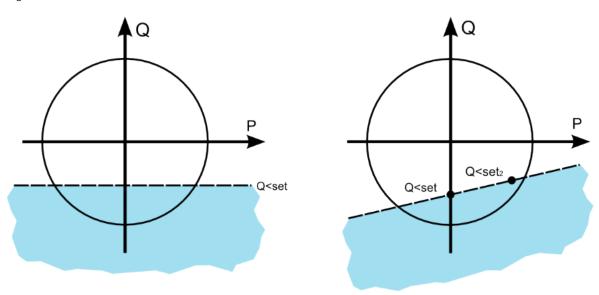
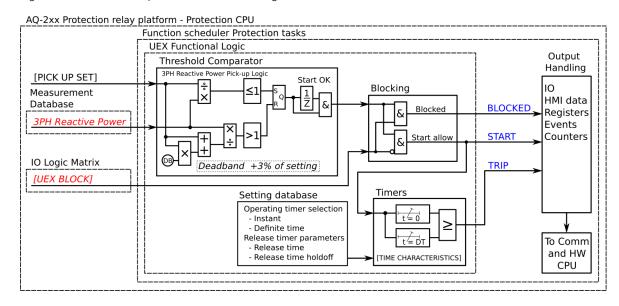


Figure. 4.4.18 - 155. Simplified function block diagram of the Q< function.



Measured input

The function block uses three-phase reactive power values. Please refer to "Power and energy calculation" chapter for a detailed description of power calculation.

Table. 4.4.18 - 169. Measurement inputs of the Q< function.

Signal	Description
3PH Reactive power (P)	Total three-phase reactive power

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.18 - 170. General settings of the function.

Name	Range	Default	Description
Q< force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Pick-up settings

The Q_{set} < setting parameter controls the pick-up of the Q< function. This defines the minimum allowed measured three-phase reactive power before action from the function. The function constantly calculates the ratio between the Q_{set} < and the measured magnitude (Q_m). The reset ratio of 97 % is built into the function and is always relative to the Q_{set} < value.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.18 - 171. Pick-up settings.

Name	Range	Step	Default	Description
Qset mode	FixedP- dependent	-	Fixed	Decides whether the pick-up area is defines only by the Q_{set} < parameter or by two points set in the PQ plane.
Qset<	0.0100 000kvar	0.01kvar	-100kvar	In Fixed mode: sets the pick-up value for the function. In P-dependent mode: chooses the reactive power for the first point.
Pick-up P1 for Qset<	0.0100 000kW	0.01kW	100kW	The value of the active power for <i>Qset</i> < when the Pdependent mode is in use.
Qset2<	0.0100 000kvar	0.01kvar	-100kvar	Chooses the reactive power for the second point when the P-dependent mode is in use.
Pick-up P2 for Qset<	0.0100 000kW	0.01kW	100kW	The value of the active power for Q_{set2} < when the P-dependent mode is in use.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.18 - 172. Information displayed by the function.

Name	Range	Step	Description
Q< condition	NormalStartTripBlocked	-	Displays the status of the protection function.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
Q _{meas} /Q _{set} at the moment	-1250.001250.00Qm/Qset	0.01Q _m /Q _{set}	The ratio between the measured reactive power and the pick-up value.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The underexcitation function (abbreviated "UEX" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's output can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

Table. 4.4.18 - 173. Event messages.

Event block name	Event names
UEX1	Start ON
UEX1	Start OFF
UEX1	Trip ON
UEX1	Trip OFF
UEX1	Block ON
UEX1	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.18 - 174. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Pre-trigger power (P&Q)	Start/Trip -20ms power
Fault power (P&Q)	Start/Trip power
Pre-fault power (P&Q)	Start -200ms power

Register	Description
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.19 Underimpedance protection (Z<; 21U)

Underimpedance protection is an alternative for voltage-restrained overcurrent protection. It can be used to detect short-circuit faults near the generator even when the short-circuit current is small. Additionally, under impedance protection can be used as backup protection for transformer protection.

Figure. 4.4.19 - 156. Operating characteristics of underimpedance protection.

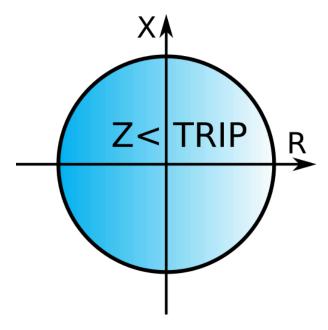
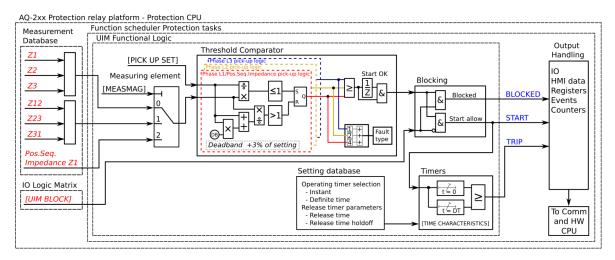


Figure. 4.4.19 - 157. Simplified function block diagram of the Z< function.



Measured input

The function block uses phase currents and phase-to-phase or phase-to-neutral voltage measurement values. These values are used for calculating impedance.

Table. 4.4.19 - 175. Measurement inputs of the Z< function.

Signal	Description
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current
I _{L3} RMS	Fundamental frequency component of phase L3 (C) current
U ₁ RMS	Fundamental frequency component of voltage channel U ₁ /V
U ₂ RMS	Fundamental frequency component of voltage channel U ₂ /V
U ₃ RMS	Fundamental frequency component of voltage channel U ₃ /V
U ₄ RMS	Fundamental frequency component of voltage channel U ₄ /V

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.19 - 176. General settings of the function.

Name	Range	Default	Description
Z< force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage</i> forcing parameter is enabled in <i>General</i> menu.
Operation mode	 P-E Impedances P-P Impedances Pos. seq. Impedance 	P-E Impedance	Selects the used impedances.

Pick-up settings

The Z_{set} (pri)< setting parameter controls the the pick-up of the Z< function. This defines the minimum allowed measured impedance before action from the function. The function constantly calculates the ratio between the impedance pick-up leveland the calculated impedance for each of the three stages or the positive sequence impedance. The reset ratio of 103 % is built into the function and is always relative to the current pick-up value.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.4.19 - 177. Pick-up settings.

Name	Range	Step	Default	Description
Z _{set} (pri)<	0.10150.00Ω	0.01Ω	10Ω	Pick-up setting as primary side impedance

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.19 - 178. Information displayed by the function.

Name	Range	Step	Description
Z< condition	NormalStartTripBlocked	-	Displays status of the protection function.
Expected operating time			Displays the expected operating time when a fault occurs.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
Z _{meas} /Z _{set} at the moment	0.001250.00	0.01	The ratio between the lowest measured impedance and the pick-up value.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The underimpedance protection function (abbreviated "UIM" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers two (2) independent stages; the events are segregated for each stage operation.

Table. 4.4.19 - 179. Event messages.

Event block name	Event names
UIM1UIM2	Start ON
UIM1UIM2	Start OFF
UIM1UIM2	Trip ON
UIM1UIM2	Trip OFF
UIM1UIM2	Block ON
UIM1UIM2	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.19 - 180. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	A-EA-B-C
Pre-trigger impedance	Start/Trip -20ms impedance
Fault impedance	Start/Trip impedance
Pre-fault impedance	Start -200ms impedance
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.20 Voltage-restrained overcurrent protection (Iv>; 51V)

Short-circuits that occur close to the generator decrease the fault current which in turn inhibits the operation of a high-set overcurrent stage. The decreasing voltage caused by these faults can be used to decrease the current pick-up level and thus to improve sensitivity. This voltage-restrained overcurrent protection function can be used as an alternative for the underimpedance function for more sensitive short-circuit detection in generator protection applications.

When there is a short-circuit near the generator, the voltage decreases which in this function's case decreases the overcurrent's pick-up level according to set parameters. The function can work as voltage-controlled overcurrent protection or as voltage-restrained overcurrent protection. When the set parameter value Ux2 is greater than Ux1, the protection function works as voltage-restrained overcurrent protection. In this case the overcurrent pick-up value increases as the voltage increases between the set values Ux1 and Ux2. The protection function uses positive sequence voltage to define the pick-up level at that moment.

When the set value of Ux1 is equal to Ux2, the function works as voltage-controlled overcurrent protection. Now the overcurrent protection doesn't operate until a fault reduces the voltage below a set value, usually about 80 % of the normal. A fixed pick-up level of voltage-controlled overcurrent protection is easier to coordinate with other protection devices. However, the voltage-restrained overcurrent protection function is less prone to making unwanted operations on motor starting currents and system swings.

Figure. 4.4.20 - 158. Pick-up levels in the two modes.

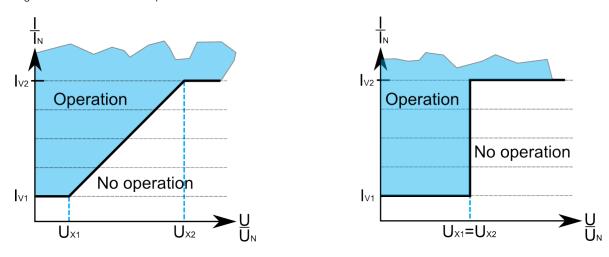
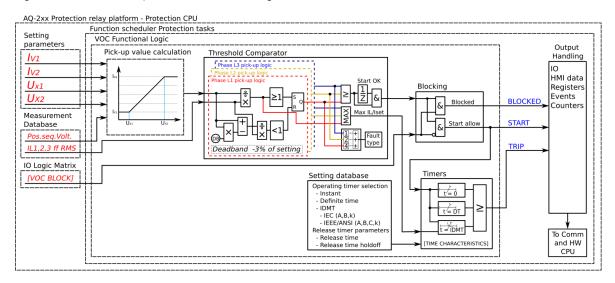


Figure. 4.4.20 - 159. Simplified function block diagram of the lv> function.



Measured input

The function block uses fundamental frequency component of phase current measurement values. The function block uses fundamental frequency component of phase-to-phase, phase-to-neutral and zero sequence voltage.

Table. 4.4.20 - 181. Measurement inputs of the voltage-restrained overcurrent protection function.

Signal	Description
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current

Signal	Description	
IL3RMS	Fundamental frequency component of phase L3 (C) current	
U ₁ RMS	Fundamental frequency component of voltage channel U ₁ /V	
U ₂ RMS	Fundamental frequency component of voltage channel U ₂ /V	
U ₃ RMS	Fundamental frequency component of voltage channel U ₃ /V	
U ₄ RMS	Fundamental frequency component of voltage channel U ₄ /V	

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.20 - 182. General settings of the function.

Name	Range	Default	Description
Iv> force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Pick-up settings

The Iv1, Iv2, Ux1, Ux2 setting parameters and the positive sequence voltage measurement control the pick-up level of the voltage-restrained overcurrent protection function. The pick-up level defines the maximum allowed measured current before action from the function. The function constantly calculates the ratio between the current pick-up level and the measured magnitude (I_m) for each of the three phases. The reset ratio of 97 % is built into the function and is always relative to the current pick-up value.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.20 - 183. Pick-up settings.

Name	Range	Step	Default	Description
1st knee point (Iv>)	0.1040.00xl _n	0.01xl _n	0.2 xl _n	The lower current limit.
2nd knee point (Iv2>)	0.1040.00xl _n	0.01xl _n	1.2xl _n	The higher current limit.
1st knee point voltage (Ux1)	0.00150.00%U _n	0.01%U _n	20%U _n	The lower voltage limit.

Name	Range	Step	Default	Description
2nd knee point voltage (Ux2)	0.00150.00%U _n	0.01%U _n	100%U _n	The higher voltage limit. When this value is higher than Ux1, the function operates as voltage-restrained overcurrent protection. If the two values are equal, the function operates as voltage-controlled overcurrent protection.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.20 - 184. Information displayed by the function.

Name	Range	Step	Description
lv> condition	NormalStartTripBlocked	-	Displays status of the protection function.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs. When IDMT mode is used, the expected operating time depends on the measured highest phase current value. If the measured current changes during a fault, the expected operating time changes accordingly.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
Voltage measurement	Invalid U1 not avail. Ok	-	If phase voltages are not available the function is not able to calculate positive sequence voltage (U1). This can happen when voltage measurement mode has been set to "3LL+U4" or "2LL+U3+U4" mode but none of the channels have been set to "U0" mode.
l> pick-up level now	0.001250.00xln	0.01xln	Overcurrent pick-up level used by the function at the moment. The pick-up level changes with positive sequence voltage setting changes.
Measured voltage now	0.001250.00%Un	0.01%Un	Calculated positive sequence voltage at the moment. This influences the overcurrent pick-up level used by the function.
I _{meas} /I _{set} at the moment	0.001250.00	0.01	The ratio between the highest measured phase current and the pick-up value.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT) and inverse definite minimum time delay (IDMT). If IDMT is selected for this function, the time delay depends on the ratio between the measured current and the current pick-up level at that moment. This means that the operation time can also shorten as a result of the reduced voltage. For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The voltage-restrained overcurrent protection function (abbreviated "VOC" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

Table. 4.4.20 - 185. Event messages.

Event block name	Event names
VOC1	Start ON
VOC1	Start OFF
VOC1	Trip ON
VOC1	Trip OFF
VOC1	Block ON
VOC1	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.20 - 186. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	L1-EL1-L2-L3
Pre-trigger current	Start/Trip -20ms current

Register	Description
Fault current	Start/Trip current
U1 Voltage	Positive sequence voltage
Current pick-up	Pick-up current level
Pre-fault current	Start -200ms current
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.21 Volts-per-hertz overexcitation protection (V/Hz>; 24)

Generators, transformers, and motors have their own, specific volts-per-hertz ratios under which these machines are expected to operate. Exceeding the V/Hz ratio results in machine overexcitation which causes iron core saturation in generators and transformers. This causes a breakdown of the insulation in the core's interlamination due to excessive voltage and eddy current heating. Additionally, stray flux is induced into non-laminated components which are not designed to carry flux-caused currents. In generators overexcitation typically occurs if the V/Hz ratio goes five percent above the nominal V/Hz ratio, with any possible damage happening within seconds. The most common situation for overexcitation is when a machine is off-line prior to synchronization.

The figure below shows how the pick-up settings and the measured frequency affect the pick-up level of the volts-per-hertz protection function.

Figure. 4.4.21 - 160. Effect of pick-up settings and the measured frequency to the overvoltage function's pick-up level.

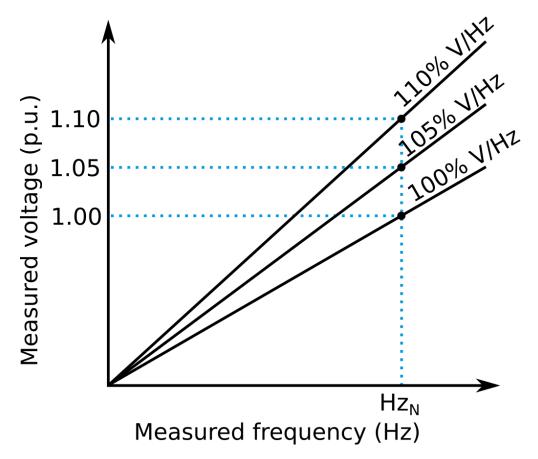
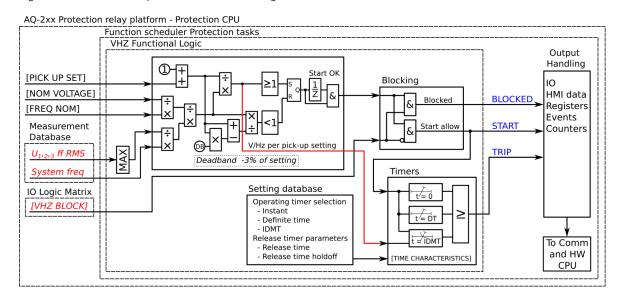


Figure. 4.4.21 - 161. Simplified function block diagram of the V/Hz> function.



Measured input

The function block uses fundamental frequency component of phase-to-phase voltage measurements. Frequency measurement values is used for determining the overvoltage pick-up level. Please refer to "Frequency tracking and scaling" chapter for a detailed description of frequency tracking.



NOTICE!

The used sampling mode for frequency must be "Tracking".

Table. 4.4.21 - 187. Measurement inputs of the volts-per-hertz function.

Signal	Description
U ₁ RMS	Fundamental frequency component of U ₁ /V voltage channel
U ₂ RMS	Fundamental frequency component of U ₁ /V voltage channel
U ₃ RMS	Fundamental frequency component of U ₁ /V voltage channel
U ₄ RMS	Fundamental frequency component of U ₁ /V voltage channel
Frequency reference 1	Primary frequency reference
Frequency reference 2	Secondary frequency reference
Frequency reference 3	Tertiary frequency reference

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.21 - 188. General settings of the function.

Name	Range	Default	Description
V/Hz > force status to	NormalStartTripBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage</i> forcing parameter is enabled in <i>General</i> menu.

Pick-up settings

Volts-per-hertz protection is based on the ratio between the maximum phase-to-phase voltage and the measured system frequency. The $Pick-up\ V/Hz > (\%\ of\ nominal)$ setting parameter controls the pick-up of the volts-per-hertz function. This defines the maximum measured voltage allowed in relation to the measured frequency before action from the function. The function constantly calculates the ratio between the $Pick-up\ V/Hz\ (\%\ of\ nominal)$ and the calculated U_{meas}/f_{meas} ratio. The reset ratio of 97 % is built into the function and is always relative to the $Pick-up\ V/Hz\ (\%\ of\ nominal)$ value.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.21 - 189. Pick-up settings.

Name	Range	Step	Default	Description
Pick-up V/Hz > (% of nominal)	0.0130.00%	0.01%	5.00%	The maximum allowed increase in the measured V/Hz ratio in relation to the nominal V/Hz ratio.
Alarm delay (DT)	0.0001800.000s	0.005s	0.040s	The definite operation time delay for alarm event.
Delay type	DT Inverse DT and inverse	-	DT	Selects the delay type(s) for the time counter.
Time dial setting k	0.0165.00	0.01	0.01	Defines the time dial/multiplier setting for inverse curve characteristics. This setting is active and visible when the "Delay type" parameter is set to "Inverse" or "DT and inverse".
Definite operating time delay	0.0001800.000s	0.005s	0.040s	The definite operating time delay which is applied no matter how much the V/Hz ratio is exceeded. This setting is only visible, when the selected delay type is "DT" or "DT and inverse".

Inverse operating time characteristics are calculated according to the following equation:

$$t_{inverse} = DT_{set} + \frac{0.18 \times TimeDial \ k}{(\frac{V}{Hz_{measured}} - 1)^{IDMT_{multiplier}}}$$

Figure. 4.4.21 - 162. Inverse (above) and inverse and DT (below) time characteristics with the TimeDial k setting effect.

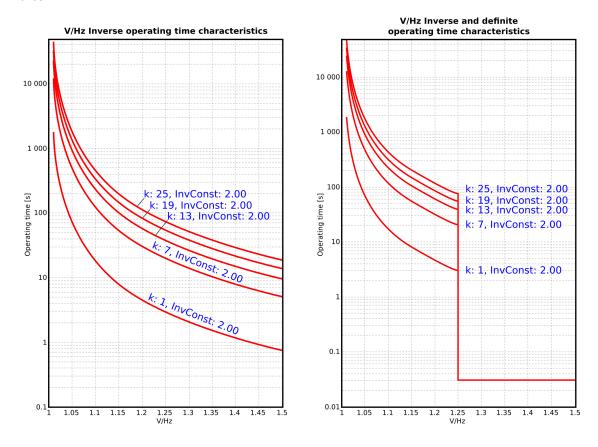
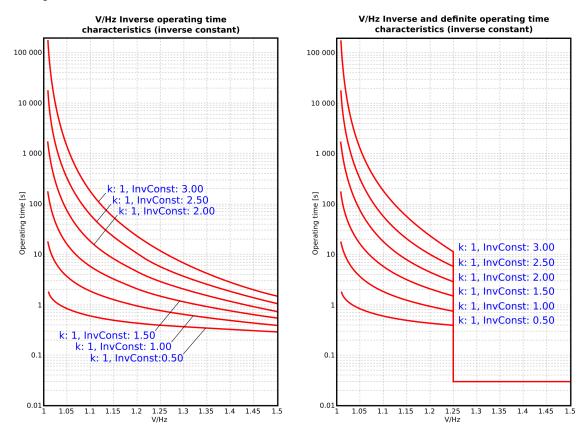


Figure. 4.4.21 - 163. Inverse (above) and inverse and DT (below) time characteristics with the inverse constant setting effect.



Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.21 - 190. Information displayed by the function.

Name	Range	Step	Description
V/ Hz> condition	NormalStartAlarmTripBlocked	-	Displays the status of the protection function.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
U/f atm to pick-up U/f ratio	-100.00100.00%	0.01P _m /P _{set}	The ratio between the measured power and the pick-up value.
Nominal U/f	-100.000100.000V/ Hz	0.001V/Hz	Nominal volts-per-hertz ratio (voltage in per-unit value divided by nominal frequency). When 50Hz is used nominal U/f
U/f at the moment	-100.000100.000V/ Hz	0.001V/Hz	Volts-per-hertz at the moment.
U/f atm to nominal U/f ratio	-100.000100.000V/ Hz	0.001V/Hz	Measured volts-per-hertz ratio divided by nominal volts- per-hertz ratio.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Events and registers

The volts-per-hertz overexcitation protection function (abbreviated "VHZ" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

The function offers one (1) stage

Table. 4.4.21 - 191. Event messages.

Event block name	Event names
VHZ1	V/Hz (12) Start ON
VHZ1	V/Hz (12) Start OFF
VHZ1	V/Hz (12) Alarm ON
VHZ1	V/Hz (12) Alarm OFF
VHZ1	V/Hz (12) Trip ON
VHZ1	V/Hz (12) Trip OFF
VHZ1	V/Hz (12) Block ON
VHZ1	V/Hz (12) Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.21 - 192. Register content.

Name	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Voltages (AB/BC/CA) pre-trig	Start/Trip -20ms voltages
Frequency pre-trig	Start/Trip -20ms frequency
Voltages (AB/BC/AC) fault	Start/Trip voltages
Frequency fault	Start/Trip frequency
Voltages (AB/BC/AC) pre-fault	Start -200ms voltages
Frequency pre-fault	Start -200ms frequency
Trip time remaining	0 ms1800 s
Setting group in use	Setting group 18 active

4.4.22 Power factor protection (PF<; 55)

The power factor protection function is the ratio of active power to apparent power ($\cos \phi$ = P/S). In a fully resistive load the power factor is 1.00. In partially inductive loads the power factor is under 1.00. Power factor protection cannot detect a power factor value that is too low.

Figure. 4.4.22 - 164. Operating characteristics of power factor protection.

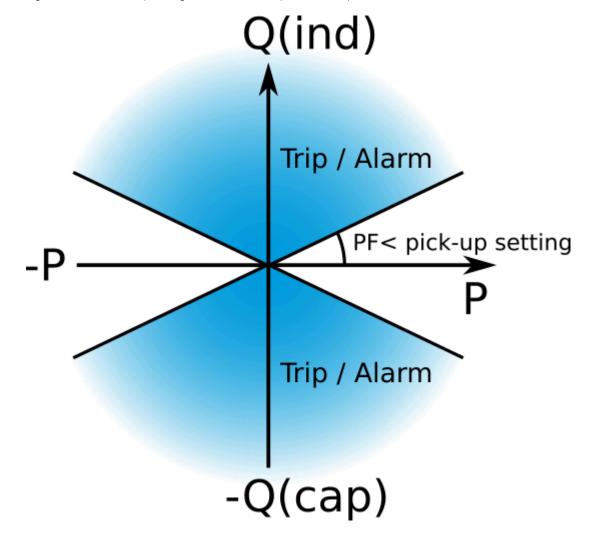
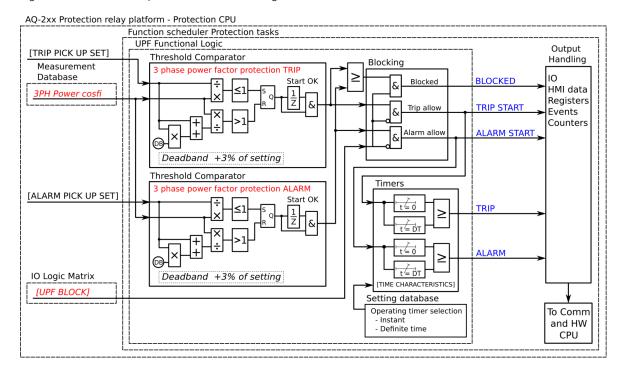


Figure. 4.4.22 - 165. Simplified function block diagram of the PF> function.



Measured input

The function block uses three phase power factor (cos phi). Please refer to "Power and energy calculation" chapter for a detailed description of how cos phi is calculated.

Table. 4.4.22 - 193. Measurement inputs of the PF< function.

Signal	Description
3PH cos φ	Three-phase cos phi (power factor)

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.22 - 194. General settings of the function.

Name	Range	Default	Description
PF< force status to	NormalStartTripBlockedAlarmStartAlarm	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Pick-up settings

The Pick-up setting PF< (lead or lag) Trip and Pick-up setting PF< (lead or lag) Alarm setting parameters control the pick-up of the PF< function. They define the minimum allowed power factor before action from the function. The function constantly calculates the ratio between the pick-up settings and the measured magnitude (power factor). The reset ratio of 103 % is built into the function and is always relative to the pick-up setting value.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.22 - 195. Pick-up settings.

Name	Range	Step	Default	Description
Available modes	TripsTripsandalarms	-	Trips and alarms	Enables or disables alarming.
Pick-up setting PF< (lead or lag) Trip	0.050.99	0.01	0.8	Pick-up setting for tripping
Pick-up setting PF< (lead or lag) Alarm	0.050.99	0.01	0.9	Pick-up setting for alarming. This parameter is only available when "Available modes" parameter has been set to "Trip and alarm".

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.22 - 196. Information displayed by the function.

Name	Range	Step	Description
PF< condition	NormalStartTripBlockedAlarm StartAlarm	-	Displays status of the protection function.
Expected alarming time	0.0001800.000s	0.005s	Displays the expected alarming time when a fault occurs.
Time remaining to alarm	0.0001800.000s	0.005s	When the function has detected a fault and counts down time towards an alarm, this displays how much time is left before alarm is activated.
PF _{meas} / PF _{alarm} at the moment	0.001250.00	0.01	The ratio between the measured power factor and the alarm pick-up value.

Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.
PF _{meas} / PF _{set} at the moment	0.001250.00	0.01	The ratio between the measured power factor and the pick-up value.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for trip and reset

This function supports definite time delay (DT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The power factor protection function (abbreviated "UPF" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the ALARM START, ALARM, START, TRIP and BLOCKED events.

Table. 4.4.22 - 197. Event messages.

Event block name	Event names
UPF1	Block ON
UPF1	Block OFF
UPF1	Start ON
UPF1	Start OFF
UPF1	Trip ON

Event block name	Event names
UPF1	Trip OFF
UPF1	Alarm Start ON
UPF1	Alarm Start OFF
UPF1	Alarm ON
UPF1	Alarm OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.22 - 198. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Pre-trigger PF	Start/Trip -20ms power factor
Fault PF	Start/Trip power factor
Pre-fault PF	Start -200ms power factor
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.23 Machine thermal overload protection (TM>; 49M)

The thermal overload protection function for machines is used for the thermal capacity monitoring and protection of electric machines like synchronous and asynchronous motors and generators. This function can also be used for any applications with single or multiple time constansts, such as inductor chokes, certain types of transformers and any other static units which do not have active cooling apart from cables and overhead lines.

The function constantly monitors the instant values of phase TRMS currents (including harmonics up to 31st) and calculates the set thermal replica status in 5 ms cycles. The function includes a total memory function of the load current conditions according to IEC 60255-8.

The function is based on a thermal replica which represents the protected object's thermal loading in relation to the effective current in the object. The thermal replica includes the calculated thermal capacity that the "memory" uses; it is an integral function which tells apart this function from a normal overcurrent function and its operating principle for overload protection applications.

In heating and cooling situations the thermal image for this function is calculated according to the two equations described below:

Figure. 4.4.23 - 166. Long time constant thermal image calculation.

$$\theta_{tL} = \left(\left(\theta_{t-1} - \left(\frac{I_{EM}}{I_N \times k_{SF} \times k_{AMB}} \right)^2 \times e^{-\frac{t}{\tau_{1h}/\tau_{1c0}/\tau_{1cr}}} \right) + \left(\frac{I_{EM}}{I_N \times k_{SF} \times k_{AMB}} \right)^2 \right) \times \left(1 - W_f \right)$$

Where:

- θ_{t-1} = Thermal image status in a previous calculation cycle (the memory of the function)
- I_{EM} = (see below)
- I_N = Current for the 100 % thermal capacity to be used (pick-up current in p.u., with this current t_{max} achieved in time t)
- ksf = Loading factor (service factor) coefficient, the maximum allowed load current in p.u., depending on the protected object
- k_{AMB} = Temperature correction factor, either from a linear approximation or from a settable ten-point thermal capacity curve
- e = Euler's number
- t = Calculation time step in seconds (0.005 s)
- τ_{1h} = Long thermal heating time constant of the protected object (in minutes)
- τ_{1c0} = Long thermal cooling time constant (motor stopped) of the protected object (in minutes)
- τ_{1cr} = Long thermal cooling time constant (motor running) of the protected object (in minutes)
- W_f = Correction factor between the times t₁ and t₂

Figure. 4.4.23 - 167. Short time constant thermal image calculation.

$$\theta_{tS} = \left(\left(\theta_{t-1} - \left(\frac{I_{EM}}{I_{N} \times k_{SF} \times k_{AMB}} \right)^{2} \times e^{-\frac{t}{\tau_{2h}/\tau_{2c}}} \right) + \left(\frac{I_{EM}}{I_{N} \times k_{SF} \times k_{AMB}} \right)^{2} \right) \times W_{f}$$

Where:

- θ_{t-1} = Thermal image status in a previous calculation cycle (the memory of the function)
- I_{EM} = (see below)
- I_N = Current for the 100 % thermal capacity to be used (pick-up current in p.u., with this current t_{max} achieved in time t)
- k_{SF} = Loading factor (service factor) coefficient, the maximum allowed load current in p.u. value, depending on the protected object
- k_{AMB} = Temperature correction factor, either from a linear approximation or from a settable ten-point thermal capacity curve
- e = Euler's number
- t = Calculation time step in seconds (0.005 s)
- τ_{2h} = Short thermal heating time constant of the protected object (in minutes)
- τ_{2C} = Short thermal cooling time constant of the protected object (in minutes)
- W_f = Correction factor between the times t₁ and t₂

The equation below is that of the effective current of the protected object including the TRMS measurement maximum phase current as well as a possible phase current unbalance condition.

$$I_{EM} = \sqrt{\left(\left(1 + \left(\left(\frac{I_2}{I_1}\right)^2 \times k_{NPS}\right)\right) \times I_{MAX}^2\right)}$$

Where:

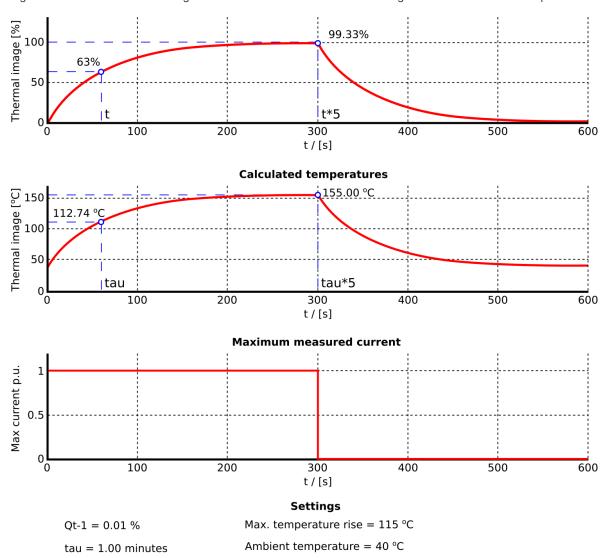
- I₁ = Calculated positive sequence current of the measured RMS phase currents
- I₂ = Calculated negative sequence current of the measured RMS phase currents
- k_{NPS} = Correction factor of the NPS current biasing to the equivalent current calculation
- I_{MAX} = Measured maximum of the three TRMS phase currents

The thermal image status (θ_t %, in percentages of the maximum thermal capacity used) calculation is based on the sum of the long and short time constant thermal image calculation:

$$\theta_{t\%} = (\theta_{tL} + \theta_{tS}) \times 100\%$$

The basic operating principle of the thermal replica is based on the nominal temperature rise, which is achieved when the protected object is loaded with a nominal load in a nominal ambient temperature. When the object is loaded with a nominal load for a time equal to its heating constant tau (τ) , 63% of the nominal thermal capacity is used. When the loading continues until five times this given constant, the used thermal capacity approaches 100 % indefinitely but never exceeds it. With a single time constant model the cooling of the object follows this same behavior, the reverse of the heating when the current feeding is completely zero.

Figure. 4.4.23 - 168. Thermal image calculation with nominal conditions: single time constant thermal replica.



Max End. Temp = 155.00 °C

Temp k fact = 1.00

Serv.Fact = 1.00

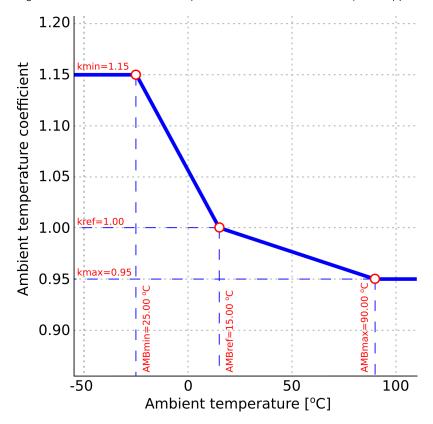
The described behavior is based on the assumption that the monitored object has a homogenous body which generates and dissipates heat with a rate proportional to the temperature rise caused by the current squared. Installation conditions considering the prevailing conditions in the thermal replica are compensated with the ambient temperature coefficient which is constantly calculated and changing when using RTD sensor for the measurement. When the ambient temperature of the protected object is stable it can be set manually.

The ambient temperature compensation takes into account the set minimum and maximum temperatures and the load capacity of the protected object as well as the measured or set ambient temperature. The formulas below present examples of the calculation of the ambient temperature coefficient (a linear correction factor to the maximum allowed current):

$$\begin{aligned} t_{Amb < t_{min}} &= k_{min} \\ t_{Amb < t_{ref}} &= \left(\frac{1 - k_{min}}{t_{ref} - t_{min}} \times (t_{AMB} - t_{min})\right) + k_{min} \\ t_{Amb > t_{ref}} &= \left(\frac{k_{max} - 1}{t_{max} - t_{ref}} \times (t_{AMB} - t_{ref})\right) + 1.0 \\ t_{Amb > t_{max}} &= k_{max} \end{aligned}$$

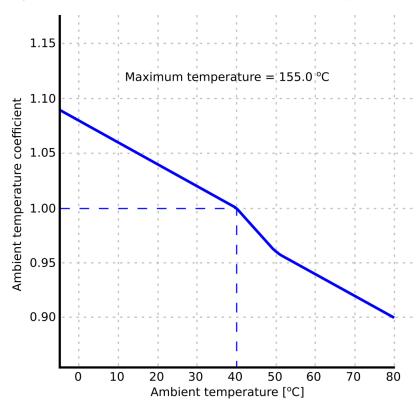
- t_{amb} = Measured (set) ambient temperature (can be set in °C or °F)
- t_{max} = Maximum temperature (can be set in °C or °F) for the protected object
- k_{max} = Ambient temperature correction factor for the maximum temperature
- t_{min} = Minimum temperature (can be set in °C or °F) for the protected object
- k_{min} = Ambient temperature correction factor for the minimum temperature
- t_{ref} = Ambient temperature reference (can be set in °C or °F, the temperature in which the given manufacturer presumptions apply and the temperature correction factor is 1.0)

Figure. 4.4.23 - 169. Ambient temperature coefficient calculation (linear approximation, three points).



This ambient temperature coefficient relates to a nominal reference temperature. The default is +40 °C (the standard ambient temperature rating for machines) which gives the coefficient value of 1.00 for the thermal replica. The settable thermal capacity curve uses linear interpolation for ambient temperature correction with a maximum of ten (10) pairs of temperature—correction factor pairs. The temperature and coefficient pairs are set to the TM> function's settable correction curve.

Figure. 4.4.23 - 170. Ambient temperature coefficient calculation (linear approximation, indefinite points).



As mentioned in the previous diagram, the reference temperature for electric machines usually is +40 °C; this gives a correction coefficient of 1.00 which can be referred to as the nominal temperature in this case. The correction curve does not need to be set with as many points as there are available. The minimum setting is two pairs and the result is a straight line, for which the linear approximation is the better choice.

Multiple time constants

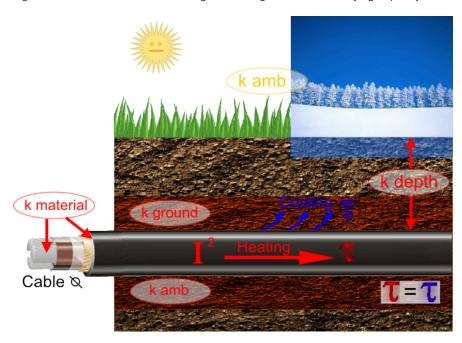
The thermal behaviour of the single time constant model was presented in the introduction of this chapter. However, it is not the optimal solution for electric machines, especially when the motor is stopped and started frequently. The following explains the main reasons as well as the differences between the single and the multiple time constant models.

By the terms of electrical machine the thermal behavior and time constants varies in between of heating and cooling as well as at certain point within heating and cooling when the loading current is decreased or increased instantly to minimum or maximum. In practice this means that the thermal replica needs to have more settable time constants than one common constant for heating and cooling, as is the case with single time constant objects like cables.

The most common practice is to separate the minimum settable time constants for heating and cooling. The main reason for this is fairly simple: the rotating machine (especially a motor) usually has a cooling fan in the same shaft with its drive, and it cools both the motor and its own surface when the motor is running. Unfortunately, the cooling stops when the motor stops, and the time constant becomes longer as the heat is slower to dissipate into the surrounding air. The cooling time constant (τ_c) may be the same as the heating time constant (τ_h) if the machine has active cooling. Additionally, the starting method (DOL/Soft start/Y-delta) also tells whether there is a need for another time constant (locked rotor, overloading situations) in order to achieve a suitable thermal image for the machine.

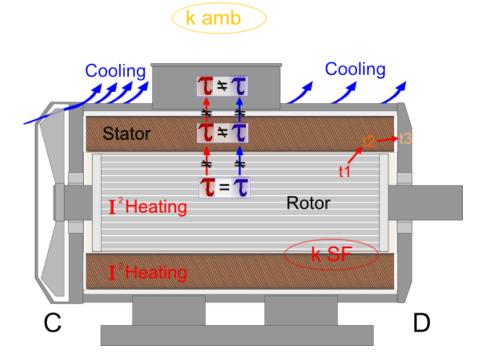
The following figure presents the various differences to consider when solve the time constants in the motor (as compared to single time constant objects like cables).

Figure. 4.4.23 - 171. Factors affecting the cooling and current-carrying capacity of a cable.



The current-carrying capacity of a cable mostly depends on the conductor's material and its diameter. The second most important factor is the cable's insulating material and how much it can withstand temperature. As can be seen in the image above, all factors (apart from the air temperature) are quite stable, especially when the cable lies below the ground frost limit in places where the outside temperature can dip well below 0 °C. The heat conduction from the cable into the surrounding ground is the same, regardless whether the cable is heating or cooling. The composition of the soil defines how well the ground conducts heat. However, these loading factors only affect the maximum current-carrying capacity of the cable; they are not the cable's time constants. The only time constant to consider is the heating time constant, which is equal to the cooling time constant for underground cables.

Figure. 4.4.23 - 172. Simplified motor construction and time constants.



Any normal induction machine such as electric motors have the following major components:

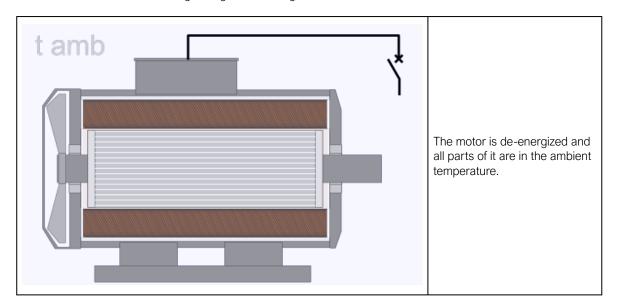
- the rotor: rotates, its shaft used as a power outlet for the motor (drive end),
- the stator: generates the electromagnetic field which induces into the rotor and makes it rotate (hence the name "induction motor"),
- the body: contains the stator and rotor.

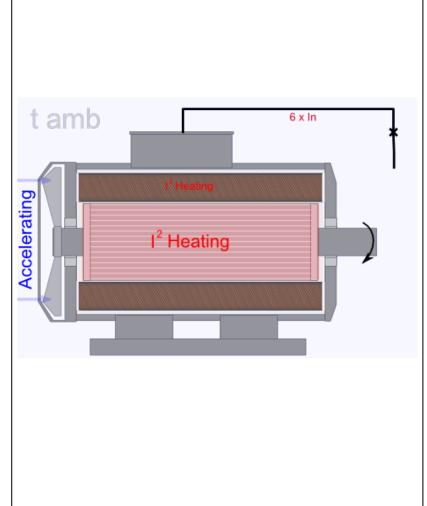
Motors always have some kind of a cooling system. The most common cooling system is the rotor's shaft-mounted fan (cooling end). Bigger motors or slowly rotating motors can have additional fans or liquid cooling.

By observing motor thermal properties, one can find several very different components which all have their own thermal time constants. The rotor has a constant that is the same for both heating and cooling ($\tau_h = \tau_c$), the stator has a constant where the heating time constant is different from the cooling constant ($\tau_h = -\tau_c$), and even the motor body has its own time constant for heating and cooling. Keeping the rotor and the stator from being overheated are required for the overall motor protection as it can cause insulator damage in the stator and melt the rotor bars. Both of these faults result in the malfunction of the motor.

When considering the thermal behavior, one can see another fundamental difference between single and multiple time constant objects like cables and electric motors. While the cable loading may vary during the operating conditions, currents higher than the nominal current are not part of the normal usage but always indicate a fault of some sort. Motor with direct-on-line (DOL) starting have a high starting current (up to $6-7 \times I_n$) and heat generation that are part of its normal operation and happen every time the motor is started. The following figure describes the process of motor heating from the ambient temperature to the nominal temperature with direct-on-line (DOL) starting.

Table. 4.4.23 - 199. Motor heating during DOL starting.





When the motor is energized the stator generates a magnetic field which induces a voltage to the squirrel cage rotor. While the rotor is not yet rotating, the induced voltage and the current it causes are at maximum in the rotor. This is due to the rotating magnetic field in the stator with synchronous speed and the rotors slip now is 1 which causes that the induced voltage to the rotor is maximum and the current is maximum also). The rotor starts to heat up very quickly compared to the stator. When the rotor is speeding up, the difference between the stator's magnetic field rotation and the rotor's magnetic field rotation decreases.

The rotor speeding up leads to the rotor current decreasing, simultaneously decreasing the rotor heating. This also makes the cooling fan start to rotate and thus cool the surface of the motor while the rotor speeds up. Depending on the size of the motor and the masses of the rotor and of the stator, the thermal capacity spent during start-up varies. The motor start-up can be rotorlimited or stator-limited, which defined which of the components limits the maximum start-up time for the motor. Most motors are rotorlimited which results in the rotor heating up to dangerously high temperatures before the stator.

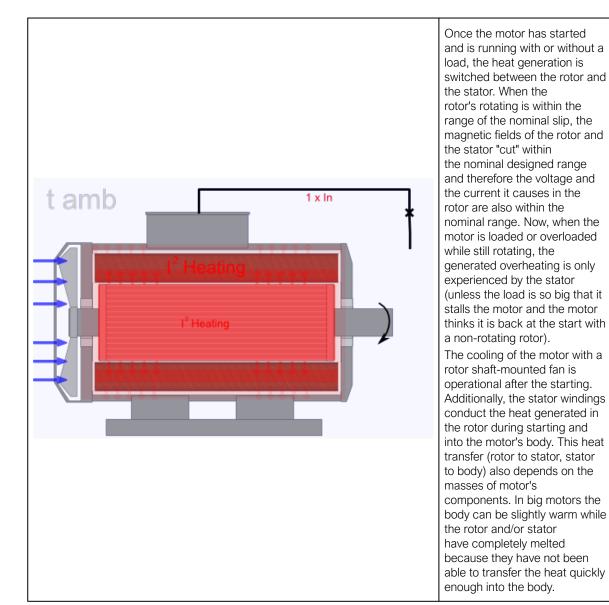
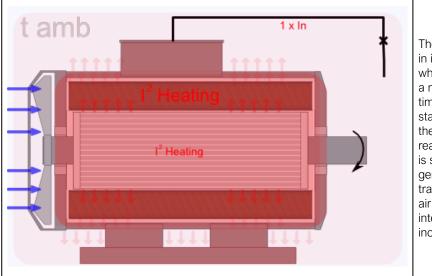
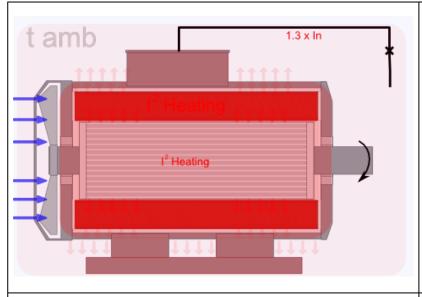


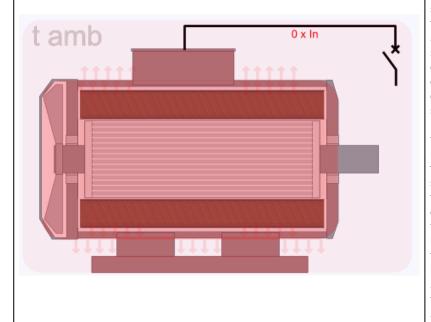
Table. 4.4.23 - 200. Motor heating during overloading and motor cooling.



The motor is said to be running in its nominal temperature, when the motor is run with a nominal load, it has enough time for the temperatures to stabilize (5 x time constant) and the final temperatures are reached. Now, the heat transfer is stabilized and the heat generated in the motor is transferred to the surrounding air and the temperatures of the internal components are not increasing any longer.



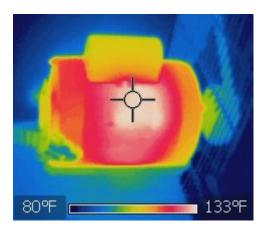
If the motor is overloaded, the stator winding starts to heat up according to its heating time constant. If the overload is not released in time, it can lead to the melting of the stator's winding insulations which in turn leads to a short-circuit; the motor is said to "burn". This situation does not differ much from the rotor's nominal conditions. When the load increases, the slip increases slightly as well and causes a small increase to the induced voltage and current. However, when rotating the heating does not differ significantly from the nominal load.



When a hot motor is deenergized the temperatures inside the motor start to stabilize. The hottest part of the motor is the rotor: its heat is transferred to the motor body through the stator windings and from the body to the surrounding air. This is why it seems that the motor body's temperature keeps rising even after a surface-cooled motor is stopped. The stopped motor cooling follows the same equation than heating, with one exception: when the surrounding air is not moving (as the fan has stopped) and the air temperature is increasing, the cooling is faster in the beginning and slows over time as the temperature difference decreases (since heat is transferred slower than in the beginning of the cooling). When the motor is run with a cyclic load, the start and stop applications for the cooling of the motor have to be modeled accurately in the thermal replica in order to avoid a situation where the calculated used thermal capacity "runs" from the actual used thermal capacity causing the protection to overshoot significantly.

The previous figures presented the thermal behavior of a motor on a theoretical level. In reality, the temperature of a rotor inside the motor windings can also be measured with RTD elements. The rotor temperature is highest on the drive end becuase the cooling is the weakest there (as can be seen in the image below).

Figure. 4.4.23 - 173. Running motor's temperature with thermal image camera.



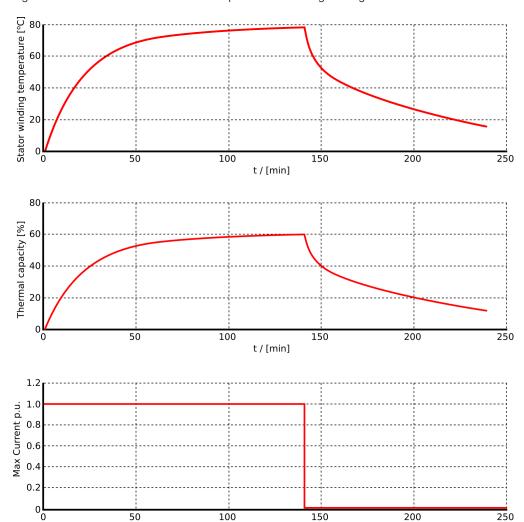
Measuring the rotor's temperature is very complicated due to its rotating nature. This is why normally there are no measurements available and why the protection of the rotor always requires a calculated thermal image. Relying solely on the measurements from RTDs installed in the motor's stator windings is not recommended as they mey not be in the actual hot spot and thus give false readings. For these reasons motor protection should not be either thermal images or RTDs but rather a combination of them both for accurate monitoring of the motor's temperature.

Thermal image modeling in protection devices require certain things to be ensured for the model to correctly match the motor thermal behavior. As was seen in the previous section, a motor usually has many states which differ from one another in terms of heating and of the parts in danger of damage. Sometimes the thermal image needs to be adjusted and fine-tuned for the application so that it matches the motor's actual temperature perfectly. This is why the thermal replica needs to offer enough setting points for various situations where the motor may be running at that time. The device needs to recognize these situations so that the thermal model can be updated correctly.

Thermal image characteristics and operating modes

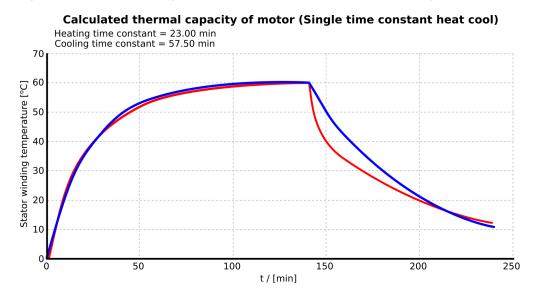
To demonstrate the various settings available in the thermal image, the following figure presents the data from a field test: a motor was loaded with a stable load, run until the final temperature was reached and then de-energized and left to cool. The motor temperature was monitored with RTDs installed into the drive end of the protection device. The motor was loaded with a nominal current, its service factor was 1.15 and the ambient temperature was measured to be 24 degrees Celsius. In this case the motor was started without a load, and the loading was increased directly after starting in order to concentrate the heating effects of stable loading.

Figure. 4.4.23 - 174. Measured motor temperature in heating/cooling test.

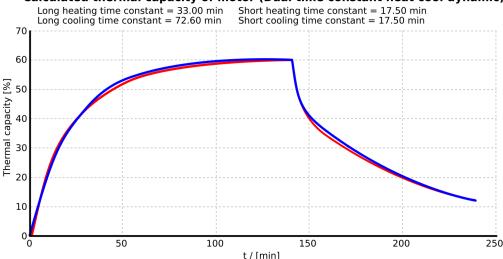


t / [min]

Figure. 4.4.23 - 175. Matching thermal replicas to the measured thermal capacity of the motor.



Calculated thermal capacity of motor (Dual time constant heat cool dynamic)

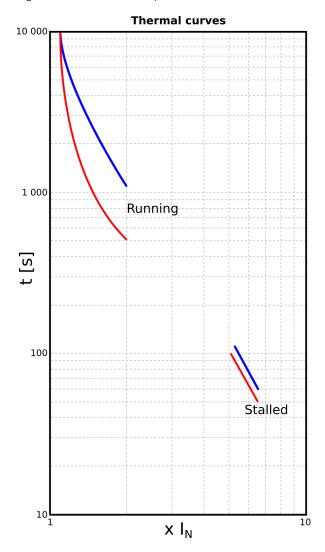


As can be seen in the figures above, when the motor is loaded with a constant current both of the replicas (single and dual time constant) follow the motor heating quite accurately. The operational difference is during cooling. With a single cooling time constant the replica does not follow the actual cooling of the motor and the match can be said to be very poor. With dynamically-controlled cooling time constants the match is very accurate. If this motor were used for cyclic loads with repeating cooling times, the single time constant model would stretch into the next duty cycle and probably cause unnecessary alarms or even trips eventhough the motor were till running in safe temperatures.

Thermal trip curves

Motor thermal curves are useful when studying motor heating in possible overload and start-up situations. These are usually available upon request from manufacturers, and the function operation can be set according to these.

Figure. 4.4.23 - 176. Example of thermal limit curves in a motor.



From motor thermal limit curves –if available– one can see the time constants for overloading as well as the safe stall times for hot and cold situations. Additionally, the cooling time constant must be checked from the motor datasheet or alternatively measured. From the image above one can estimate the safe stall time in cold situations to be approximately 80 seconds, and in hot situation approximately 67 seconds. When the thermal limit curves are available, the operation of the thermal replica can be set very accurately for both overloading and stall conditions.

The cooling time constant as presented in the previous example is very crucial in the case of variable duty cycle motor applications. If the motor is continuously running with a constant load, the cooling time constant is not that significant and can be estimated to be e.g. two to three times longer than the heating time constant.

Figure. 4.4.23 - 177. Comparing single time constant thermal replica tripping curves to given motor thermal characteristics.

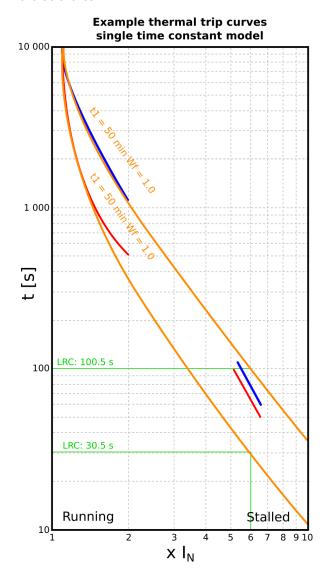
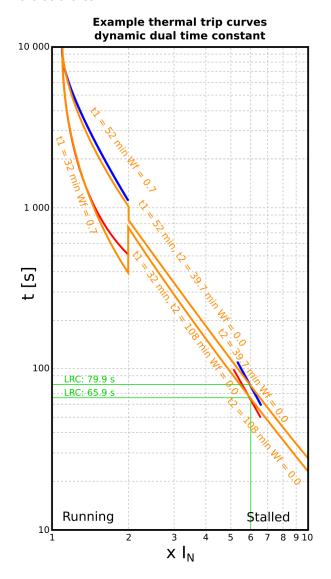


Figure. 4.4.23 - 178. Comparing dual time constant thermal replica tripping curves to given motor thermal characteristics.



As the figures above have shown, with estimated time constants from the motor thermal limit curves the single time constant model underprotects the motor in the stall condition when the motor is cold. When the motor is hot the model overprotects with a heavy hand, allowing the motor only 30.5 seconds of stalling time of the approximately 67 seconds the motor can withstand. When dual time constants and dynamic time constants are in use, the function automatically selects the correct tripping curves for the thermal replica according to the settings, producing therefore an exact thermal image response (as compared to the single time constant thermal image). In overload conditions the response from both of the thermal replicas is acceptable as even a small overshoot is noticed when the motor is hot. In the curve simulations the hot condition was defined as 70 % of the thermal capacity.

The following figures present the tripping and cooling curves of the thermal replica.

Figure. 4.4.23 - 179. Thermal tripping curves with single time constant, pre-load 0% (cold).

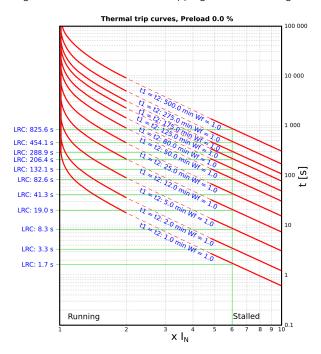


Figure. 4.4.23 - 180. Thermal tripping curves with single time constant, pre-load 90% (hot).

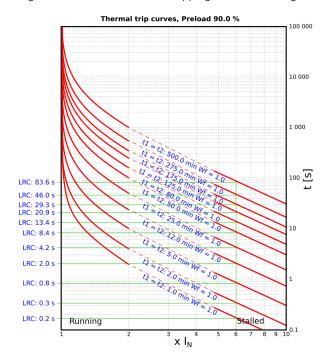


Figure. 4.4.23 - 181. Thermal tripping curves with dual dynamic time constants and correction factor, pre-load 0% (cold)

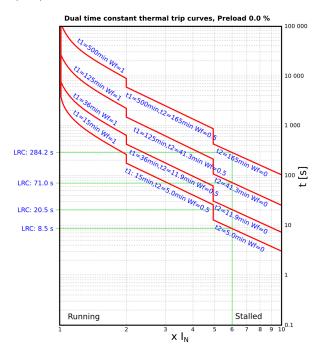


Figure. 4.4.23 - 182. Thermal tripping curves with dual dynamic time constants and correction factor, pre-load 90% (hot).

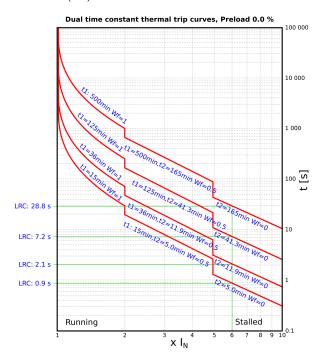


Figure. 4.4.23 - 183. Thermal cooling curves, single cooling time constant.

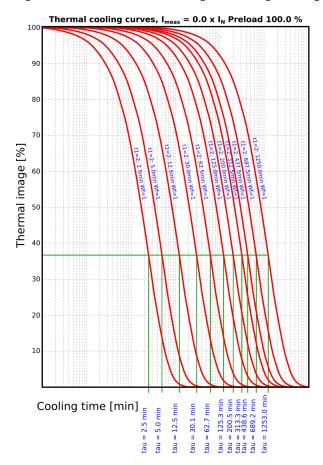


Figure. 4.4.23 - 184. Thermal cooling curves, dynamic dual time constant.

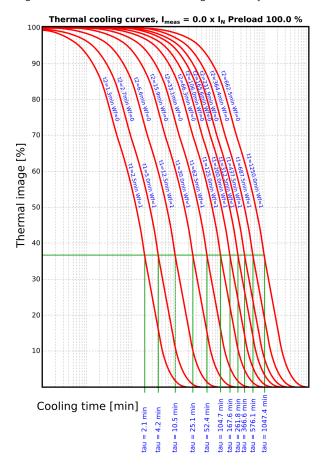


Figure. 4.4.23 - 185. Thermal cooling curves, dynamic triple time constant (motor is running without load in the first part with dedicated time constant).

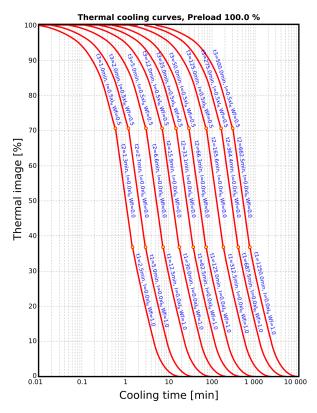


Figure. 4.4.23 - 186. NPS-biased thermal trip curves with k_{NPS} value of 1.

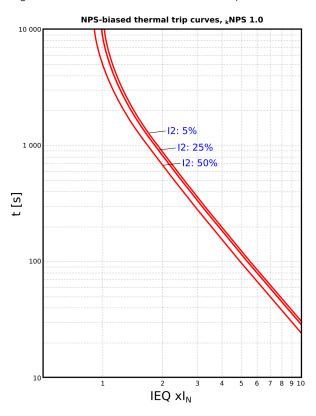


Figure. 4.4.23 - 187. NPS-biased thermal trip curves with k_{NPS} value of 3.

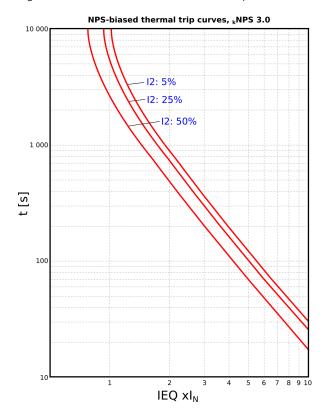


Figure. 4.4.23 - 188. NPS-biased thermal trip curves with kNPS value of 7.

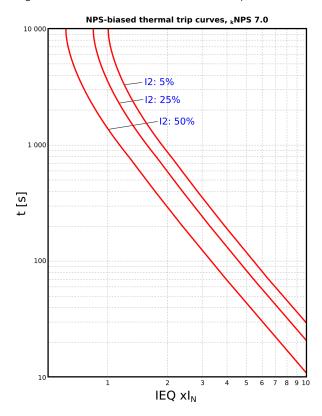
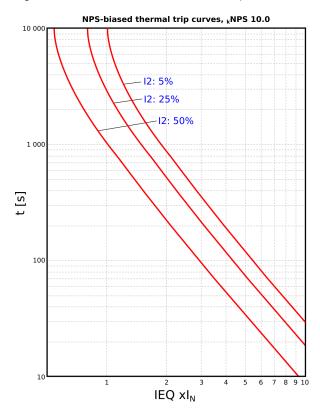


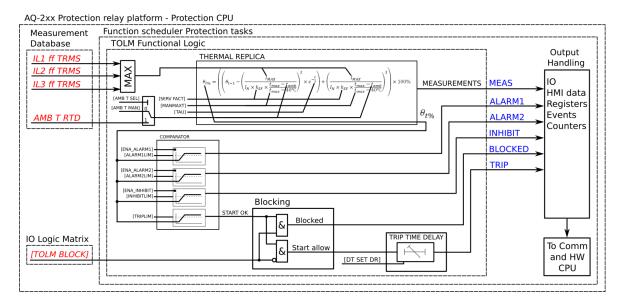
Figure. 4.4.23 - 189. NPS-biased thermal trip curves with k_{NPS} value of 10.



Function inputs and outputs

The blocking signal and the setting group selection control the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running. The function has a total of eight (8) setting groups available.

Figure. 4.4.23 - 190. Simplified function block diagram of the TM> function.



Measured input

The function block uses phase current measurement values. The function block uses TRMS values from the whole harmonic specter of 32 components. RTD measurement can be used for measuring the ambient temperature.

Table. 4.4.23 - 201. Measurement inputs of the TM> function.

Signal	Description
I _{L1} TRMS	TRMS measurement of phase L1 (A) current
I _{L2} TRMS	TRMS measurement of phase L2 (B) current
I _{L3} TRMS	TRMS measurement of phase L3 (C) current
RTD	Temperature measurement for the ambient correction

Setting parameters

Table. 4.4.23 - 202. General settings (not selectable under setting groups)

Name	Range	Default	Description
TM> mode	DisabledActivated	Disabled	The selection of the function is activated or disabled in the configuration. By default it is not in use.

Name	Range	Default	Description
TM> Status Force to	 Normal Blocked Alarm1 On Alarm2 On Inhibit On Trip On 	Normal	Force the status of the function. Visible only when <i>Enable stage</i> forcing parameter is enabled in <i>General</i> menu.
Temp C or F deg	• C • F	С	The selection of whether the temperature values of the thermal image and RTD compensation are shown in Celsius or in Fahrenheit.

Table. 4.4.23 - 203. Settings of the motor status monitoring function and how they are shared by other protection functions.

Name	Range	Step	Default	Prot.funcs.	Description
Motor In Scaled	0.140.0xI _n	0.1xl _n	-	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (Ist>; 48/14) - non-directional undercurrent protection (I<; 37) - mechanical jam protection (Im>; 51M)	The motor's nominal current scaled to per unit. If the user selects <i>Object In</i> in the CT settings, this value should be 1.00. If scaled to the CT nominal, this value may vary.
Motor In A	0.1 5000.0A	0.1A	-	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - non-directional undercurrent protection (I<; 37) - mechanical jam protection (lm>; 51M)	The motor's nominal current in amperes.

Name	Range	Step	Default	Prot.funcs.	Description
Nominal starting current	0.140.0xl _n	0.1xl _n	6.0xIn	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (Im>; 51M)	The motor's locked rotor current with the nominal voltage. This setting is used for automatic curve selection and calculation. Also, the nominal starting capacity calculation is based on this value.
Nominal starting current A	0.15000.0A	0.1A	-	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (lm>; 51M)	The motor's locked rotor current in amperes.
Min locked rotor current	0.140.0xl _n	0.1xl _n	3.5xIn	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (lm>; 51M)	The motor's minimum locked rotor current. This setting defines the current limit for when this current is exceeded while the automatic curve selection and the control only short time constant (stall) are in use.
Min locked rotor current A	0.15000.0A	0.1A	-	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (lm>; 51M)	The motor's minimum locked rotor current. This setting defines the current limit for when this current is exceeded while the automatic curve selection and the control only short time constant (stall) are in use.

Name	Range	Step	Default	Prot.funcs.	Description
Max locked rotor current	0.140.0xln	0.1xl _n	7.5xln	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (lm>; 51M)	The maximum locked rotor current of the motor. This setting defines the current limit which is maximum current for the motor to draw in locked rotor situation (starting or stalled). If the measured current exceeds this setting limit it is considered to be overcurrent fault and corresponding measures can be applied to disconnect the feeder and motor from the supply.
Max locked rotor current A	0.15000.0A	0.1A	-	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (lm>; 51M)	The maximum locked rotor current in amperes.
Max overload current	0.140.0xl _n	0.1xl _n	2.0xl _n	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (lm>; 51M)	The motor's maximum overload current. Exceeding this setting stalls the motor. This setting defines when the thermal replica switches to the short (stall) time constant. As long as the current stays below this setting value, the motor should run even when overloaded.
Max overload current A	0.15000.0A	0.1A	-	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (lm>; 51M)	The maximum overload current of the motor in amperes.

Name	Range	Step	Default	Prot.funcs.	Description
No load current <	0.140.0xln	0.1xl _n	0.2xl _n	- motor status monitoring - machine thermal overload protection (TM>; 49M) - non- directional undercurrent protection (I<; 37)	The motor's no load current. This setting defines the "Stopped" condition when the current is below this setting value. Also, when the current is below this value, the undercurrent protection stage is locked.
No load current < A	0.15000.0A	0.1A	-	- motor status monitoring - machine thermal overload protection (TM>; 49M) - non- directional undercurrent protection (I<; 37)	The motor's no load current in amperes.
Motor service factor	0.015.00xl _n	0.01xl _n	1.00xl _n	- motor status monitoring - machine thermal overload protection (TM>; 49M)	Service factor which corrects the maximum allowed loading according to various conditions (e.g. installation, construction, etc.) which vary from the presumption conditions. Frequently motors are stamped to a service factor of 1.15: this means that they can withstand a continuous 15% overloading from the rated current (as this is not necessary in all conditions, it is recommended to consult the motor's datasheet or manual for details). If the service factor is not known, this parameter should be left at its default setting of 1.00 x I_n .
Hot condition theta limit	0.0100.0%	0.1%	70%	- motor status monitoring - frequent start protection (N>) - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (lm>; 51M)	Setting the thermal limit for a hot motor and a cold motor. When this setting value is not exceeded while a locked rotor situation occurs, the function uses a cold stall curve adjusted with the actually used thermal capacity. The function uses a hot stall curve when this setting value is exceeded. This also applies to starts when the motor is hot or cold. Please note that using this setting requires that the Machine thermal overload protection (TM>) function is activated and in use.

Name	Range	Step	Default	Prot.funcs.	Description
Safe stall time cold	0.1600.0s	0.1s	20.0s	- motor status monitoring - machine thermal overload protection (TM>; 49M) - motor start/ locked rotor monitoring (lst>; 48/14) - mechanical jam protection (Im>; 51M) - frequent start protection (N>; 66)	The safe stall time when the motor is cold. Unless this value is specified, it is set to be equal to the hot stall time. Most probably this leads to overprotection with the cold motor stall (best case scenario). This setting value is used for the cold thermal stall curve selection in automatic control. This parameter is also used in the motor start-up and the number of starts calculations.
Safe stall time hot	0.1600.0s	0.1s	15.0s	- motor status monitoring - machine thermal overload protection (TM>; 49M) - Motor start/ locked rotor monitoring (Ist>; 48/14) - mechanical jam protection (Im>; 51M) - frequent start protection (N>; 66)	The safe stall time when the motor is hot. This setting value is used for the hot thermal stall curve selection in automatic control. This parameter is also used in the motor start-up and the number of starts calculations.

Table. 4.4.23 - 204. Motor's thermal image settings.

Name	Range	Step	Default	Description
Pick-up current	0.0040.00xI _n	0.01xl _n	1.00xl _n	The current for 100 % thermal capacity to be used (the pick-up current in p.u., this current t_{max} achieved in $t \times 5$).
NPS- biasing in use	No NPS-biasing NPS-biasing in use	-	No NPS- biasing in use	The selection of whether or not the thermal replica reference current is biased with the NPS current.
NPS-bias factor	0.110.0	0.1	3.0	The negative sequence current biasing factor. This factor depends on the motor's construction and is in relation to the positive and negative sequence rotor resistances. A typical value for this is the default setting 3.0.
Time constants	SingleMultiple	-	Single	The selection of whether the thermal replica uses single or multiple heating and cooling time constants. If "Single" is selected, only the time constants Long heating (cold) and Long cool Stop are shown. If "Multiple" is selected, all available time constants are shown.

Name	Range	Step	Default	Description
Estimate short TC and timings	Set manually Estimate (online)	-	Set manually	The selection of whether the function estimates short time constants for heating and cooling. It also selects the timing for short and long time constants when the motor is stopped.
Long heat T const (cold)	0500.0min	1.0min	10.0min	The setting for the long heating time constant. This setting is for "Cold" motor conditions and is used when the calculated thermal capacity is below the set value for "Hot condition theta limit".
Long heat T const (hot)	0500.0min	1.0min	10.0min	The setting for the long heating time constant. This setting is for "Hot" motor conditions and is used when the calculated thermal capacity is above the set value for "Hot condition theta limit". This setting can be modified for when the motor's thermal characteristics vary between "hot" and "cold" situation. If the characteristics do not change, this setting should be the same as the setting value of "Long heat T const (cold)". This setting is visible when the time constant option "Multiple" is selected.
Long cool T const Run	03000.0min	1.0min	10.0min	The setting for the long cooling time constant for the "Run" condition of the motor. When the motor cools while running, its time constant is not the same as the stopped cooling constant but instead typically a lot shorter (since the motor cooling fan is active). This setting may need the testing of the motor cooling characteristics. If unknown, this setting should be the same as the setting value of "Long Cool T const Stop" (slower cooling) or "Long heat T const" (faster cooling). This setting is visible when the time constant option "Multiple" is selected.
Long cool T const Stop	03000.0min	1.0min	10.0min	The setting for the stopped motor cooling time constant. When the motor is stopped, the thermal replica calculates the cooling according to this setting value. Typically this time constant is about 2.5 – 3.5 times the heating time constant.
Short heat T const (cold)	0500.0min	1.0min	10.0min	The setting for short heating time constant for "cold" motor status. This time constant defines the locked rotor and stalled tripping curve selection. While this setting is not the safe stall time directly, it defines the used tripping curve for the locked rotor condition. This setting is visible when the time constants option "Multiple" and the "Set manually" option from "Estimate short TC and timings" are both selected.
Short heat T const (cold) est	0500.0min	1.0min	10.0min	The estimated setting for short heating time constant for "cold" motor status. This time constant defines the locked rotor and stalled tripping curve selection. This setting value is calculated based on the information given by the locked rotor current (LRC) and the cold safe stall time. This setting value is visible when the time constants option "Multiple" and the "Estimate" option from "Estimate short TC and timings" are both selected.
Short heat T const (hot)	0500.0min	1.0min	10.0min	The setting for short heating time constant for "hot" motor status. This time constant defines the locked rotor and stalled tripping curve selection. While this setting is not the safe stall time directly, it defines the used tripping curve for the locked rotor condition. This setting is visible when the time constants option "Multiple" and the "Set manually" option from "Estimate short TC and timings" are both selected.

Name	Range	Step	Default	Description
Short heat T const (hot) est	0500.0min	1.0min	10.0min	The estimated setting for short heating time constant for "hot" motor status. This time constant defines the locked rotor and stalled tripping curve selection. This setting value is calculated based on the information given by the LRC and the hot safe stall time. This setting value is visible when the time constants option "Multiple" and the "Estimate" option from "Estimate short TC and timings" are both selected.
Short cool T const	03000.0min	1.0min	10.0min	The setting for the short cooling time constant. This value is the same for both running and stopped conditions, and typically it is the same between heating and cooling. This setting is visible when the time constants option "Multiple" and the "Set manually" option from "Estimate short TC and timings" are both selected.
Wf factor for L/S T const	0.01.0	0.1	0.5	The correction factor between the currently used long and short time constants. With this setting the heating and cooling calculations can be fine-tuned. A setting value of 0.5 means that 50 % of the heating or cooling calculation is based on the long time constant and another 50 % is based on the short time constant. A setting value of 0.0 means the calculation is completely based on the short time constant, while a value of 1.0 means it its completely based on the long time constant. This setting value is visible when the time constants option "Multiple" is selected.
T const dyn. balancing	• Fixed • Dynamic	-	Fixed	The selection of whether or not the thermal replica balances and switches the time constants dynamically based on the detected motor status. The switching is based on the settings given for maximum overload current and for minimum locked rotor current. If "Dynamic" is selected, the thermal replica switches the time constants. If "Fixed" is selected, no time constants are switched. This setting value is visible when the time constants option "Multiple" is selected.
Short cool T used when stop	0.03000min	0.1min	30.0min	The setting for how long the short cooling time constant is used when the motor is stopped. The cooling is typically faster in right after the motor has stopped. This setting may need adjusting depending on the application for a perfect match. This setting value is visible when the time constansts option "Multiple" is selected.
Short cool T used when stop (est)	0.03000min	0.1min	30.0min	The estimated setting for how long the short cooling time constant is used when the motor is stopped. The cooling is typically faster right after the motor has stopped. This setting value is visible when the time constansts option "Multiple" is selected.
Cold reset default theta	0.0150.0%	0.1%	60.0%	The default theta when the function is restarted. It is also possible to fully reset the thermal element. This parameter can be used when testing the function to manually set the current thermal cap to any value.

Table. 4.4.23 - 205. Environmental settings

Name	Range	Step	Default	Description
Dev. temp (tmax)	• A • B • F • H • Manual set	-	F	The maximum allowed temperature for the protected object. The default setting is "F" which is +155 °C.
Obj. max. temp (tmax = 100 %)	0500 deg	1 deg	125 deg	Visible when the Dev. temp. (tmax) is set to "4: Manual set".
Ambient temp. sel.	Manual set RTD	-	Manual set	The selection of whether the thermal image biasing uses a fixed or a measured ambient temperature.
Man. amb. temp. set.	0500 deg	1 deg	40 deg	The manual fixed ambient temperature setting for thermal image biasing. Underground cables commonly use +15 °C. This setting is visible if "Ambient temp. sel." is set to "Manual set".
RTD amb. temp. read.	0500 deg	1 deg	40 deg	The RTD ambient temperature reading for the thermal image biasing. This setting is visible if "Ambient temp. sel." is set to "RTD".
Ambient lin. or curve	Linear est.Set curve	-	Linear est	The selection of how to correct the ambient temperature, either by internally calculated compensation based on end temperatures or by a user-settable curve. The default setting is "Linear est." which means the internally calculated correction for ambient temperature.
Temp. reference (tref) kamb = 1.0	-60500 deg	1 deg	15 deg	The temperature reference setting. The manufacturer's temperature presumptions apply and the thermal correction factor is 1.00 (rated temperature). For underground cables the set value for this is usually 15 °C and for cables in the air it is usually 25 °C. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
Max. ambient temp.	0500 deg	1 deg	45 deg	The maximum ambient temperature setting. If the measured temperature is more than the maximum set temperature, the set correction factor for the maximum temperature is used. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
k at max. amb. temp.	0.015.00 x In	0.01 x I _n	1.00 x In	The temperature correction factor for the maximum ambient temperature setting. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
Min. ambient temp.	-60500 deg	1 deg	0 deg	The minimum ambient temperature setting. If the measured temperature is below the minimum set temperature, the set correction factor for minimum temperature is used. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
k at min. amb. temp.	0.015.00 x I _n	0.01 x I _n	1.00 x I _n	The temperature correction factor for the minimum ambient temperature setting. This setting is visible if "Ambient lin. or curve" is set to "Linear est."
Amb. temp. ref. 110	-50.0500.0 deg	0.1 deg	15 deg	The temperature reference points for the user-settable ambient temperature coefficient curve. This setting is visible if "Ambient lin. or curve" is set to "Set curve".

Name	Range	Step	Default	Description
Amb. temp. k1k10	0.015.00	1.00	0.01	The coefficient value for the temperature reference point. The coefficient and temperature reference points must be set as pairs. This setting is visible if "Ambient lin. or curve" is set to "Set curve".
Add curvepoint 310	Not used Used	-	Not used	The selection of whether or not the curve temperature/coefficient pair is in use. The minimum number to be set for the temperature/coefficient curve is two pairs and the maximum is ten pairs. If the measured temperature is below the set minimum temperature reference or above the maximum set temperature reference, the used temperature coefficient is the first or last value in the set curve. This setting is visible if "Ambient lin. or curve" is set to "Set curve".

Operating characteristics

The operating characteristics of the machine thermal overload protection function are completely controlled by the thermal image. The thermal capacity value calculated from the thermal image can set the I/O controls with ALARM 1, ALARM 2, INHIBIT and TRIP signals.

Table. 4.4.23 - 206. Pick-up settings.

Name	Range	Step	Default	Description	
Enable TM> Alarm 1	DisabledEnabled	-	Disabled	Enabling/disabling the ALARM 1 signal and the I/O.	
TM> Alarm 1 level	0.0150.0 %	0.1	40 %	ALARM 1 activation threshold.	
Enable TM> Alarm 2	DisabledEnabled	-	Disabled	Enabling/disabling the ALARM 2 signal and the IO.	
TM> Alarm 2 level	0.0150.0 %	0.1	40 %	ALARM 2 activation threshold.	
Enable TM> Rest Inhibit	DisabledEnabled	-	Disabled	Enabling/disabling the INHIBIT signal and the IO.	
TM> Inhibit level	0.0150.0 %	0.1	80 %	INHIBIT activation threshold.	
TM> Trip level	0.0150.0 %	0.1	100 %	TRIP activation threshold.	
TM> Trip delay	0.0003600.000 s	0.005 s	0.000 s	The trip signal's additional delay. This delay delays the trip signal generation by a set time. The default setting is 0.000 s which does not give an added time delay for the trip signal.	

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and processes the release time characteristics similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Measurements and indications

The function outputs measured process data from the following magnitudes:

Table. 4.4.23 - 207. General status codes.

Name	Range	Description
TM> Condition	NormalAlarm 1 ONAlarm 2 ONInhibit ONTrip ONBlocked	The function's operating condition. No outputs are controlled when the status is "Normal".
Motor status	StoppedStalledJust StoppedOverloadingRunning normal	The function's thermal image status. When the measured current is below 1 % of the nominal current, the status "Light/No load" is shown. When the measured current is below the trip limit, the status "Load normal" is shown. When the measured current is above the pick-up limit but below $2 \times I_n$, the status "Overloading" is shown. When the measured current is above $2 \times I_n$, the status "High overload" is shown.
TM> Setting alarm	SF setting ok Service factor set fault. Override to 1.0	Indicates if SF setting has been set wrong and the actually used setting is 1.0. Visible only when there is a setting fault.
TM> Setting alarm	 Ambient setting ok Ambient t set fault. Override to 1.0 	Indicates if ambient temperature settings have been set wrong and actually used setting is 1.0. Visible only when there is a setting fault.

Name	Range	Description
TM> Setting alarm	 Nominal current calc ok Nominal current set fault. Override to 1.0 	Indicates if nominal current calculation is set wrong and actually used setting is 1.0. Visible only when there is a setting fault.
TM> Setting alarm	Ambient setting okInconsistent setting of ambient k	Indicates if ambient k setting has been set wrong. Visible only when there is a setting fault.

Table. 4.4.23 - 208. Measurements.

Name	Range	Description / values		
Currents	Primary ASecondary APer unit	The active phase current measurement from IL1 (A), IL2 (B) and IL3 (C) phases in given scalings.		
Thermal image calc.		- TM> Trip expect mode: No trip expected/Trip expected - TM> Time to 100 % theta: Time to reach the 100 % thermal cap - TM> Rreference T curr.: reference/pick-up value (IEQ) - TM> Active meas. curr.: the measured maximum TRMS current at a given moment - TM> T est. with act. curr.: estimation of the used thermal capacity including the current at a given moment - TM> T at a given moment: the thermal capacity used at that moment		
Thermal image	Temp. estimates	- TM> Used k for amb. temp: the ambient correction factor at a givenmoment - TM> Max. temp. rise all.: the maximum allowed temperature rise - TM> Temp. rise atm: the calculated temperature rise at a given moment - TM> Hot spot estimate: the estimated hot spot temperature including the ambient temperature - TM> Hot spot max. all.: the maximum allowed temperature for the object		
	Timing status	- TM> Trip delay remaining: the time to reach 100% theta - TM> Trip time to rel.: the time to reach theta while staying below the trip limit during cooling - TM> Alarm 1 time to rel.: the time to reach theta while staying below the Alarm 1 limit during cooling - TM> Alarm 2 time to rel.: the time to reach theta while staying below the Alarm 2 limit during cooling - TM> Inhibit time to rel.: the time to reach theta while staying below the Inhibit limit during cooling		

Table. 4.4.23 - 209. Counters.

Name	Description / values
Alarm1 inits	The number of times the function has activated the Alarm 1 output
Alarm2 inits	The number of times the function has activated the Alarm 2 output

Name	Description / values			
Restart inhibits	The number of times the function has activated the Restart inhibit output			
Trips	The number of times the function has tripped			
Trips Blocked	The number of times the function trips has been blocked			

Events and registers

The machine thermal overload protection function (abbreviated "TOLM" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's output signals can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the TRIP, ALARM 1, ALARM 2, INHIBIT and BLOCKED events.

Table. 4.4.23 - 210. Event messages.

Event block name	Description
TOLM1	Alarm1 ON
TOLM1	Alarm1 OFF
TOLM1	Alarm2 ON
TOLM1	Alarm2 OFF
TOLM1	Inhibit ON
TOLM1	Inhibit OFF
TOLM1	Trip ON
TOLM1	Trip OFF
TOLM1	Block ON
TOLM1	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for TRIP, BLOCKED, etc. signals. The table below presents the structure of the function's register content.

Table. 4.4.23 - 211. Register content.

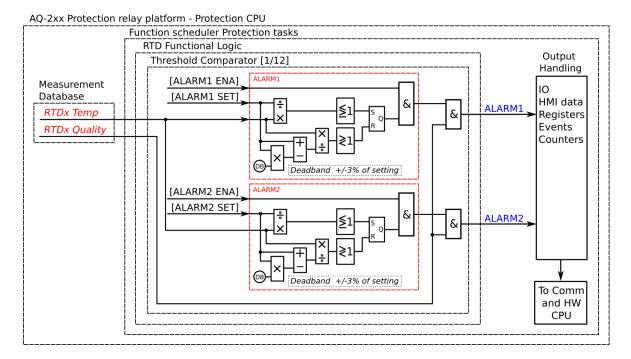
Name	Event names
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Time to reach 100 % theta	seconds
Ref. T current	x I _n

Name	Event names
Active meas. current	x I _n
T at a given moment	%
Max. temp. rise allowed	degrees
Temp. rise at a given moment	degrees
Hot spot estimate	degrees
Hot spot max. all.	degrees
Trip delay rem.	Remaining time to trip in seconds
Setting group in use	Setting group 18 active

4.4.24 Resistance temperature detectors (RTD)

Resistance temperature detectors (or RTDs) can be used to measure both temperatures of motors/ generators and ambient temperatures. Typically an RTD is a thermocouple or of type PT100. Up to three (3) separate RTD modules based on an external Modbus are supported; each can hold up to eight (8) measurement elements. Up to two (2) separate RTD option cards are supported by this function. Sixteen (16) individual element monitors can be set for this alarm function, and each of those can be set to alarm two (2) separate alarms from one selected input. The user can set alarms and measurements to be either in degrees Celsius or Fahrenheit.

Figure. 4.4.24 - 191. Simplified function block diagram of the resistance temperature detection function.



Settings

Setting up an RTD measurement, the user first needs to set the measurement module to scan the wanted RTD elements. A multitude of Modbus-based modules are supported. Communication requires bitrate, databits, parity, stopbits and Modbus I/O protocol to be set; this is done at $Communication \rightarrow Connections$. Once communication is set, the wanted channels are selected at $Communication \rightarrow Protocols \rightarrow ModbusIO$. Then the user selects the measurement module from the three (3) available modules (A, B and C), as well as the poll address. Additionally, both the module type and the polled channels need to be set. When using a thermocouple module, the thermo element type also needs to be set for each of the measurement channels. Once these settings are done the RTDs are ready for other functions.

Table. 4.4.24 - 212. Function settings for Channel x (Sx).

Name	Range	Step	Default	Description
S1S16 enable	No Yes	-	No	Enables/disables the selecion of sensor measurements and alarms.
S1S16 module	InternalRTD1 InternalRTD2 ExtModuleA ExtModuleB ExtModuleC	-	InternalRTD1	Selects the measurement module. Internal RTD modules are option cards installed to the device. External modules are Modbus based external devices.
S1S16 channel	 Channel 0 Channel 1 Channel 2 Channel 3 Channel 4 Channel 5 Channel 6 Channel 7 	-	Channel 0	Selects the measurement channel in the selected module.
S1S16 Deg C/Dec F	Deg C Deg F	-	Deg C	Selects the measurement temperature scale (Celsius or Fahrenheit).
S1S16 Measurement	-	-	-	Displays the measurement value in the selected temperature scale.
S1S16 Sensor	Ok Invalid	-	-	Displays the measured sensor's data validity. If the sensor reading has any problems, the sensor data is set to "Invalid" and the alarms are not activated.
S1S16 Enable alarm	DisableEnable	-	Disable	Enables/disables the selection of Alarm 1 for the measurement channel x.
S1S16 Alarm1 >/<	• >	-	>	Selects whether the alarm activates when measurement is above or below the pick-up setting value.
S1S16 Alarm1	-101.02000.0deg	0.1deg	0.0deg	Sets the pick-up value for Alarm 1. The alarm is activated if the measurement goes above or below this setting mode (depends on the selected mode in "Sx Alarm1 >/<").

Name	Range	Step	Default	Description
S1S16 sensor	Ok Invalid	-	-	Displays the measured sensor's data validity. If the sensor reading has any problems, the sensor data is set to "Invalid" and the alarms are not activated.
S1S16 Enable alarm 2	Disable Enable	-	Disable	Enables/disables the selection of Alarm 2 for the measurement channel x.
S1S16 Alarm2 >/<	• >	-	>	Selects whether the measurement is above or below the setting value.
S1S16 Alarm2	-101.02000.0deg	0.1deg	0.0deg	Sets the value for Alarm 2. The alarm is activated if the measurement goes above or below this setting mode (depends on the selected mode in "Sx Alarm2 >/<").

Function can be set to monitor the measurement data from previously set RTD channels. A single channel can be set to have several alarms if the user sets the channel to multiple sensor inputs. In each sensor setting the user can select the monitored module and channel, as well as the monitoring and alarm setting units (°C or °F). The alarms can be enabled, given a setting value (in degrees), and be set to trigger either above or below the setting value. There are sixteen (16) available sensor inputs in the function. An active alarm requires a valid channel measurement. It can be invalid if communication is not working or if a sensor is broken.

When the RTDs have been set, the values can be read to SCADA (or some other control system). The alarms can also be used for direct output control as well as in logics.

Events

The resistance temperature detector function (abbreviated "RTD" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the ALARM events.

The function offers sixteen (16) independent stages; the events are segregated for each stage operation.

Table. 4.4.24 - 213. Event messages.

Event block name	Event names
RTD1	S1S16 Alarm1 ON
RTD1	S1S16 Alarm1 OFF
RTD1	S1S16 Alarm2 ON
RTD1	S1S16 Alarm2 OFF
RTD1	S1S16 Meas Ok
RTD1	S1S16 Meas Invalid

4.4.25 Programmable stage (PSx>/<; 99)

The programmable stage is a stage that the user can program to create more advanced applications, either as an individual stage or together with programmable logic. The device has ten programmable stages, and each can be set to follow one to three analog measurements. The programmable stages have three available pick up terms options: overX, underX and rate-of-change of the selected signal. Each stage includes a definite time delay to trip after a pick-up has been triggered.

The programmable stage cycle time is 5 ms. The pick-up delay depends on which analog signal is used as well as its refresh rate (typically under a cycle in a 50 Hz system).

The number of programmable stages to be used is set in the *INFO* tab. When this function has been set as "Activated", the number of programmable stages can be set anywhere between one (1) and ten (10) depending on how many the application needs. In the image below, the number of programmable stages have been set to two which makes PS1 and PS2 to appear. Inactive stages are hidden until they are activated.

Please note that setting the number of available stages does not activate those stages, as they also need to be enabled individually with the *PSx* >/< *Enabled* parameter. When enabled an active stage shows its current state (condition), the expected operating time and the time remaining to trip under the activation parameters. If a stage is not active the *PSx*>/< *condition* parameter will merely display "Disabled".

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Analog values

The numerous analog signals have been divided into categories to help the user find the desired value.

Table. 4.4.25 - 214. Phase and residual current measurements (IL1, IL2, IL3, Io1 and Io2)

Name	Description
ILx ff (p.u.)	Fundamental frequency RMS value (in p.u.)
ILx 2 nd h.	ILx 2 nd harmonic value (in p.u.)
ILx 3 rd h.	ILx 3 nd harmonic value (in p.u.)
ILx 4 th h.	ILx 4 nd harmonic value (in p.u.)
ILx 5 th h.	ILx 5 nd harmonic value (in p.u.)
ILx 7 th h.	ILx 7 nd harmonic value (in p.u.)
ILx 9 th h.	ILx 9 nd harmonic value (in p.u.)
ILx 11 th h.	ILx 11 nd harmonic value (in p.u.)
ILx 13 th h.	ILx 13 nd harmonic value (in p.u.)
ILx 15 th h.	ILx 15 nd harmonic value (in p.u.)
ILx 17 th h.	ILx 17 nd harmonic value (in p.u.)

Name	Description
ILx 19 th h.	ILx 19 nd harmonic value (in p.u.)
ILx TRMS	ILx TRMS value (in p.u.)
ILx Ang	ILx Angle (degrees)

Table. 4.4.25 - 215. Other current measurements

Name	Description
IOZ Mag	Zero sequence current value (in p.u.)
IOCALC Mag	Calculated I0 value (in p.u.)
I1 Mag	Positive sequence current value (in p.u.)
I2 Mag	Negative sequence current value (in p.u.)
I0CALC Ang	Angle of calculated residual current (degrees)
I1 Ang	Angle of positive sequence current (degrees)
I2 Ang	Angle of negative sequence current (degrees)
I01ResP	I01 primary current of a current-resistive component
I01CapP	I01 primary current of a current-capacitive component
I01ResS	I01 secondary current of a current-resistive component
I01CapS	I01 secondary current of a current-capacitive component
I02ResP	I02 primary current of a current-resistive component
I02CapP	I02 primary current of a current-capacitive component
I02ResS	I02 secondary current of a current-resistive component
I02CapS	I02 secondary current of a current-capacitive component

Table. 4.4.25 - 216. Voltage measurements

Name	Description
UL12Mag	UL12 Primary voltage V
UL23Mag	UL23 Primary voltage V
UL31Mag	UL31 Primary voltage V
UL1Mag	UL1 Primary voltage V
UL2Mag	UL2 Primary voltage V
UL3Mag	UL3 Primary voltage V
UL12Ang	UL12 angle (degrees)

Name	Description
UL23Ang	UL23 angle (degrees)
UL31Ang	UL31 angle (degrees)
UL1Ang	UL1 angle (degrees)
UL2Ang	UL2 angle (degrees)
UL3Ang	UL3 angle (degrees)
U0Ang	UL0 angle (degrees)
U0CalcMag	Calculated residual voltage
U1 pos.seq.V Mag	Positive sequence voltage
U2 neg.seq.V Mag	Negative sequence voltage
U0CalcAng	Calculated residual voltage angle (degrees)
U1 pos.seq.V Ang	Positive sequence voltage angle (degrees)
U2 neg.seq.V Ang	Negative sequence voltage angle (degrees)

Table. 4.4.25 - 217. Power measurements

Name	Description
S3PH	Three-phase apparent power S (kVA)
РЗРН	Three-phase active power P (kW)
Q3PH	Three-phase reactive power Q (kvar)
tanfi3PH	Three-phase active power direction
cosfi3PH	Three-phase reactive power direction
SLx	Phase apparent power L1 / L2 / L3 S (kVA)
PLx	Phase active power L1 / L2 / L3 P (kW)
QLx	Phase reactive power L1 / L2 / L3 Q (kVar)
tanfiLx	Phase active power direction L1 / L2 / L3
cosfiLx	Phase reactive power direction L1 / L2 / L3

Table. 4.4.25 - 218. Phase-to-phase and phase-to-neutral impedances, resistances and reactances

Name	Description
RLxPri	Resistance R L12, L23, L31, L1, L2, L3 primary (Ω)
XLxPri	Reactance X L12, L23, L31, L1, L2, L3 primary (Ω)
ZLxPri	Impedance Z L12, L23, L31, L1, L2, L3 primary (Ω)

Name	Description
RLxSec	Resistance R L12, L23, L31, L1, L2, L3 secondary (Ω)
XLxSec	Reactance X L12, L23, L31, L1, L2, L3 secondary (Ω)
ZLxSec	Impedance Z L12, L23, L31, L1, L2, L3 secondary (Ω)
ZLxAngle	Impedance Z L12, L23, L31, L1, L2, L3 angle

Table. 4.4.25 - 219. Other impedances, resistances and reactances

Name	Description
RSeqPri	Positive Resistance R primary (Ω)
XSeqPri	Positive Reactance X primary (Ω)
RSeqSec	Positive Resistance R secondary (Ω)
XSeqSec	Positive Reactance X secondary (Ω)
ZSeqPri	Positive Impedance Z primary (Ω)
ZSeqSec	Positive Impedance Z secondary (Ω)
ZSeqAngle	Positive Impedance Z angle

Table. 4.4.25 - 220. Conductances, susceptances and admittances (L1, L2, L3)

Name	Description
GLxPri	Conductance G L1, L2, L3 primary (mS)
BLxPri	Susceptance B L1, L2, L3 primary (mS)
YLxPriMag	Admittance Y L1, L2, L3 primary (mS)
GLxSec	Conductance G L1, L2, L3 secondary (mS)
BLxSec	Susceptance B L1, L2, L3 secondary (mS)
YLxSecMag	Admittance Y L1, L2, L3 secondary (mS)
YLxAngle	Admittance Y L1, L2, L3 angle (degrees)

Table. 4.4.25 - 221. Other conductances, susceptances and admittances

Name	Description
G0Pri	Conductance G0 primary (mS)
B0Pri	Susceptance B0 primary (mS)
G0Sec	Conductance G0 secondary (mS)
B0Sec	Susceptance B0 secondary (mS)

Name	Description		
Y0Pri	Admittance Y0 primary (mS)		
Y0Sec	Admittance Y0 secondary (mS)		
Y0Angle	Admittance Y0 angle		

Table. 4.4.25 - 222. Other measurements

Name	Description		
System f.	System frequency		
Ref f1	Reference frequency 1		
Ref f2	Reference frequency 2		
M Thermal T	Motor thermal temperature		
F Thermal T	Feeder thermal temperature		
T Thermal T	Transformer thermal temperature		
RTD meas 116	RTD measurement channels 116		
Ext RTD meas 18	External RTD measurement channels 18 (ADAM)		
mA input 7,8,15,16	mA input channels 7, 8, 15, 16		
ASC 14	Analog scaled curves 14		

Magnitude multiplier

Programmable stages can be set to follow one, two or three analog measurements with the *PSx* >/< *Measurement setting* parameter. The user must choose a measurement signal value to be compared to the set value, and possibly also set a scaling for the signal. The image below is an example of scaling: a primary zero sequence voltage has been scaled to a percentage value for easier handling when setting up the comparator.

The scaling factor was calculated by taking the inverse value of a 20 kV system:

$$k = \frac{1}{20\,000\,\text{V}/\sqrt{3}} = 0.008\,66$$

When this multiplier is in use, the full earth fault zero sequence voltage is 11 547 V primary which is then multiplied with the above-calculated scaling factor, inversing the final result to 100%. This way a pre-processed signal is easier to set, although it is also possible to just use the scaling factor of 1.0 and set the desired pick-up limit as the primary voltage. Similarly, any chosen measurement value can be scaled to the desired form.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.25 - 223. Information displayed by the function.

Name	Range	Description	
Condition	NormalStartTripBlocked	Displays status of the function.	
Expected operating time	-1800.0001800.000s	Displays the expected operating time when a fault occurs.	
Time remaining to trip	0.0001800.000s	When the function has detected a fault and counts down time towards a trip, this displays how much time is left before tripping occurs.	
PSx Scaled magnitude X	-5 000 0005 000 000	Displays measurement value after multiplying it the value set to PSx Magnitude multiplier.	
PSx >/< MeasMag1/ MagSet1 at the moment	-5 000 0005 000 000	The ratio between measured magnitude and the pick-up setting.	
PSx >/< MeasMag2/ MagSet2 at the moment	-5 000 0005 000 000	The ratio between measured magnitude and the pick-up setting.	
PSx >/< MeasMag3/ MagSet3 at the moment	-5 000 0005 000 000	The ratio between measured magnitude and the pick-up setting.	
PSx >/< CalcMeasMag/ MagSet at the moment	-5 000 0005 000 000	The ratio between calculated magnitude and the pick-up setting.	

Pick-up settings

The *Pick-up setting Mag* setting parameter controls the pick-up of the PSx>/< function. This defines the maximum or minimum allowed measured magnitude before action from the function. The function constantly calculates the ratio between the set and the measured magnitudes. The user can set the reset hysteresis in the function (by default 3 %). It is always relative to the *Pick-up setting Mag* value.

Table. 4.4.25 - 224. Pick-up settings.

Name	Range	Step	Default	Description
PS# Pick-up term Mag#	 Over > Over (abs) > Under Under (abs) Delta set (%) +/- > Delta abs (%) > Delta +/- measval Delta abs measval 	-	Over	Comparator mode for the magnitude. See "Comparator modes" section below for more information.

Name	Range	Step	Default	Description	
PS# Pick-up setting Mag#/calc >/<	-5 000 000.00005 000 000.0000	0.0001	0.01	Pick-up magnitude	
PS# Setting hysteresis Mag# 0.000050.0000%		0.0001%	3%	Setting hysteresis	
Definite operating time delay	perating time 0.0001800.000s		0.04s	Delay setting	
Release time delays	0.0001800.000s	0.005s	0.06s	Pick-up release delay	

Comparator modes

When setting the comparators, the user must first choose a comparator mode.

Table. 4.4.25 - 225. Comparator modes

Mode	Description
Over >	Greater than. If the measured signal is greater than the set pick-up level, the comparison condition is fulfilled.
Over (abs) >	Greater than (absolute). If the absolute value of the measured signal is greater than the set pick-up level, the comparison condition is fulfilled.
Under <	Less than. If the measured signal is less than the set pick-up level, the comparison condition is fulfilled. The user can also set a blocking limit: the comparison is not active when the measured value is less than the set blocking limit.
Under (abs) <	Less than (absolute). If the absolute value of the measured signal is less than the set pick-up level, the comparison condition is fulfilled. The user can also set a blocking limit: the comparison is not active when the measured value is less than the set blocking limit.
Delta set (%) +/- >	Relative change over time. If the measured signal changes more than the set relative pick-up value in 20 ms, the comparison condition is fulfilled. The condition is dependent on direction.
Delta abs (%) >	Relative change over time (absolute). If the measured signal changes more than the set relative pick-up value in 20 ms in either direction, the comparison condition is fulfilled. The condition is not dependent on direction.
Delta +/- measval	Change over time. If the measured signal changes more than the set pick-up value in 20 ms, the comparison condition is fulfilled. The condition is dependent on direction.
Delta abs measval	Change over time (absolute). If the measured signal changes more than the set pick-up value in 20 ms in either direction, the comparison condition is fulfilled. The condition is not dependent on direction.

The pick-up level is set individually for each comparison. When setting up the pick-up level, the user needs to take into account the modes in use as well as the desired action. The pick-up limit can be set either as positive or as negative. Each pick-up level has a separate hysteresis setting which is 3 % by default.

The user can set the operating and releasing time delays for each stage.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Events and registers

The programmable stage function (abbreviated "PSx" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, TRIP and BLOCKED events.

Table. 4.4.25 - 226. Event messages.

Event block name	Event names
PSx	PS110 >/< Start ON
PSx	PS110 >/< Start OFF
PSx	PS110 >/< Trip ON
PSx	PS110 >/< Trip OFF
PSx	PS110 >/< Block ON
PSx	PS110 >/< Block OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.4.25 - 227. Register content.

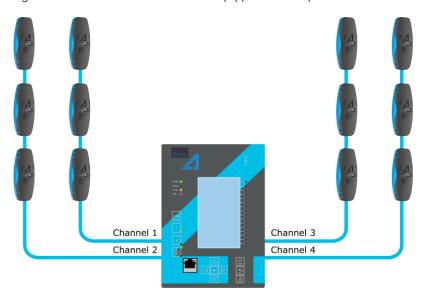
Register	Description		
Date and time	dd.mm.yyyy hh:mm:ss.mss		
Event	Event name		
>/< Mag#	The numerical value of the magnitude		
Mag#/Set#	Ratio between the measured magnitude and the pick-up setting		

Register	Description
Trip time remaining	0 ms1800s
Setting group in use	Setting group 18 active

4.4.26 Arc fault protection (IArc>/I0Arc>; 50Arc/50NArc)

Arc faults occur for a multitude of reasons: e.g. insulation failure, incorrect operation of the protected device, corrosion, overvoltage, dirt, moisture, incorrect wiring, or even because of aging caused by electric load. It is important to detect the arc as fast as possible in order to minimize its effects. Using arc sensors to detect arc faults is much faster than merely measuring currents and voltages. In busbar protection devices with normal protection can be too slow to disconnect arcs within a safe time frame. For example, it may be necessary to delay operation time for hundreds of milliseconds when setting up an overcurrent protection relay to control the feeder breakers to achieve selectivity. This delay can be avoided by using arc protection. The arc protection card has a high-speed output to trip signals faster as well as to extend the speed of arc protection.

Figure. 4.4.26 - 192. Protection device equipped with arc protection.



The arc protection card has four (4) sensor channels, and up to three (3) arc point sensors can be connected to each channel. The sensor channels support Arcteq AQ-01 (light sensing) and AQ-02 (pressure and light sensing) units. Optionally, the protection function can also be applied with a phase current or a residual current condition: the function trips only if the light and overcurrent conditions are met.

Table. 4.4.26 - 228. Output signals of the IArc>/I0Arc> function.

Outputs	Activation condition
Channel 1 Light In Channel 2 Light In Channel 3 Light In Channel 4 Light In	The arc protection card's sensor channel detects light.

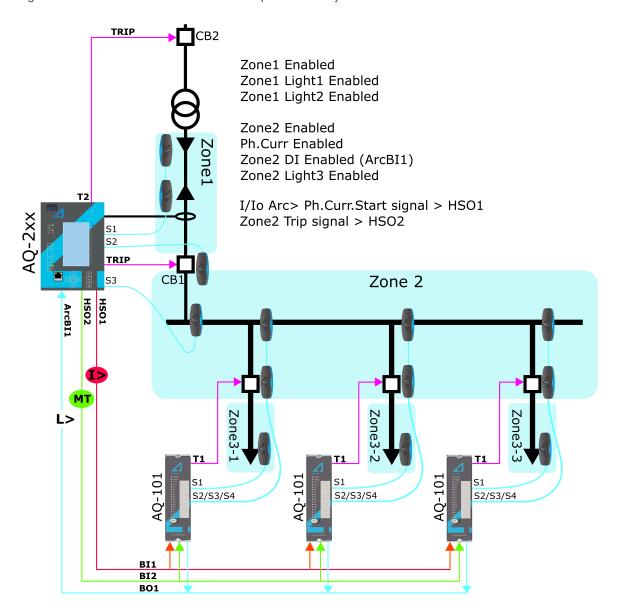
Outputs	Activation condition
Channel 1 Pressure In Channel 2 Pressure In Channel 3 Pressure In Channel 4 Pressure In	The arc protection card's sensor channel detects pressure.
ARC Binary input signal	The arc protection card's binary input is energized.
I/I0 Arc> Ph. curr. START I/I0 Arc> Res. curr. START	The measured phase current or the residual current is over the set limit.
I/I0 Arc> Ph. curr. BLOCKED I/I0 Arc> Res. curr. BLOCKED	The phase current or the residual current measurement is blocked by an input.
I/I0 Arc> Zone 1 TRIP I/I0 Arc> Zone 2 TRIP I/I0 Arc> Zone 3 TRIP I/I0 Arc> Zone 4 TRIP	All required conditions for tripping the zone are met (light OR light and current).
I/I0 Arc> Zone 1 BLOCKED I/I0 Arc> Zone 2 BLOCKED I/I0 Arc> Zone 3 BLOCKED I/I0 Arc> Zone 4 BLOCKED	All required conditions for tripping the zone are met (light OR light and current) but the tripping is blocked by an input.
I/I0 Arc> S1 Sensor fault I/I0 Arc> S2 Sensor fault I/I0 Arc> S3 Sensor fault I/I0 Arc> S4 Sensor fault	The detected number of sensors in the channel does not match the settings.
I/I0 Arc> IO unit fault	The number of connected AQ-100 series units does not match the number of units set in the settings.

Example of scheme setting

The following examples helps the user better understand how the arc protection function is set. In the examples AQ-101 models are used to extend the protection of Zone 2 and to protect each outgoing feeder (Zone 3).

This scheme is a single-line diagram with AQ-200 series devices and with AQ-101 arc protection relays. The settings are for an incoming feeder AQ-200 device.

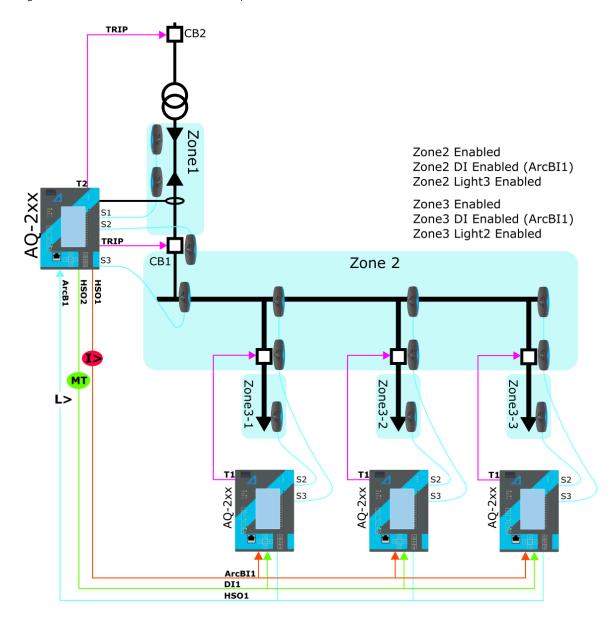
Figure. 4.4.26 - 193. Scheme with AQ-101 arc protection relays.



To set the zones for the AQ-200 models sensor channels start by enabling the protected zones (in this case, Zones 1 and 2). Then define which sensor channels are sensing which zones (in this case, sensor channels S1 and S2 are protecting Zone 1). Enable Light 1 of Zone 1 as well as Light 2 of Zone 2. The sensor channel S3 deals with Zone 2. Enable Light 3 of Zone 2. The high-speed output contacts HSO1 and HSO2 have been set to send overcurrent and master trip signals to the AQ-101 arc protection relays. The AQ-100 series units send out test pulses in specific intervals to check the health of the wiring between the AQ-100 series units. The parameter *I/IO Arc> Self supervision test pulse* should be activated when connecting the AQ-100 series units to the AQ-200 series arc protection card to prevent the pulses from activating ArcBI1.

The next example is almost like the previous one: it is also a single-line diagram with AQ 200 series devices. However, this time each outgoing feeder has an AQ-200 protection device instead of an AQ-101 arc protection relay.

Figure. 4.4.26 - 194. Scheme with AQ-200 protection devices.



The settings for the device supervising the incoming feeder are the same as in the first example. The devices supervising the busbar and the outgoing feeder, however, have a different setting. Both Zones 2 and 3 need to be enabled as there are sensors connected to both Zone 2 and 3 starts. Sensors connected to the channel S3 are in Zone 2. Then enable Light 3 of Zone 2. The sensor connected to the channel S2 is in Zone 3. Then enable Light 2 of Zone 3.

If any of the channels have a pressure sensing sensor, enable it the same way as the regular light sensors. If either phase overcurrent or residual overcurrent is needed for the tripping decision, they can be enabled in the same way as light sensors in the zone. When a current channel is enabled, the measured current needs to be above the set current limit in addition to light sensing.

Measured input

Arc protection uses samples based on current measurements. If the required number of samples is found to be above the setting limit, the current condition activates. The arc protection can use either phase currents, residual currents or both.

Table. 4.4.26 - 229. Measurement inputs of the U1/U2>/< function.

Signal	Description	Time base
I _{L1} samples	Samples received by I _{L1} current measurement channel	5ms
I _{L2} samples	Samples received by I _{L2} current measurement channel	5ms
I _{L3} samples	Samples received by I _{L3} current measurement channel	5ms
I ₀₁ samples	Samples received by I ₀₁ current measurement channel	5ms
l ₀₂ samples	Samples received by I ₀₂ current measurement channel	5ms

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.4.26 - 230. General settings of the function.

Name	Range	Default	Description
I/I0 Arc> force status to	 Normal PH curr blocked PH curr Start ResCurr Blocked ResCurr Start Zone 1 Trip Zone1 Blocked Zone2 Trip Zone2 Blocked Zone3 Trip Zone3 Blocked Zone4 Trip Zone4 Blocked 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Channel 1 sensors			
Channel 2 sensors	No sensors1 sensor	No s sensors	Defines the number of sensors connected to the channel (channels 1/2/
Channel 3 sensors	2 sensors3 sensors		3/4).
Channel 4 sensors			

Name	Range	Default	Description
Channel 1 sensor status			
Channel 2 sensor status	Sensors OK Configuration	-	Displays the status of the sensor channel. If the number of sensors
Channel 3 sensor status	Configuration fault state		connected to the channel does not match with the set "Channel 1/2/3/4 sensors" setting, this parameter will go to the "Configuration fault" state.
Channel 4 sensor status			

Pick-up settings

The pick-up of each zone of the larc>/I0arc> function is controlled by one of the following: the phase current pick-up setting, the residual current pick-up setting, or the sensor channels. The pick-up setting depends on which of these are activated in the zone.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.4.26 - 231. Enabled Zone pick-up settings.

Name	Range	Step	Default	Description
Phase current pick-up	0.0540.00 x l _n	0.01 x I _n	1.2 x I _n	The phase current measurement's pick-up value (in p.u.).
I0 input selection	NoneI01I02	-	None	Selects the residual current channel (I01 or I02).
Res.current pick-up	0.0540.00 x l _{0n}	0.01 x l _{0n}	1.2 x I _{0n}	The residual current measurement's pick-up value (in p.u.).
Zone1/2/ 3/4 Enabled	DisabledEnabled	-	Disabled	Enables the chosen zone. Up to 4 zones can be enabled.
Zone1/2/ 3/4 Ph. curr. Enabled	DisabledEnabled	-	Disabled	The phase overcurrent allows the zone to trip when light is detected.
Zone1/2/ 3/4 Res. curr. Enabled	DisabledEnabled	-	Disabled	The residual overcurrent allows the zone to trip when light is detected.

Name	Range	Step	Default	Description
Zone1/2/ 3/4 Light 1 Enabled	DisabledEnabled	-	Disabled	Light detected in sensor channel 1 trips the zone.
Zone1/2/ 3/4 Light 2 Enabled	DisabledEnabled	-	Disabled	Light detected in sensor channel 2 trips the zone.
Zone1/2/ 3/4 Light 3 Enabled	DisabledEnabled	-	Disabled	Light detected in sensor channel 3 trips the zone.
Zone1/2/ 3/4 Light 4 Enabled	DisabledEnabled	-	Disabled	Light detected in sensor channel 4 trips the zone.
Zone1/2/ 3/4 Pres. 1 Enabled	DisabledEnabled	-	Disabled	Pressure detected in sensor channel 1 trips the zone.
Zone1/2/ 3/4 Pres. 2 Enabled	DisabledEnabled	-	Disabled	Pressure detected in sensor channel 2 trips the zone.
Zone1/2/ 3/4 Pres. 3 Enabled	DisabledEnabled	-	Disabled	Pressure detected in sensor channel 3 trips the zone.
Zone1/2/ 3/4 Pres. 4 Enabled	DisabledEnabled	-	Disabled	Pressure detected in sensor channel 4 trips the zone.
Zone1/2/ 3/4 DI Enabled	DisabledLight InCurrentIn	-	Disabled	Arc protection option card digital input function selection. "Light In" mode trips the zone when digital input is active. In "Current In" mode digital input must be active at the same time as any of the sensor channels for the zone to trip.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.4.26 - 232. Information displayed by the function.

Name	Range	Description
I/I0 Arc> condition	 Z1 Trip Z1 Blocked Z2 Trip Z2 Blocked Z3 Trip Z3 Blocked Z4 Trip Z4 Blocked 	Displays status of the protection function.

Sensor status	 Ph Curr Blocked Ph Curr Start Res Curr Blocked Res Curr Start Channel1 Light Channel2 Light Channel2 Pressure Channel3 Light Channel3 Pressure Channel4 Pressure Digital input I/10 Arc> Sensor 1 Fault I/10 Arc> Sensor 3 Fault I/10 Arc> Sensor 4 Fault I/10 Arc> I/O-unit Fault 	Displays the general status of sensors.	
---------------	--	---	--

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a TRIP signal is generated.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Events and registers

The arc fault protection function (abbreviated "ARC" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the events.

Table. 4.4.26 - 233. Event messages.

Event block name	Event names
ARC1	Zone 14 Trip ON
ARC1	Zone 14 Trip OFF
ARC1	Zone 14 Block ON
ARC1	Zone 14 Block OFF
ARC1	Phase current Blocked ON
ARC1	Phase current Blocked OFF
ARC1	Phase current Start ON

Event block name	Event names
ARC1	Phase current Start OFF
ARC1	Residual current Blocked ON
ARC1	Residual current Blocked OFF
ARC1	Residual current Start ON
ARC1	Residual current Start OFF
ARC1	Channel 14 Light ON
ARC1	Channel 14 Light OFF
ARC1	Channel 14 Pressure ON
ARC1	Channel 14 Pressure OFF
ARC1	DI Signal ON
ARC1	DI Signal OFF
ARC1	I/I0 Arc> Sensor 14 Fault ON
ARC1	I/I0 Arc> Sensor 14 Fault OFF
ARC1	I/I0 Arc> I/O-unit Fault ON
ARC1	I/I0 Arc> I/O-unit Fault OFF

The function registers its operation into the last twelve (12) time-stamped registers. The table below presents the structure of the function's register content.

Table. 4.4.26 - 234. Register content.

Register	Description	
Date and time	dd.mm.yyyy hh:mm:ss.mss	
Event	Event name	
Phase A current		
Phase B current	Trip current	
Phase C current		
Residual current		
Active sensors	14	
Setting group in use	Setting group 18 active	

4.5 Control functions

4.5.1 Common signals

Common signals function has all protection function start and trip signals internally connected to Common START and TRIP output signals. When any of the activated protection functions generate a START or a TRIP signal, Common signals function will also generate the same signal.

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.5.1 - 235. General settings of the function.

Name	Range	Default	Description
Common force status to	NormalStartTrip	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Common signals function has all START and TRIP signals of protection functions internally connected to Common START and TRIP output signals. But it is also possible to assign extra signals to activate Common START and TRIP.

Table. 4.5.1 - 236. Common signals extra inputs.

Name	Description
Common Start In	Assign extra signals to activate common START signal. Please note that all protection function START signals are already assigned internally to Common START.
Common Trip In	Assign extra signals to activate common TRIP signal. Please note that all protection function TRIP signals are already assigned internally to Common TRIP.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.5.1 - 237. Information displayed by the function.

Name	Range	Description
Common signals condition	Normal Start Trip	Displays status of the function.

Function blocking

Common signals function itself doesn't have blocking input signals. Blocking of tripping should be done in each protection function settings.

Events

The common signals function (abbreviated "GNSIG" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START and TRIP events.

The events triggered by the function are recorded with a time stamp.

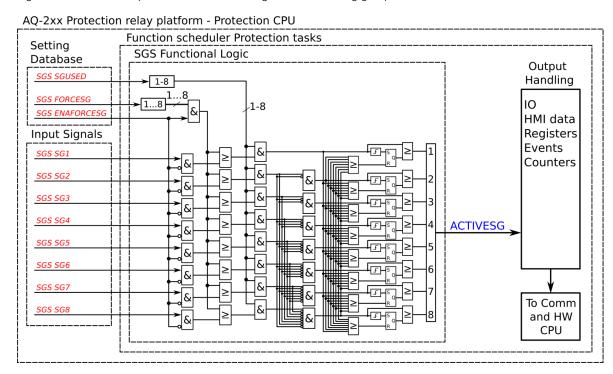
Table. 4.5.1 - 238. Event messages.

Event block name	Event names
GNSIG	Common Start ON
GNSIG	Common Start OFF
GNSIG	Common Trip ON
GNSIG	Common Trip OFF

4.5.2 Setting group selection

All device types support up to eight (8) separate setting groups. The Setting group selection function block controls the availability and selection of the setting groups. By default, only Setting group 1 (SG1) is active and therefore the selection logic is idle. When more than one setting group is enabled, the setting group selector logic takes control of the setting group activations based on the logic and conditions the user has programmed.

Figure. 4.5.2 - 195. Simplified function block diagram of the setting group selection function.

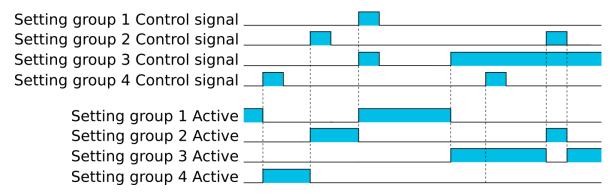


Setting group selection can be applied to each of the setting groups individually by activating one of the various internal logic inputs and connected digital inputs. The user can also force any of the setting groups on when the "Force SG change" setting is enabled by giving the wanted quantity of setting groups as a number in the communication bus or in the local HMI, or by selecting the wanted setting group from $Control \rightarrow Setting \ groups$. When the forcing parameter is enabled, the automatic control of the local device is overridden and the full control of the setting groups is given to the user until the "Force SG change" is disabled again.

Setting groups can be controlled either by pulses or by signal levels. The setting group controller block gives setting groups priority values for situations when more than one setting group is controlled at the same time: the request from a higher-priority setting group is taken into use.

Setting groups follow a hierarchy in which setting group 1 has the highest priority, setting group 2 has second highest priority etc. If a static activation signal is given for two setting groups, the setting group with higher priority will be active. If setting groups are controlled by pulses, the setting group activated by pulse will stay active until another setting groups receives and activation signal.

Figure. 4.5.2 - 196. Example sequences of group changing (control with pulse only, or with both pulses and static signals).



Settings and signals

The settings of the setting group control function include the active setting group selection, the forced setting group selection, the enabling (or disabling) of the forced change, the selection of the number of active setting groups in the application, as well as the selection of the setting group changed remotely. If the setting group is forced to change, the corresponding setting group must be enabled and the force change must be enabled. Then, the setting group can be set from communications or from HMI to any available group. If the setting group control is applied with static signals right after the "Force SG" parameter is released, the application takes control of the setting group selection.

Table. 4.5.2 - 239. Settings of the setting group selection function.

Name	Range	Default	Description
Active setting group	• SG1 • SG2 • SG3 • SG4 • SG5 • SG6 • SG7 • SG8	SG1	Displays which setting group is active.

Name	Range	Default	Description
Force setting group	 None SG1 SG2 SG3 SG4 SG5 SG6 SG7 SG8 	None	The selection of the overriding setting group. After "Force SG change" is enabled, any of the configured setting groups in the device can be overriden. This control is always based on the pulse operating mode. It also requires that the selected setting group is specifically controlled to ON after "Force SG" is disabled. If there are no other controls, the last set setting group remains active.
Force setting group change	DisabledEnabled	Disabled	The selection of whether the setting group forcing is enabled or disabled. This setting has to be active before the setting group can be changed remotely or from a local HMI. This parameter overrides the local control of the setting groups and it remains on until the user disables it.
Used setting groups	• SG1 • SG12 • SG13 • SG14 • SG15 • SG16 • SG17	SG1	The selection of the activated setting groups in the application. Newly-enabled setting groups use default parameter values.
Remote setting group change	 None SG1 SG2 SG3 SG4 SG5 SG6 SG7 SG8 	None	This parameter can be controlled through SCADA to change the setting group remotely. Please note that if a higher priority setting group is being controlled by a signal, a lower priority setting group cannot be activated with this parameter.

Table. 4.5.2 - 240. Signals of the setting group selection function.

Name	Description
Setting group 1	The selection of Setting group 1 ("SG1"). Has the highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no other SG requests will be processed.
Setting group 2	The selection of Setting group 2 ("SG2"). Has the second highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no requests with a lower priority than SG1 will be processed.
Setting group 3	The selection of Setting group 3 ("SG3"). Has the third highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no requests with a lower priority than SG1 and SG2 will be processed.
Setting group 4	The selection of Setting group 4 ("SG4"). Has the fourth highest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, no requests with a lower priority than SG1, SG2 and SG3 will be processed.
Setting group 5	The selection of Setting group 5 ("SG5"). Has the fourth lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, SG6, SG7 and SG8 requests will not be processed.

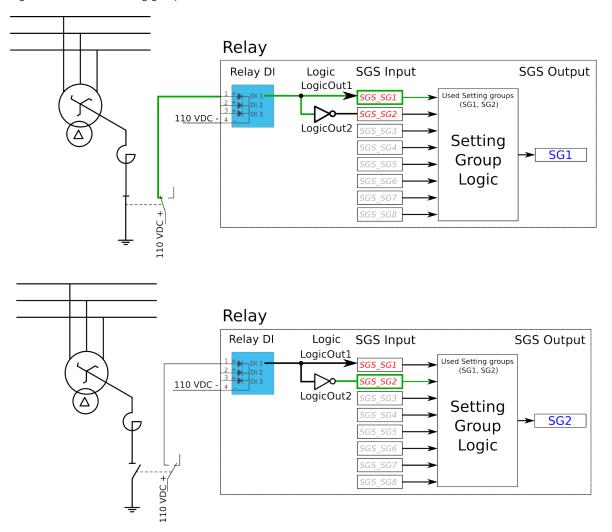
Name	Description
Setting group 6	The selection of Setting group 6 ("SG6"). Has the third lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, SG7 and SG8 requests will not be processed.
Setting group 7	The selection of Setting group 7 ("SG7"). Has the second lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, only SG8 requests will not be processed.
Setting group 8	The selection of Setting group 8 ("SG8"). Has the lowest priority input in setting group control. Can be controlled with pulses or static signals. If static signal control is applied, all other SG requests will be processed regardless of the signal status of this setting group.

Example applications for setting group control

This chapter presents some of the most common applications for setting group changing requirements.

A Petersen coil compensated network usually uses directional sensitive earth fault protection. The user needs to control its characteristics between varmetric and wattmetric; the selection is based on whether the Petersen coil is connected when the network is compensated, or whether it is open when the network is unearthed.

Figure. 4.5.2 - 197. Setting group control – one-wire connection from Petersen coil status.



Depending on the application's requirements, the setting group control can be applied either with a one-wire connection or with a two-wire connection by monitoring the state of the Petersen coil connection.

When the connection is done with one wire, the setting group change logic can be applied as shown in the figure above. The status of the Petersen coil controls whether Setting group 1 is active. If the coil is disconnected, Setting group 2 is active. This way, if the wire is broken for some reason, the setting group is always controlled to SG2.

Figure. 4.5.2 - 198. Setting group control – two-wire connection from Petersen coil status.

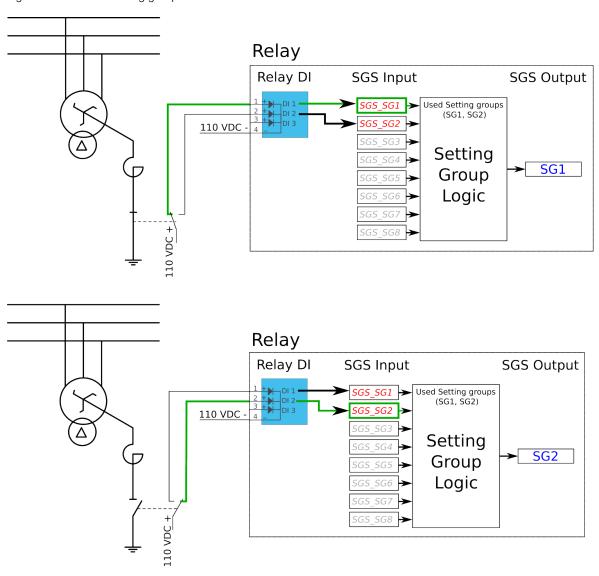
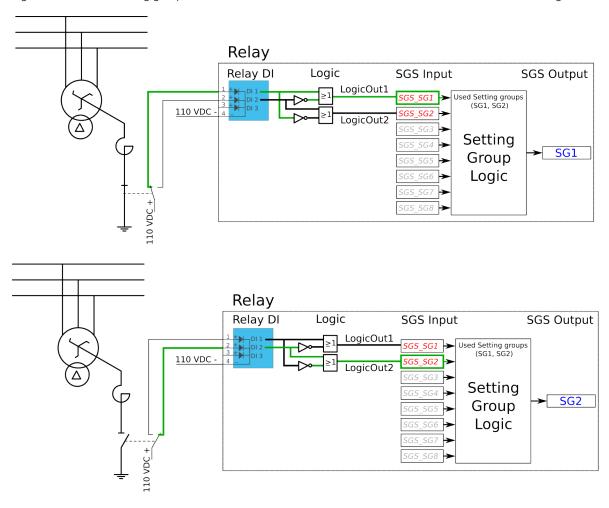


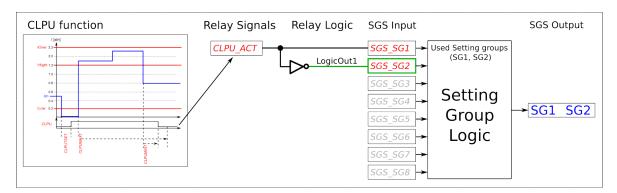
Figure. 4.5.2 - 199. Setting group control – two-wire connection from Petersen coil status with additional logic.

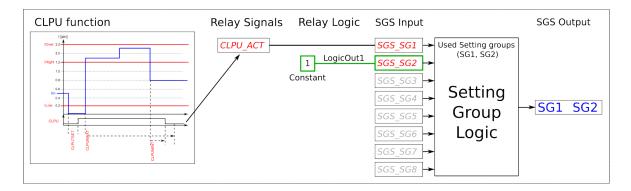


The images above depict a two-wire connection from the Petersen coil: the two images at the top show a direct connection, while the two images on the bottom include additional logic. With a two-wire connection the state of the Petersen coil can be monitored more securely. The additional logic ensures that a single wire loss will not affect the correct setting group selection.

The application-controlled setting group change can also be applied entirely from the device's internal logics. For example, the setting group change can be based on the cold load pick-up function (see the image below).

Figure. 4.5.2 - 200. Entirely application-controlled setting group change with the cold load pick-up function.





In these examples the cold load pick-up function's output is used for the automatic setting group change. Similarly to this application, any combination of the signals available in the device's database can be programmed to be used in the setting group selection logic.

As all these examples show, setting group selection with application control has to be built fully before they can be used for setting group control. The setting group does not change back to SG1 unless it is controlled back to SG1 by this application; this explains the inverted signal NOT as well as the use of logics in setting group control. One could also have SG2 be the primary SG, while the ON signal would be controlled by the higher priority SG1; this way the setting group would automatically return to SG2 after the automatic control is over.

Events

The setting group selection function block (abbreviated "SGS" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

Table. 4.5.2 - 241. Event messages.

Event block name	Event names
SGS	SG28 Enabled
SGS	SG28 Disabled
SGS	SG18 Request ON
SGS	SG18 Request OFF
SGS	Remote Change SG Request ON

Event block name	Event names
SGS	Remote Change SG Request OFF
SGS	Local Change SG Request ON
SGS	Local Change SG Request OFF
SGS	Force Change SG ON
SGS	Force Change SG OFF
SGS	SG Request Fail Not configured SG ON
SGS	SG Request Fail Not configured SG OFF
SGS	Force Request Fail Force ON
SGS	Force Request Fail Force OFF
SGS	SG Req. Fail Lower priority Request ON
SGS	SG Req. Fail Lower priority Request OFF
SGS	SG18 Active ON
SGS	SG18 Active OFF

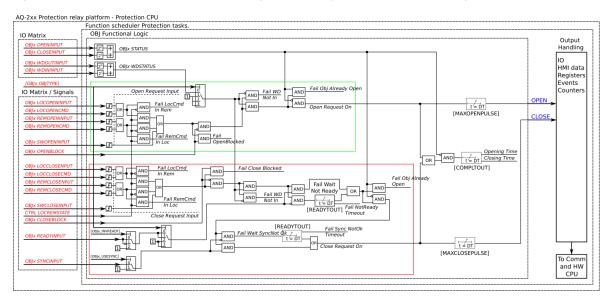
4.5.3 Object control and monitoring

The object control and monitoring function takes care of both for circuit breakers and disconnectors. The monitoring and controlling are based on the statuses of the device's configured digital inputs and outputs. The number of controllable and monitored objects in each device depends on the device type and amount of digital inputs. One controllable object requires a minimum of two (2) output contacts. The status monitoring of one monitored object usually requires two (2) digital inputs. Alternatively, object status monitoring can be performed with a single digital input: the input's active state and its zero state (switched to 1 with a NOT gate in the Logic editor).

An object can be controlled manually or automatically. Manual control can be done by local control, or by remote control. Local manual control can be done by devices front panel (HMI) or by external push buttons connected to devices digital inputs. Manual remote control can be done through one of the various communication protocols available (Modbus, IEC101/103/104 etc.). The function supports the modes "Direct control" and "Select before execute" while controlled remotely. Automatic controlling can be done with functions like auto-reclosing function (ANSI 79).

The main outputs of the function are the OBJECT OPEN and OBJECT CLOSE control signals. Additionally, the function reports the monitored object's status and applied operations. The setting parameters are static inputs for the function, which can only be changed by the user in the function's setup phase.

Figure. 4.5.3 - 201. Simplified function block diagram of the object control and monitoring function.



Settings

The following parameters help the user to define the object. The operation of the function varies based on these settings and the selected object type. The selected object type determines how much control is needed and which setting parameters are required to meet those needs.

Table. 4.5.3 - 242. Object settings and status parameters.

Name	Range	Default	Description
Local/Remote status	Local Remote	Remote	Displays the status of the device's "local/remote" switch. Local controls cannot override the open and close commands while device is in "Remote" status. The remote controls cannot override the open and close commands while device is in "Local" status.
Object status force to	 Normal Openreq On Closereq On Opensignal On Closesignal On WaitNoRdy On WaitNoSnc On NotrdyFail On NosyncFail On Opentout On Clotout On OpenreqUSR On CloreqUSR On 	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
Object name	-	Objectx	The user-set name of the object, at maximum 32 characters long.

Name	Range	Default	Description
Object type	Withdrawable circuit breaker Circuit breaker Disconnector (MC) Disconnector (GND)	Circuit breaker	The selection of the object type. This selection defines the number of required digital inputs for the monitored object. This affects the symbol displayed in the HMI and the monitoring of the circuit breaker. It also affects whether the withdrawable cart is in/out status is monitored. See the next table ("Object types") for a more detailed look at which functionalities each of the object types have.
Objectx Breaker status	IntermediateOpenClosedBad	-	Displays the status of breaker. Intermediate is displayed when neither of the status signals (open or close) are active. Bad status is displayed when both status signals (open and close) are active.
Objectx Withdraw status	WDIntermediate WDCartOut WDCart In WDBad Not in use	-	Displays the status of circuit breaker cart. WDIntermediate is displayed when neither of the status signals (in or out) are active. WDBad status is displayed when both status signals (in and out) are active. If the selected object type is not set to "Withdrawable circuit breaker", this setting displays the "No in use" option.
Additional status information	Open Blocked Open Allowed Close Blocked Close Allowed Object Ready Object Not Ready Sync Ok Sync Not Ok	-	Displays additional information about the status of the object.
Use Synchrocheck	Not in use Synchrocheck in use	Not in use	Selects whether the "Synchrocheck" condition is in use for the circuit breaker close command. If "In use" is selected the input chosen to "Sync.check status in" has to be active to be able to close circuit breaker. Synchrocheck status can be either an internal signal generated by synchrocheck function or digital input activation with an external synchrocheck device.
Use Object ready	Ready HighReady LowNot in use	Not in use	Selects whether the "Object ready" condition is in use for the circuit breaker close command. If in use the signal connected to "Object ready status In" has to be high or low to be able to close the breaker (depending on "Ready High or Low" selection).
Open requests	02 ³² –1	-	Displays the number of successful "Open" requests.
Close requests	02 ³² –1	-	Displays the number of successful "Close" requests.
Open requests failed	02 ³² –1	-	Displays the number of failed "Open" requests.
Close requests failed	02 ³² –1	-	Displays the number of failed "Close" requests.
Clear statistics	• - • Clear	-	Clears the request statistics, setting them back to zero (0). Automatically returns to "-" after the clearing is finished.

Table. 4.5.3 - 243. Object types.

Name	Functionalities	Description
Withdrawable circuit breaker	Breaker cart position Circuit breaker position Circuit breaker control Object ready check before closing breaker Synchrochecking before closing breaker Interlocks	The monitor and control configuration of the withdrawable circuit breaker.
Circuit breaker	Position indication Control Object ready check before closing breaker Synchrochecking before closing breaker Interlocks	The monitor and control configuration of the circuit breaker.
Disconnector (MC)	Position indication Control	The position monitoring and control of the disconnector.
Disconnector (GND)	Position indication	The position indication of the earth switch.

Table. 4.5.3 - 244. I/O.

Signal	Range	Description
Objectx Open Status In	Digital input or other logical signal selected by the user (SWx)	A link to a physical digital input. The monitored object's OPEN status. "1" refers to the active open state of the monitored object.
Objectx Close Status In		A link to a physical digital input. The monitored object's CLOSE status. "1" refers to the active close state of the monitored object.
Withdrw.Cartln.Status In		A link to a physical digital input. The monitored withdrawable object's position is IN. "1" means that the withdrawable object cart is in.
Withdrw.CartOut.Status In		A link to a physical digital input. The monitored withdrawable object's position is OUT. "1" means that the withdrawable object cart is pulled out.
Objectx Ready status In		A link to a physical digital input. Indicates that status of the monitored object. "1" means that the object is ready and the spring is charged for a close command.
Sync.Check status In		A link to a physical digital input or a synchrocheck function. "1" means that the synchrocheck conditions are met and the object can be closed.
Objectx Open Command	OUT1OUTx	The physical "Open" command pulse to the device's output relay.
Objectx Close Command	1 0011001x	The physical "Close" command pulse to the device's output relay.

Table. 4.5.3 - 245. Operation settings.

Name	Range	Step	Default	Description
Breaker traverse time	0.02500.00 s	0.02 s	0.2 s	Determines the maximum time between open and close statuses when the breaker switches. If this set time is exceeded and both open and closed status inputs are active, the status "Bad" is activated in the "Objectx Breaker status" setting. If neither of the status inputs are active after this delay, the status "Intermediate" is activated.
Sync wait timeout	0.02500.00 s	0.02 s	0.2 s	If synchrocheck is used, the object will wait for a "synchrocheck ok" signal before giving the closing command. This parameter will cancel the command if synchronization is not achieved on time.
Maximum Close command pulse length	0.02500.00 s	0.02 s	0.2 s	Determines the maximum length for a Close pulse from the output relay to the controlled object. If the object operates faster than this set time, the control pulse is reset and a status change is detected.
Maximum Open command pulse length	0.02500.00 s	0.02 s	0.2 s	Determines the maximum length for a Open pulse from the output relay to the controlled object. If the object operates faster than this set time, the control pulse is reset and a status change is detected.
Control termination timeout	0.02500.00 s	0.02 s	10 s	Determines the control pulse termination timeout. If the object has not changed it status in this given time the function will issue error event and the control is ended. This parameter is common for both open and close commands.
Final trip pulse length	0.00500.00 s	0.02 s	0.2 s	Determines the length of the final trip pulse length. When the object has executed the final trip, this signal activates. If set to 0 s, the signal is continuous. If auto-recloser function controls the object, "final trip" signal is activated only when there are no automatic reclosings expected after opening the breaker.

Table. 4.5.3 - 246. Control settings (DI and Application).

Signal	Range	Description
Access level for MIMIC control	UserOperatorConfiguratorSuper user	Defines what level of access is required for MIMIC control. The default is the "Configurator" level.
Objectx LOCAL Close control input		The local Close command from a physical digital input (e.g. a push button).
Objectx LOCAL Open control input		The local Open command from a physical digital input (e.g. a push button).
Objectx REMOTE Close control input	Digital input or other logical signal selected by the user	The remote Close command from a physical digital input (e.g. RTU).
Objectx REMOTE Open control input		The remote Open command from a physical digital input (e.g. RTU).
Objectx Application Close		The Close command from the application. Can be any logical signal.

Signal	Range	Description
Objectx Application Open		The Close command from the application. Can be any logical signal.

Blocking and interlocking

The interlocking and blocking conditions can be set for each controllable object, with Open and Close set separately. Blocking and interlocking can be based on any of the following: other object statuses, a software function or a digital input.

In order for the blocking signal to be received on time, it has to reach the function 5 ms before the control command.

Events and registers

The object control and monitoring function (abbreviated "OBJ" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function also provides a resettable cumulative counter for OPEN, CLOSE, OPEN FAILED, and CLOSE FAILED events.

Table. 4.5.3 - 247. Event messages of the OBJ function.

Event block name	Description
ОВЈХ	Object Intermediate
OBJX	Object Open
OBJX	Object Close
OBJX	Object Bad
OBJX	WD Intermediate
OBJX	WD Out
OBJX	WD in
OBJX	WD Bad
OBJX	Open Request ON/OFF
OBJX	Open Command ON/OFF
OBJX	Close Request ON/OFF
OBJX	Close Command ON/OFF
OBJX	Open Blocked ON/OFF
ОВЈХ	Close Blocked ON/OFF
OBJX	Object Ready
ОВЈХ	Object Not Ready

Event block name	Description
OBJX	Sync Ok
OBJX	Sync Not Ok
OBJX	Open Command Fail
OBJX	Close Command Fail
OBJX	Final trip ON/OFF
OBJX	Contact Abrasion Alarm ON/OFF
OBJX	Switch Operating Time Exceeded ON/OFF
OBJX	XCBR Loc ON/OFF
OBJX	XSWI Loc ON/OFF
OBJX	OBJX Cond monitoring alarm 1 ON/OFF
OBJX	OBJX Cond monitoring alarm 2 ON/OFF
OBJX	OBJX Trip Circuit Supervision ON/OFF

The function registers its operation into the last twelve (12) time-stamped registers. The table below presents the structure of the function's register content.

Table. 4.5.3 - 248. Register content.

Name	Description	
Date and time	dd.mm.yyyy hh:mm:ss.mss	
Event	Event name	
Recorded Object opening time	Time difference between the object receiving an "Open" command and the object receiving the "Open" status.	
Recorded Object closing time	Time difference between the object receiving a "Close" command and object receiving the "Closed" status.	
Object status	The status of the object.	
WD status	The status of the withdrawable circuit breaker.	
Open fail	The cause of an "Open" command's failure.	
Close fail	The cause of a "Close" command's failure.	
Open command	The source of an "Open" command.	
Close command	The source of an "Open" command.	
General status	The general status of the function.	

4.5.4 Indicator object monitoring

The indicator object monitoring function takes care of the status monitoring of disconnectors. The function's sole purpose is indication and does not therefore have any control functionality. To control circuit breakers and/or disconnectors, please use the Object control and monitoring function. The monitoring is based on the statuses of the configured device's digital inputs. The number of monitored indicators in a device depends on the device type and available inputs. The status monitoring of one monitored object usually requires two (2) digital inputs. Alternatively, object status monitoring can be performed with a single digital input: the input's active state and its zero state (switched to 1 with a NOT gate in the Logic editor).

The outputs of the function are the monitored indicator statuses (Open, Close, Intermediate and Bad). The setting parameters are static inputs for the function, which can only be changed by the use in the function's setup phase.

The inputs of the function are the binary status indications. The function generates general time stamped ON/OFF events to the common event buffer from each of the following signals: OPEN, CLOSE, BAD and INTERMEDIATE event signals. The time stamp resolution is 1 ms.

Settings

Function uses available hardware and software digital signal statuses. These input signals are also setting parameters for the function.

Table, 4.5.4 - 249, Indicator status.

Name	Range	Default	Description
Indicator name ("Ind. Name")	-	IndX	The user-set name of the object, at maximum 32 characters long.
IndicatorX Object status ("Ind.X Object Status")	IntermediateOpenClosedBad	-	Displays the status of the indicator object. Intermediate status is displayed when neither of the status conditions (open or close) are active. Bad status is displayed when both of the status conditions (open and close) are active.

Table. 4.5.4 - 250. Indicator I/O.

Signal	Range	Description
IndicatorX Open input ("Ind.X Open Status In")	Digital input or other logical signal selected by the user (SWx)	A link to a physical digital input. The monitored indicator's OPEN status. "1" refers to the active "Open" state of the monitored indicator.
IndicatorX Close input ("Ind.X Close Status In")	Digital input or other logical signal selected by the user (SWx)	A link to a physical digital input. The monitored indicator's CLOSE status. "1" refers to the active "Close" state of the monitored indicator.

Events

The indicator object monitoring function (abbreviated "CIN" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

Table. 4.5.4 - 251. Event messages (instances 1 - 5).

Event block name	Event names
CIN15	Intermediate
CIN15	Open
CIN15	Close
CIN15	Bad

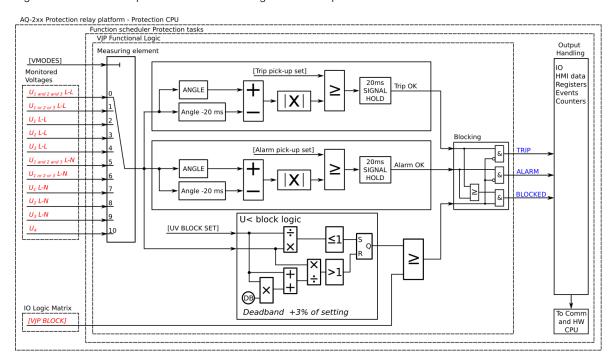
4.5.5 Vector jump ($\Delta \varphi$; 78)

Distribution systems may include different kinds of distributed power generation sources, such as wind farms and diesel or fuel generators. When a fault occurs in the distribution system, it is usually detected and isolated by the protection system closest to the faulty point, resulting in the electrical power system shutting dow either partially or completely. The remaining distributed generators try to deliver the power to the part of the distribution system that has been disconnected from the grid, and usually an overload condition can be expected. Under such overload conditions, it is normal to have a drop in voltage and frequency. This overload results in the final system disconnection from the islanding generator(s). The disconnection depends greatly on the ratio between the power generation and the demand of the islanded system. When any power is supplied to a load only from distributed generators, (due to the opening of the main switch), the situation is called an isolated island operation or an islanded operation of the electrical distribution network.

The vector jump control function is suitable to detect most islanding situations and to switch off the mains breaker in order to let the generator only supply loads according to their rated power value. Therefore, an overload does not cause any mechanical stress to the generator unit(s). The vector jump function should be located either on the mains side of the operated breaker or on the islanding generator side.

The vector jump function is used for instant tripping and has only one operating stage. The function has an algorithm which follows the samples of chosen measured voltages (64 samples/cycle). The reference voltage used can be all or any of the phase-to-phase or phase-to-neutral voltages.

Figure. 4.5.5 - 202. Simplified function block diagram of the $\Delta \varphi$ function.



Measured input

The function block uses phase-to-phase or phase-to-neutral voltages and always uses complex measurement from samples.

Table. 4.5.5 - 252. Measurement inputs of the vector jump function.

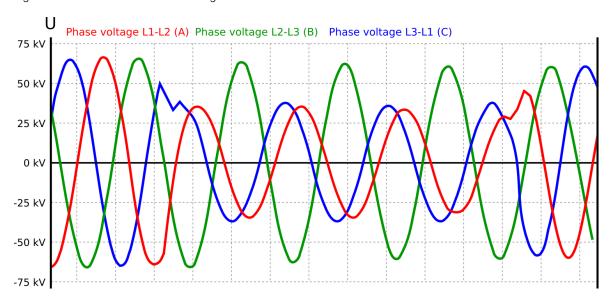
Signal	Description			
U ₁ CMPLX	The complex vector of U ₁ /V voltage channel			
U ₂ CMPLX	The complex vector of U ₂ /V voltage channel			
U ₃ CMPLX	The complex vector of U ₃ /V voltage channel			
U ₄ CMPLX	The complex vector of U ₄ /V voltage channel			

Pick-up settings

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

When a fault appears in the power system and some areas are disconnected, normally the remaining generators connected to the network must supply the area disconnected from the utility side supply. This results in an instantaneous demand of power that the generators must tackle. The excitation and the mechanical systems cannot answer such a huge demand of power quickly even if there were enough reserve power. The worst of the situation is received by the rotors of the generator units: they suffer a torsion torque that can even break the rotor and cause subsequent damage not only for the generator but for the entire power plant too.

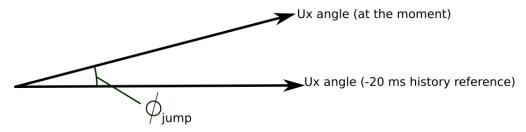
Figure. 4.5.5 - 203. Generator islanding.



As can be seen in the example above, only phase-to-phase voltages L1-L2 and L3-L1 have been reduced, while voltage L2-L3 remains the same. This means that the problem occured in phase L1 of the network. The voltage level is not reduced to zero, nor is the voltage in any phase is totally lost. The phases without the fault condition remain normal with the same value. On the other hand, the frequency can sag as can be seen in the figure above.

The Δa setting parameter controls the pick-up of the vector jump function. This defines the minimum allowed rapid measured voltage angle change before action from the function. The function constantly calculates the ratio between the Δa_{set} and the measured magnitude (Δa_m) for each of the selected voltages. The function's stage trip signal lasts for 20 ms and automatically resets after that time has passed. The setting value is common for all measured amplitudes.

Figure. 4.5.5 - 204. Vector jump from the function's point of view.



The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.5.5 - 253. General settings of the function.

Name	Range	Default	Description
Δα force status to	Normal Blocked Trip Alarm	Normal	Force the status of the function. Visible only when Enable stage forcing parameter is enabled in General menu.
Available stages	Trip Trip and alarm	Trip	Defines if alarm is included with trip or not.

Name	Range	Default	Description
Monitored voltages	System all P-P Voltages System any P-P Voltage System L12 Voltage System L23 Voltage System L31 Voltage System all P-E voltages System any P-E voltage System L1 Voltage System L1 Voltage System L2 Voltage System L3 Voltage U4 Voltage U4 Voltage	System any P-P Voltage	Defines the monitored voltage channel(s)

Table. 4.5.5 - 254. Pick-up settings.

Name	Range	Step	Default	Description
Pick-up setting Δα (lead or lag) Trip	0.0530.00°	0.01°	5°	Pick-up setting for trip signal
Pick-up setting Δα (lead or lag) Alarm	0.0530.00°	0.01°	5°	Pick-up setting for alarm signal
Undervoltage block limit % < Un	0.01100.00%Un	0.01%Un	95%Un	Block setting. When measured voltage is below this setting the function is blocked.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.5.5 - 255. Information displayed by the function.

Name	Range	Step	Description
$\Delta \alpha$ > condition	Normal Blocked Trip Alarm	ı	Displays status of the protection function.

Name	Range	Step	Description
Voltage meas selected	Selection OkSelection not available	-	Displays validity of the voltage channel(s) selected in "Monitored voltages" parameter.
Δα > U1 Angle difference			
Δα > U2 Angle difference	-360360deg	0.01deg	Displays the angle difference between present time and 20 ms ago.
Δα > U3 Angle difference			
Δα > U1meas/set			
Δα > U2meas/set	-360360p.u.	0.01p.u.	Displays the ratio between the measured voltage and undervoltage block limit setting.
Δα > U3meas/set			

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a ALARM or TRIP signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Events and registers

The vector jump function (abbreviated "VJP" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the ALARM, TRIP and BLOCKED events.

Table. 4.5.5 - 256. Event messages.

Event block name	Event names
VJP1	Block ON
VJP1	Block OFF
VJP1	Trip ON
VJP1	Trip OFF
VJP1	Alarm ON

Event block name	Event names
VJP1	Alarm OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for ALARM, TRIP or BLOCKED. The table below presents the structure of the function's register content.

Table. 4.5.5 - 257. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
Fault type	L1(2), L2(3), L3(1) and U4
Trip Δα meas / dataset	Trip angle difference
Alarm Δα meas / dataset	Alarm angle difference
Setting group in use	Setting group 18 active

4.5.6 Synchrocheck ($\Delta V/\Delta a/\Delta f$; 25)

Checking the synchronization is important to ensure the safe closing of the circuit breaker between two systems. Closing the circuit breaker when the systems are not synchronized can cause several problems such as current surges which damage the interconnecting elements. The synchrocheck function has three stages: SYN1, SYN2 and SYN3. Their function and availability of these stages depend on which voltage channels are set to "SS" mode or not. Voltage measurement settings are located at $Measurements \rightarrow Transformers \rightarrow VT$ module. When synchroswitching is used, the function automatically closes the breaker when both sides of the breaker are synchronized.

When only U3 or U4 voltage measurement channel has been set to "SS" mode:

- SYN1 Supervises the synchronization condition between the channel set to "SS" mode and the selected system voltage (UL1, UL2, UL3, UL12, UL23 or UL31).
- SYN2 Not active and not visible.
- SYN3 Not active and not visible.

When both U3 and U4 have been set to "SS" mode:

- SYN1 Supervises the synchronization condition between the U3 channel and the selected system voltage (UL12, UL23 or UL31).
- SYN2 Supervises the synchronization condition between the U4 channel and the selected system voltage (UL12, UL23 or UL31).
- SYN3 Supervises the synchronization condition between the channels U3 and U4.

The seven images below present three different example connections and four example applications of the synchrocheck function.

Figure. 4.5.6 - 205. Example connection of the synchrocheck function (3LN+U4 mode, SYN1 in use, UL1 as reference voltage).

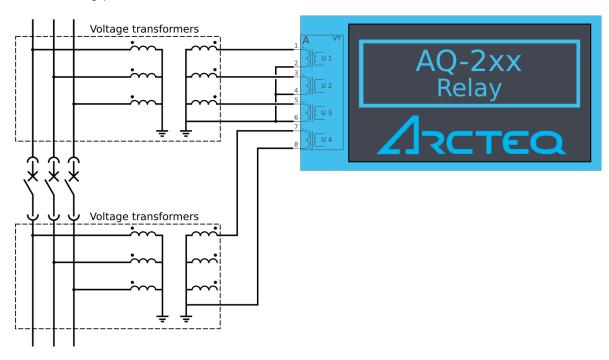


Figure. 4.5.6 - 206. Example connection of the synchrocheck function (2LL+U0+U4 mode, SYN1 in use, UL12 as reference voltage).

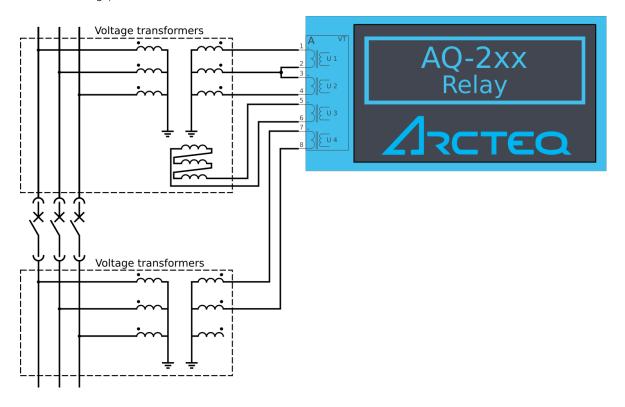


Figure. 4.5.6 - 207. Example connection of the synchrocheck function (2LL+U3+U4 mode, SYN3 in use, UL12 as reference voltage).

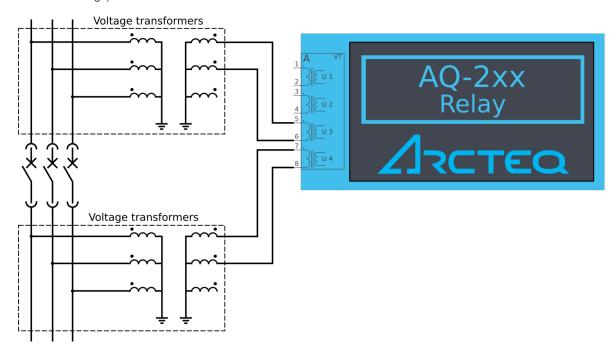


Figure. 4.5.6 - 208. Example application (synchrocheck over one breaker, with 3LL and 3LN VT connections).

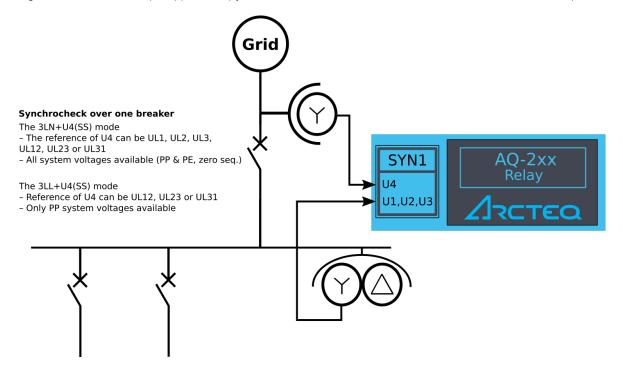


Figure. 4.5.6 - 209. Example application (synchrocheck over one breaker, with 2LL VT connection).

Synchrocheck over one breaker OPTIONAL CONNECTION

Mode 2LL+U3(U0)+U4(SS)

- Reference of U4 can be UL1, UL2, Reference of U3 can be UL1, UL2, UL3, UL12, UL23 or UL31 UL3, UL12, UL23 or UL31 All system voltages available (PP & PE, zero seq.) UL3, UL12, UL23 or UL31
- All system voltages available (PP & PE, zero seq.)

Mode 2LL+U3(SS)+U4(U0)

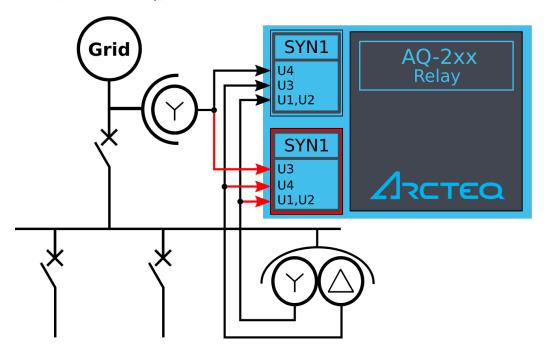


Figure. 4.5.6 - 210. Example application (synchrocheck over two breakers, with 2LL VT connection).

Synchrocheck over two breakers

Mode 2LL+U3(SS)+U4(SS)

- Reference of U3 and U4 can be UL12, UL23 or UL31
- PP system voltages available

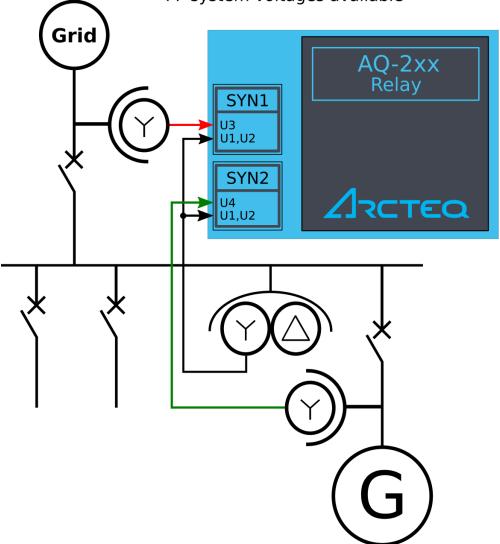
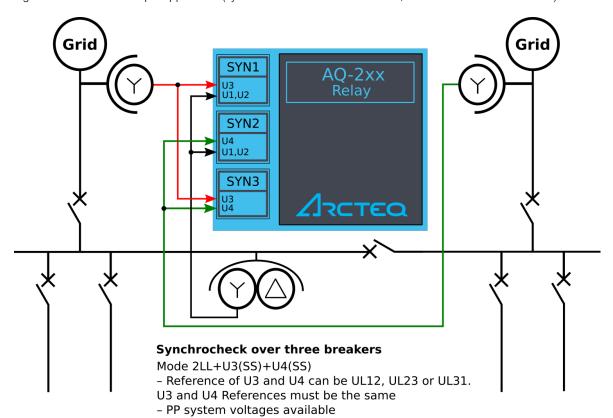


Figure. 4.5.6 - 211. Example application (synchrocheck over three breakers, with 2LL+U3+U4 connection).





NOTICE!

When synchrocheck is used over three breakers, SYN1 and SYN2 must have the same reference voltage.

The following aspects of the compared voltages are used in synchorization:

- · voltage magnitudes
- · voltage frequencies
- · voltage phase angles

The two systems are synchronized when these three aspects are matched. All three cannot, of course, ever be exactly the same so the function requires the user to set the maximum difference between the measured voltages.

Depending on how the measured voltage compares to the set *U live>* and *U dead<* parameters, either system can be in a "live" or a "dead" state. The parameter *SYNx U conditions* is used to determine the conditions (in addition to the three aspects) which are required for the systems to be considered synchronized.

The image below shows the different states the systems can be in.

Figure. 4.5.6 - 212. System states.

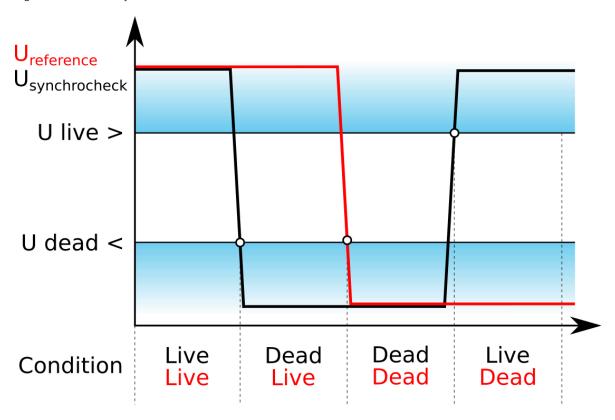


Figure. 4.5.6 - 213. Simplified function block diagram of the SYN1 and SYN2 function.

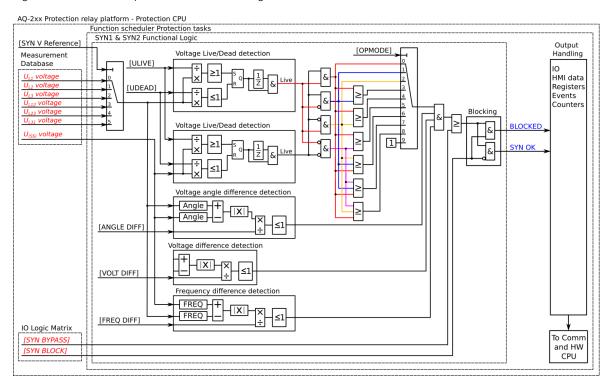
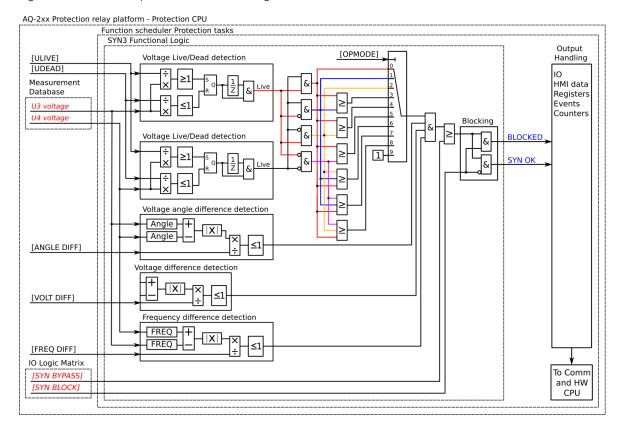


Figure. 4.5.6 - 214. Simplified function block diagram of the SYN3 function.



Measured input

The function block uses user selected voltage channels. The function monitors frequency, angle and fundamental frequency component value of the selected channels.

Table. 4.5.6 - 258. Measurement inputs of the synchrocheck function.

Signal	Description		
U ₁ RMS	Fundamental frequency component of U ₁ /V voltage channel		
U ₂ RMS	Fundamental frequency component of U ₂ /V voltage channel		
U ₃ RMS	Fundamental frequency component of U ₃ /V voltage channel		
U ₄ RMS	Fundamental frequency component of U ₄ /V voltage channel		

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.5.6 - 259. Information displayed by the function.

Name	Range	Step	Description
SYN condition	SYN1 Blocked SYN1 Ok SYN1 Bypass SYN1 Vcond Ok SYN1 Vdiff Ok SYN1 Adiff Ok SYN1 fdiff Ok Ok Ok	-	Displays status of the control function.
SYN volt status	Dead Dead Live Dead Dead Live Live Live Undefined Not monitored	-	Displays the voltage status of both sides.
SYN Mag diff	-120120%Un	0.01%Un	Displays voltage difference between the two measured voltages.
SYN Ang diff	-360'360deg	0.01deg	Displays angle difference between the two measured voltages.
SYN Freq diff	-7575Hz	0.001Hz	Displays frequency difference between the two measured voltages.
SYN Switch status	Still Departing Enclosing	-	Displays the synchroswitching status. This parameter is visible when "SYN Switching" parameter has been set to "Use SynSW".
Estimated BRK closing time	0360s	0.005s	Estimated time left to breaker closing.
Networks rotating time	0360s	0.005s	Estimated time how long it takes for the network to rotate fully.
Networks placement atm	-360360deg	0.001deg	Networks placement in degrees.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the synchronization is OK, a SYN OK signal is generated.

If the blocking signal is active when the SYN OK activates, a BLOCKED signal is generated and the function does not process the situation further. If the SYN OK function has been activated before the blocking signal, it resets.

Setting parameters

NOTE! Before these settings can be accessed, a voltage channel (U3 or U4) must be set into the synchrocheck mode ("SS") in the voltage transformer settings ($Measurements \rightarrow VT Module$).

The general settings can be found at the synchrocheck function's *INFO* tab, while the synchrocheck stage settings can be found in the *Settings* tab ($Control \rightarrow Control functions \rightarrow Synchrocheck$).

Table. 4.5.6 - 260. General settings.

Name	Range	Step	Default	Description
SYN(1,2,3) Status Force to	 Normal SYN1 Blocked SYN1 Ok SYN2 Blocked SYN2 Ok SYN3 Blocked SYN3 Ok 	-	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
System voltages are measured on	Bus, Line is reference Line, Bus is reference	-	Bus, Line is reference	Defines which voltage is the reference when determining dead/live status of voltages.
Use SYNx	• No • Yes	-	No	Activated/de-activates the individual stages (SYN1, 2, and 3) of the synchrocheck function. Activating a stage reveals the parameter settings for the configuration.
SYNx Start check	Always On start	-	Always	Selects synchrocheck start behaviour. If "On start" is selected "SYNx START" input must be active for synchrochecking to begin. "SYNx START" input signal can be defined at <i>IO</i> → <i>Input control</i> menu. If "Always" is selected "SYNx START" input is not needed for synchrochecking to start.
SYN1 V Reference	 Not in use UL12 UL23 UL31 UL1 UL2 UL3 	-	Not in use	Selects the reference voltage of the stage. Please note that the available references depend on the selected mode. All references available: - 3LN+U4(SS) - 2LL+U3(U0)+U4(SS) - 2LL+U3(SS)+U4(U0) Reference options 03 available: - 3LL+U4(SS) - 2LL+U3(Not in use)+U4(SS) - 2LL+U3(SS)+U4(Not in use)
SYN2 V Reference	Not in useUL12UL23UL31	-	Not in use	Selects the reference voltage of the stage. SYN2 is available when both U3 and U4 have been set to SS mode.
SYN3 V Reference	Not in useU3–U4	-	Not in use	Enables and disables the SYN3 stage. Operable in the 2LL+U3+U4 mode, with references UL12, UL23 and UL31 can be connected to the channels.

Name	Range	Step	Default	Description
SYNx Switching	Not in use Use SynSW	-	Not in use	Disables or enables synchroswitching. Synchroswitching is available only for SYN1. When synchroswitching is used, the function automatically closes the breaker when both sides of the breaker are synchronized. This setting is only visible when "Use SYN1" is activated.
SYNx Switch bk time	0.0001800.000s	0.005s	0.05s	Estimated time between a close command given to a breaker and the breaker entering the closed state. This setting is used to time the closing of the breaker so that both sides are as synchronized as possible when the breaker is actually closed. This setting is only visible when "SYN1 switching" is activated.
SYNx Switching object	Object 1Object 2Object 3Object 4Object 5	-	Object 1	When synchroswitching is enabled, this parameter defines which object receives the breaker's closing command. This setting is only visible when "SYNx Switching" is activated.
Estimated BRK closing time	0.000360.000s	0.005s	-	Displays the estimated time until networks are synchronized.
Networks rotating time	0.000360.000s	0.005s	-	Displays the time it takes for both sides of the network to fully rotate.
Networks placement atm	-360.000360.000deg	0.001deg	-	Indicates the angle difference between the two sides of the breaker at the moment.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.5.6 - 261. Synchrocheck stage settings.

Name	Range	Step	Default	Description
SYNx U conditions	 LL only LD only DL only LL & LD LL & DL LL & DD LL & LD & DL LL & LD & DD LL & DL & DD Bypass 	-	LL only	Determines the allowed states of the supervised systems. L = Live D = Dead
SYNx U live >	0.10100.00%Un	0.01%Un	20%Un	The voltage limit of the live state.
SYNx U dead	0.00100.00%Un	0.01%Un	20%Un	The voltage limit of the dead state. Not in use when set to 0%Un

Name	Range	Step	Default	Description
SYNx U diff <	2.0050.00%Un	0.01%Un	2.00%Un	The maximum allowed voltage difference between the systems.
SYNx angle diff <	3.0090.00deg	0.01deg	3deg	The maximum allowed angle difference between the systems.
SYNx freq diff	0.050.50Hz	0.01Hz	0.1Hz	The maximum allowed frequency difference between the systems.

Events and registers

The synchrocheck function (abbreviated "SYN" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming.

The function offers three (3) independent stages; the events are segregated for each stage operation.

Table. 4.5.6 - 262. Event messages.

Event block name	Event names			
SYN1	SYN1 Blocked On			
SYN1	SYN1 Blocked Off			
SYN1	SYN1 Ok On			
SYN1	SYN1 Ok Off			
SYN1	SYN1 Bypass On			
SYN1	SYN1 Bypass Off			
SYN1	SYN1 Volt condition OK			
SYN1	SYN1 Volt cond not match			
SYN1	SYN1 Volt diff Ok			
SYN1	SYN1 Volt diff out of setting			
SYN1	SYN1 Angle diff Ok			
SYN1	SYN1 Angle diff out of setting			
SYN1	SYN1 Frequency diff Ok			
SYN1	SYN1 Frequency diff out of setting			
SYNX1	SYN1 Voltage difference Ok On			
SYNX1	SYN1 Voltage difference Ok Off			
SYNX1	SYN1 Angle difference Ok On			

Event block name	Event names			
SYNX1	SYN1 Angle difference Ok Off			
SYNX1	SYN1 Frequency difference Ok On			
SYNX1	SYN1 Frequency difference Ok On			
SYNX1	SYN1 Live Live Condition On			
SYNX1	SYN1 Live Live Condition Off			
SYNX1	SYN1 Live Dead Condition On			
SYNX1	SYN1 Live Dead Condition Off			
SYNX1	SYN1 Dead Live Condition On			
SYNX1	SYN1 Dead Live Condition Off			
SYNX1	SYN1 Dead Dead Condition On			
SYNX1	SYN1 Dead Dead Condition On			
SYNX1	SYN1 Voltage Difference too high Vbus > Vline On			
SYNX1	SYN1 Voltage Difference too high Vbus > Vline Off			
SYNX1	SYN1 Voltage Difference too high Vline > Vbus On			
SYNX1	SYN1 Voltage Difference too high Vline > Vbus Off			
SYNX1	SYN1 Frequency Difference too high fbus > fline On			
SYNX1	SYN1 Frequency Difference too high fbus > fline Off			
SYNX1	SYN1 Frequency Difference too high fline > fbus On			
SYNX1	SYN1 Frequency Difference too high fline > fbus Off			
SYNX1	SYN1 Angle Difference too high a bus leads a line On			
SYNX1	SYN1 Angle Difference too high a bus leads a line Off			
SYNX1	SYN1 Angle Difference too high a line leads a bus On			
SYNX1	SYN1 Angle Difference too high a line leads a bus Off			
SYNX1	SYN1 Bus voltage Live On			
SYNX1	SYN1 Bus voltage Live Off			
SYNX1	SYN1 Bus voltage Dead On			
SYNX1	SYN1 Bus voltage Dead Off			
SYNX1	SYN1 Line voltage Live On			
SYNX1	SYN1 Line voltage Live Off			
SYNX1	SYN1 Line voltage Dead On			
SYNX1	SYN1 Line voltage Dead Off			

The function registers its operation into the last twelve (12) time-stamped registers. The table below presents the structure of the function's register content.

Table. 4.5.6 - 263. Register content.

Name	Range			
Date and time	dd.mm.yyyy hh:mm:ss.mss			
Event	Event name			
SYNx Ref1 voltage	The reference voltage of the selected stage.			
SYNx Ref2 voltage	The reference voltage of the selected stage.			
SYNx Volt Cond	The voltage condition of the selected stage.			
SYNx Volt status	The voltage status of the selected stage.			
SYNx Vdiff	The voltage difference of the selected stage.			
SYNx Vdiff cond	The set condition of the voltage difference of the selected stage.			
SYNx Adiff	The angle difference of the selected stage.			
SYNx Adiff cond	The set condition of the angle difference of the selected stage.			
SYNx fdiff	The frequency difference of the selected stage.			
SYNx fdiff cond	The set condition of the frequency difference of the selected stage.			
Setting group in use	Setting group 18 active.			

4.5.7 Milliampere output control

The milliamp current loop is the prevailing process control signal in many industries. It is an ideal method of transferring process information because a current does not change as it travels from a transmitter to a receiver. It is also much more simple and cost-effective.

The benefits of 4...20 mA loops:

- the dominant standard in many industries
- · the simplest option to connect and configure
- · uses less wiring and connections than other signals, thus greatly reducing initial setup costs
- good for travelling long distances, as current does not degrade over long connections like voltage does
- · less sensitive to background electrical noise
- detects a fault in the system incredibly easily since 4 mA is equal to 0 % output.

Milliampere (mA) outputs

AQ-200 series supports up to two (2) independent mA option cards. Each card has four (4) mA output channels and one (1) mA input channel. If the device has an mA option card, enable mA outputs at $Control \rightarrow Device\ IO \rightarrow mA\ outputs$. The outputs are activated in groups of two: channels 1 and 2 are activated together, as are channels 3 and 4.

Table. 4.5.7 - 264. Main settings (output channels).

Name		Range	Default	Description
mA option	Enable mA output channels 1 and 2	Disabled	DisabledEnabled	Enables and disables the outputs of the mA output card 1.
card 1	Enable mA output channels 3 and 4	Enabled		
mA option	Enable mA output channels 5 and 6	Disabled	Disabled	Enables and disables the outputs of the
card 2	Enable mA output channels 7 and 8	• Enabled	Disabled	mA output card 2.

Table. 4.5.7 - 265. Settings for mA output channels.

Name	Range	Step	Default	Description
Enable mA output channel	DisabledEnabled	ı	Disabled	Enables and disables the selected mA output channel. If the channel is disabled, the channel settings are hidden.
Magnitude selection for mA output channel	CurrentsVoltagesPowersImpedance and admittanceOther	-	Currents	Defines the measurement category that is used for mA output control.
Magnitude of mA output channel	(dependent on the measurement category selection)	-	(dependent on the measurement category selection)	Defines the measurement magnitude used for mA output control. The available measurements depend on the selection of the "Magnitude selection for mA output channel" parameter.
Input value 1	-10 ⁷ 10 ⁷	0.001	0	The first input point in the mA output control curve.
Scaled mA output value 1	0.000024.0000mA	0.0001mA	0mA	The mA output value when the measured value is equal to or less than Input value 1.
Input value 2	-10 ⁷ 10 ⁷	0.001	1	The second input point in the mA output control curve.
Scaled mA output value 2	0.000024.0000mA	0.0001mA	0mA	The mA output value when the measured value is equal to or greater than Input value 2.

Figure. 4.5.7 - 215. Example of the effects of mA output channel settings.

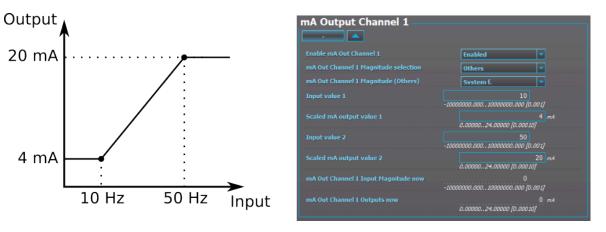


Table. 4.5.7 - 266. Hardware indications.

Name	Range	Description
Hardware in mA output channels 14 Hardware in mA output channels 58	 None Slot A Slot B Slot C Slot D Slot E Slot F 	Indicates the option card slot where the mA output card is located.

Table. 4.5.7 - 267. Measurement values reported by mA output cards.

Name	Range	Step	Description
mA in Channel 1	0.000024.0000mA	0.0001mA	Displays the measured mA value of the selected input channel.
mA in Channel 2	0.000024.0000IIIA		
mA Out Channel Input Magnitude now	-10 ⁷ 10 ⁷	0.001	Displays the input value of the selected mA output channel at that moment.
mA Out Channel Outputs now	0.000024.0000mA	0.0001mA	Displays the output value of the selected mA output channel at that moment.

4.5.8 Programmable control switch

The programmable control switch is a control function that controls its binary output signal. This output signal can be controlled locally from the device's mimic or remotely from the RTU. The main purpose of programmable control switches is to block or enable function and to change function properties by changing the setting group. However, this binary signal can also be used for any number of other purposes, just like all other binary signals. Once a programmable control switch has been activated or disabled, it remains in that state until given a new command to switch to the opposite state (see the image below). The switch cannot be controlled by an auxiliary input, such as digital inputs or logic signals; it can only be controlled locally (mimic) or remotely (RTU).

Figure. 4.5.8 - 216. When a PCS has been controlled "ON" or "OFF", the PCS will keep its state.



Settings.

These settings can be accessed at Control \rightarrow Device I/O \rightarrow Programmable control switch.

Table. 4.5.8 - 268. Settings.

Name	Range	Default	Description
Switch name	-	Switchx	The user-settable name of the selected switch. The name can be up to 32 characters long.
Access level for Mimic control	UserOperatorConfiguratorSuper user	Configurator	Determines which access level is required to be able to control the programmable control switch via the Mimic.

Events

The programmable control switch function (abbreviated "PCS" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp. The function offers five (5) independent switches. The function's output signals can be used for direct I/O controlling and user logic programming.

Table. 4.5.8 - 269. Event messages.

Event block name	Event names
PCS	Switch 1 ON
PCS	Switch 1 OFF
PCS	Switch 2 ON
PCS	Switch 2 OFF
PCS	Switch 3 ON
PCS	Switch 3 OFF

Event block name	Event names
PCS	Switch 4 ON
PCS	Switch 4 OFF
PCS	Switch 5 ON
PCS	Switch 5 OFF

4.5.9 Analog input scaling curves

Sometimes when measuring with RTD inputs, milliampere inputs and digital inputs the measurement might be inaccurate because the signal coming from the source is inaccurate. One common example of this is tap changer location indication signal not changing linearly from step to step. If the output difference between the steps are not equal to each other, measuring the incoming signal accurately is not enough. "Analog input scaling curves" menu can be used to take these inaccuracies into account.

Analog input scaling curve settings can be found at *Measurement* \rightarrow *Al(mA, Dl volt) scaling* menu.

Currently following measurements can be scaled with analog input scaling curves:

- RTD inputs and mA inputs in "RTD & mA input" option cards
- mA inputs in "4x mA output & 1x mA input" option cards
- mA input in "4x mA input & 1x mA output" option cards
- · Digital input voltages

Table. 4.5.9 - 270. Main settings (input channel).

Name	Range	Step	Default	Description
Analog input scaling	DisabledActivated	-	Disabled	Enables and disables the input.
Scaling curve 110	Disabled Activated	-	Disabled	Enables and disables the scaling curve and the input measurement.

Name	Range	Step	Default	Description
Curve 110 input signal select	S7 mA Input S8 mA Input S15 mA Input S16 mA Input Inp	-	S7 mA Input	Defines the measurement used by scaling curve.
Curve 110 input signal filtering	No Yes	-	No	Enables calculation of the average of received signal.
Curve 110 input signal filter time constant	0.0053800.000 s	0.005 s	1 s	Time constant for input signal filtering. This parameter is visible when "Curve 14 input signal filtering" has been set to "Yes".
Curve 110 input signal out of range set	No Yes	-	No	Enables out of range signals. If input signal is out of minimum and maximum limits, "ASC14 input out of range" signal is activated.
Curve110 input minimum	-1 000 000.001 000 000.00	0.00001	0	Defines the minimum input of the curve. If input is below the set limit, "ASC14 input out of range" is activated.
Curve 110 input	-1 000 000.001 000 000.00	0.00001	-	Displays the input measurement received by the curve.
Curve110 input maximum	-1 000 000.001 000 000.00	0.00001	0	Defines the maximum input of the curve. If input is above the set limit, "ASC14 input out of range" is activated.
Curve110 output	-1 000 000.001 000 000.00	0.00001	-	Displays the output of the curve.

The input signal filtering parameter calculates the average of received signals according to the set time constant. This is why rapid changes and disturbances (such as fast spikes) are smothered. The Nyquist rate states that the filter time constant must be at least double the period time of the disturbance process signal. For example, the value for the filter time constant is 2 seconds for a 1 second period time of a disturbance oscillation.

$$H(s) = \frac{wc}{s + wc} = \frac{1}{1 + s/wc}$$

When the curve signal is out of range, it activates the "ASC1...10 input out of range" signal, which can be used inside logic or with other functions of the device. The signal can be assigned directly to an output relay or to an LED in the I/O matrix. The "Out of range" signal is activated, when the measured signal falls below the set input minimum limit, or when it exceeds the input maximum limit.

If for some reason the input signal is lost, the value is fixed to the last actual measured cycle value. The value does not go down to the minimum if it has been something else at the time of the signal breaking.

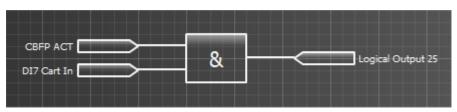
Table. 4.5.9 - 271. Output settings and indications.

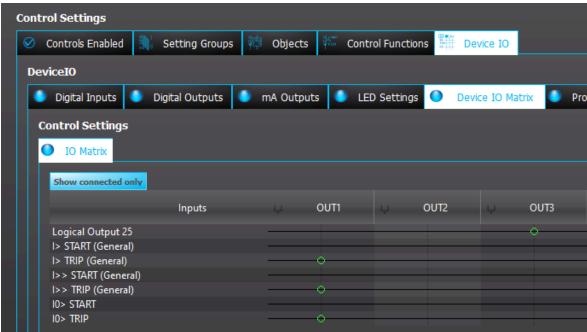
Name	Range	Step	Default	Description
Curve 110 update cycle	510 000ms	5ms	150ms	Defines the length of the input measurement update cycle. If the user wants a fast operation, this setting should be fairly low.
Scaled value handling	Floating point Integer out (Floor) Integer (Ceiling) Integer (Nearest)	-	Floating point	Rounds the milliampere signal output as selected.
Input value	04000	0.000 01	0	The measured input value at Curve Point 1.
Scaled output value 1	-10 ⁷ 10 ⁷	0.000 01	0	Scales the measured milliampere signal at Point 1.
Input value 2	04000	0.000 01	1	The measured input value at Curve Point 2.
Scaled output value 1	-10 ⁷ 10 ⁷	0.000 01	0	Scales the measured milliampere signal at Point 2.
Add curvepoint 320	Not usedUsed	-	Not used	Allows the user to create their own curve with up to twenty (20) curve points, instead of using a linear curve between two points.

4.5.10 Logical outputs

Logical outputs are used for sending binary signals out from a logic that has been built in the logic editor. Logical signals can be used for blocking functions, changing setting groups, controlling digital outputs, activating LEDs, etc. The status of logical outputs can also be reported to a SCADA system. 32 logical outputs are available. The figure below presents a logic output example where a signal from the circuit breaker failure protection function controls the digital output relay number 3 ("OUT3") when the circuit breaker's cart status is "In".

Figure. 4.5.10 - 217. Logic output example. Logical output is connected to an output relay in matrix.





Logical output descriptions

Logical outputs can be given a description. The user defined description are displayed in most of the menus:

- · logic editor
- matrix
- block settings
- •
- •
- etc.

Table. 4.5.10 - 272. Logical output user description.

Name	Range	Default	Description
User editable description LO132	131 characters	Logical output 132	Description of the logical output. This description is used in several menu types for easier identification.

Events

The logical outputs (abbreviated "LOGIC" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp. The function's output signals can be used for direct I/O controlling and user logic programming.

Table. 4.5.10 - 273. Event messages.

Event block name	Event names
LOGIC1	Logical out 132 ON
LOGIC1	Logical out 132 OFF

4.5.11 Logical inputs

Logical inputs are binary signals that a user can control manually to change the behavior of the AQ-200 unit or to give direct control commands. Logical inputs can be controlled with a virtual switch built in the mimic and from a SCADA system. Logical inputs are volatile signals: their status will always return to "0" when the AQ-200 device is rebooted. 32 logical inputs are available.

Logical inputs have two modes available: Hold and Pulse. When a logical input which has been set to "Hold" mode is controlled to "1", the input will switch to status "1" and it stays in that status until it is given a control command to go to status "0" or until the device is rebooted. When a logical input which has been set to "Pulse" mode is controlled to "1", the input will switch to status "1" and return back to "0" after 5 ms.

The figure below presents the operation of a logical input in Hold mode and in Pulse mode.

Figure. 4.5.11 - 218. Operation of logical input in "Hold" and "Pulse" modes.

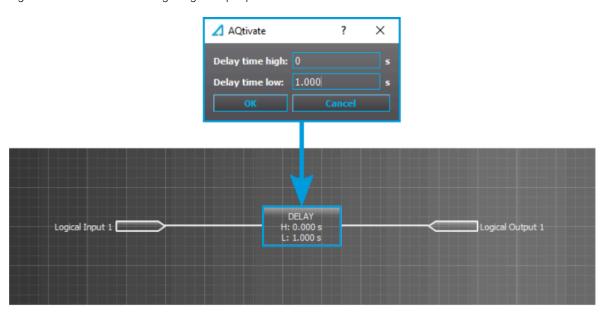
Logical input control "0" command
Logical input control "1" command
Logical input status "Hold" mode
Logical input status "Pulse" mode

5 ms



A logical input pulse can also be extended by connecting a DELAY-low gate to a logical output, as has been done in the example figure below.

Figure. 4.5.11 - 219. Extending a logical input pulse.



Logical input control "1" command Logical input status "Pulse" mode Logical output status



Logical input descriptions

Logical inputs can be given a description. The user defined description are displayed in most of the menus:

- · logic editor
- matrix
- block settings
- •
- etc.

Table. 4.5.11 - 274. Logical input user description.

Name	Range	Default	Description
User editable description LI132	131 characters	Logical input 132	Description of the logical input. This description is used in several menu types for easier identification.

Events

The logical outputs (abbreviated "LOGIC" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp. The function's output signals can be used for direct I/O controlling and user logic programming.

Table. 4.5.11 - 275. Event messages.

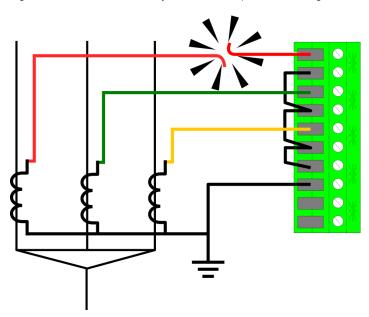
Event block name	Event names
LOGIC2	Logical in 132 ON
LOGIC2	Logical in 132 OFF

4.6 Monitoring functions

4.6.1 Current transformer supervision

The current transformer supervision function (abbreviated CTS in this document) is used for monitoring the CTs as well as the wirings between the device and the CT inputs for malfunctions and wire breaks. An open CT circuit can generate dangerously high voltages into the CT secondary side, and cause unintended activations of current balance monitoring functions.

Figure. 4.6.1 - 220. Secondary circuit fault in phase L1 wiring.

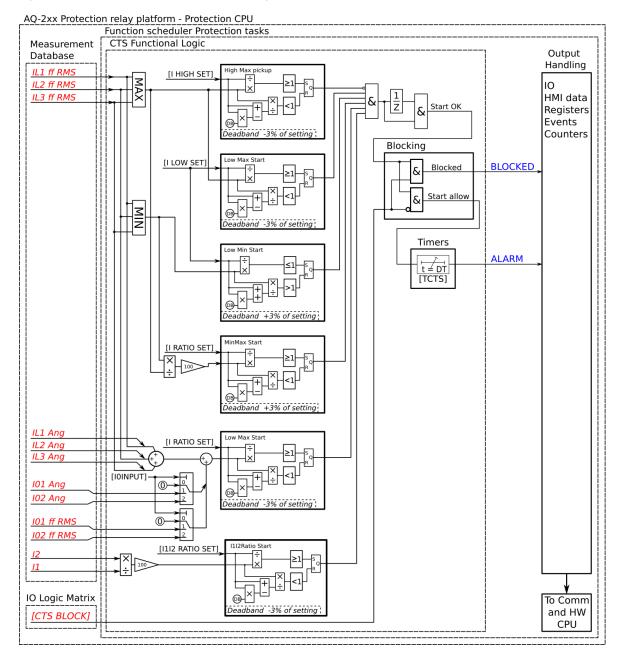


The function constantly monitors the instant values and the key calculated magnitudes of the phase currents. Additionally, the residual current circuit can be monitored if the residual current is measured from a dedicated residual current CT. The user can enable and disable the residual circuit monitoring at will.

The following conditions have to be met simultaneously for the function alarm to activate:

- None of the three-phase currents exceeds the *lset high limit* setting.
- At least one of the three-phase currents exceeds the *l_{set} low limit* setting.
- At least one of the three-phase currents are below the *lset low limit* setting.
- The ratio between the calculated minimum and maximum of the three-phase currents is below the *l_{set} ratio* setting.
- The ratio between the negative sequence and the positive sequence exceeds the *12/11 ratio* setting.
- The calculated difference (IL1+IL2+IL3+I0) exceeds the *I_{sum} difference* setting (optional).
- The above-mentioned condition is met until the set time delay for alarm.

Figure. 4.6.1 - 221. Simplified function block diagram of the CTS function.



Measured input

The function block uses fundamental frequency component of phase current measurement values and residual current measurement values. The function supervises the angle of each current measurement channel. Positive sequence current and negative sequence currents are calculated from the phase currents. The user can select what is used for the residual current measurement: nothing, the l01 channel, or the l02 channel.

Table. 4.6.1 - 276. Measured inputs of the CTS function.

Signal	Description
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current

Signal	Description
I _{L3} RMS	Fundamental frequency component of phase L3 (C) current
I ₀₁ RMS	Fundamental frequency component of residual input I01
I ₀₂ RMS	Fundamental frequency component of residual input I02

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.6.1 - 277. General settings of the function.

Name	Range Default		Description
CTS force status to	NormalAlarmBlocked	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.
I0 input selection	Not in useI01I02	Not in use	Selects the measurement input for the residual current. If the residual current is measured with a separate CT, the residual current circuit can be monitored with the CTS function as well. However, this does not apply to summing connections (Holmgren, etc.). If the phase current CT is summed with I01 or I02, this selection should be set to "Not in use".
I0 direction	AddSubtract	Add	Defines the polarity of residual current channel connection.
Compensate natural unbalance	• - • Comp	-	When activated while the line is energized, the currently present calculated residual current is compensated to 0.

Pick-up settings

The l_{set} and lO_{set} setting parameters control the current-dependent pick-up and activation of the current transformer supervision function. They define the minimum and maximum allowed measured current before action from the function. The function constantly calculates the ratio between the setting values and the measured magnitude (l_m) for each of the three phases and for the selected residual current input. The reset ratio of 97 % and 103% are built into the function and is always relative to the l_{set} value. The setting value is common for all measured amplitudes, and when the l_m exceeds the l_{set} value (in single, dual or all currents) it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.6.1 - 278. Pick-up settings.

Name	Range	Step	Default	Description
I _{set} high limit	0.0140.00×I _n	0.01×I _n	1.20×I _n	Determines the pick-up threshold for phase current measurement. This setting limit defines the upper limit for the phase current's pick-up element. If this condition is met, it is considered as fault and the function is not activated.

Name	Range	Step	Default	Description
I _{set} low limit	0.0140.00×I _n	0.01×I _n	0.10×I _n	Determines the pick-up threshold for phase current measurement. This setting limit defines the lower limit for the phase current's pick-up element. This condition has to be met for the function to activate.
I _{set} ratio	0.01100.00%	0.01%	10.00%	Determines the pick-up ratio threshold between the minimum and maximum values of the phase current. This condition has to be met for the function to activate.
I2/I1 ratio	0.01100.00%	0.01%	49.00%	Determines the pick-up ratio threshold for the negative and positive sequence currents calculated from the phase currents. This condition has to be met for the function to activate. The ratio is 50 % for a full single-phasing fault (i.e. when one of the phases is lost entirely). Setting this at 49 % allows a current of $0.01 \times I_n$ to flow in one phase, wile the other two are at nominal current.
I _{sum} difference	0.0140.00×I _n	0.01×I _n	0.10×I _n	Determines the pick-up ratio threshold for the calculated residual phase current and the measured residual current. If the measurement circuit is healthy, the sum of these two currents should be 0.
Time delay for alarm	0.0001800.000s	0.005s	0.5s	Determines the delay between the activation of the function and the alarm.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.6.1 - 279. Information displayed by the function.

Name	Range	Step	Description
Uncompensated residual unbalance Pri	NormalStartTripBlocked	-	Displays the natural unbalance of current after compensating it with <i>Compensate natural unbalance</i> parameter.
Natural unbalance ang	-360.00360.00 deg	0.01 deg	Displays the natural unbalance of angle after compensating it with Compensate natural unbalance parameter.
Measured current difference Isum, I0	0.0050.00 xln	0.01 xln	Current difference between summed phases and residual current.
Measured angle difference Isum, I0	-360360 deg	0.01 deg	Angle difference between summed phases and residual current.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

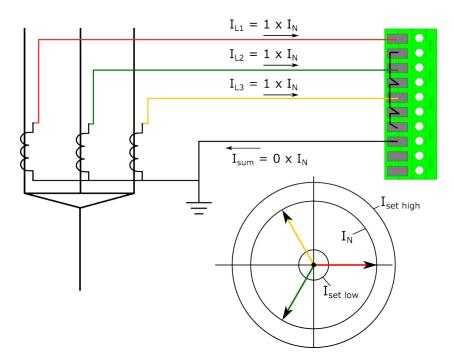
Operating time characteristics

This function supports definite time delay (DT). For detailed information on this delay type please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Typical cases of current transformer supervision

The following nine examples present some typical cases of the current transformer supervision and their setting effects.

Figure. 4.6.1 - 222. All works properly, no faults.



Settings:

$$\begin{split} &I_{set} \text{ High limit} = 1.20 \times I_{N} \\ &I_{set} \text{ Low limit} = 0.10 \times I_{N} \\ &I_{set} \text{ ratio} = 10.00 \% \\ &I1/I2 \text{ ratio} = 49.00 \% \\ &I_{0} \text{ input} = \text{Not in use} \end{split}$$

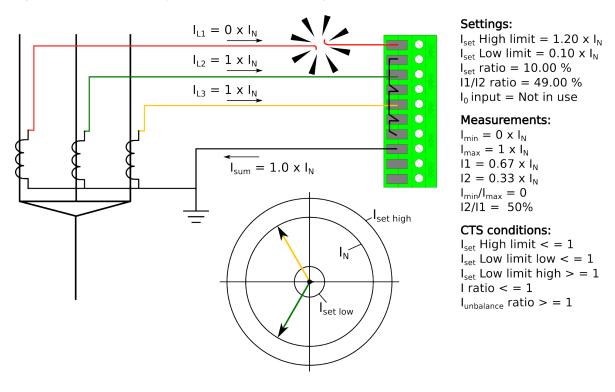
Measurements:

$$\begin{split} I_{\text{min}} &= 1 \times I_{\text{N}} \\ I_{\text{max}} &= 1 \times I_{\text{N}} \\ I1 &= 1 \times I_{\text{N}} \\ I2 &= 0 \times I_{\text{N}} \\ I_{\text{min}}/I_{\text{max}} &= 1 \\ I2/I1 &= 0\% \end{split}$$

CTS conditions:

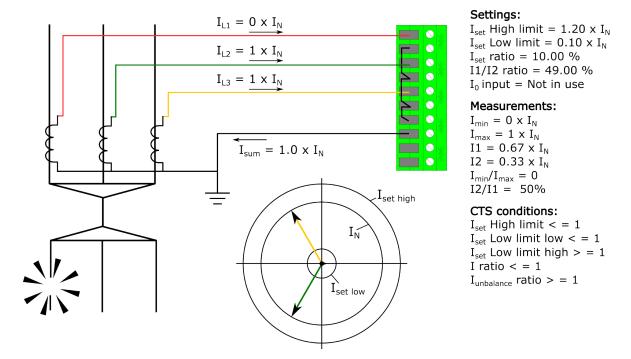
$$\begin{split} &I_{set} \text{ High limit } < = 1 \\ &I_{set} \text{ Low limit low } < = 0 \\ &I_{set} \text{ Low limit high } > = 1 \\ &I \text{ ratio } < = 0 \\ &I_{unbalance} \text{ ratio } > = 0 \end{split}$$

Figure. 4.6.1 - 223. Secondary circuit fault in phase L1 wiring.



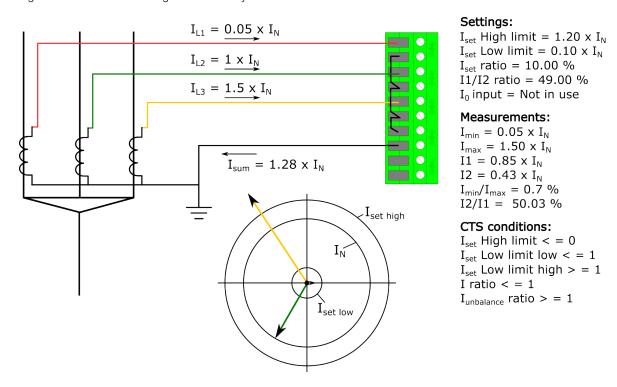
When a fault is detected and all conditions are met, the CTS timer starts counting. If the situation continues until the set time has passed, the function issues an alarm.

Figure. 4.6.1 - 224. Primary circuit fault in phase L1 wiring.



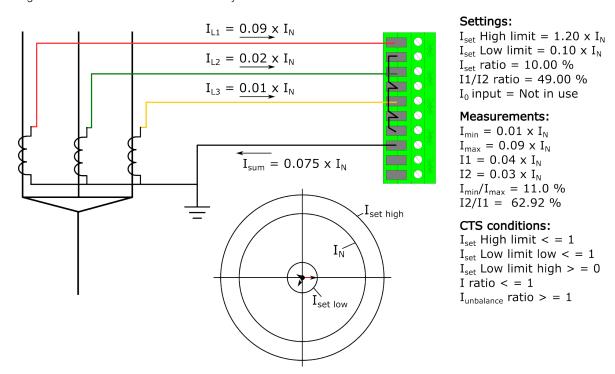
In this example, distinguishing between a primary fault and a secondary fault is impossible. However, the situation meets the function's activation conditions, and if this state (secondary circuit fault) continues until the set time has passed, the function issues an alarm. This means that the function supervises both the primary and the secondary circuit.

Figure. 4.6.1 - 225. No wiring fault but heavy unbalance.



If any of the phases exceed the I_{set} high limit setting, the operation of the function is not activated. This behavior is applied to short-circuits and earth faults even when the fault current exceeds the I_{set} high limit setting.

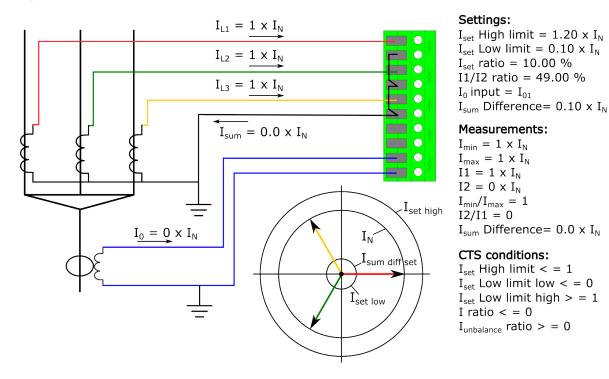
Figure. 4.6.1 - 226. Low current and heavy unbalance.



If all of the measured phase magnitudes are below the l_{set} low limit setting, the function is not activated even when the other conditions (inc. the unbalance condition) are met.

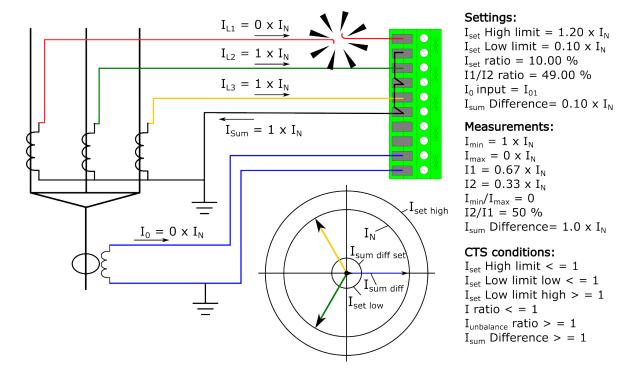
If the *I_{set} high limit* and *I_{set} low limit* setting parameters are adjusted according to the application's normal behavior, the operation of the function can be set to be very sensitive for broken circuit and conductor faults.

Figure. 4.6.1 - 227. Normal situation, residual current also measured.



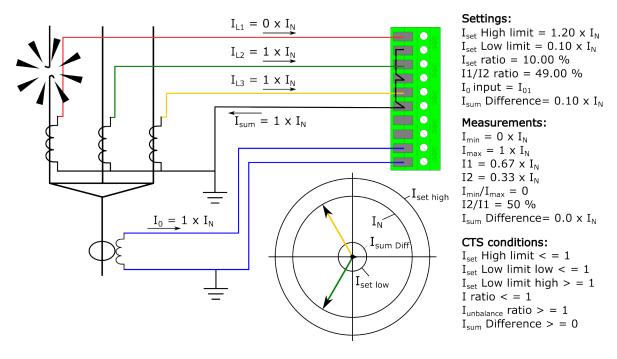
When the residual condition is added with the "I0 input selection", the sum of the current and the residual current are compared against each other to verify the wiring condition.

Figure. 4.6.1 - 228. Broken secondary phase current wiring.



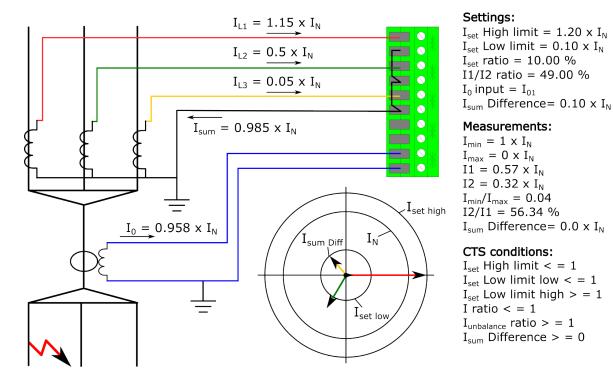
When phase current wire is broken all of the conditions are met in the CTS and alarm shall be issued in case if the situation continues until the set alarming time is met.

Figure. 4.6.1 - 229. Broken primary phase current wiring.



In this example, all other condition are met except the residual difference. That is now $0 \times I_n$, which indicates a primary side fault.

Figure. 4.6.1 - 230. Primary side high-impedance earth fault.



In this example there is a high-impedance earth fault. It does not activate the function, if the measurement conditions are met, while the calculated and measured residual current difference does not reach the limit. The *I_{sum} difference* setting should be set according to the application in order to reach maximum security and maximum sensitivity for the network earthing.

Events and registers

The current transformer supervision function (abbreviated "CTS" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the CTS ALARM and BLOCKED events.

Table. 4.6.1 - 280. Event messages.

Event block name	Event names
CTS1	Alarm ON
CTS1	Alarm OFF
CTS1	Block ON
CTS1	Block OFF

The function registers its operation into the last twelve (12) time-stamped registers; this information is available for all provided instances separately. The register of the function records the ON event process data for ACTIVATED, BLOCKED, etc. The table below presents the structure of the function's register content.

Table. 4.6.1 - 281. Register content.

Register	Description			
Date and time	dd.mm.yyyy hh:mm:ss.mss			
Event	Event name			
Trigger currents	The phase currents (L1, L2 & L3), the residual currents (I01 & I02), and the sequence currents (I1 & I2) on trigger time.			
Time to CTSact	Time remaining before alarm activation.			
Fault type	The status code of the monitored current.			
Setting group in use	Setting group 18 active			

4.6.2 Voltage transformer supervision (60)

Voltage transformer supervision is used to detect errors in the secondary circuit of the voltage transformer wiring and during fuse failure. This signal is mostly used as an alarming function or to disable functions that require adequate voltage measurement.

Figure. 4.6.2 - 231. Secondary circuit fault in phase L1 wiring.

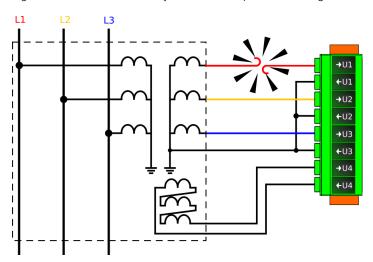
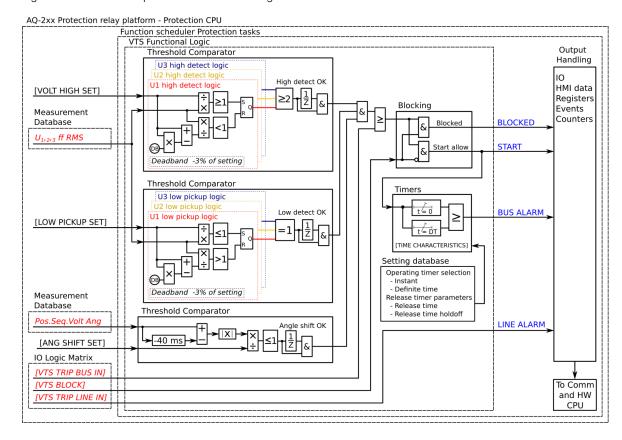


Figure. 4.6.2 - 232. Simplified function block diagram of the VTS function.



Measured input

The function block uses fundamental frequency component of voltage measurement channels. The function uses calculated positive, negative and zero sequence voltages. The function also monitors the angle of each voltage channel.

Table. 4.6.2 - 282. Measurement inputs of the voltage transformer supervision function.

Signal	Description	Time base
U ₁ RMS	Fundamental frequency component of U ₁ /V voltage measurement	5ms

Signal	Description	Time base
U ₂ RMS	Fundamental frequency component of U ₂ /V voltage measurement	5ms
U ₃ RMS	Fundamental frequency component of U ₃ /V voltage measurement	5ms
U ₄ RMS	Fundamental frequency component of U ₄ /V voltage measurement	5ms

Pick-up settings

The *Voltage low pick-up* and *Voltage high detect* setting parameters control the voltage-dependent pick-up and activation of the voltage transformer supervision function. The function's pick-up activates, if at least one of the three voltages is under the set *Voltage low pick-up* value, or if at least two of the three voltages exceed the set *Voltage high detect* value. The function constantly calculates the ratio between the setting values and the measured magnitude for each of the three phases.

Setting group selection controls the operating characteristics of the function, i.e. the user or user-defined logic can change function parameters while the function is running.

Table. 4.6.2 - 283. Pick-up settings.

Name	Range	Step	Default	Description
Voltage low pickup	0.050.50×Un	0.01×U _n	0.05×U _n	If one the measured voltages is below low pickup value and
Voltage high detect	0.011.10×U _n	0.01×U _n	0.80×U _n	two of the measured voltages exceed high detect value the function's pick-up activates.
Angle shift limit	2.0090.00deg	0.10deg	5.00deg	If the difference between the present angle and the angle 40 ms before is below the set value, the function's pick-up is blocked.
Bus fuse fail check	• No • Yes	-	Yes	Selects whether or not the state of the bus fuse is supervised. The supervised signal is determined the "VTS MCB Trip bus" setting ($I/O \rightarrow Fuse\ failure\ inputs$).
Line fuse fail check	• No • Yes	-	Yes	Selects whether or not the state of the line fuse is supervised. The supervised signal is determined by the "VTS MCB Trip line" setting ($I/O \rightarrow Fuse\ failure\ inputs$).

The voltage transformer supervision can also report several different states of the measured voltage. These can be seen in the function's *INFO* menu.

Name	Description
Bus dead	No voltages.
Bus Live VTS Ok	All of the voltages are within the set limits.
Bus Live VTS Ok SEQ Rev	All of the voltages are within the set limits BUT the voltages are in a reversed sequence.
Bus Live VTS Ok SEQ Undef	Voltages are within the set limits BUT the sequence cannot be defined.

Name	Description
Bus Live VTS problem	Any of the VTS pick-up conditions are met.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.6.2 - 284. Information displayed by the function.

Name	Range	Step	Description
VTS condition	NormalStartVTLinefailVTBusfailBlocked	-	Displays status of the monitoring function.
Bus voltages	 Bus dead Bus Live VTS Ok SEQ Ok Bus Live VTS Ok SEQ Rev Bus Live VTS Ok SEQ Undef Bus Live VTS problem 	-	Displays the status of bus voltages.
Expected operating time	0.0001800.000s	0.005s	Displays the expected operating time when a fault occurs.
Time remaining to trip	-1800.0001800.000s	0.005s	When the function has detected a fault and counts down time towards a operation, this displays how much time is left before operation occurs.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for activation

This function supports definite time delay (DT). For detailed information on these delay types please refer to the chapter "General properties of a protection function" and its section "Operating time characteristics".

Events and registers

The voltage transformer supervision function (abbreviated "VTS" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, ALARM BUS, ALARM LINE and BLOCKED events.

Table. 4.6.2 - 285. Event messages.

Event block name	Event names
VTS1	Bus VT fail Start ON
VTS1	Bus VT fail Start OFF
VTS1	Bus VT fail Trip ON
VTS1	Bus VT fail Trip OFF
VTS1	Bus VT fail Block ON
VTS1	Bus VT fail Block OFF
VTS1	Line VT fail ON
VTS1	Line VT fail OFF
VTS1	Bus Fuse fail ON
VTS1	Bus Fuse fail OFF
VTS1	Line Fuse fail ON
VTS1	Line Fuse fail OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for ACTIVATED, BLOCKED, etc. The table below presents the structure of the function's register content.

Table. 4.6.2 - 286. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name

Register	Description
Volt 1, 2, 3, 4 status	No voltageVoltage OKLow voltage
System status	 Bus dead Bus live, VTS OK, Seq. OK Bus live, VTS OK, Seq. reversed Bus live, VTS OK, Seq. undefined Bus live, VTS fault
Input A, B, C, D angle diff	0.00360.00deg
Trip time remaining	Time remaining to alarm 01800s
Setting group in use	Setting group 18 active

4.6.3 Circuit breaker wear monitoring

The circuit breaker wear function is used for monitoring the circuit breaker's lifetime and its maintenance needs caused by interrupting currents and mechanical wear. The function uses the circuit breaker's manufacturer-supplied data for the breaker operating cycles in relation to the interrupted current magnitudes.

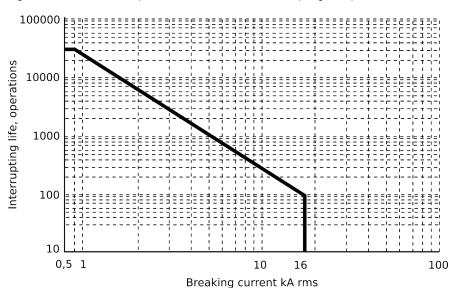
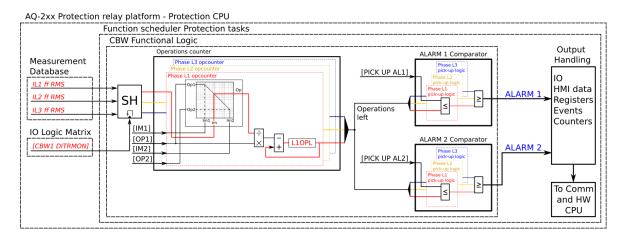


Figure. 4.6.3 - 233. Example of the circuit breaker interrupting life operations.

The function is triggered from the circuit breaker's "Open" command output and it monitors the three-phase current values in both the tripping moment and the normal breaker opening moment. The maximum value of interrupting life operations for each phase is calculated from these currents. The value is cumulatively deducted from the starting operations starting value. The user can set up two separate alarm levels, which are activated when the value of interrupting life operations is below the setting limit. The "Trip contact" setting defines the output that triggers the current monitoring at the breaker's "Open" command.

Figure. 4.6.3 - 234. Simplified function block diagram of the circuit breaker wear function.



Measured input

The function block uses fundamental frequency component of phase current measurement values.

Table. 4.6.3 - 287. Measurement inputs of the circuit breaker wear function.

Signal	Description		
I _{L1} RMS	Fundamental frequency component of phase L1 (A) current		
I _{L2} RMS	Fundamental frequency component of phase L2 (B) current		
I _{L3} RMS	Fundamental frequency component of phase L3 (C) current		

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by switching the setting group.

Table. 4.6.3 - 288. General settings.

Name	Range	Default	Description
CBW force status to	Normal Alarm1 On Alarm2 On	Normal	Force the status of the function. Visible only when <i>Enable stage forcing</i> parameter is enabled in <i>General</i> menu.

Circuit breaker characteristics settings

The circuit breaker characteristics are set by two operating points, defined by the nominal breaking current, the maximum allowed breaking current and their respective operation settings. This data is provided by the circuit breaker's manufacturer.

Table. 4.6.3 - 289. Settings for circuit breaker characteristics.

Name	Range	Step	Default	Description
Operations 1	0200 000	1	50 000	The number of interrupting life operations at the nominal current (Close - Open).
Operations 2	0200 000	1	100	The number of interrupting life operations at the rated breaking current (Open).
Current 1 (Inom)	0100.00kA	0.01kA	1kA	The rated normal current (RMS).
Current 2 (I _{max})	0100.00kA	0.01kA	20kA	The rated short-circuit breaking current (RMS).

Pick-up settings

For the alarm stages Alarm 1 and Alarm 2, the user can set the pick-up level for the number of operations left. The pick-up setting is common for all phases and the alarm stage picks up if any of the phases goes below this setting.

Table. 4.6.3 - 290. Pick-up settings.

Name	Range	Default	Description
Alarm 1	DisabledEnabled	Disabled	Enable and disable the Alarm 1 stage.
Alarm 1 Set	0200 000	1 000	Defines the pick-up threshold for remaining operations. When the number of remaining operations is below this setting, the ALARM 1 signal is activated.
Alarm 2	DisabledEnabled	Disabled	Enable and disable the Alarm 2 stage.
Alarm 2 Set	0200 000	100	Defines the pick-up threshold for remaining operations. When the number of remaining operations is below this setting, the ALARM 2 signal is activated.

Setting example

Let us examine the settings, using a low-duty vacuum circuit breaker as an example. The image below presents the technical specifications provided by the manufacturer, with the data relevant to our settings highlighted in red:

Rated voltage, kV	24
Rated current, A	800
Rated power frequency test voltage, kV	50
Rated frequency, Hz	50/60
Rated impulse test voltage, kV peak	125
Partial discharge level at 1,1 rated voltage kV, pC	<10
Rated short-circuit breaking current, kA	16
Rated short-circuit making current, kA peak	41.5
Short time withstand current, 4s, kA	16
Mechanical life, CO cycles, not less than	30,000
Interrupting life operations, not less than	
at rated current	30,000
at breaking current	100
at other currents	see Fig.41
Closing time, ms, not more than	35
Opening time, ms, not more than	15
Breaking time, ms, not more than	25
Main contact resistance, µ Ohm, not more than	40
Maximum ambient temperature, C°	+55
Minimum ambient temperature, C°	-40
Design class (according to IEC 60932)	1
Electrical endurance class at rated IEEE/IEC duty	E2
Mechanical endurance class at rated IEEE/IEC duty	M2
Capacitive current switching class	C2
"Mechanical vibration and shock withstand capability, IEC 60721, IEC 60068"	Class 4M4
Maximum altitude above sea level, m	3000*
Maximum humidity, non condensing	98 %
Weight, kg - LD_1	35
Weight, kg - LD_6	55

Now, we set the stage as follows:

Parameter	Setting
Current 1	0.80 kA
Operation 1	30 000 operations
Current 2	16.00 kA
Operations 2	100 operations
Enable Alarm 1	Enabled
Alarm 1 Set	1000 operations
Enable Alarm 2	Enabled
Alarm 2 Set	100 operations

With these settings, Alarm 1 is issued when the cumulative interruption counter for any of the three phases dips below the set 1000 remaining operations ("Alarm 1 Set"). Similarly, when any of the counters dips below 100 remaining operations, Alarm 2 is issued.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.6.3 - 291. Information displayed by the function.

Name	Range	Description
CBW condition	Normal Alarm1 On Alarm2 On	Displays the status of the function.
Breaker operations	-	Cumulative counter of "open" operations.
Alarm 1 counter	-	Alarm 1 operation counter.
Alarm 2 counter	-	Alarm 2 operation counter.
L1 Operations left	-	Operations left for phase L1.
L2 Operations left	-	Operations left for phase L2.
L3 Operations left	-	Operations left for phase L3.

Events and registers

The circuit breaker wear function (abbreviated "CBW" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The function's outputs can be used for direct I/O controlling and user logic programming. The events triggered by the function are recorded with a time stamp.

The function also provides a resettable cumulative counter for the "Open" operations as well as the ALARM 1 and ALARM 2 events.

Table. 4.6.3 - 292. Event messages.

Event block name	Event names
CBW1	CBWEAR1 Triggered
CBW1	CBWEAR1 Alarm 1 ON
CBW1	CBWEAR1 Alarm 1 OFF
CBW1	CBWEAR1 Alarm 2 ON
CBW1	CBWEAR1 Alarm 2 OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data. The table below presents the structure of the function's register content.

Table. 4.6.3 - 293. Register content.

Register	Description		
Date and time	dd.mm.yyyy hh:mm:ss.mss		
Event	Event name		
Trigger current	Phase currents on trigger time		
Deducted Op	L1/L2/L3 Deducted operations from the cumulative sum		
Operations left	L1/L2/L3 Operations left		

4.6.4 Current total harmonic distortion (THD)

The total harmonic distortion (THD) function is used for monitoring the content of the current harmonic. The THD is a measurement of the harmonic distortion present, and it is defined as the ratio between the sum of all harmonic components' powers and the power of the fundamental frequency (RMS).

Harmonics can be caused by different sources in electric networks such as electric machine drives, thyristor controls, etc. The function's monitoring of the currents can be used to alarm of the harmonic content rising too high; this can occur when there is an electric quality requirement in the protected unit, or when the harmonics generated by the process need to be monitored.

The function constantly measures the phase and residual current magnitudes as well as the harmonic content of the monitored signals up to the 31st harmonic component. When the function is activated, the measurements are also available for the mimic and the measurement views in the HMI carousel. The user can also set the alarming limits for each measured channel if the application so requires.

The monitoring of the measured signals can be selected to be based either on an amplitude ratio or on the above-mentioned power ratio. The difference is in the calculation formula (as shown below):

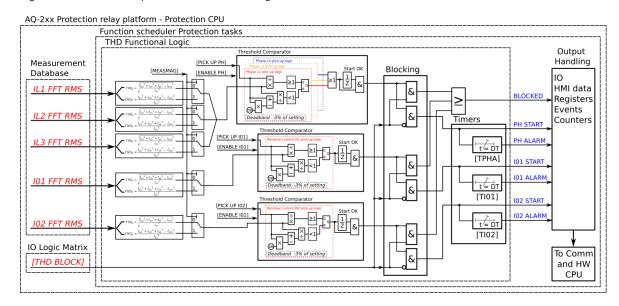
Figure. 4.6.4 - 235. THD calculation formulas.

$$THD_P = \frac{{I_{x2}}^2 + {I_{x3}}^2 + {I_{x4}}^2 \dots {I_{x31}}^2}{{I_{x1}}^2} \qquad \begin{array}{c} \text{, where} \\ \text{I = measured current,} \\ \text{x= measurement input,} \\ \text{n = harmonic number} \end{array}$$

$$THD_A = \sqrt{\frac{{I_{x2}}^2 + {I_{x3}}^2 + {I_{x4}}^2 \dots {I_{x31}}^2}{{I_{x1}}^2}} \qquad \begin{array}{c} \text{, where} \\ \text{I = measured current,} \\ \text{x= measurement input,} \\ \text{n = harmonic number} \end{array}$$

While both of these formulas exist, the power ratio (THDP) is recognized by the IEEE, and the amplitude ratio (THDA) is recognized by the IEC.

Figure. 4.6.4 - 236. Simplified function block diagram of the total harmonic distortion monitor function.



Measured input

The function block uses phase and residual current measurement channels. The function always uses FFT measurement of the whole harmonic specter of 32 components from each measured current channel. From these measurements the function calculates either the amplitude ratio or the power ratio.

Table. 4.6.4 - 294. Measurement inputs of the total harmonic distortion monitor function.

Signal	Description		
I _{L1} FFT	FFT measurement of phase L1 (A) current		
I _{L2} FFT	FFT measurement of phase L2 (B) current		
I _{L3} FFT	FFT measurement of phase L3 (C) current		
I ₀₁ FFT	FFT measurement of residual I01 current		
I ₀₂ FFT	FFT measurement of residual I02 current		

The selection of the calculation method is made with a setting parameter (common for all measurement channels).

General settings

The following general settings define the general behavior of the function. These settings are static i.e. it is not possible to change them by editing the setting group.

Table. 4.6.4 - 295. General settings.

Name	Range	Default	Description
Measurement magnitude	Amplitude Power	Amplitude	Defines which available measured magnitude the function uses.

Pick-up settings

The *PhaseTHD*, *I01THD* and *I02THD* setting parameters control the the pick-up and activation of the function. They define the maximum allowed measured current THD before action from the function. Before the function activates alarm signals, their corresponding pick-up elements need to be activated with the setting parameters *Enable phase THD alarm*, *Enable I01 THD alarm* and *Enable I02 THD alarm*. The function constantly calculates the ratio between the setting values and the calculated THD for each of the three phases. The reset ratio of 97 % is built into the function and is always relative to the setting value. The setting value is common for all measured phases. When the calculated THD exceeds the pick-up value (in single, dual or all phases), it triggers the pick-up operation of the function.

Setting group selection controls the operating characteristics of the function, i.e. the user or userdefined logic can change function parameters while the function is running.

Table. 4.6.4 - 296. Pick-up settings.

Name	Range	Step	Default	Description
Enable phase THD alarm	EnabledDisabled	-	Enabled	Enables and disables the THD alarm function from phase currents.
Enable 101 THD alarm	Enabled Disabled	-	Enabled	Enables and disables the THD alarm function from residual current input I01.
Enable 102 THD alarm	EnabledDisabled	-	Enabled	Enables and disables the THD alarm function from residual current input 102.
Phase THD pick-up	0.10100.00%	0.01%	10.00%	The pick-up setting for the THD alarm element from the phase currents. At least one of the phases' measured THD value has to exceed this setting in order for the alarm signal to activate.
I01 THD pick-up	0.10100.00%	0.01%	10.00%	The pick-up setting for the THD alarm element from the residual current I01. The measured THD value has to exceed this setting in order for the alarm signal to activate.
I02 THD pick-up	0.10100.00%	0.01%	10.00%	The pick-up setting for the THD alarm element from the residual current I02. The measured THD value has to exceed this setting in order for the alarm signal to activate.

Read-only parameters

The function's *Info* page displays useful, real-time information on the state of the protection function. It is accessed either through the device's HMI display, or through the setting tool software when it is connected to the device and its Live Edit mode is active.

Table. 4.6.4 - 297. Information displayed by the function.

Name	Range	Description
THD condition	NormalStartAlarmBlocked	Displays status of the monitoring function.

Function blocking

The block signal is checked in the beginning of each program cycle. The blocking signal is received from the blocking matrix in the function's dedicated input. If the blocking signal is not activated when the pick-up element activates, a START signal is generated and the function proceeds to the time characteristics calculation.

If the blocking signal is active when the pick-up element activates, a BLOCKED signal is generated and the function does not process the situation further. If the START function has been activated before the blocking signal, it resets and the release time characteristics are processed similarly to when the pick-up signal is reset.

The variables the user can set are binary signals from the system. The blocking signal needs to reach the device minimum of 5 ms before the set operating delay has passed in order for the blocking to activate in time.

Operating time characteristics for activation and reset

This function supports definite time delay (DT). The following table presents the setting parameters for the function's time characteristics.

Table. 4.6.4 - 298. Settings for operating time characteristics.

Name	Range	Step	Default	Description
Phase THD alarm delay	0.0001800.000s	0.005s	10.000s	Defines the delay for the alarm timer from the phase currents' measured THD.
I01 THD alarm delay	0.0001800.000s	0.005s	10.000s	Defines the delay for the alarm timer from the residual current I01's measured THD.
I02 THD alarm delay	0.0001800.000s	0.005s	10.000s	Defines the delay for the alarm timer from the residual current I02's measured THD.

Events and registers

The total harmonic distortion monitor function (abbreviated "THD" in event block names) generates events and registers from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

The function's outputs can be used for direct I/O controlling and user logic programming. The function also provides a resettable cumulative counter for the START, ALARM and BLOCKED events.

Table. 4.6.4 - 299. Event messages.

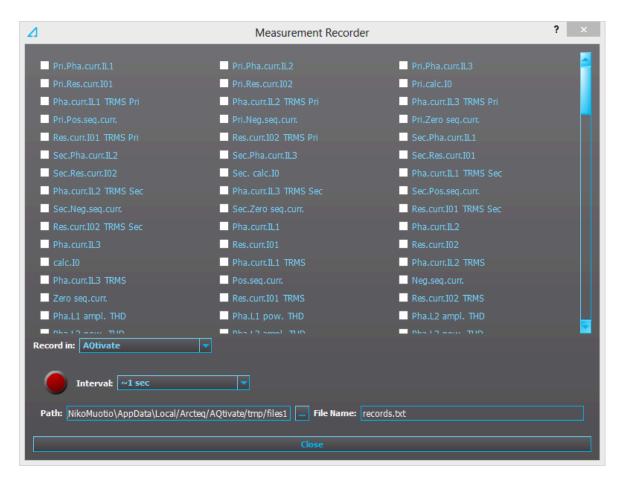
Event block name	Event names
THD1	THD Start Phase ON
THD1	THD Start Phase OFF
THD1	THD Start I01 ON
THD1	THD Start I01 OFF
THD1	THD Start I02 ON
THD1	THD Start I02 OFF
THD1	THD Alarm Phase ON
THD1	THD Alarm Phase OFF
THD1	THD Alarm I01 ON
THD1	THD Alarm I01 OFF
THD1	THD Alarm I02 ON
THD1	THD Alarm I02 OFF
THD1	Blocked ON
THD1	Blocked OFF

The function registers its operation into the last twelve (12) time-stamped registers. The register of the function records the ON event process data for START, ALARM and BLOCKED. The table below presents the structure of the function's register content.

Table. 4.6.4 - 300. Register content.

Register	Description
Date and time	dd.mm.yyyy hh:mm:ss.mss
Event	Event name
L1h, L2h, L3h Fault THD	Start/Alarm THD of each phase.
Setting group in use	Setting group 18 active.

4.6.5 Measurement recorder



Measurements can be recorded to a file with the measurement recorder. The chosen measurements are recorded at selected intervals. In the "Measurement recorder" window, the measurements the user wants to be recorded can be selected by checking their respective check boxes. In order for the measurement recorder to activate, a connection to a device must be established via the setting tool software and its Live Edit mode must be enabled (see the AQtivate 200 manual for more information). Navigate to the measurement recorder through $Tools \rightarrow Miscellaneous\ tools \rightarrow Measurement$ recorder. The recording interval can be changed from the "Interval" drop-down menu. From the "Record in" drop-down menu the user can also choose whether the measurements are recorded in the setting tool or in the device.

If the recording is done in the setting tool, both the setting tool software and its Live Edit mode have to be activated. The user can change the recording file location by editing the "Path" field. File names can also be changed with the "File name" field. Hitting the "Record" button (the big red circle) starts the recorder. Please note that closing the "Measurement recorder" window does not stop the recording; that can only be done by hitting the "Stop" button (the big blue circle).

If the recording is done in the device, only the recording interval needs to be set before recording can be started. The setting tool estimates the maximum recording time, which depends on the recording interval. When the measurement recorder is running, the measurements can be viewed in graph form with the AQtivate PRO software (see the image below).

Figure. 4.6.5 - 237. Measurement recorder values viewed with AQtivate PRO.



Table. 4.6.5 - 301. Available analog signals.

Current measurements	P-P Curr.I"L3	L1 Imp.React.Ind.E.Mvarh
Pri.Pha.Curr.IL1	P-P Curr.I"01	L1 Imp.React.Ind.E.kvarh
Pri.Pha.Curr.IL2	P-P Curr.I"02	L1 Exp/Imp React.Ind.E.bal.Mvarh
Pri.Pha.Curr.IL3	Pha.angle I"L1	L1 Exp/Imp React.Ind.E.bal.kvarh
Pri.Res.Curr.I01	Pha.angle I"L2	L2 Exp.Active Energy MWh
Pri.Res.Curr.I02	Pha.angle I"L3	L2 Exp.Active Energy kWh
Pri.Calc.I0	Res.Curr.angle I"01	L2 Imp.Active Energy MWh
Pha.Curr.IL1 TRMS Pri	Res.Curr.angle I"02	L2 Imp.Active Energy kWh
Pha.Curr.IL2 TRMS Pri	Calc.I"0.angle	L2 Exp/Imp Act. E balance MWh
Pha.Curr.IL3 TRMS Pri	I" Pos.Seq.Curr.angle	L2 Exp/Imp Act. E balance kWh
Pri.Pos.Seq.Curr.	I" Neg.Seq.Curr.angle	L2 Exp.React.Cap.E.Mvarh
Pri.Neg.Seq.Curr.	I" Zero.Seq.Curr.angle	L2 Exp.React.Cap.E.kvarh
Pri.Zero.Seq.Curr.	Voltage measurements	L2 Imp.React.Cap.E.Mvarh
Res.Curr.I01 TRMS Pri	U1Volt Pri	L2 Imp.React.Cap.E.kvarh
Res.Curr.I02 TRMS Pri	U2Volt Pri	L2 Exp/Imp React.Cap.E.bal.Mvarh
Sec.Pha.Curr.IL1	U3Volt Pri	L2 Exp/Imp React.Cap.E.bal.kvarh
Sec.Pha.Curr.IL2	U4Volt Pri	L2 Exp.React.Ind.E.Mvarh

Sec.Pha.Curr.IL3	U1Volt Pri TRMS	L2 Exp.React.Ind.E.kvarh
Sec.Res.Curr.I01	U2Volt Pri TRMS	L2 Imp.React.Ind.E.Mvarh
Sec.Res.Curr.I02	U3Volt Pri TRMS	L2 Imp.React.Ind.E.kvarh
Sec.Calc.I0	U4Volt Pri TRMS	L2 Exp/Imp React.Ind.E.bal.Mvarh
Pha.Curr.IL1 TRMS Sec	Pos.Seq.Volt.Pri	L2 Exp/Imp React.Ind.E.bal.kvarh
Pha.Curr.IL2 TRMS Sec	Neg.Seq.Volt.Pri	L3 Exp.Active Energy MWh
Pha.Curr.IL3 TRMS Sec	Zero.Seq.Volt.Pri	L3 Exp.Active Energy kWh
Sec.Pos.Seq.Curr.	U1Volt Sec	L3 Imp.Active Energy MWh
Sec.Neg.Seq.Curr.	U2Volt Sec	L3 Imp.Active Energy kWh
Sec.Zero.Seq.Curr.	U3Volt Sec	L3 Exp/Imp Act. E balance MWh
Res.Curr.I01 TRMS Sec	U4Volt Sec	L3 Exp/Imp Act. E balance kWh
Res.Curr.I02 TRMS Sec	U1Volt Sec TRMS	L3 Exp.React.Cap.E.Mvarh
Pha.Curr.IL1	U2Volt Sec TRMS	L3 Exp.React.Cap.E.kvarh
Pha.Curr.IL2	U3Volt Sec TRMS	L3 Imp.React.Cap.E.Mvarh
Pha.Curr.IL3	U4Volt Sec TRMS	L3 Imp.React.Cap.E.kvarh
Res.Curr.I01	Pos.Seq.Volt.Sec	L3 Exp/Imp React.Cap.E.bal.Mvarh
Res.Curr.I02	Neg.Seq.Volt.Sec	L3 Exp/Imp React.Cap.E.bal.kvarh
Calc.I0	Zero.Seq.Volt.Sec	L3 Exp.React.Ind.E.Mvarh
Pha.Curr.IL1 TRMS	U1Volt p.u.	L3 Exp.React.Ind.E.kvarh
Pha.Curr.IL2 TRMS	U2Volt p.u.	L3 Imp.React.Ind.E.Mvarh
Pha.Curr.IL3 TRMS	U3Volt p.u.	L3 Imp.React.Ind.E.kvarh
Pos.Seq.Curr.	U4Volt p.u.	L3 Exp/Imp React.Ind.E.bal.Mvarh
Neg.Seq.Curr.	U1Volt TRMS p.u.	L3 Exp/Imp React.Ind.E.bal.kvarh
Zero.Seq.Curr.	U2Volt TRMS p.u.	Exp.Active Energy MWh
Res.Curr.I01 TRMS	U3Volt p.u.	Exp.Active Energy kWh
Res.Curr.I02 TRMS	U4Volt p.u.	Imp.Active Energy MWh
Pha.L1 ampl. THD	Pos.Seq.Volt. p.u.	Imp.Active Energy kWh
Pha.L2 ampl. THD	Neg.Seq.Volt. p.u.	Exp/Imp Act. E balance MWh
Pha.L3 ampl. THD	Zero.Seq.Volt. p.u.	Exp/Imp Act. E balance kWh
Pha.L1 pow. THD	U1Volt Angle	Exp.React.Cap.E.Mvarh
Pha.L2 pow. THD	U2Volt Angle	Exp.React.Cap.E.kvarh
Pha.L3 pow. THD	U3Volt Angle	Imp.React.Cap.E.Mvarh

	,	,
Res.I01 ampl. THD	U4Volt Angle	Imp.React.Cap.E.kvarh
Res.I01 pow. THD	Pos.Seq.Volt. Angle	Exp/Imp React.Cap.E.bal.Mvarh
Res.I02 ampl. THD	Neg.Seq.Volt. Angle	Exp/Imp React.Cap.E.bal.kvarh
Res.I02 pow. THD	Zero.Seq.Volt. Angle	Exp.React.Ind.E.Mvarh
P-P Curr.IL1	System Volt UL12 mag	Exp.React.Ind.E.kvarh
P-P Curr.IL2	System Volt UL12 mag (kV)	Imp.React.Ind.E.Mvarh
P-P Curr.IL3	System Volt UL23 mag	Imp.React.Ind.E.kvarh
P-P Curr.I01	System Volt UL23 mag (kV)	Exp/Imp React.Ind.E.bal.Mvarh
P-P Curr.I02	System Volt UL31 mag	Exp/Imp React.Ind.E.bal.kvarh
Pha.angle IL1	System Volt UL31 mag (kV)	Other measurements
Pha.angle IL2	System Volt UL1 mag	TM> Trip expect mode
Pha.angle IL3	System Volt UL1 mag (kV)	TM> Time to 100% T
Res.Curr.angle I01	System Volt UL2 mag	TM> Reference T curr.
Res.Curr.angle I02	System Volt UL2 mag (kV)	TM> Active meas curr.
Calc.I0.angle	System Volt UL3 mag	TM> T est.with act. curr.
Pos.Seq.Curr.angle	System Volt UL3 mag (kV)	TM> T at the moment
Neg.Seq.Curr.angle	System Volt U0 mag	TM> Max.Temp.Rise All.
Zero.Seq.Curr.angle	System Volt U0 mag (kV)	TM> Temp.Rise atm.
Pri.Pha.Curr.I"L1	System Volt U1 mag	TM> Hot Spot estimate
Pri.Pha.Curr.I"L2	System Volt U1 mag (kV)	TM> Hot Spot Max. All
Pri.Pha.Curr.I"L3	System Volt U2 mag	TM> Used k for amb.temp
Pri.Res.Curr.I"01	System Volt U2 mag (kV)	TM> Trip delay remaining
Pri.Res.Curr.I"02	System Volt U3 mag	TM> Alarm 1 time to rel.
Pri.Calc.I"0	System Volt U3 mag (kV)	TM> Alarm 2 time to rel.
Pha.Curr.I"L1 TRMS Pri	System Volt U4 mag	TM> Inhibit time to rel.
Pha.Curr.I"L2 TRMS Pri	System Volt U4 mag (kV)	TM> Trip time to rel.
Pha.Curr.I"L3 TRMS Pri	System Volt UL12 ang	S1 Measurement
I" Pri.Pos.Seq.Curr.	System Volt UL23 ang	S2 Measurement
I" Pri.Neg.Seq.Curr.	System Volt UL31 ang	S3 Measurement
I" Pri.Zero.Seq.Curr.	System Volt UL1 ang	S4 Measurement
Res.Curr.I"01 TRMS Pri	System Volt UL2 ang	S5 Measurement
Res.Curr.I"02 TRMS Pri	System Volt UL3 ang	S6 Measurement

stem Volt U0 ang	S7 Measurement
stem Volt U1 ang	S8 Measurement
stem Volt U2 ang	S9 Measurement
stem Volt U3 ang	S10 Measurement
stem Volt U4 ang	S11 Measurement
wer measurements	S12 Measurement
Apparent Power (S)	Sys.meas.frqs
Active Power (P)	f atm.
Reactive Power (Q)	f meas from
Tan(phi)	SS1.meas.frqs
Cos(phi)	SS1f meas from
Apparent Power (S)	SS2 meas.frqs
Active Power (P)	SS2f meas from
Reactive Power (Q)	L1 Bias current
Tan(phi)	L1 Diff current
Cos(phi)	L1 Char current
Apparent Power (S)	L2 Bias current
Active Power (P)	L2 Diff current
Reactive Power (Q)	L2 Char current
Tan(phi)	L3 Bias current
Cos(phi)	L3 Diff current
H Apparent Power (S)	L3 Char current
H Active Power (P)	HV I0d> Bias current
H Reactive Power (Q)	HV I0d> Diff current
H Tan(phi)	HV I0d> Char current
H Cos(phi)	LV I0d> Bias current
ergy measurements	LV I0d> Diff current
Exp.Active Energy MWh	LV I0d> Char current
Exp.Active Energy kWh	Curve1 Input
Imp.Active Energy MWh	Curve1 Output
Imp.Active Energy kWh	Curve2 Input
	tem Volt U2 ang tem Volt U3 ang tem Volt U4 ang ver measurements Apparent Power (S) Active Power (P) Reactive Power (Q) Tan(phi) Cos(phi) Apparent Power (S) Active Power (P) Reactive Power (Q) Tan(phi) Cos(phi) Apparent Power (S) Active Power (P) Reactive Power (Q) Tan(phi) Cos(phi) H Apparent Power (S) H Active Power (P) H Reactive Power (Q) H Tan(phi) H Cos(phi) H Cos(phi)

Pha.IL"2 pow. THD	L1 Exp/Imp Act. E balance kWh	Curve3 Input
Pha.IL"3 pow. THD	L1 Exp.React.Cap.E.Mvarh	Curve3 Output
Res.I"01 ampl. THD	L1 Exp.React.Cap.E.kvarh	Curve4 Input
Res.I"01 pow. THD	L1 Imp.React.Cap.E.Mvarh	Curve4 Output
Res.I"02 ampl. THD	L1 Imp.React.Cap.E.kvarh	Control mode
Res.I"02 pow. THD	L1 Exp/Imp React.Cap.E.bal.Mvarh	Motor status
P-P Curr.I"L1	L1 Exp/Imp React.Cap.E.bal.kvarh	Active setting group
P-P Curr.I"L2	L1 Exp.React.Ind.E.Mvarh	
	L1 Exp.React.Ind.E.kvarh	

4.6.6 Fault register

The fault register function records the value of the selected magnitudes at the time of a pre-defined trigger signal. A typical application is the recording of fault currents or voltages at the time of the breaker trips; it can also be used to record the values from any trigger signal set by the user. The user can select whether the function records per-unit values or primary values. Additionally, the user can set the function to record overcurrent fault types or voltage fault types. The function operates instantly from the trigger signal.

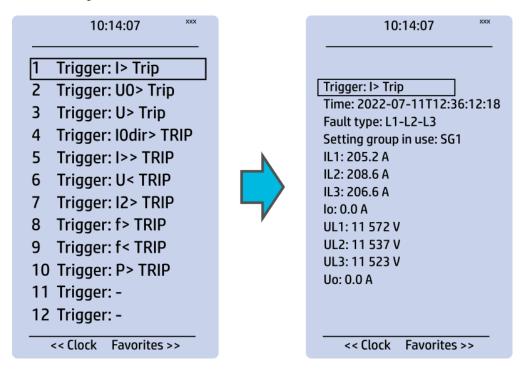
The fault register function has an integrated fault display which shows the current fault values when the tripped by one of the following functions:

- I> (non-directional overcurrent)
- I2> (current unbalance)
- Idir> (directional overcurrent)
- 10> (non-directional earth fault)
- I0dir> (directional earth fault)
- f<(underfrequency)
- f> (overfrequency)
- U< (undervoltage)
- U> (overvoltage)
- U1/U2 >/< (sequence voltage)
- U0> (residual voltage)
- P> (over power)
- P< (under power)
- Prev> (reverse power)
- T> (thermal overload)

When any of these functions trip, the fault values and the fault type are displayed in the Mimic view. The view can be enabled by activating the "VREC Trigger on" setting ($Tools \rightarrow Events$ and $Logs \rightarrow Set$ alarm events). The resetting of the fault values is done by the input selected in the General menu.

Function keeps 12 latest recordings in memory. Recordings can be viewed in the HMI if "Fault registers" view has been added with "Carousel designer" tool.

Figure. 4.6.6 - 238. 12 latest recordings can be accessed from HMI if "Fault registers" view has been enabled in "Carousel designer" tool.



Measured input

The function block uses analog current and voltage measurement values. Based on these values, the device calculates the primary and secondary values of currents, voltages, powers, and impedances as well as other values.

The user can set up to eight (8) magnitudes to be recorded when the function is triggered. An overcurrent fault type, a voltage fault type, and a tripped stage can be recorded and reported straight to SCADA.



NOTICE!

The available measurement values depend on the device type. If only current analog measurements are available, the recorder can solely use signals which only use current. The same applies, if only voltage analog measurements are available.

Table. 4.6.6 - 302. Current based measurements available.

Currents	Description
IL1 (ff), IL2 (ff), IL3 (ff), I01 (ff), I02 (ff)	The fundamental frequency current measurement values (RMS) of phase currents and of residual currents.
IL1TRMS, IL2TRMS, IL3TRMS, I01TRMS, I02TRMS	The TRMS current measurement values of phase currents and of residual currents.
IL1,2,3 & I01/I02 2 nd h., 3 rd h., 4 th h., 5 th h., 7 th h., 9 th h., 11 th h., 13 th h., 15 th h., 17 th h., 19 th h.	The magnitudes of phase current components: Fundamental, 2 nd harmonic, 3 rd harmonic, 4 th harmonic, 5 th harmonic 7 th , harmonic 9 th , harmonic 11 th , harmonic 13 th , harmonic 15 th , harmonic 17 th , harmonic 19 th harmonic current.
I1, I2, I0Z	The positive sequence current, the negative sequence current and the zero sequence current.

I0CalcMag	The residual current calculated from phase currents.
IL1Ang, IL2Ang, IL3Ang, I01Ang, I02Ang, I0CalcAng, I1Ang, I2Ang	The angles of each measured current.

Table. 4.6.6 - 303. Voltage based measurements available.

Voltages	Description
UL1Mag, UL2Mag, UL3Mag, UL12Mag, UL23Mag, UL31Mag U0Mag, U0CalcMag	The magnitudes of phase voltages, of phase-to-phase voltages, and of residual voltages.
U1 Pos.seq V mag, U2 Neg.seq V mag	The positive sequence voltage and the negative sequence voltage.
UL1Ang, UL2Ang, UL3Ang, UL12Ang, UL23Ang, UL31Ang U0Ang, U0CalcAng	The angles of phase voltages, of phase-to-phase voltages, and of residual voltages.
U1 Pos.seq V Ang, U2 Neg.seq V Ang	The positive sequence angle and the negative sequence angle.

Table. 4.6.6 - 304. Power based measurements available.

Powers	Description
S3PH, P3PH, Q3PH	The three-phase apparent, active and reactive powers.
SL1, SL2, SL3, PL1, PL2, PL3, QL1, QL2, QL3	The phase apparent, active and reactive powers.
tanfi3PH, tanfiL1, tanfiL2, tanfiL3	The tan (φ) of three-phase powers and phase powers.
cosfi3PH, cosfiL1, cosfiL2, cosfiL3	The cos (φ) of three-phase powers and phase powers.

Table. 4.6.6 - 305. Impedance and admittance based measurements available.

Impedances and admittances	Description
RL12, RL23, RL31 XL12, XL23, XL31, RL1, RL2, RL3 XL1, XL2, XL3 Z12, Z23, Z31 ZL1, ZL2, ZL3	The phase-to-phase and phase-to-neutral resistances, reactances and impedances.
Z12Ang, Z23Ang, Z31Ang, ZL1Ang, ZL2Ang, ZL3Ang	The phase-to-phase and phase-to-neutral impedance angles.
Rseq, Xseq, Zseq RseqAng, XseqAng, ZseqAng	The positive sequence resistance, reactance and impedance values and angles.
GL1, GL2, GL3, G0 BL1, BL2, BL3, B0 YL1, YL2, YL3, Y0	The conductances, susceptances and admittances.

YL1angle, YL3angle Y0angle	angle, The admittance angles.	
----------------------------------	-------------------------------	--

Table. 4.6.6 - 306. Other measurements available.

Others	Description
System f.	The tracking frequency in use at that moment.
Ref f1	The reference frequency 1.
Ref f2	The reference frequency 2.
M thermal T	The motor thermal temperature.
F thermal T	The feeder thermal temperature.
T thermal T	The transformer thermal temperature.
RTD meas 116	The RTD measurement channels 116.
Ext RTD meas 18	The external RTD measurement channels 18 (ADAM module).

Reported values

When triggered, the function holds the recorded values of up to eight channels, as set. In addition to this tripped stage, the overcurrent fault type and the voltage fault types are reported to SCADA.

Table. 4.6.6 - 307. Reported values.

Name	Range	Description
Tripped stage	 I> Trip I>> Trip I>>> Trip I>>>> Trip I >>>> Trip I >>>>> Trip I >>>>> Trip I >>>>> Trip I >>>>> Trip I >>>>>> Trip I >>>>>>> Trip I >>>>>>>>> Trip I >>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>>	The tripped stage.
Overcurrent fault type	 A-G B-G A-B C-G A-C B-C A-B-C 	The overcurrent fault type.

Name	Range	Description
Voltage fault type	 A(AB) B(BC) A-B(AB-BC) C(CA) A-C(AB-CA) B-C(BC-CA) A-B-C Overfrequency Underfrequency Overpower Underpower Reversepower Thermal overload Unbalance Harmonic overcurrent Residual overvoltage 	The voltage fault type.
Magnitude 18	0.0001800.000 A/V/p.u.	The recorded value in one of the eight channels.

Events

The fault register function (abbreviated "VREC" in event block names) generates events from the status changes in the events listed below. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp.

Table. 4.6.6 - 308. Event messages.

Event block name	Event name
VREC1	Recorder triggered ON
VREC1	Recorder triggered OFF

4.6.7 Event logger

Event logger records status changes of protection functions, digital inputs, logical signals etc. Events are recorded with a timestamp. The time stamp resolution is 1 ms. Up to 15 000 events can be stored at once. When 15 000 events have been recorded, the event history will begin to remove the oldest events to make room for new events. You can find more information about event masks in the selected function's "Events" tab. Event masks determine what is recorded into the event history; they are configured in each function's individual settings in the *Protection, Control* and *Monitoring* menu. Event history is accessible with PC setting tool ($Tools \rightarrow Events$ and $Tools \rightarrow Event$ history) and from the device HMI if "Events" view has been configured with Carousel designer in PC setting tool.

4.6.8 Disturbance recorder (DR)

The disturbance recorder is a high-capacity (64 MB permanent flash memory) and fully digital recorder integrated to the protection relay. The maximum sample rate of the recorder's analog channels is 64 samples per cycle. The recorder also supports 96 digital channels simultaneously with the twenty (20) measured analog channels. Maximum capacity of recordings is 100.

The recorder provides an effective tool to analyze the performance of the power system during network disturbance situations. The recorder's output is in general COMTRADE format and it is compatible with most recording viewers and injection devices. The files are based on the IEEE standard C37.111-1999. Captured recordings can be injected as playback with secondary testing tools that support the COMTRADE file format. Playback of files might help to analyze the fault, or can be simply used for educational purposes.

Analog and digital recording channels

Up to 20 analog recording channels and 96 digital channels are supported.

Table. 4.6.8 - 309. Analog recording channels.

Signal	Description
IL1	Phase current I _{L1}
IL2	Phase current I _{L2}
IL3	Phase current I _{L3}
101c	Residual current I ₀₁ coarse*
I01f	Residual current I ₀₁ fine*
102c	Residual current I ₀₂ coarse*
102f	Residual current I ₀₂ fine*
IL1"	Phase current I _{L1} (CT card 2)
IL2"	Phase current I _{L2} (CT card 2)
IL3"	Phase current I _{L3} (CT card 2)
I01"c	Residual current I ₀₁ coarse* (CT card 2)
I01"f	Residual current I ₀₁ fine* (CT card 2)
102"c	Residual current I ₀₂ coarse* (CT card 2)
102"f	Residual current I ₀₂ fine* (CT card 2)
U1(2)VT1	Line-to-neutral U _{L1} or line-to-line voltage U _{L12} (VT card 1)
U2(3)VT1	Line-to-neutral U _{L2} or line-to-line voltage U _{L23} (VT card 1)
U3(1)VT1	Line-to-neutral U _{L3} or line-to-line voltage U _{L31} (VT card 1)
U0(ss)VT1	Zero sequence voltage U ₀ or synchrocheck voltage U _{SS} (VT card 1)
F tracked 1	Tracked frequency of reference 1
F tracked 2	Tracked frequency of reference 2
F tracked 3	Tracked frequency of reference 3
ISup	Current measurement module voltage supply supervision (CT card 1)
ISup"	Current measurement module voltage supply supervision (CT card 2)

Signal	Description
USup	Voltage measurement module voltage supply supervision (VT card 1)
IL1"	Phase current I _{L1} (CT card 3)
IL2"'	Phase current I _{L2} (CT card 3)
IL3"'	Phase current I _{L3} (CT card 3)
I01'''c	Residual current I ₀₁ coarse* (CT card 3)
101'''f	Residual current I ₀₁ fine* (CT card 3)
102'''c	Residual current I ₀₂ coarse* (CT card 3)
102"'f	Residual current I ₀₂ fine* (CT card 3)
ISup_3	Current measurement module voltage supply supervision (CT card 3)
UL1(2)VT2	Line-to-neutral U _{L1} or line-to-line voltage U _{L12} (VT card 2)
UL2(3)VT2	Line-to-neutral U _{L2} or line-to-line voltage U _{L23} (VT card 2)
UL3(1)VT2	Line-to-neutral U _{L3} or line-to-line voltage U _{L31} (VT card 2)
U0(SS)VT2	Zero sequence voltage U ₀ or synchrocheck voltage U _{SS} (VT card 2)
USup_2	Voltage measurement module voltage supply supervision (VT card 2)

*NOTE: There are two signals for each residual current channel in the disturbance recorder: coarse and fine. A coarse signal is capable of sampling in the full range of the current channel but suffers a loss of accuracy at very low currents. A fine signal is capable of sampling at very low currents and with high accuracy but cuts off at higher currents. Table below lists performance of both channels with fine and coarse gain.

Table. 4.6.8 - 310. Residual current channel performance with coarse or residual gain.

Channel	Coarse gain range	Fine gain range	Fine gain peak
101	0150 A	010 A	15 A
102	075 A	05 A	8 A

Table. 4.6.8 - 311. Digital recording channels – Measurements.

Signal	Description	Signal	Description
Currents			
Pri.Pha.curr.lLx	Primary phase current ILx (IL1, IL2, IL3)	Pha.curr.ILx TRMS Pri	Primary phase current TRMS (IL1, IL2, IL3)
Pha.angle ILx	Phase angle ILx (IL1, IL2, IL3)	Pos./Neg./Zero seq.curr.	Positive/Negative/Zero sequence current
Pha.curr.lLx	Phase current ILx (IL1, IL2, IL3)	Sec.Pos./Neg./Zero seq.curr.	Secondary positive/negative/zero sequence current

Signal	Description	Signal	Description
Sec.Pha.curr.ILx	Secondary phase current ILx (IL1, IL2, IL3)	Pri.Pos./Neg./Zero seq.curr.	Primary positive/negative/zero sequence current
Pri.Res.curr.I0x	Primary residual current I0x (I01, I02)	Pos./Neg./Zero seq.curr.angle	Positive/Negative/Zero sequence current angle
Res.curr.angle I0x	Residual current angle I0x (I01, I02)	Res.curr.I0x TRMS	Residual current TRMS I0x (I01, I02)
Res.curr.l0x	Residual current I0x (I01, I02)	Res.curr.I0x TRMS Sec	Secondary residual current TRMS I0x (I01, I02)
Sec.Res.curr.I0x	Secondary residual current I0x (I01, I02)	Res.curr.l0x TRMS Pri	Primary residual current TRMS I0x (I01, I02)
Pri.cal.l0	Primary calculated I0	Pha.Lx ampl. THD	Phase Lx amplitude THD (L1, L2, L3)
Sec.calc.I0	Secondary calculated I0	Pha.Lx pow. THD	Phase Lx power THD (L1, L2, L3)
calc.I0	Calculated I0	Res.I0x ampl. THD	Residual I0x amplitude THD (I01, I02)
calc.l0 Pha.angle	Calculated I0 phase angle	Res.I0x pow. THD	Residual I0x power THD (I01, I02)
Pha.curr.lLx TRMS	Phase current TRMS ILx (IL1, IL2, IL3)	P-P curr.ILx	Phase-to-phase current ILx (IL1, IL2, IL3)
Pha.curr.ILx TRMS Sec	Secondary phase current TRMS (IL1, IL2, IL3)	P-P curr.I0x	Phase-to-phase current I0x (I01, I02)
Voltages			
Ux Volt p.u.	Ux voltage in per-unit values (U1, U2, U3, U4)	System volt ULxx mag	Magnitude of the system voltage ULxx (UL12, UL23, UL31)
Ux Volt pri	Primary Ux voltage (U1, U2, U3, U4)	System volt ULxx mag(kV)	Magnitude of the system voltage ULxx in kilovolts (UL12, UL23, UL31)
Ux Volt sec	Secondary Ux voltage (U1, U2, U3, U4)	System volt ULxx ang	Angle of the system voltage ULxx (UL12, UL23, UL31)
Ux Volt TRMS p.u.	Ux voltage TRMS in per-unit values (U1, U2, U3, U4)	System volt ULx mag	Magnitude of the system voltage ULx (U1, U2, U3, U4)
Ux Volt TRMS pri	Primary Ux voltage TRMS (U1, U2, U3, U4)	System volt ULx mag(kV)	Magnitude of the system voltage ULx in kilovolts (U1, U2, U3, U4)
Ux Volt TRMS sec	Secondary Ux voltage TRMS (U1, U2, U3, U4)	System volt ULx ang	Angle of the system voltage ULx (U1, U2, U3, U4)

Signal	Description	Signal	Description
Pos/Neg./Zero seq.Volt.p.u.	Positive/Negative/Zero sequence voltage in per-unit values	System volt U0 mag	Magnitude of the system voltage U0
Pos./Neg./Zero seq.Volt.pri	Primary positive/ negative/zero sequence voltage	System volt U0 mag(kV)	Magnitude of the system voltage U0 in kilovolts
Pos./Neg./Zero seq.Volt.sec	Secondary positive/ negative/zero sequence voltage	System volt U0 mag(%)	Magnitude of the system voltage U0 in percentages
Ux Angle	Ux angle (U1, U2, U3, U4)	System volt U0 ang	Angle of the system voltage U0
Pos./Neg./Zero Seq volt.Angle	Positive/Negative/Zero sequence voltage angle	Ux Angle difference	Ux angle difference (U1, U2, U3)
Resistive and reactive currents			
ILx Resistive Current p.u.	ILx resistive current in per-unit values (IL1, IL2, IL3)	Pos.seq. Resistive Current Pri.	Primary positive sequence resistive current
ILx Reactive Current p.u.	ILx reactive current in per-unit values (IL1, IL2, IL3)	Pos.seq. Reactive Current Pri.	Primary positive sequence reactive current
Pos.Seq. Resistive Current p.u.	Positive sequence resistive current in perunit values	I0x Residual Resistive Current Pri.	Primary residual resistive current I0x (I01, I02)
Pos.Seq. Reactive Current p.u.	Positive sequence reactive current in perunit values	I0x Residual Reactive Current Pri.	Primary residual reactive current I0x (I01, I02)
I0x Residual Resistive Current p.u.	I0x residual resistive current in per-unit values (I01, I02)	ILx Resistive Current Sec.	Secondary resistive current ILx (IL1, IL2, IL3)
I0x Residual Reactive Current p.u.	I0x residual ractive current in per-unit values (I01, I02)	ILx Reactive Current Sec.	Secondary reactive current ILx (IL1, IL2, IL3)
ILx Resistive Current Pri.	Primary resistive current ILx (IL1, IL2, IL3)	I0x Residual Resistive Current Sec.	Secondary residual resistive current I0x (I01, I02)
ILx Reactive Current Pri.	Primary reactive current ILx (IL1, IL2, IL3)	I0x Residual Reactive Current Sec.	Secondary residual reactive current 10x (101, 102)
Power, GYB, frequency			
Lx PF	Lx power factor (L1, L2, L3)	Curve x Input	Input of Curve x (1, 2, 3, 4)

Signal	Description	Signal	Description
POW1 3PH Apparent power (S)	Three-phase apparent power	Curve x Output	Output of Curve x (1, 2, 3, 4)
POW1 3PH Apparent power (S MVA)	Three-phase apparent power in megavolt-amperes	Enablefbasedfunctions(VT1)	Enable frequency-based functions
POW1 3PH Active power (P)	Three-phase active power	Track.sys.f.	Tracked system frequency
POW1 3PH Active power (P MW)	Three-phase active power in megawatts	Sampl.f. used	Used sample frequency
POW1 3PH Reactive power (Q)	Three-phase reactive power	Tr f CH x	Tracked frequency (channels A, B, C)
POW1 3PH Reactive power (Q MVar)	Three-phase reactive power in megavars	Alg f Fast	Fast frequency algorithm
POW1 3PH Tan(phi)	Three-phase tangent phi	Alg f avg	Average frequency algorithm
POW1 3PH Cos(phi)	Three-phase cosine phi	Frequency based protections blocked	When true ("1"), all frequency-based protections are blocked.
3PH PF	Three-phase power factor	f atm. Protections (when not measurable returns to nominal)	Frequency at the moment. If the system nominal is set to 50 Hz, this will show "50 Hz".
Neutral conductance G (Pri)	Primary neutral conductance	f atm. Display (when not measurable is 0 Hz)	Frequency at the moment. If the frequency is not measurable, this will show "0 Hz".
Neutral susceptance B (Pri)	Primary neutral susceptance	f meas qlty	Quality of tracked frequency
Neutral admittance Y (Pri)	Primary neutral admittance	f meas from	Indicates which of the three voltage or current channel frequencies is used by the device.
Neutral admittance Y (Ang)	Neutral admittace angle	SS1.meas.frqs	Synchrocheck – the measured frequency from voltage channel 1
I01 Resistive component (Pri)	Primary resistive component I01	SS2.meas.frqs	Synchrocheck – the measured frequency from voltage channel 2
I01 Capacitive component (Pri)	Primary capacitive component I01	Enable f based functions	Status of this signal is active when frequency-based protection functions are enabled.

Table. 4.6.8 - 312. Digital recording channels – Binary signals.

Signal	Description	Signal	Description
DIx	Digital input 111	Timer x Output	Output of Timer 110
Open/close control buttons	Active if buttons I or 0 in the unit's front panel are pressed.	Internal Relay Fault active	If the unit has an internal fault, this signal is active.
Status PushButton x On	Status of Push Button 112 is ON	(Protection, control and monitoring event signals)	(see the individual function description for the specific outputs)
Status PushButton x Off	Status of Push Button 112 is OFF	Always True/False	"Always false" is always "0". Always true is always "1".
Forced SG in use	Stage forcing in use	OUTx	Output contact statuses
SGx Active	Setting group 18 active	GOOSE INX	GOOSE input 164
Double Ethernet LinkA down	Double ethernet communication card link A connection is down.	GOOSE INx quality	Quality of GOOSE input 164
Double Ethernet LinkB down	Double ethernet communication card link B connection is down.	Logical Input x	Logical input 132
MBIO ModA Ch x Invalid	Channel 18 of MBIO Mod A is invalid	Logical Output x	Logical output 164
MBIO ModB Ch x Invalid	Channel 18 of MBIO Mod B is invalid	NTP sync alarm	If NTP time synchronization is lost, this signal will be active.
MBIO ModB Ch x Invalid	Channel 18 of MBIO Mod C is invalid	Ph.Rotating Logic control 0=A-B-C, 1=A- C-B	Phase rotating order at the moment. If true ("1") the phase order is reversed.

Recording settings and triggering

Disturbance recorder can be triggered manually or automatically by using the dedicated triggers. Every signal listed in "Digital recording channels" can be selected to trigger the recorder.

The number of analog and digital channels together with the sample rate and the time setting affect the recording size. See calculation examples below in the section titled "Estimating the maximum length of total recording time". The recording size affects how many recordings can be stored at a time, but the number can't exceed 100 recordings.

Table. 4.6.8 - 313. Recorder control settings.

Name	Range	Description
Recorder enabled	EnabledDisabled	Enables and disables the disturbance recorder function.

Name	Range	Description	
Recorder status	Recorder ready Recording triggered Recording and storing Storing recording Recorder full Wrong config	Indicates the status of recorder. "Wrong config" is activated if: • "Pre-triggering time" is longer than "Max length of recording" setting • "Max amount of recordings" is "1" and "Recording mode" is "FIFO". • "1ms" digital channel sample rate is selected when analog channel sample rate is 8 or 16 s/c.	
Clear record+	02 ³² -1	Clears selected recording. If "1" is inserted, first recording will be cleared from memory. If "10" is inserted, tenth (10th) recording will be cleared from memory.	
Manual trigger	• - • Trig	Triggers disturbance recording manually. This parameter will return back to "-" automatically.	
Clear all records	• - • Clear	Clears all disturbance recordings.	
Clear newest record	• - • Clear	Clears the newest stored disturbance recording.	
Clear oldest record	• - • Clear	Clears the oldest stored disturbance recording.	
Max. number of recordings	0100	Displays the maximum number of recordings that can be stored in the device's memory with settings currently in use. The maximum number of recordings can go up to 100.	
Max. length of a recording	0.0001800.000s	Displays the maximum length of a single recording.	
Max. location of the pre- trigger	0.0001800.000s	Displays the highest pre-triggering time that can be set with the settings currently in use.	
Recordings in memory	0100	Displays how many recordings are stored in the memory.	

Table. 4.6.8 - 314. Recorder trigger setting.

Name	Description
Recorder trigger	Selects the trigger input(s). Clicking the "Edit" button brings up a pop-up window, and checking the boxes enable the selected triggers.

Table. 4.6.8 - 315. Recorder settings.

Name	Range	Default	Description
Recording length	0.1001800.000s	1s	Sets the length of a recording.
Recording mode	FIFO Keep olds	FIFO	Selects what happens when the memory is full. "FIFO" (= first in, first out) replaces the oldest stored recording with the latest one. "Keep olds" does not accept new recordings.
Analog channel samples	• 64s/c • 32s/c • 16s/c • 8s/c	64s/c	Selects the sample rate of the disturbance recorder in samples per cycle. The samples are saved from the measured wave according to this setting.
Digital channel samples	• 5 ms 5 ms		The fixed sample rate of the recorded digital channels. Recorded digital channels can be chosen with "Recorder digital channels" below.
Pretriggering time	0.215.0s	0.2s	Sets the recording length before the trigger.
Analog recording CH1CH20	08 freely selectable channels	-	Selects the analog channel for recording. Please see the list of all available analog channels in the section titled "Analog and digital recording channels".
Automatically get recordings	bisabled Disabled		Enables and disables the automatic transfer of recordings. The recordings are taken from the device's protection CPU and transferred to the device's FTP directory in the communication CPU; the FTP client then automatically loads the recordings from the device and transfers them further to the SCADA system. Please note that when this setting is enabled, all new disturbance recordings will be pushed to the FTP server of the device. Up to six (6) recordings can be stored in the FTP at once. Once those six recordings have been retrieved and removed, more recordings will then be pushed to the FTP. When a recording has been sent to the FTP server of the device, it is no longer accessible through setting tools <i>Disturbance recorder</i> → <i>Get DR files</i> command.
Recorder digital channels	096 freely selectable channels	-	Selects the digital channel for recording. Please see the list of all available digital channels in the section titled "Analog and digital recording channels".

NOTICE! The distu



The disturbance recorder is not ready unless the "Max. length of a recording" parameter is showing some value other than zero. At least one trigger input has to be selected in the "Recorder Trigger" setting to fulfill this term.



NOTICE!

When writing new disturbance recorder settings to the device, any existing recordings in the device memory will be deleted.

Estimating the maximum length of total recording time

Once the disturbance recorder's settings have been made and loaded to the device, the device automatically calculates and displays the total length of recordings. However, if the user wishes to confirm this calculation, they can do so with the following formula. Please note that the formula assumes there are no other files in the FTP that share the 64 MB space.

$$\frac{\text{Total sample reserve}}{(f_n*(Ch_{an}+1)*SR) + (200~Hz*Ch_{dig})}$$

Where:

- total sample reserve = the number of samples available in the FTP when no other files are saved; calculated by dividing the total number of available bytes by 4 bytes (=the size of one sample); e.g. 64 306 588 bytes/4 bytes = 16 076 647 samples.
- f_n = the nominal frequency (Hz).
- Chan = the number of analog channels recorded; "+ 1" stands for the time stamp for each recorded sample.
- SR = the selected sample rate (s/c).
- 200 Hz = the rate at which digital channels are always recorded, i.e. 5 ms.
- *Chdig* = the number of digital channels recorded.

For example, let us say the nominal frequency is 50 Hz, the selected sample rate is 64 s/c, nine (9) analog channels and two (2) digital channels record. The calculation is as follows:

$$\frac{16\,076\,647\,samples}{(50\,Hz*(9+1)*64)+(200\,Hz*2)}\approx 496\,s$$

Therefore, the maximum recording length in our example is approximately 496 seconds.

Application example

This chapter presents an application example of how to set the disturbance recorder and analyze its output. The recorder is configured by using the setting tool software or device HMI, and the results are analyzed with the AQviewer software (is automatically downloaded and installed with AQtivate). Registered users can download the latest tools from the Arcteq website (arcteq.fi./downloads/).

In this example, we want the recordings to be made according to the following specifications:

- the recording length is 6.0 s
- the sample rate is 64 s/c (therefore, with a 50 Hz system frequency a sample is taken every 312.5 µs)
- the analog channels 1...8 are used
- · digital channels are tracked every 5 ms
- the first activation of the overcurrent stage trip (I> TRIP) triggers the recorder
- the pre-triggering time is 5 (ie. how long is recorded before the I> TRIP signal) and the post-triggering time is 1 s

The image below shows how these settings are placed in the setting tool.

Figure. 4.6.8 - 239. Disturbance recorder settings.

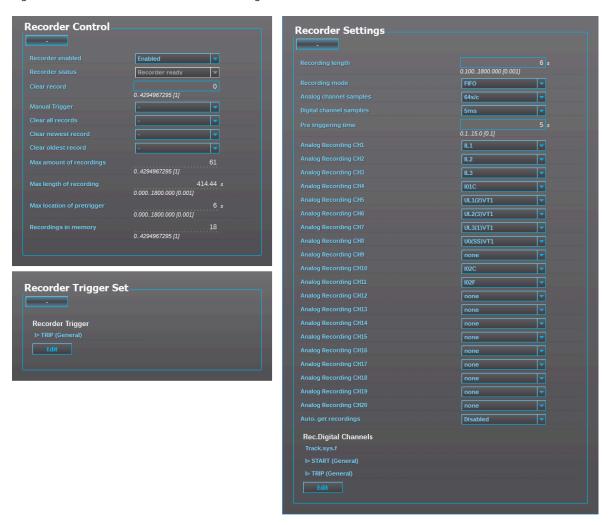
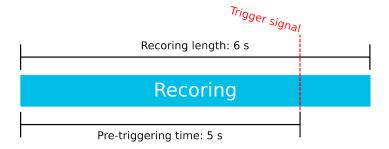


Figure. 4.6.8 - 240. Effects of recording length and pre-triggering time signals. This example is based on the settings shown above.



When there is at least one recording in the device's memory, that recording can be analyzed by using the AQviewer software (see the image below). However, the recording must first be made accessible to AQViewer. The user can read it from the device's memory ($Disturbance\ recorder \rightarrow Get\ DR\-files$). Alternatively, the user can load the recordings individually ($Disturbance\ recorder \rightarrow DR\ List$) from a folder in the PC's hard disk drive; the exact location of the folder is described in $Tools \rightarrow Settings \rightarrow DR\ path$.



The user can also launch the AQviewer software from the *Disturbance recorder* menu. AQviewer software instructions can be found in AQtivate 200 Instruction manual (arcteq.fi./downloads/).

Events

The disturbance recorder function (abbreviated "DR" in event block names) generates events and registers from the status changes in the events listed below. Events cannot be masked off. The events triggered by the function are recorded with a time stamp.

Table. 4.6.8 - 316. Event messages.

Event block name	Event names
DR1	Recorder triggered ON
DR1	Recorder triggered OFF
DR1	Recorder memory cleared
DR1	Oldest record cleared
DR1	Recorder memory full ON
DR1	Recorder memory full OFF
DR1	Recording ON
DR1	Recording OFF
DR1	Storing recording ON
DR1	Storing recording OFF
DR1	Newest record cleared

5 Communication

5.1 Connections menu

"Connections" menu is found under "Communication" menu. It contains all basic settings of ethernet port and RS-485 serial port included with every AQ-200 device as well as settings of communication option cards.

Table. 5.1 - 317. Ethernet settings.

Name	Range	Description
IP address	0.0.0.0255.255.255.255	Set IP address of the ethernet port in the back of the AQ-200 series device.
Netmask	0.0.0.0255.255.255.255	Set netmask of the ethernet port in the back of the AQ-200 series device.
Gateway	0.0.0.0255.255.255.255	Set gateway of the ethernet port in the back of the AQ-200 series device.
MAC- Address	00-00-00-00-00FF- FF-FF-FF-FF	Indication of MAC address of the AQ-200 series device.
Storm Protection	Disable Enable	When enabled, the Storm protection functionality of the internal switch in the device is enabled. This functionality aims to protect the device from excess ethernet traffic caused by storm situation. When enabled, the packet rate allowed to pass through on the ingress port towards the device, is limited to 150 packets per second. Multicast packets are also included in the packet limit.
Double Ethernet card mode	Switch HSR PRP	If the device has a double ethernet option card it is possible to choose its mode.
COM A and Ethernet option card connection	Block all Allow both directions Allow COM A to option card Allow option card to COM A	If the device has ethernet option card it is possible to determine the allowed direction of data.
Double Ethernet link events	Disable Enable	Disables or enables "Double Ethernet Link A down" and "Double Ethernet Link B down" logic signals and events.
Double Ethernet PRP ports	• AB • BA	LanA and LanB port assigment for communication cards that support PRP.

Virtual Ethernet enables the device to be connected to multiple different networks simultaneously via one physical Ethernet connection. Virtual Ethernet has its own separate IP address and network configurations. All Ethernet-based protocol servers listen for client connections on the IP addresses of both the physical Ethernet and the Virtual Ethernet.

Table. 5.1 - 318. Virtual Ethernet settings.

Name	Description
Enable virtual adapter (No / Yes)	Enable virtual adapter. Off by default.
IP address	Set IP address of the virtual adapter.
Netmask	Set netmask of the virtual adapter.
Gateway	Set gateway of the virtual adapter.

AQ-200 series devices are always equipped with an RS-485 serial port. In the software it is identified as "Serial COM1" port.

Table. 5.1 - 319. Serial COM1 settings.

Name	Range	Description
Bitrate	9600bps19200bps38400bps	Bitrate used by RS-485 port.
Databits	78	Databits used by RS-485 port.
Parity	None Even Odd	Paritybits used by RS-485 port.
Stopbits	12	Stopbits used by RS-485 port.
Protocol	NoneModbutRTUModbusIOIEC103SPADNP3IEC101	Communication protocol used by RS-485 port.

AQ-200 series supports communication option card type that has serial fiber ports (Serial COM2) an RS-232 port (Serial COM3).

Table. 5.1 - 320. Serial COM2 settings.

Name	Range	Description
Bitrate	9600bps19200bps38400bps	Bitrate used by serial fiber channels.
Databits	78	Databits used by serial fiber channels.
Parity	None Even Odd	Paritybits used by serial fiber channels.
Stopbits	12	Stopbits used by serial fiber channels.

Name	Range	Description
Protocol	NoneModbutRTUModbusIOIEC103SPADNP3IEC101	Communication protocol used by serial fiber channels.
Echo	• Off • On	Enable or disable echo.
Idle Light	• Off • On	Idle light behaviour.

Table. 5.1 - 321. Serial COM3 settings.

Name	Range	Description
Bitrate	9600bps19200bps38400bps	Bitrate used by RS-232 port.
Databits	78	Databits used by RS-232 port.
Parity	None Even Odd	Paritybits used by RS-232 port.
Stopbits	12	Stopbits used by RS-232 port.
Protocol	NoneModbutRTUModbusIOIEC103SPADNP3IEC101	Communication protocol used by RS-232 port.

5.2 Time synchronization

Time synchronization source can be selected with "Time synchronization" parameter in the "General" menu.

Table. 5.2 - 322. General time synchronization source settings.

Name	Range	Description
Time synchronization source	InternalExternal NTPExternal serialIRIG-B	Selection of time synchronization source.

5.2.1 Internal

If no external time synchronization source is available the mode should be set to "internal". This means that the AQ-200 device clock runs completely on its own. Time can be set to the device with AQtivate setting tool with *Commands* \rightarrow *Sync Time* command or in the clock view from the HMI. When using *Sync time* command AQtivate sets the time to device the connected computer is currently using. Please note that the clock doesn't run when the device is powered off.

5.2.2 NTP

When enabled, the NTP (Network Time Protocol) service can use external time sources to synchronize the device's system time. The NTP client service uses an Ethernet connection to connect to the NTP time server. NTP can be enabled by setting the primary time server and the secondary time server parameters to the address of the system's NTP time source(s).

Table. 5.2.2 - 323. Server settings.

Name	Range	Description
Primary time server address	0.0.0.0255.255.255.255	Defines the address of the primary NTP server. Setting this parameter at "0.0.0.0" means that the server is not in use.
Secondary time server address	0.0.0.0255.255.255	Defines the address of the secondary (or backup) NTP server. Setting this parameter at "0.0.0.0" means that the server is not in use.

Table. 5.2.2 - 324. Client settings.

Name	Range	Description	
IP address	0.0.0.0255.255.255	Defines the address of the NTP client. NOTE: This address must be different than the general IP address of the device.	
Netmask	0.0.0.0255.255.255	Defines the client's netmask.	
Gateway	0.0.0.0255.255.255	Defines the client's gateway.	
MAC address	00-00-00-00-00-00FF-FF-FF- FF-FF-FF	Displays the MAC address of the client.	
Network status	RunningIP errorNM errorGW error	Displays the status or possible errors of the NTP (client) settings.	

Table. 5.2.2 - 325. Status.

Name	Range	Description
NTP quality for events	No sync Synchronized	Displays the status of the NTP time synchronization at the moment. NOTE: This indication is not valid if another time synchronization method is used (external serial).

Name	Range	Description
NTP-processed message count	04294967295	Displays the number of messages processed by the NTP protocol.



NOTICE!

A unique IP address must be reserved for the NTP client. The device's IP address cannot be used.

Additionally, the time zone of the device can be set by connecting to the device and the selecting the time zone at $Commands \rightarrow Set \ time \ zone$ in AQtivate setting tool.

5.3 Communication protocols

The following chapters will describe all available communication protocols. The device includes an RJ-45 ethernet port and an RS-485 serial port, which are able to use communication protocols. See other options for communication ports under "Construction and installation".



NOTICE!

Only one communication protocol can be used at a time by an AQ-210 device!

5.3.1 IEC 61850

The user can enable the IEC 61850 protocol in device models that support this protocol at $Communication \rightarrow Protocols \rightarrow IEC61850$. AQ-21x frame units support Edition 1 of IEC 61850. AQ-25x frame units support both Edition 1 and 2 of IEC 61850. The following services are supported by IEC 61850 in Arcteg devices:

- Up to six data sets (predefined data sets can be edited with the IEC 61850 tool in AQtivate)
- · Report Control Blocks (both buffered and unbuffered reporting)
- Control ('Direct operate with normal security', 'Select before operate with normal security, 'Direct with enhanced security' and 'Select before operate with enhanced sequrity' control sequences)
- · Disturbance recording file transfer
- GOOSE
- · Time synchronization

The device's current IEC 61850 setup can be viewed and edited with the IEC61850 tool ($Tools \rightarrow Communication \rightarrow IEC 61850$).

Settings

The general setting parameters for the IEC 61850 protocol are visible both in AQtivate and in the local HMI. The settings are described in the table below.

Table. 5.3.1 - 326. General settings.

Name	Range	Step	Default	Description
Enable IEC 61850	DisabledEnabled	-	Disabled	Enables and disables the IEC 61850 communication protocol.
Reconfigure IEC 61850	-Reconfigure	-	-	Reconfigures IEC 61850 settings.

Name	Range	Step	Default	Description
IP port	065 535	1	102	Defines the IP port used by the IEC 61850 protocol. The standard (and default) port is 102.
Control Authority switch	Remote Control Station Level Control	-	Remote Control	The device can be set to allow object control via IEC 61850 only from clients that are of category Station level control. This would mean that other Remote control clients would not be allowed to control. In Remote control mode all IEC 61850 clients of both remote and station level category are allowed to control objects.
Ethernet port	All COM A Double ethernet card	-	All	Determines which ports use IEC61850. Parameter is visible if double ethernet option card is found in the device.
General deadband	0.110.0 %	0.1	2 %	Determines the general data reporting deadband settings.
Active energy deadband	0.11000.0 kWh	0.1 kWh	2 kWh	Determines the data reporting deadband settings for this measurement.
Reactive energy deadband	0.11000.0 kVar	0.1 kVar	2 kVar	Determines the data reporting deadband settings for this measurement.
Active power deadband	0.11000.0 kW	0.1 kW	2 kW	Determines the data reporting deadband settings for this measurement.
Reactive power deadband	0.11000.0 kVar	0.1 kVar	2 kVar	Determines the data reporting deadband settings for this measurement.
Apparent power deadband	0.11000.0 kVA	0.1 kVA	2 kVA	Determines the data reporting deadband settings for this measurement.
Power factor deadband	0.010.99	0.01	0.05	Determines the data reporting deadband settings for this measurement.
Frequency deadband	0.011.00 Hz	0.01 Hz	0.1 Hz	Determines the data reporting deadband settings for this measurement.
Current deadband	0.0150.00 A	0.01 A	5 A	Determines the data reporting deadband settings for this measurement.
Residual current deadband	0.0150.00 A	0.01 A	0.2 A	Determines the data reporting deadband settings for this measurement.
Voltage deadband	0.015000.00 V	0.01 V	200 V	Determines the data reporting deadband settings for this measurement.
Residual voltage deadband	0.015000.00 V	0.01 V	200 V	Determines the data reporting deadband settings for this measurement.
Angle measurement deadband	0.15.0 deg	0.1 deg	1 deg	Determines the data reporting deadband settings for this measurement.
Integration time	010 000 ms	1 ms	0 ms	Determines the integration time of the protocol. If this parameter is set to "0 ms", no integration time is in use.

Name	Range	Step	Default	Description
GOOSE Ethernet port	All COM A Double ethernet card	-	All	Determines which ports can use GOOSE communication. Visible if double ethernet option card is found in the device.

For more information on the IEC 61850 communication protocol support, please refer to the conformance statement documents (www.arcteg.fi/downloads/ → AQ 200 series → Resources).

5.3.1.1 GOOSE

Arcteq devices support both GOOSE publisher and GOOSE subscriber. GOOSE subscriber is enabled with the "GOOSE subscriber enable" parameter at $Communication \rightarrow Protocols \rightarrow IEC 61850/GOOSE$. The GOOSE inputs are configured using either the local HMI or the AQtivate software.

There are up to 64 GOOSE inputs available for use. Each of the GOOSE inputs also has a corresponding input quality signal which can also be used in internal logic. The quality is good, when the input quality status is "low" (that is, when the quality is marked as "0"). The value of the input quality can switch on as a result of a GOOSE time-out or a configuration error, for example. The status and quality of the various logical input signals can be viewed at the $GOOSE~IN~status~and~GOOSE~IN~quality~tabs~at~Control \rightarrow Device~I/O \rightarrow Logical~signals.$

GOOSE input settings

The table below presents the different settings available for all 64 GOOSE inputs.

These settings can be found from Communication \rightarrow Protocols \rightarrow IEC61850.

Table. 5.3.1.1 - 327. GOOSE input settings.

Name	Range	Description
In use	No (Default) Yes	Enables and disables the GOOSE input in question.
Application ID ("AppID")	0×00×3FFF	Defines the application ID that will be matched with the publisher's GOOSE control block.
Configuration revision ("ConfRev")	12 ³² -1	Defines the configuration revision that will be matched with the publisher's GOOSE control block.
Data index ("Dataldx")	099	Defines the data index of the value in the matched published frame. It is the status of the GOOSE input.
Nextldx is quality	No (Default) Yes	Selects whether or not the next received input is the quality bit of the GOOSE input.

GOOSE input descriptions

Each of the GOOSE inputs can be given a description. The user defined description are displayed in most of the menus:

- · logic editor
- matrix
- · block settings
- •
- •

· etc.

These settings can be found from $Control \rightarrow Device IO \rightarrow Logical Signals \rightarrow GOOSE IN Description.$

Table. 5.3.1.1 - 328. GOOSE input user description.

Name	Range	Default	Description
User editable description GI x	131 characters		Description of the GOOSE input. This description is used in several menu types for easier identification.

GOOSE events

GOOSE signals generate events from status changes. The user can select which event messages are stored in the main event buffer: ON, OFF, or both. The events triggered by the function are recorded with a time stamp and with process data values. The time stamp resolution is 1 ms.

Table. 5.3.1.1 - 329. GOOSE event

Event block name	Event name	Description
GOOSE1GOOSE2	GOOSE IN 164 ON/OFF	Status change of GOOSE input.
GOOSE3GOOSE4	GOOSE IN 164 quality Bad/Good	Status change of GOOSE inputs quality.

Setting the publisher

The configuration of the GOOSE publisher is done using the IEC 61850 tool in AQtivate ($Tools \rightarrow Communication \rightarrow IEC 61850$). Refer to AQtivate-200 Instruction manual for more information on how to set up GOOSE publisher.

5.3.2 Modbus TCP and Modbus RTU

The device supports both Modbus TCP and Modbus RTU communication. Modbus TCP uses the Ethernet connection to communicate with Modbus TCP clients. Modbus RTU is a serial protocol that can be selected for the available serial ports.

The user can enable the Modbus TCP protocol at $Communication \rightarrow Protocols \rightarrow Modbus TCP$. The user can enable the Modbus RTU protocol at $Communication \rightarrow Connections$.

The following Modbus function types are supported:

- Read multiple holding registers (function code 3)
- Write single holding register (function code 6)
- Write multiple holding registers (function code 16)
- · Read/Write multiple registers (function code 23)

The following data can be accessed using both Modbus TCP and Modbus RTU:

- · Device measurements
- · Device I/O

- Commands
- Events
- Time

Once the configuration file has been loaded, the user can access the Modbus map of the device via the AQtivate software ($Tools \rightarrow Communication \rightarrow Modbus Map$). Please note that holding registers start from 1. Some masters might begin numbering holding register from 0 instead of 1; this will cause an offset of 1 between the device and the master. Modbus map can be edited with Modbus Configurator ($Tools \rightarrow Communication \rightarrow Modbus Configurator$).

Table. 5.3.2 - 330. Modbus TCP settings.

Parameter	Range	Description
Enable Modbus TCP	DisabledEnabled	Enables and disables the Modbus TCP on the Ethernet port.
IP port	065 535	Defines the IP port used by Modbus TCP. The standard port (and the default setting) is 502.
Event read mode	Get oldest availableContinue previous connectionNew events only	Get oldest event possible (Default) Continue with the event idx from previous connection Get only new events from connection time and forward.

Table. 5.3.2 - 331. Modbus RTU settings.

Parameter	Range	Description
Slave address	1247	Defines the Modbus RTU slave address for the unit.

Reading events

Modbus protocol does not support time-stamped events by standard definition. This means that every vendor must come up with their own definition how to transfer events from the device to the client. In AQ-200 series devices events can be read from HR17...HR22 holding registers. HR17 contains the event-code, HR18...20 contains the time-stamp in UTC, HR21 contains a sequential index and HR22 is reserved for future expansion. See the Modbus Map for more information. The event-codes and their meaning can be found from Event list ($Tools \rightarrow Events \ ang \ Logs \rightarrow Event \ list$ in setting tool). The event-code in HR17 is 0 if no new events can be found in the device event-buffer. Every time HR17 is read from client the event in event-buffer is consumed and on following read operation the next un-read event information can be found from event registers. HR11...HR16 registers contains a back-up of last read event. This is because some users want to double-check that no events were lost

5.3.3 IEC 103

IEC 103 is the shortened form of the international standard IEC 60870-5-103. The AQ 200 series units are able to run as a secondary (slave) station. The IEC 103 protocol can be selected for the serial ports that are available in the device. A primary (master) station can then communicate with the AQ-200 device and receive information by polling from the slave device. The transfer of disturbance recordings is not supported.

The user can enable the IEC 103 protocol at Communication \rightarrow Connections.

NOTE: Once the configuration file has been loaded, the IEC 103 map of the device can be found in the AQtivate software ($Tools \rightarrow IEC \ 103 \ map$).

Table. 5.3.3 - 332. IEC 103 settings.

Name	Range	Step	Default	Description
Slave address	1254	1	1	Defines the IEC 103 slave address for the unit.
Measurement interval	060 000 ms	1 ms	2000 ms	Defines the interval for the measurements update.

The following table presents the setting parameters for the IEC 103 protocol.

5.3.4 IEC 101/104

The standards IEC 60870-5-101 and IEC 60870-5-104 are closely related. Both are derived from the IEC 60870-5 standard. On the physical layer the IEC 101 protocol uses serial communication whereas the IEC 104 protocol uses Ethernet communication. The IEC 101/104 implementation works as a slave in the unbalanced mode.

For detailed information please refer to the IEC 101/104 interoperability document (<u>www.arcteq.fi/downloads/</u> \rightarrow AQ-200 series \rightarrow Resources \rightarrow "AQ-200 IEC101 & IEC104 interoperability").

The user can enable the IEC104 protocol at $Communication \rightarrow Protocols \rightarrow IEC101/104$. The user can enable the IEC101 protocol at $Communication \rightarrow Connections$.

IEC 101 settings

Table. 5.3.4 - 333. IEC 101 settings.

Name	Range	Step	Default	Description
Common address of ASDU	065 534	1	1	Defines the common address of the application service data unit (ASDU) for the IEC 101 communication protocol.
Common address of ASDU size	12	1	2	Defines the size of the common address of ASDU.
Link layer address	065 534	1	1	Defines the address for the link layer.
Link layer address size	12	1	2	Defines the address size of the link layer.
Information object address size	23	1	3	Defines the address size of the information object.
Cause of transmission size	12	1	2	Defines the cause of transmission size.

IEC 104 settings

Table. 5.3.4 - 334. IEC 104 settings.

Name	Range	Step	Default	Description
IEC 104 enable	DisabledEnabled	-	Disabled	Enables and disables the IEC 104 communication protocol.
IP port	065 535	1	2404	Defines the IP port used by the protocol.
Common address of ASDU	065 534	1	1	Defines the common address of the application service data unit (ASDU) for the IEC 104 communication protocol.
APDU timeout (t1)	03600 s	1 s	0 s	The maximum amount of time the slave waits for a transmitted Application Protocol Data Unit (APDU) to be confirmed as received by the master.
Idle timeout (t3)	03600 s	1 s	0 s	The slave outstation can use a test fram to determine if the channel is still available after a prolonged period of communications inactivity. Test frame is sent at an interval specified here.

Measurement scaling coefficients

The measurement scaling coefficients are available for the following measurements, in addition to the general measurement scaling coefficient:

Table. 5.3.4 - 335. Measurements with scaling coefficient settings.

Name	Range
Active energy	
Reactive energy	
Active power	No speling
Reactive power	No scaling1/10
Apparent power	• 1/100 • 1/1000 • 1/10 000
Power factor	• 1/10 000 • 1/100 000 • 1/1 000 000
Frequency	• 10 • 10
Current	• 1000 • 10 000
Residual current	• 100 000 • 1 000 000
Voltage	
Residual voltage	
Angle	

Deadband settings.

Table. 5.3.4 - 336. Analog change deadband settings.

Name	Range	Step	Default	Description
General deadband	0.110.0%	0.1%	2%	Determines the general data reporting deadband settings.
Active energy deadband	0.11000.0kWh	0.1kWh	2kWh	
Reactive energy deadband	0.11000.0kVar	0.1kVar	2kVar	
Active power deadband	0.11000.0kW	0.1kW	2kW	
Reactive power deadband	0.11000.0kVar	0.1kVar	2kVar	
Apparent power deadband	0.11000.0kVA	0.1kVA	2kVA	
Power factor deadband	0.010.99	0.01	0.05	Determines the data reporting deadband settings for
Frequency deadband	0.011.00Hz	0.01Hz	0.1Hz	this measurement.
Current deadband	0.0150.00A	0.01A	5A	
Residual current deadband	0.0150.00A	0.01A	0.2A	
Voltage deadband	0.015000.00V	0.01V	200V	
Residual voltage deadband	0.015000.00V	0.01V	200V	
Angle measurement deadband	0.15.0deg	0.1deg	1deg	
Integration time	010 000ms	1ms	-	Determines the integration time of the protocol. If this parameter is set to "0 ms", no integration time is in use.

5.3.5 SPA

The device can act as a SPA slave. SPA can be selected as the communication protocol for the RS-485 port (Serial COM1). When the device has a serial option card, the SPA protocol can also be selected as the communication protocol for the serial fiber (Serial COM2) ports or RS-232 (Serial COM3) port. Please refer to the chapter "Construction and installation" in the device manual to see the connections for these modules.

The data transfer rate of SPA is 9600 bps, but it can also be set to 19 200 bps or 38 400 bps. As a slave the device sends data on demand or by sequenced polling. The available data can be measurements, circuit breaker states, function starts, function trips, etc. The full SPA signal map can be found in AQtivate ($Tools \rightarrow SPA \ map$).

The SPA event addresses can be found at $Tools \rightarrow Events$ and $logs \rightarrow Event$ list.

The user can enable the SPA protocol at Communication \rightarrow Connections.

Table. 5.3.5 - 337. SPA setting parameters.

Name	Range	Description
SPA address	1899	SPA slave address.
UTC time sync	DisabledEnabled	Determines if UTC time is used when synchronizing time. When disabled it is assumed time synchronization uses local time. If enabled it is assumed that UTC time is used. When UTC time is used the timezone must be set at <i>Commands</i> → <i>Set time zone</i> .



NOTICE!

To access SPA map and event list, an .aqs configuration file should be downloaded from the device.

5.3.6 DNP3

DNP3 is a protocol standard which is controlled by the DNP Users Group (www.dnp.org). The implementation of a DNP3 slave is compliant with the DNP3 subset (level) 2, but it also contains some functionalities of the higher levels. For detailed information please refer to the DNP3 Device Profile document (www.arcteg.fi/downloads/ \rightarrow AQ-200 series \rightarrow Resources).

The user can enable the DNP3 TCP protocol at $Communication \rightarrow Protocols \rightarrow DNP3$. The user can enable the DNP3 serial protocol at $Communication \rightarrow Connections$.

Settings

The following table describes the DNP3 setting parameters.

Table. 5.3.6 - 338. Settings.

Name	Range	Step	Default	Description
Enable DNP3 TCP	DisabledEnabled	-	Disabled	Enables and disables the DNP3 TCP communication protocol when the Ethernet port is used for DNP3. If a serial port is used, the DNP3 protocol can be enabled from <i>Communication</i> → <i>DNP3</i> .
IP port	065 535	1	20 000	Defines the IP port used by the protocol.
Slave address	165 519	1	1	Defines the DNP3 slave address of the unit.
Master address	165 534	1	2	Defines the address for the allowed master.
Link layer time-out	060 000ms	1ms	0ms	Defines the length of the time-out for the link layer.

Name	Range	Step	Default	Description
Link layer retries	120	1	1	Defines the number of retries for the link layer.
Diagnostic - Error counter	02 ³² -1	1	-	Counts the total number of errors in received and sent messages.
Diagnostic - Transmitted messages	02 ³² -1	1	-	Counts the total number of transmitted messages.
Diagnostic - Received messages	02 ³² -1	1	-	Counts the total number of received messages.

Default variations

Table. 5.3.6 - 339. Default variations.

Name	Range	Default	Description
Group 1 variation (BI)	• Var 1 • Var 2	Var 1	Selects the variation of the binary signal.
Group 2 variation (BI change)	• Var 1 • Var 2	Var 2	Selects the variation of the binary signal change.
Group 3 variation (DBI)	• Var 1 • Var 2	Var 1	Selects the variation of the double point signal.
Group 4 variation (DBI change)	• Var 1 • Var 2	Var 2	Selects the variation of the double point signal.
Group 20 variation (CNTR)	Var 1Var 2Var 5Var 6	Var 1	Selects the variation of the control signal.
Group 22 variation (CNTR change)	Var 1Var 2Var 5Var 6	Var 5	Selects the variation of the control signal change.
Group 30 variation (AI)	Var 1Var 2Var 3Var 4Var 5	Var 5	Selects the variation of the analog signal.
Group 32 variation (Al change)	Var 1Var 2Var 3Var 4Var 5Var 7	Var 5	Selects the variation of the analog signal change.

Setting the analog change deadbands

Table. 5.3.6 - 340. Analog change deadband settings.

Name	Range	Step	Default	Description
General deadband	0.110.0%	0.1%	2%	Determines the general data reporting deadband settings.
Active energy deadband	0.11000.0kWh	0.1kWh	2kWh	
Reactive energy deadband	0.11000.0kVar	0.1kVar	2kVar	
Active power deadband	0.11000.0kW	0.1kW	2kW	
Reactive power deadband	0.11000.0kVar	0.1kVar	2kVar	
Apparent power deadband	0.11000.0kVA	0.1kVA	2kVA	
Power factor deadband	0.010.99	0.01	0.05	Determines the data reporting deadband settings for
Frequency deadband	0.011.00Hz	0.01Hz	0.1Hz	this measurement.
Current deadband	0.0150.00A	0.01A	5A	
Residual current deadband	0.0150.00A	0.01A	0.2A	
Voltage deadband	0.015000.00V	0.01V	200V	
Residual voltage deadband	0.015000.00V	0.01V	200V	
Angle measurement deadband	0.15.0deg	0.1deg	1deg	
Integration time	010 000ms	1ms	0ms	Determines the integration time of the protocol. If this parameter is set to "0 ms", no integration time is in use.

5.3.7 Modbus I/O

The Modbus I/O protocol can be selected to communicate on the available serial ports. The Modbus I/O is actually a Modbus/RTU master implementation that is dedicated to communicating with serial Modbus/RTU slaves such as RTD input modules. Up to three (3) Modbus/RTU slaves can be connected to the same bus polled by the Modbus I/O implementation. These are named I/O Module A, I/O Module B and I/O Module C. Each of the modules can be configured using parameters in the following two tables.

Table. 5.3.7 - 341. Module settings.

Name	Range	Description
I/O module X address	0247	Defines the Modbus unit address for the selected I/O Module (A, B, or C). If this setting is set to "0", the selected module is not in use.
Module x type	• ADAM-4018+ • ADAM-4015	Selects the module type.
Channels in use	Channel 0Channel 7 (or None)	Selects the number of channels to be used by the module.

Table. 5.3.7 - 342. Channel settings.

Name	Range	Step	Default	Description
Thermocouple type	 +/- 20mA 420mA Type J Type K Type T Type E Type R Type S 	-	420mA	Selects the thermocouple or the mA input connected to the I/O module. Types J, K, T and E are nickel-alloy thermocouples, while Types R and S are platinum/rhodium-alloy thermocouples.
Input value	-101.02 000.0	0.1	-	Displays the input value of the selected channel.
Input status	InvalidOK	-	-	Displays the input status of the selected channel.

5.4 Analog fault registers

At $Communication \rightarrow General I/O \rightarrow Analog fault registers$ the user can set up to twelve (12) channels to record the measured value when a protection function starts or trips. These values can be read in two ways: locally from this same menu, or through a communication protocol if one is in use.

The following table presents the setting parameters available for the 12 channels.

Table. 5.4 - 343. Fault register settings.

Name	Range	Step	Default	Description
Select record source	Not in use >, >>, >>>, >>>> (IL1, L2, L3) d>, d>>>, d>>>> (IL1, L2, L3) d>, d>>>> (IL1, L2, L3) d>, d>>>> (IL1, L2, L3) d>, d>>>> (ID) d>>>, d>>>> (ID) d>>>> (ID) d>>>, d>>>> (ID) d>>>, d>>>> (ID) d>>>, d>>>> (ID) d>>>, d>>>> (ID) d>>> (ID) d>>>> (ID) d>>> (ID) d>>>> (ID) d>>> (ID) d>>>> (ID) d>>> (ID) d>> (ID) d> (ID) d	-	Not in use	Selects the protection function and its stage to be used as the source for the fault register recording. The user can choose between non-directional overcurrent, directional overcurrent, non-directional earth fault, directional earth fault, and fault locator functions.
Select record trigger	 TRIP signal START signal START and TRIP signals 	-	TRIP signal	Selects what triggers the fault register recording: the selected function's TRIP signal, its START signal, or either one.
Recorded fault value	- 1000 000.001 000 000.00	0.01	-	Displays the recorded measurement value at the time of the selected fault register trigger.

5.5 Real-time measurements to communication

With the *Real-time signals to communication* menu the user can report measurements to SCADA in a faster interval. The real measurement update delay depends on the used communication protocol and equipment used. Up to ten (10) magnitudes can be selected. The recorded value can be either a perunit value or a primary value (set by the user).

Measurable values

Function block uses analog current and voltage measurement values. The device uses these values as the basis when it calculates the primary and secondary values of currents, voltages, powers, impedances and other values.

Table. 5.5 - 344. Available measured values.

Signals	Description
Currents	
IL1 (ff), IL2 (ff), IL3 (ff), I01 (ff), I02 (ff)	Fundamental frequency (RMS) current measurement values of phase currents and residual currents.
IL1 (TRMS), IL2 (TRMS), IL3 (TRMS), I01 (TRMS), I02 (TRMS)	TRMS current measurement values of phase currents and residual currents.

Signals	Description	
IL1, IL2, IL3, I01, I02 & 2 nd h., 3 rd h., 4 th h., 5 th h., 7 th h., 9 th h., 11 th h., 13 th h., 15 th h., 17 th h., 19 th h.	Magnitudes of the phase current components: 2 nd harmonic, 3 rd harmonic, 4 th harmonic, 5 th harmonic 7 th , harmonic 9 th , harmonic 11 th , harmonic 13 th , harmonic 15 th , harmonic 17 th , harmonic 19 th harmonic current.	
I1, I2, I0Z	Positive sequence current, negative sequence current and zero sequence current.	
I0CalcMag	Residual current calculated from phase currents.	
IL1Ang, IL2Ang, IL3Ang, I01Ang, I02Ang, I0CalcAng I1Ang, I2Ang	Angles of each measured current.	
Voltages		
UL1Mag, UL2Mag, UL3Mag, UL12Mag, UL23Mag, UL31Mag, U0Mag, U0CalcMag	Magnitudes of phase voltages, phase-to-phase voltages and residual voltages.	
U1 Pos.seq V mag, U2 Neg.seq V mag	Positive and negative sequence voltages.	
UL1Ang, UL2Ang, UL3Ang, UL12Ang, UL23Ang, UL31Ang, U0Ang, U0CalcAng	Angles of phase voltages, phase-to-phase voltages and residual voltages.	
U1 Pos.seq V Ang, U2 Neg.seq V Ang	Positive and negative sequence angles.	
Powers		
S3PH P3PH Q3PH	Three-phase apparent, active and reactive power.	
SL1, SL2, SL3, PL1, PL2, PL3, QL1, QL2, QL3	Phase apparent, active and reactive powers.	
tanfi3PH tanfiL1 tanfiL2 tanfiL3	Tan (φ) of three-phase powers and phase powers.	
cosfi3PH cosfiL1 cosfiL2 cosfiL3	Cos (φ) of three-phase powers and phase powers.	
Impedances and admittances		
RL12, RL23, RL31 XL12, XL23, XL31 RL1, RL2, RL3 XL1, XL2, XL3 Z12, Z23, Z31 ZL1, ZL2, ZL3	Phase-to-phase and phase-to-neutral resistances, reactances and impedances.	
Z12Ang, Z23Ang, Z31Ang, ZL1Ang, ZL2Ang, ZL3Ang	Phase-to-phase and phase-to-neutral impedance angles.	

Signals	Description	
Rseq, Xseq, Zseq RseqAng, XseqAng, ZseqAng	Positive sequence resistance, reactance and impedance values and angles.	
GL1, GL2, GL3, G0 BL1, BL2, BL3, B0 YL1, YL2, YL3, Y0	Conductances, susceptances and admittances.	
YL1angle, YL2angle, YL3angle, Y0angle	Admittance angles.	
Others		
System f.	Used tracking frequency at the moment.	
Ref f1	Reference frequency 1.	
Ref f2	Reference frequency 2.	
M thermal T	Motor thermal temperature.	
F thermal T	Feeder thermal temperature.	
T thermal T	Transformer thermal temperature.	
RTD meas 116	RTD measurement channels 116.	
Ext RTD meas 18	External RTD measurement channels 18 (ADAM module).	

Settings

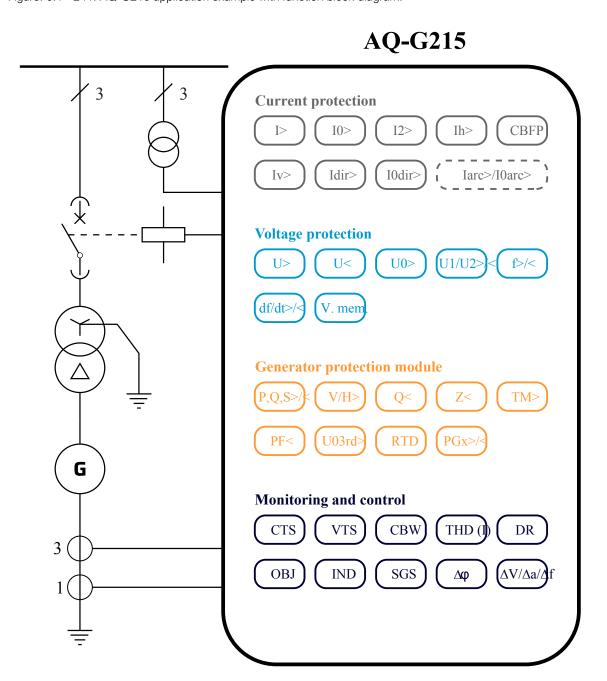
Table. 5.5 - 345. Settings.

Name	Range	Step	Default	Description
Measurement value recorder mode	Disabled Activated	-	Disabled	Activates and disables the real-time signals to communication.
Scale current values to primary	• No • Yes	-	No	Selects whether or not values are scaled to primary.
Slot X magnitude selection	 Currents Voltages Powers Impedance (ZRX) and admittance (YGB) Others 	-	Currents	Selects the measured magnitude catecory of the chosen slot.
Slot X magnitude	Described in table above ("Available measured values")	-	-	Selects the magnituge in the previously selected category.
Magnitude X	-10 000 000.00010 000 000.000	0.001	-	Displays the measured value of the selected magnitude of the selected slot. The unit depends on the selected magnitude (either amperes, volts, or perunit values).

6 Connections and application examples

6.1 Connections of AQ-G215

Figure. 6.1 - 241. AQ-G215 application example with function block diagram.

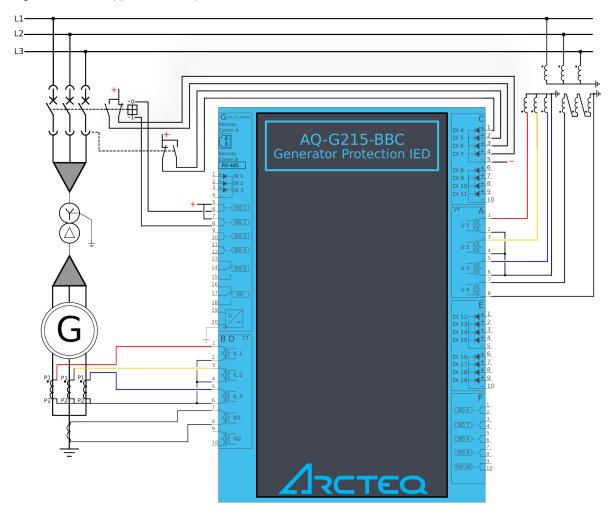


6.2 Application example and its connections

This chapter presents an application example for the generator protection relay.

Since three line-to-neutral voltages and the zero sequence voltage (U4) are connected, this application uses the voltage measurement mode "3LN+U0" (see the image below). Additionally, the three phase currents and the residual current (I01) are also connected. The digital inputs are connected to indicate the breaker status, while the digital outputs are used for breaker control.

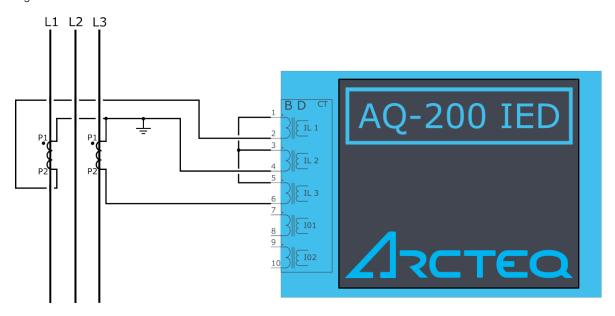
Figure. 6.2 - 242. Application example and its connections.



6.3 Two-phase, three-wire ARON input connection

This chapter presents the two-phase, three-wire ARON input connection for any AQ-200 series device with a current transformer. The example is for applications with protection CTs for just two phases. The connection is suitable for both motor and feeder applications.

Figure. 6.3 - 243. ARON connection.



The ARON input connection can measure the load symmetrically despite the fact that one of the CTs is missing from the installation. Normally, Phase 2 does not have a current transformer installed as an external fault is much more likely to appear on Lines 1 or 3.

A fault between Line 2 and the earth cannot be detected when the ARON input connection is used. In order to detect an earth fault in Phase 2, a cable core CT must be used.

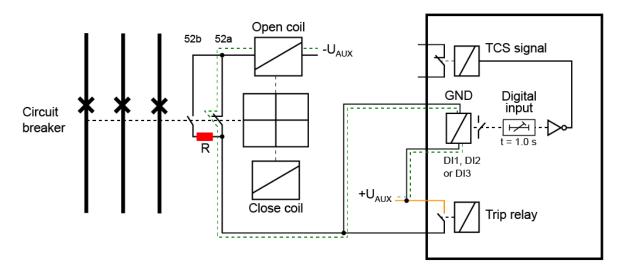
6.4 Trip circuit supervision (95)

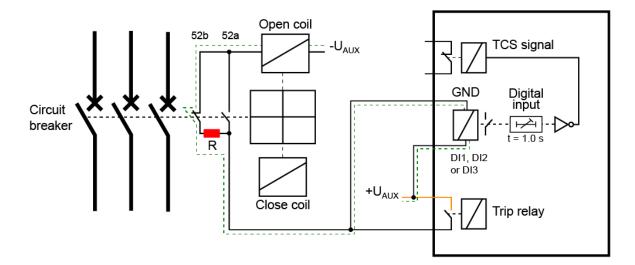
Trip circuit supervision is used to monitor the wiring from auxiliary power supply, through the device's digital output, and all the way to the open coil of the breaker. It is recommended to supervise the health of the trip circuit when breaker is closed.

Trip circuit supervision with one digital input and one non-latched trip output

The figure below presents an application scheme for trip circuit supervision with one digital input and a non-latched trip output. With this connection the current keeps flowing to the open coil of the breaker via the breaker's closing auxiliary contacts (52b) even when the circuit breaker is opened. This requires a resistor which reduces the current: this way the coil is not energized and the relay output does not need to cut off the coil's inductive current.

Figure. 6.4 - 244. Trip circuit supervision with one DI and one non-latched trip output.



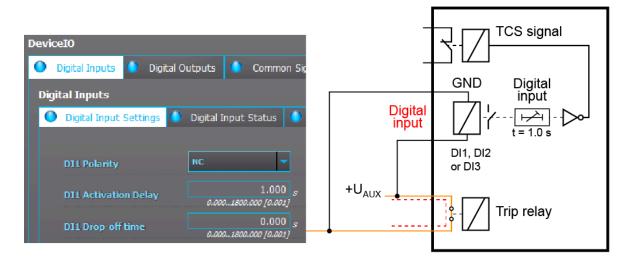


Note that the digital input that monitors the circuit is normally closed, and the same applies to the alarm relay if one is used. For monitoring and especially trip circuit supervision purposes it is recommended to use a normally closed contact to confirm the wiring's condition. An active digital input generates a less than 2 mA current to the circuit, which is usually small enough not to make the breaker's open coil operate.

When the trip relay is controlled and the circuit breaker is opening, the digital input is shorted by the trip contact as long as the breaker is opening. Normally, this takes about 100 ms if the relay is non-latched. A one second activation delay should, therefore, be added to the digital input. An activation delay that is slightly longer than the circuit breaker's operations time should be enough. When circuit breaker failure protection (CBFP) is used, adding its operation time to the digital input activation time is useful. The whole digital input activation time is, therefore, t_{DI} = t_{CB} + t_{IEDrelease} + t_{CBFP}.

The image below presents the necessary settings when using a digital input for trip circuit supervision. The input's polarity must be NC (normally closed) and a one second delay is needed to avoid nuisance alarm while the circuit breaker is controlled open.

Figure. 6.4 - 245. Settings for a digital input used for trip circuit supervision.

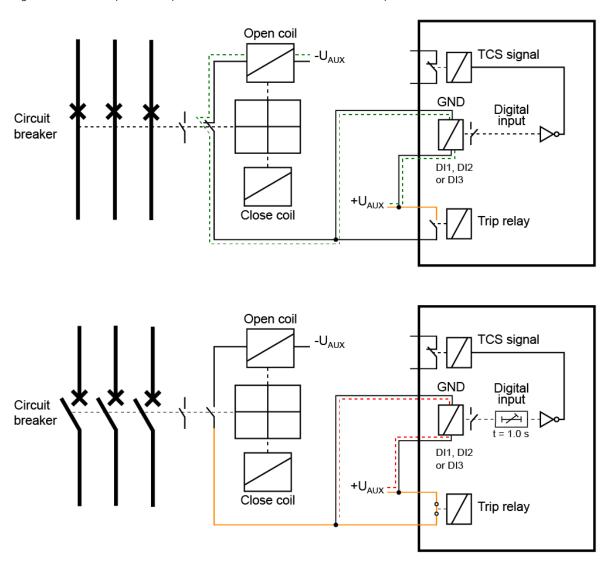


The open coil remains energized only as long as the circuit breaker is opened and the trip relay is open. This takes approximately 100 ms depending on the size and type of the breaker. When the breaker opens, the auxiliary contacts of the circuit breaker open the inductive circuit; however, the trip contact does not open at the same time. The device's output relay contact opens in under 50 ms or after a set release delay that takes place after the breaker is opened. This means that the open coil is energized for a while after the breaker has already opened. The coil could even be energized a moment longer if the circuit breaker failure protection has to be used and the incomer performs the trip.

Trip circuit supervision with one digital input and one connected, non-latched trip output

There is one main difference between non-latched and latched control in trip circuit supervision: when using the latched control, the trip circuit (in an open state) cannot be monitored as the digital input is shorted by the device's trip output.

Figure. 6.4 - 246. Trip circuit supervision with one DI and one latched output contact.



The trip circuit with a latched output contact can be monitored, but only when the circuit breaker's status is "Closed". Whenever the breaker is open, the supervision is blocked by an internal logic scheme. Its disadvantage is that the user does not know whether or not the trip circuit is intact before the breaker is closed again.

The following logic scheme (or similar) blocks the supervision alarm when the circuit breaker is open. The alarm is issued whenever the breaker is closed and whenever the inverted digital input signal ("TCS") activates. A normally closed digital input activates only when there is something wrong with the trip circuit and the auxiliary power goes off. Logical output can be used in the output matrix or in SCADA as the user wants.

The image below presents a block scheme when a non-latched trip output is not used.

Figure. 6.4 - 247. Example block scheme.



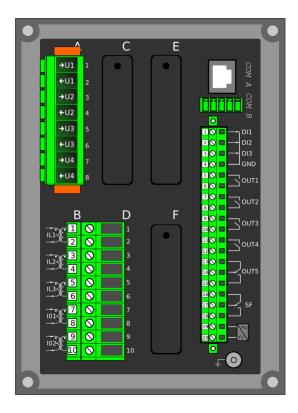
7 Construction and installation

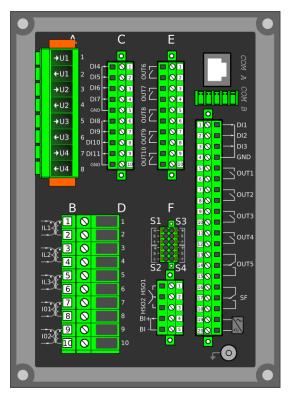
7.1 Construction

AQ-X215 is a member of the modular and scalable AQ-200 series, and it includes three (3) configurable and modular add-on card slots. As a standard configuration the device includes the CPU module (which consists of the CPU, a number of inputs and outputs, and the power supply) as well as one separate voltage measurement module and one separate current measurement module.

The images below present the modules of both the non-optioned model (AQ-X215-XXXXXXX-AAA, on the left) and the fully optioned model (AQ-X215-XXXXXXX-BCD, on the right).

Figure. 7.1 - 248. Modular construction of AQ-X215.





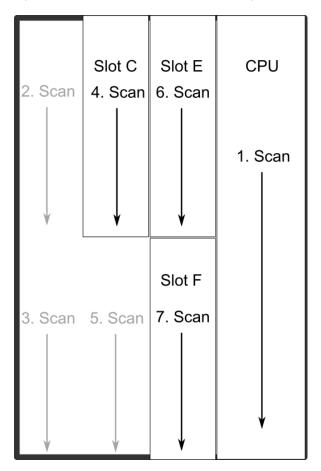
The modular structure of AQ-X215 allows for scalable solutions for different application requirements. In non-standard configurations Slots C, E and F accept all available add-on modules, such as digital I/O modules, integrated arc protection and other special modules. The only difference between the slots affecting device scalability is that Slots E and F also support communication options.

Start-up scan searches for modules according to their type designation code. If the module content is not what the device expects, the device issues a hardware configuration error message. In field upgrades, therefore, add-on modules must be ordered from Arcteq Relays Ltd. or its representative who can then provide the module with its corresponding unlocking code to allow the device to operate correctly once the hardware configuration has been upgraded.

When an I/O module is inserted into the device, the module location affects the naming of the I/O. The I/O scanning order in the start-up sequence is as follows: the CPU module I/O, Slot C, Slot E, and Slot F. This means that the digital input channels DI1, DI2 and DI3 as well as the digital output channels OUT1, OUT2, OUT3, OUT4 and OUT5 are always located in the CPU module. If additional I/O cards are installed, their location and card type affect the I/O naming.

The figure below presents the start-up hardware scan order of the device as well as the I/O naming principles.

Figure. 7.1 - 249. AQ-X215 hardware scanning and I/O naming principles.



1 Scan

The start-up system; detects and self-tests the CPU module, voltages, communication and the I/O; finds and assigns "DI1", "DI2", "DI3", "OUT1", "OUT2", "OUT3", "OUT4" and "OUT5".

- 2. Scan
 - Scans Slot A and finds the four channels of the VT module (fixed for AQ-X215). If the VTM is not found, the device issues an alarm.
- 3. Scan

Scans Slot B, which should always remain empty in AQ-X215 devices. If it is not empty, the device issues an alarm.

4. Scan

Scans Slot C, and moves to the next slot if Slot C is empty. If the scan finds an 8DI module (that is, a module with eight digital inputs), it reserves the designations "DI4", "DI5", "DI6", "DI7", "DI8", "DI9", "DI9", "DI10" and "DI11" to this slot. If the scan finds a DO5 module (that is, a module with five digital outputs), it reserves the designations "OUT6", "OUT7", "OUT8", "OUT9" and "OUT10" to this slot. The I/O is then added if the type designation code (e.g. AQ-P215-PH0AAAA-BBC) matches with the existing modules in the device. If the code and the modules do not match, the device issues and alarm. An alarm is also issued if the device expects to find a module here but does not find one.

5. Scan

Scans Slot D and finds the five channels of the CT module (fixed for AQ-X215). If the CTM is not found, the device issues an alarm.

6. Scan

Scans Slot E, and moves to the next slot if Slot E is empty. If the scan finds an 8DI module, it reserves the designations "DI4", "DI5", "DI6", "DI7", "DI8", "DI9", "DI9", "DI10" and "DI11" to this slot. If Slot C also has an 8DI module (and therefore has already reserved these designations), the device reserves the designations "DI12", "DI13", "DI14", "DI15", "DI16", "DI17", "DI18" and "DI19" to this slot. If the scan finds a 5DO module, it reserves the designations "OUT6", "OUT7", "OUT8", "OUT9" and "OUT10" to this slot. Again, if Slot C also has a 5DO and has therefore already reserved these designations, the device reserves the designations "OUT11", "OUT12", "OUT13", "OUT14" and "OUT15" to this slot. If the scan finds the arc protection module, it reserves the sensor channels ("S1", "S2", "S3", "S4"), the high-speed outputs ("HSO1", "HSO2"), and the digital input channel ("ArcBI") to this slot.

7. Scan

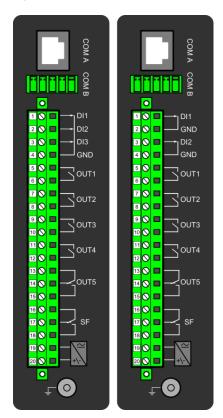
A similar operation to Scan 6 (checks which designations have been reserved by modules in previous slots and numbers the new ones accordingly).

Thus far this chapter has only explained the installation of I/O add-on cards to the option module slots. This is because all other module types are treated in a same way. For example, when an additional communication port is installed into the upper port of the communication module, its designation is Communication port 3 or higher, as Communication ports 1 and 2 already exist in the CPU module (which is scanned, and thus designated, first). After a communication port is detected, it is added into the device's communication space and its corresponding settings are enabled.

The fully optioned example case of AQ-X215-XXXXXXX-BCD (the first image pair, on the right) has a total of 11 digital input channels available: three (DI1...DI3) in the CPU module, and eight (DI4...DI11) in Slot C. It also has a total of 10 digital output channels available: five (DO1...DO5) in the CPU module, and five (DO6...DO10) in Slot E. These same principles apply to all non-standard configurations in the AQ-X215 devices.

7.2 CPU module

Figure. 7.2 - 250. CPU module.



Module connectors

Table. 7.2 - 346. Module connector descriptions.

Description						
Communication port A, or the RJ-45 port. Used for the setting tool connection and for SCADA communication.						
Communication port B, or the RS-485 port. Used for SCADA communication. The pins have the following designations: • Pin 1 = DATA + • Pin 2 = DATA - • Pin 3 = GND • Pins 4 & 5 = Terminator resistor enabled by shorting.						
Model with 3 digital inputs	Model with 2 digital inputs					
Digital input 1, nominal threshold voltage 24 V, 110 V or 220 V.	Digital input 1, nominal threshold voltage 24 V, 110 V or 220 V.					
Digital input 2, nominal threshold voltage 24 V, 110 V or 220 V.	GND for digital input 1.					
Digital input 3, nominal threshold voltage 24 V, 110 V or 220 V.	Digital input 2, nominal threshold voltage 24 V, 110 V or 220 V.					
Common GND for digital inputs 1, 2 and 3.	GND for digital input 2.					
Output relay 1, with a normally open (NO) contact.						
Output relay 2, with a normally open (NO) contact.						
Output relay 3, with a normally open (NO) contact.						
Output relay 4, with a normally open (NO) contact.						
Signaling relay 5, with a changeover contact. Not to be used in trip coil control.						
System fault's signaling relay, with a changeover contact. Pins 16 and 17 are closed when the unit has a system fault or is powered OFF. Pins 16 and 18 are closed when the unit is powered ON and there is no system fault.						
Power supply IN. Either 80265 VAC/DC (model A; order code "H") or 1875 DC (model B; order code "L"). Positive side (+) to Pin 20.						
The device's earthing connector.						
	Communication port A, or the RJ-45 port. Used for communication. Communication port B, or the RS-485 port. Used following designations: Pin 1 = DATA + Pin 2 = DATA - Pin 3 = GND Pins 4 & 5 = Terminator resistor enabled by slands and signal inputs Digital input 1, nominal threshold voltage 24 V, 110 V or 220 V. Digital input 2, nominal threshold voltage 24 V, 110 V or 220 V. Digital input 3, nominal threshold voltage 24 V, 110 V or 220 V. Common GND for digital inputs 1, 2 and 3. Output relay 1, with a normally open (NO) contact Output relay 2, with a normally open (NO) contact Output relay 3, with a normally open (NO) contact Output relay 4, with a normally open (NO) contact Output relay 5, with a changeover contact. Not System fault's signaling relay, with a changeover of has a system fault or is powered OFF. Pins 16 and there is no system fault. Power supply IN. Either 80265 VAC/DC (model code "L"). Positive side (+) to Pin 20.					

By default, the CPU module (combining the CPU, the I/O and the power supply) is included in all AQ 200 series devices to provide two standard communication ports and the device's basic digital I/O. The module can be ordered to include 2 or 3 digital inputs.

The digital output controls can be set by the user with software. Digital outputs are controlled in 5 ms program cycles. All output contacts are mechanical. The rated voltage of the NO/NC outputs is 250 VAC/DC.

The auxiliary voltage is defined in the ordering code: the available power supply models available are A (80...265 VAC/DC) and B (18...75 DC). For further details, please refer to the "Auxiliary voltage" chapter in the "Technical data" section of this document.

Digital input and output settings.

The current consumption of the digital inputs is 2 mA when activated. The range of the operating voltage is 24 V/110 V/220 V depending on the ordered hardware. All digital inputs are scannced in 5 ms program cycles. Pick-up and release delays as well as the NO/NC selection can be set with software.

The settings described in the table below can be found at Control o Device I/O o Digital input settings in the device settings.

Table. 7.2 - 347. Digital input settings.

Name	Range	Step	Default	Description
Dlx Polarity	NO (Normally open) NC (Normally closed)	-	NO	Selects whether the status of the digital input is 1 or 0 when the input is energized.
DIx Activation delay	0.0001800.000 s	0.001 s	0.000 s	Defines the delay for the status change from 0 to 1.
Dlx Drop- off time	0.0001800.000 s	0.001 s	0.000 s	Defines the delay for the status change from 1 to 0.
Dlx AC mode	DisabledEnabled	-	Disabled	Selects whether or not a 30-ms deactivation delay is added to account for alternating current.

Table. 7.2 - 348. Digital output settings.

Name	Range	Description
Out x Polarity		Determines the normal status of the output relay. Please not that an NC relay goes to the default position (NO) if the device loses the auxiliary voltage or if the system is fully reset. An NC output signal does not open during a Communication or Protection reset.

Digital input and output descriptions

CPU card digital inputs and outputs can be given a description. The user defined description are displayed in most of the menus:

- · logic editor
- matrix
- block settings
- •
- •
- etc.

Table. 7.2 - 349. Digital input and output user description.

Name	Range	Default	Description
User editable description Dlx	131 characters	Dlx	Description of the digital input. This description is used in several menu types for easier identification.

Name	Range	Default	Description
User editable description OUTx		OUTx	Description of the digital output. This description is used in several menu types for easier identification.

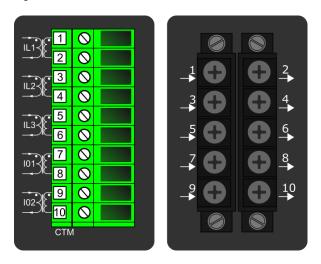
Scanning cycle

All digital inputs are scanned in a 5 ms cycle, meaning that the state of an input is updated every 0...5 milliseconds. When an input is used internally in the device (either in setting group change or logic), it takes additional 0...5 milliseconds to operate. Theoretically, therefore, it takes 0...10 milliseconds to change the setting group when a digital input is used for setting group control or a similar function. In practice, however, the delay is between 2...8 milliseconds about 95 % of the time. When a digital input is connected directly to a digital output (OUT1...OUTx), it takes an additional 5 ms round. Therefore, when a digital input controls a digital output internally, it takes 0...15 milliseconds in theory and 2...13 milliseconds in practice.

Please note that the mechanical delay of the relay is <u>not</u> included in these approximations.

7.3 Current measurement module

Figure. 7.3 - 251. Module connections with standard and ring lug terminals.



Connector	Description				
CTM 1-2	Phase current measurement for phase L1 (A).				
CTM 3-4	Phase current measurement for phase L2 (B).				
CTM 5-6	Phase current measurement for phase L3 (C).				
CTM 7-8	Coarse residual current measurement I01.				
CTM 9-10	Fine residual current measurement I02.				

A basic current measurement module with five channels includes three-phase current measurement inputs as well as coarse and fine residual current inputs. The CT module is available with either standard or ring lug connectors.

The current measurement module is connected to the secondary side of conventional current transformers (CTs). The nominal current for the phase current inputs is 5 A. The input nominal current can be scaled for secondary currents of 1...10 A. The secondary currents are calibrated to nominal currents of 1 A and 5 A, which provide ± 0.5 % inaccuracy when the range is $0.005...4 \times I_D$.

The measurement ranges are as follows:

- Phase currents 25 mA...250 A (RMS)
- Coarse residual current 5 mA...150 A (RMS)
- Fine residual current 1 mA...75 A (RMS)

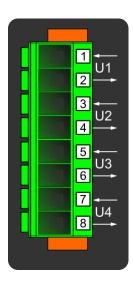
The characteristics of phase current inputs are as follows:

- The angle measurement inaccuracy is less than ± 0.2 degrees with nominal current.
- The frequency measurement range of the phase current inputs is 6...1800 Hz with standard hardware.
- The quantization of the measurement signal is applied with 18-bit AD converters, and the sample rate of the signal is 64 samples/cycle when the system frequency ranges from 6 Hz to 75 Hz.

For further details please refer to the "Current measurement" chapter in the "Technical data" section of this document.

7.4 Voltage measurement module

Figure. 7.4 - 252. Voltage measurement module.



Connector	Description			
VTM 1-2	Configurable voltage measurement input U1.			
VTM 3-4	Configurable voltage measurement input U2.			
VTM 5-6	Configurable voltage measurement input U3.			
VTM 7-8	Configurable voltage measurement input U4.			

A basic voltage measurement module with four channels includes four voltage measurement inputs that can be configured freely.

The voltage measurement module is connected to the secondary side of conventional voltage transformers (VTs) or directly to low-voltage systems secured by fuses. The nominal voltage can be set between 100...400 V. Voltages are calibrated in a range of 0...240 V, which provides \pm 0.2 % inaccuracy in the same range.

The voltage input characteristics are as follows:

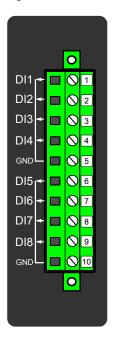
- The measurement range is 0.5...480.0 V per channel.
- The angle measurement inaccuracy is less than \pm 0.5 degrees within the nominal range.
- The frequency measurement range of the voltage inputs is 6...1800 Hz with standard hardware.
- The quantization of the measurement signal is applied with 18-bit AD converters, and the sample rate of the signal is 64 samples/cycle when the system frequency ranges from 6 Hz to 75 Hz.

For further details please refer to the "Voltage measurement" chapter in the "Technical data" section of this document.

7.5 Option cards

7.5.1 Digital input module (optional)

Figure. 7.5.1 - 253. Digital input module (DI8) with eight add-on digital inputs.



Connector	Description (x = the number of digital inputs in other modules that preceed this one in the configuration)	
X 1	Dlx + 1	
X 2	Dlx + 2	
Х3	Dlx + 3	
X 4	Dlx + 4	
X 5	Common earthing for the first four digital inputs.	
X 6	DIx + 5	

Connector	Description (x = the number of digital inputs in other modules that preceed this one in the configuration)	
X 7	Dlx + 6	
X 8	Dlx + 7	
X 9	Dlx + 8	
X 10	Common earthing for the other four digital inputs.	

The DI8 module is an add-on module with eight (8) galvanically isolated digital inputs. This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required. The properties of the inputs in this module are the same as those of the inputs in the main processor module. The current consumption of the digital inputs is 2 mA when activated, while the range of the operating voltage is from 0...265 VAC/DC. The activation and release thresholds are set in the software and the resolution is 1 V. All digital inputs are scannced in 5 ms program cycles, and their pick-up and release delays as well as their NO/NC selection can be set with software.

For the naming convention of the digital inputs provided by this module please refer to the chapter titled "Construction and installation".

For technical details please refer to the chapter titled "<u>Digital input module</u>" in the "Technical data" section of this document.

The hardware configuration code of this module is "B". For more information, please refer to the "Ordering information" chapter of this document.

Setting up the activation and release delays

The settings described in the table below can be found at Control o Device I/O o Digital input settings in the device settings.

Table. 7.5.1 - 350. Digital input settings of DI8 module.

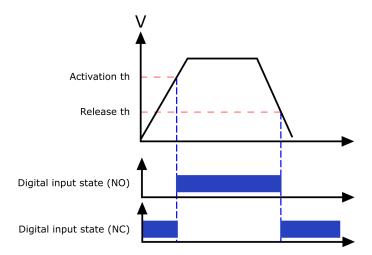
Name	Range	Step	Default	Description
DIx Polarity	NO (Normally open) NC (Normally closed)	-	NO	Selects whether the status of the digital input is 1 or 0 when the input is energized.
DIx Activation threshold	16.0200.0 V	0.1 V	88 V	Defines the activation threshold for the digital input. When "NO" is the selected polarity, the measured voltage exceeding this setting activates the input. When "NC" is the selected polarity, the measured voltage exceeding this setting deactivates the input.
DIx Release threshold	10.0200.0 V	0.1 V	60V	Defines the release threshold for the digital input. When "NO" is the selected polarity, the measured voltage below this setting deactivates the input. When "NC" is the selected polarity, the measured voltage below this setting activates the input.
Dlx Activation delay	0.0001800.000 s	0.001 s	0.000 s	Defines the delay when the status changes from 0 to 1.

Name	Range	Step	Default	Description
DIx Drop- off time	0.0001800.000 s	0.001 s	0.000 s	Defines the delay when the status changes from 1 to 0.
DIx AC Mode	DisabledEnabled	-	Disabled	Selects whether or not a 30-ms deactivation delay is added to take the alternating current into account. The "DIx Release threshold" parameter is hidden and forced to 10 % of the set "DIx Activation threshold" parameter.
Dlx Counter	02 ³² –1	1	0	Displays the number of times the digital input has changed its status from 0 to 1.
Dlx Clear counter	• - • Clear	-	-	Resets the DIx counter value to zero.

The user can set the activation threshold individually for each digital input. When the activation and release thresholds have been set properly, they will result in the digital input states to be activated and released reliably. The selection of the normal state between normally open (NO) and normally closed (NC) defines whether or not the digital input is considered activated when the digital input channel is energized.

The diagram below depicts the digital input states when the input channels are energized and deenergized.

Figure. 7.5.1 - 254. Digital input state when energizing and de-energizing the digital input channels.



Digital input descriptions

Option card inputs can be given a description. The user defined description are displayed in most of the menus:

- · logic editor
- matrix
- block settings
- .
- -
- etc.

Table. 7.5.1 - 351. Digital input user description.

Name	Range	Default	Description
User editable description Dlx	131 characters	Dlx	Description of the digital input. This description is used in several menu types for easier identification.

Digital input voltage measurements

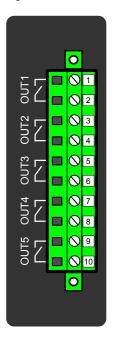
Digital input option card channels measure voltage on each channel. The measured voltage can be seen at Control o Device IO o Digital inputs o Digital input voltages.

Table. 7.5.1 - 352. Digital input channel voltage measurement.

Name	Range	Step	Description
Dlx Voltage now	0.000275.000 V	0.001 V	Voltage measurement of a digital input channel.

7.5.2 Digital output module (optional)

Figure. 7.5.2 - 255. Digital output module (DO5) with five add-on digital outputs.



Connector	Description
X 1–2	OUTx + 1 (1 st and 2 nd pole NO)
X 3–4	OUTx + 2 (1 st and 2 nd pole NO)
X 5–6	OUTx + 3 (1 st and 2 nd pole NO)
X 7–8	OUTx + 4 (1 st and 2 nd pole NO)
X 9–10	OUTx + 5 (1 st and 2 nd pole NO)

The DO5 module is an add-on module with five (5) mechanical type digital outputs. This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required. The properties of the outputs in this module are the same as those of the outputs in the main processor module. Output control logic is user configurable. All digital outputs are controlled in 5 ms program cycles. The rated voltage of the NO/NC outputs is 250 VAC/DC.

For the naming convention of the digital outputs provided by this module please refer to the chapter titled "Construction and installation".

For technical details please refer to the chapter titled "<u>Digital output module</u>" in the "Technical data" section of this document.

The hardware configuration code of this module is "C". For more information, please refer to the "Ordering information" chapter of this document.

Digital output descriptions

Option card outputs can be given a description. The user defined description are displayed in most of the menus:

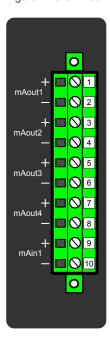
- · logic editor
- matrix
- · block settings
- •
- .
- · etc.

Table. 7.5.2 - 353. Digital output user description.

Name	Range	Default	Description
User editable description OUTx	131 characters	OUTx	Description of the digital output. This description is used in several menu types for easier identification.

7.5.3 Milliampere output module (4x mA out & 1x mA in) (optional)

Figure. 7.5.3 - 256. Milliampere output (mA) I/O module connections.



Connector	Description	
Pin 1	mA OUT 1 + connector (024 mA)	
Pin 2	mA OUT 1 – connector (024 mA)	
Pin 3	mA OUT 2 + connector (024 mA)	
Pin 4	mA OUT 2 – connector (024 mA)	
Pin 5	mA OUT 3 + connector (024 mA)	
Pin 6	mA OUT 3 – connector (024 mA)	
Pin 7	mA OUT 4 + connector (024 mA)	
Pin 8	mA OUT 4 – connector (024 mA)	
Pin 9	mA IN 1 + connector (033 mA)	
Pin 10	mA IN 1 – connector (033 mA)	

The milliampere output (mA) I/O module is an add-on module with four (4) mA outputs and one (1) mA input. Both the outputs and the input are in two galvanically isolated groups, with one pin for the positive (+) connector and one pin for the negative (–) connector.

This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required.

The user sets the mA I/O with the mA outputs control function. This can be done at $Control \rightarrow Device$ $I/O \rightarrow mA$ outputs in the device configuration settings.

For further information please refer to the chapter titled " $\underline{\text{Milliampere output module } (4 \times \text{mA out } \& 1 \times \text{mA in})}$ " in the "Technical data" section of this manual.

The hardware configuration code of this module is "I". For more information, please refer to the "Ordering information" chapter of this document.

7.5.4 Point sensor arc protection module (optional)

Figure. 7.5.4 - 257. Arc protection module.

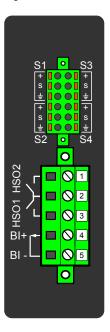


Table. 7.5.4 - 354. Module connections.

Connector	Description	
S1		
S2	Light concern beginned at the modifier (IIII) concern (IICII) and conthe congressions	
S3	Light sensor channels 14 with positive ("+"), sensor ("S") and earth connectors.	
S4		
X 1	HSO2 (+, NO)	
X 2	Common battery positive terminal (+) for the HSOs.	
X 3	HSO1 (+, NO)	
X 4	Binary input 1 (+ pole)	
X 5	Binary input 1 (– pole)	

The arc protection module is an add-on module with four (4) light sensor channels, two (2) high-speed semiconductor outputs and one (1) binary input. This module can be ordered directly to be installed into the device in the factory, or it can be upgraded in the field after the device's original installation when required. Each channel can have up to three (3) light sensors serially connected to it.

High-speed outputs can used as signaling outputs. HSO1 and HSO2 can send overcurrent or light information to external AQ 100 or AQ 200 series devices.

The rated voltage of the binary input is 24 VDC. The pick-up threshold is \geq 16 VDC. The binary input can be used for receiving external light signal or other signals related to arc protection applications. Please note that the binary input's delay is 5...10ms.

NOTICE!

BI1, HSO1 and HSO2 are not visible in the *Binary inputs* and *Binary outputs* menus (*Control* \rightarrow *Device I/O*), they can only be programmed in the arc protection function matrix menu (*Protection* \rightarrow *Arc protection* \rightarrow *I/O* \rightarrow *Direct output control* and *HSO control*).

For further information please refer to the chapter titled "Point sensor arc protection module" in the "Technical data" section of this manual.

The hardware configuration code of this module is "D". For more information, please refer to the "Ordering information" chapter of this document.

7.5.5 RTD input module (optional)

Figure. 7.5.5 - 258. RTD input module connectors.

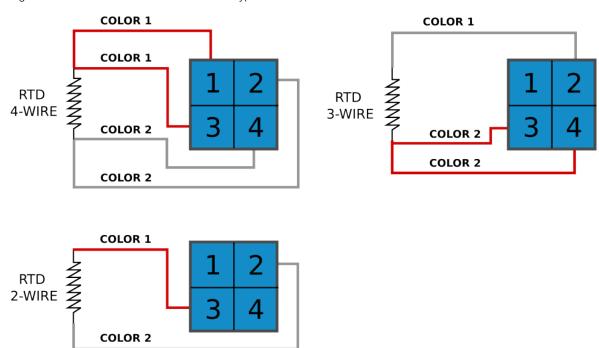
	I								
Channel	Connector			0	L	Co	nne	ect	or
1	RTD1-1	1	Q	Q		2	RT	D1	-2
	RTD1-3	3	Q	Q		4	RT	D1	-4
_	RTD2-1	5	Q	Q		6	RT	D2	-2
2	RTD2-3	7	Q	Q		8	RT	D2	-4
3	RTD3-1	9	Q	Q		10	RT	D3	-2
3	RTD3-3	11	Q	Q		12	RT	D 3	-4
4	RTD4-1	13	Q	Q		14	RT	D 4	-2
4	RTD4-3	15	Q	Q		16	RT	D 4	-4
5	RTD5-1	17	Q	Q		18	RT	D5	-2
	RTD5-3	19	Q	Q		20	RT	D5	-4
•	RTD6-1	21	Q	Q		22	RT	D6	-2
6	RTD6-3	23	Q	Q		24	RT	D6	-4
7	RTD7-1	25	Q	Q		26	RT	D 7	-2
	RTD7-3	27	Q	Q		28	RT	D7	-4
8	RTD8-1	29	Q	Q		30	RT	D8	-2
	RTD8-3	31	\bigcirc			32	RT	D8	-4
				0					

The RTD input module is an add-on module with eight (8) RTD input channels. Each input supports 2-wire, 3-wire and 4-wire RTD sensors. The sensor type can be selected with software for two groups, four channels each. The card supports Pt100 and Pt1000 sensors.

For further information please refer to the chapter titled "<u>RTD input module</u>" in the "Technical data" section of this manual.

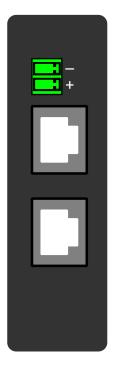
The hardware configuration code of this module is "F". For more information, please refer to the "Ordering information" chapter of this document.

Figure. 7.5.5 - 259. RTD sensor connection types.



7.5.6 Double RJ45 Ethernet & IRIG-B communication module (optional)

Figure. 7.5.6 - 260. Double RJ-45 10/100 Mbps Ethernet communication module.



Connector	Description
Two-pin connector	IRIG-B input
RJ-45 connectors	Two Ethernet ports RJ-45 connectors 10BASE-T and 100BASE-TX

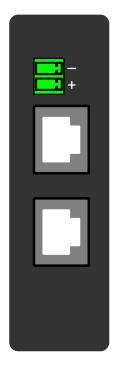
This option card supports daisy chain configurations.

For further information please refer to the chapter titled "<u>Double RJ45 Ethernet & IRIG-B communication module</u>" in the "Technical data" section of this manual.

The hardware configuration code of this module is "G". For more information, please refer to the "Ordering information" chapter of this document.

7.5.7 Double RJ45 Ethernet & IRIG-B communication module (optional)

Figure. 7.5.7 - 261. Double RJ-45 10/100 Mbps Ethernet communication module.



Connector	Description
Two-pin connector	IRIG-B input
RJ-45 connectors	Two Ethernet ports RJ-45 connectors 10BASE-T and 100BASE-TX

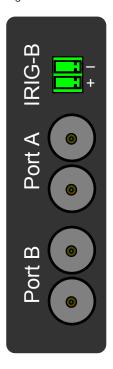
This option card supports daisy chain configurations.

For further information please refer to the chapter titled "<u>Double RJ45 Ethernet & IRIG-B communication module</u>" in the "Technical data" section of this manual.

The hardware configuration code of this module is "G". For more information, please refer to the "Ordering information" chapter of this document.

7.5.8 Double ST 100 Ethernet & IRIG-B communication module (optional)

Figure. 7.5.8 - 262. Double ST 100 Mbps Ethernet communication module connectors.



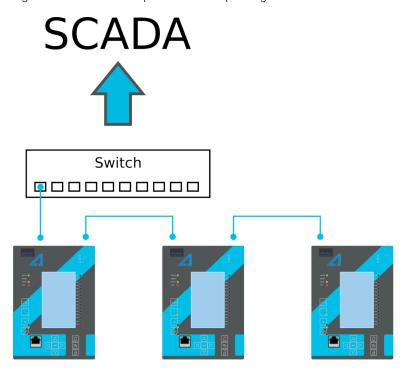
Connector	Description	
Two-pin connector	IRIG-B input	
ST connectors	 Duplex ST connectors 62.5/125 µm or 50/125 µm multimode fiber Transmitter wavelength: 12601360 nm (nominal: 1310 nm) Receiver wavelength: 11001600 nm 100BASE-FX Up to 2 km 	

This option cards supports redundant ring configuration and multidrop configurations. Please note that each ring can only contain AQ 200 series devices, and any third party devices must be connected to a separate ring.

For further information please refer to the chapter titled "<u>Double ST Ethernet & IRIG-B communication</u> module" in the "Technical data" section of this manual.

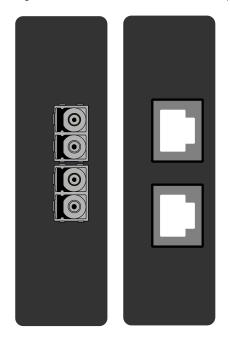
The hardware configuration code of this module is "H". For more information, please refer to the "Ordering information" chapter of this document.

Figure. 7.5.8 - 263. Example of a multidrop configuration.



7.5.9 Double LC or RJ45 (HSR/PRP) Ethernet communication module (optional)

Figure. 7.5.9 - 264. LC and RJ45 100 Mbps Ethernet module connectors.



Card type	Description
LC ports	 Communication port D, 100 Mbps LC fiber connector. 62.5/125 µm or 50/125 µm multimode (glass). Wavelength 1300 nm. HSR and PRP protocols supported.

Card type	Description		
RJ45	 RJ-45 connectors. 10BASE-T and 100BASE-TX. HSR and PRP protocols supported. 		

For further information please refer to the chapters titled "<u>Double LC (HSR/PRP) Ethernet communication module</u>" and "<u>Double RJ45 (HSR/PRP) Ethernet communication module</u>" in the "Technical data" section of this manual.

The hardware configuration codes of these modules are "J" (Double LC 100Mb Ethernet) and "K" (Double RJ45 100Mb Ethernet). For more information, please refer to the "Ordering information" chapter of this document.

7.5.10 Serial RS-232 communication module (optional)

Figure. 7.5.10 - 265. Serial RS-232 module connectors.

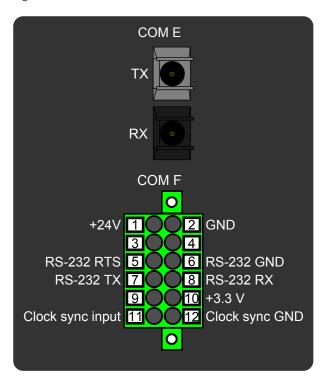


Table. 7.5.10 - 355. Module connections.

Connector	Pin	Name	Description
COM E	-	Serial fiber	 Serial-based communications Port options: Glass/glass Plastic/plastic Glass/plastic Plastic/glass Wavelength 660 nm Compatible with 50/125 µm, 62.5/125 µm, 100/140 µm, and 200 µm Plastic-Clad Silica (PCS) fiber Compatible with ST connectors

Connector	Pin	Name	Description
	1	+24 V input	Optional external auxiliary voltage for serial fiber.
2 GND 3	2	GND	
	4	-	Not in use.
	5	RS-232 RTS	
	6	RS-232 GND	Serial based communications.
COM F	7	RS-232 TX	Senai based communications.
	8	RS-232 RX	
	9	-	Not in use.
11 (+3.3 V output (spare)	Spare power source for external equipment (45 mA).	
	11	Clock sync input	Clock synchronization input (supports IRIG-B).
	12	Clock sync GND	

The option card includes two serial communication interfaces: COM E is a serial fiber interface with glass/glass, plastic/plastic, glass/plastic and plastic/glass options, COM F is an RS-232 interface.

For further information please refer to the chapter titled "RS-232 & serial fiber communication module" in the "Technical data" section of this manual.

The hardware configuration codes of these modules are "L", "M", "N" and "O". For more information, please refer to the "Ordering information" chapter of this document.

7.6 Dimensions and installation

The device can be installed either to a standard 19" rack or to a switchgear panel with cutouts. The desired installation type is defined in the order code. When installing to a rack, the device takes a quarter (¼) of the rack's width, meaning that a total of three devices can be installed to the same rack next to one another.

The figures below describe the device dimensions (first figure), the device installation (second), and the panel cutout dimensions and device spacing (third).

Figure. 7.6 - 266. Device dimensions.

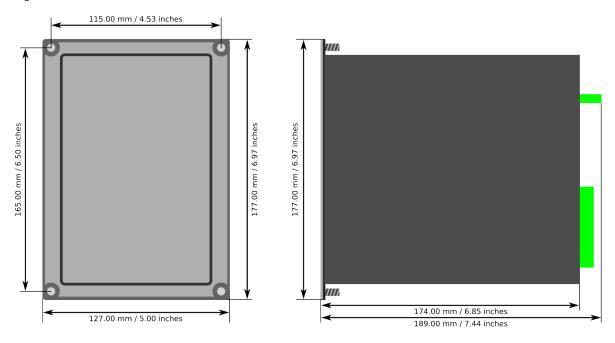


Figure. 7.6 - 267. Device installation.

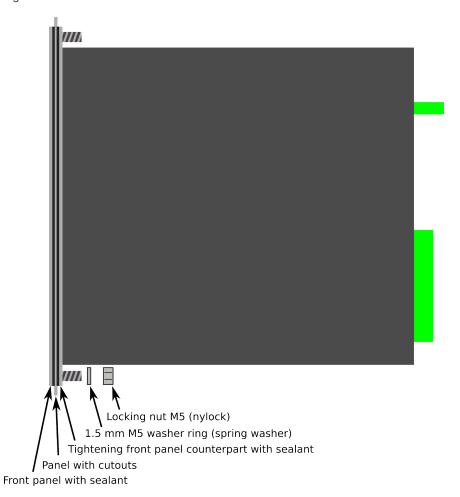
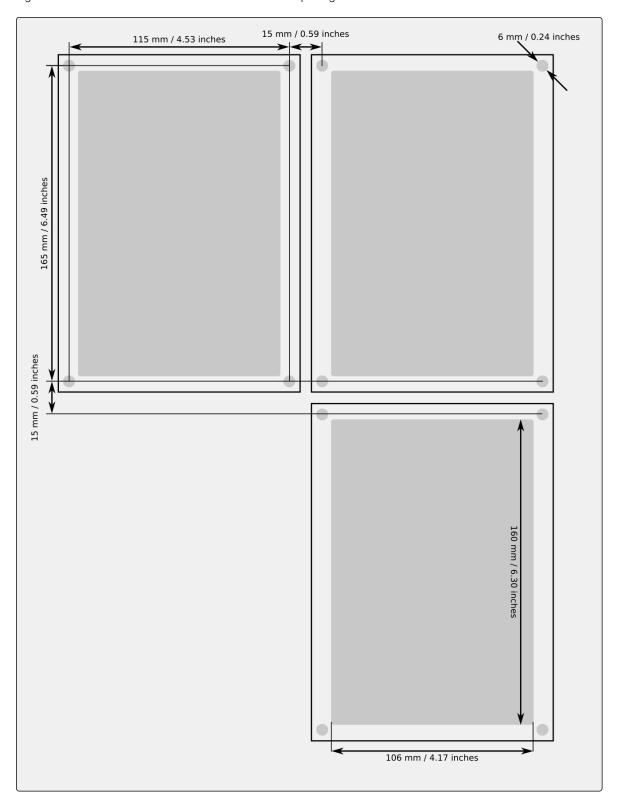


Figure. 7.6 - 268. Panel cutout dimensions and device spacing.



8 Technical data

8.1 Hardware

8.1.1 Measurements

8.1.1.1 Current measurement

Table. 8.1.1.1 - 356. Technical data for the current measurement module.

Connections		
Measurement channels/CT inputs	Three phase current inputs: IL1 (A), IL2 (B), IL3 (C) Two residual current inputs: Coarse residual current input I01, Fine residual current input I02	
Phase current inputs (A, B, C)		
Sample rate	64 samples per cycle in frequency range 675Hz	
Rated current IN	5 A (configurable 0.220 A)	
Thermal withstand	20 A (continuous) 100 A (for 10 s) 500 A (for 1 s) 1250 A (for 0.01 s)	
Frequency measurement range	From 675Hz fundamental, up to the 31 st harmonic current	
Current measurement range	25 mA250 A (RMS)	
Current measurement inaccuracy	0.0054.000 × I _N < ±0.5 % or < ±15 mA 420 × I _N < ±0.5 % 2050 × I _N < ±1.0 %	
Angle measurement inaccuracy	< ±0.2° (I> 0.1 A) < ±1.0° (I≤ 0.1 A)	
Burden (50/60 Hz)	<0.1 VA	
Transient overreach	<8 %	
Coarse residual current input (I01)		
Rated current I _N	1 A (configurable 0.110 A)	
Thermal withstand	25 A (continuous) 100 A (for 10 s) 500 A (for 1 s) 1250 A (for 0.01 s)	
Frequency measurement range	From 675 Hz fundamental, up to the 31 st harmonic current	
Current measurement range	5 mA150 A (RMS)	

	,	
Current measurement inaccuracy	$0.00210.000 \times I_N < \pm 0.5 \%$ or $< \pm 3$ mA $10150 \times I_N < \pm 0.5 \%$	
Angle measurement inaccuracy	< ±0.2° (I> 0.05 A) < ±1.0° (I≤ 0.05 A)	
Burden (50/60Hz)	<0.1 VA	
Transient overreach	<5 %	
Fine residual current input (I02)		
Rated current I _N	0.2 A (configurable 0.00110 A)	
Thermal withstand	25 A (continuous) 100 A (for 10 s) 500 A (for 1 s) 1250 A (for 0.01 s)	
Frequency measurement range	From 675 Hz fundamental, up to the 31 st harmonic current	
Current measurement range	1 mA75 A (RMS)	
Current measurement inaccuracy	0.00225.000 × I _N < ±0.5 % or < ±0.6 mA 25375 × I _N < ±1.0 %	
Angle measurement inaccuracy	< ±0.2° (I> 0.01 A) < ±1.0° (I≤ 0.01 A)	
Burden (50/60Hz)	<0.1 VA	
Transient overreach	<5 %	
Screw connection terminal block (standard)		
Terminal block	Phoenix Contact FRONT 4-H-6,35	
Nominal cross section (solid or stranded wire)	4 mm ²	
Ring lug terminal block connection (option)		
Ring terminal dimensions	Max 8mm diameter, with minimum 3,5mm screw hole	



NOTICE!

Current measurement accuracy has been verified with 50/60 Hz.

The amplitude difference is 0.2~% and the angle difference is 0.5~degrees higher at 16.67~Hz and other frequencies.

8.1.1.2 Voltage measurement

Table. 8.1.1.2 - 357. Technical data for the voltage measurement module.

Connection	
Measurement channels/VT inputs	4 independent VT inputs (U1, U2, U3 and U4)

Measurement	
Sample rate	64 samples per cycle in frequency range 675Hz
Voltage measuring range	0.50480.00 V (RMS)
Voltage measurement inaccuracy	12 V ±1.5 % 210 V ±0.5 % 10480 V ±0.35 %
Angle measurement inaccuracy	±0.2 degrees (15300 V) ±1.5 degrees (115 V)
Voltage measurement bandwidth (freq.)	775 Hz fundamental, up to the 31 st harmonic voltage
Terminal block connection	
Screw connection terminal block (standard)	Phoenix Contact PC 5/ 8-STCL1-7,62
Spring cage terminal block (optional)	Phoenix Contact SPC 5/ 8-STCL-7,82
Nominal cross section (solid or stranded wire)	6 mm ²
Input impedance	~24.5 MΩ
Burden (50/60 Hz)	<0.02 VA
Thermal withstand	630 V _{RMS} (continuous)



NOTICE!

Voltage measurement accuracy has been verified with 50/60 Hz.

The amplitude difference is $0.2\,\%$ and the angle difference is $0.5\,$ degrees higher at $16.67\,$ Hz and other frequencies.

8.1.1.3 Voltage memory

Table. 8.1.1.3 - 358. Technical data for the voltage memory function.

Measurement inputs			
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} + U ₀		
Current inputs (back-up frequency)	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)		
Pick-up			
Pick-up voltage setting Pick-up current setting (optional)	$2.0050.00~\%U_N$, setting step $0.01~x~\%U_N$ $0.0150.00~x~I_N$, setting step $0.01~x~I_N$		
Inaccuracy: - Voltage - Current	±1.5 %Uset or ±30 mV ±0.5 %Iset or ±15 mA (0.104.0 × Iset)		
Operation time			

Angle memory activation delay	<20 ms (typically 5 ms)
Maximum active time	0.02050.000 s, setting step 0.005 s
Inaccuracy: - Definite time (U _M /U _{SET} ratio >1.05)	±1.0 % or ±35 ms
Angle memory	
Angle drift while voltage is absent	±1.0° per 1 second
Reset	
Reset ratio: - Voltage memory (voltage) - Voltage memory (current)	103 % of the pick-up voltage setting 97 % of the pick-up current setting
Reset time	<50 ms



NOTICE!

Voltage memory is activated only when all line voltages fall below set pick-up value.



NOTICE!

Voltage memory activation captures healthy situation voltage angles, one cycle before actual activation (50Hz/20ms before "bolted" fault)

8.1.1.4 Power and energy measurement

Table. 8.1.1.4 - 359. Power and energy measurement accuracy

Power measurement P, Q, S	Frequency range 675 Hz
Inaccuracy	0.3 % <1.2 × I _N or 3 VA secondary 1.0 % >1.2 × I _N or 3 VA secondary
Energy measurement	Frequency range 675 Hz
Energy and power metering inaccuracy	0.5% down to 1A RMS (50/60Hz) as standard 0.2% down to 1A RMS (50/60Hz) option available (see the order code for details)

8.1.1.5 Frequency measurement

Table. 8.1.1.5 - 360. Frequency measurement accuracy.

Frequency measurement performance		
Frequency measuring range	675 Hz fundamental, up to the 31 st harmonic current or voltage	
Inaccuracy	<1 mHz	

8.1.2 CPU & Power supply

8.1.2.1 Auxiliary voltage

Table. 8.1.2.1 - 361. Power supply model A

Rated values		
Rated auxiliary voltage	80265 V (AC/DC)	
Power consumption	< 7 W (no option cards) < 15 W (maximum number of option cards)	
Maximum permitted interrupt time	< 60 ms with 110 VDC	
DC ripple	< 15 %	
Other		
Minimum recommended fuse rating	MCB C2	

Table. 8.1.2.1 - 362. Power supply model B

Rated values		
Rated auxiliary voltage	1872 VDC	
Power consumption	< 7 W (no option cards) < 15 W (maximum number of option cards)	
Maximum permitted interrupt time	< 90 ms with 24 VDC	
DC ripple	< 15 %	
Other		
Minimum recommended fuse rating	MCB C2	

8.1.2.2 CPU communication ports

Table. 8.1.2.2 - 363. Front panel local communication port.

Port		
Port media	Copper Ethernet RJ-45	
Number of ports	1	
Port protocols	PC-protocols FTP	
Features		
Data transfer rate	100 MB/s	
System integration	Can't be used for system protocols, only for local programming	

Table. 8.1.2.2 - 364. Rear panel system communication port A.

Port	
Port media	Copper Ethernet RJ-45
Number of ports	1
Features	
Port protocols	IEC 61850 (1st edition) IEC 104 Modbus/TCP DNP3 FTP
Data transfer rate	100 MB/s
System integration	Can be used for system protocols and for local programming

Table. 8.1.2.2 - 365. Rear panel system communication port B.

Port	
Port media	Copper RS-485
Number of ports	1
Features	
Port protocols	Modbus/RTU IEC 103 IEC 101 DNP3 SPA
Data transfer rate	65 580 kB/s
System integration	Can be used for system protocols

8.1.2.3 CPU digital inputs

Table. 8.1.2.3 - 366. CPU model-isolated digital inputs, with thresholds defined by order code.

Rated values	
Rated auxiliary voltage	265 V (AC/DC)
Nominal voltage	Order code defined: 24, 110, 220 V (AC/DC)
Pick-up threshold Release threshold	Order code defined: 19, 90,170 V Order code defined: 14, 65, 132 V
Scanning rate	5 ms
Settings	
Pick-up delay	Software settable: 01800 s

Polarity	Software settable: Normally On/Normally Off
Current drain	2 mA

8.1.2.4 CPU digital outputs

Table. 8.1.2.4 - 367. Digital outputs (Normally Open)

Rated values	
Rated auxiliary voltage	265 V (AC/DC)
Continuous carry	5 A
Make and carry 0.5 s Make and carry 3 s	30 A 15 A
Breaking capacity, DC (L/R = 40 ms) at 48 VDC at 110 VDC at 220 VDC	1 A 0.4 A 0.2 A
Control rate	5 ms
Settings	
Polarity	Software settable: Normally Open / Normally Closed

Table. 8.1.2.4 - 368. Digital outputs (Change-Over)

Rated values	
Rated auxiliary voltage	265 V (AC/DC)
Continuous carry	2.5 A
Make and carry 0.5 s Make and carry 3 s	30 A 15 A
Breaking capacity, DC (L/R = 40 ms) at 48 VDC at 110 VDC at 220 VDC	1 A 0.3 A 0.15 A
Control rate	5 ms
Settings	
Polarity	Software settable: Normally Open / Normally Closed



CAUTION!

Please note, that signaling relay 5 and system fault's signaling relay are designed only for signaling purposes, and are not to be used in trip coil control.

8.1.3 Option cards

8.1.3.1 Digital input module

Table. 8.1.3.1 - 369. Technical data for the digital input module.

General information		
Hardware configuration code	В	
Rated values		
Rated auxiliary voltage	5265 V (AC/DC)	
Current drain	2 mA	
Scanning rate Activation/release delay	5 ms 511 ms	
Settings		
Pick-up threshold Release threshold	Software settable: 16200 V, setting step 1 V Software settable: 10200 V, setting step 1 V	
Pick-up delay	Software settable: 01800 s	
Drop-off delay	Software settable: 01800 s	
Polarity	Software settable: Normally On/Normally Off	
Terminal block connection		
Screw connection terminal block (standard)	Phoenix Contact MSTB 2,5/10-ST-5,08	
Spring cage terminals block (option)	Phoenix Contact FKC 2,5/10-STF-5,08	
Solid or stranded wire Nominal cross section	2.5 mm ²	

8.1.3.2 Digital output module

Table. 8.1.3.2 - 370. Technical data for the digital output module.

General information	
Hardware configuration code	С
Rated values	
Rated auxiliary voltage	265 V (AC/DC)
Continuous carry	5 A
Make and carry 0.5 s Make and carry 3 s	30 A 15 A

Breaking capacity, DC (L/R = 40 ms) at 48 VDC at 110 VDC at 220 VDC	1 A 0.4 A 0.2 A	
Control rate	5 ms	
Settings		
Polarity	Software settable: Normally On/Normally Off	
Terminal block connection		
Screw connection terminal block (standard)	Phoenix Contact MSTB 2,5/10-ST-5,08	
Spring cage terminals block (option)	Phoenix Contact FKC 2,5/10-STF-5,08	
Maximum cross section (solid or stranded wire)	2.5 mm ²	

8.1.3.3 Milliampere output module (4 x mA out & 1 x mA in)

Table. 8.1.3.3 - 371. Technical data for the milliampere output module.

General information	
Hardware configuration code	I
Signals	
Output magnitudes Input magnitudes	4 × mA output signal (DC) 1 × mA input signal (DC)
mA input	
Range (hardware) Range (measurement) Inaccuracy	033 mA 024 mA ±0.1 mA
Update cycle Response time at 5 ms cycle Update cycle time inaccuracy	510 000 ms, setting step 5 ms ~ 15 ms (1318 ms) Max. +20 ms above the set cycle
mA input scaling range Output scaling range	04000 mA -1 000 000.00001 000 000.0000, setting step 0.0001
mA output	
Inaccuracy at 024 mA	±0.01 mA
Response time at 5 ms cycle [fixed]	< 5 ms
mA output scaling range Source signal scaling range	024 mA, setting step 0.001 mA -1 000 000.0001 000 000.0000, setting step 0.0001
Terminal block connection	
Screw connection terminal block (standard)	Phoenix Contact MSTB 2,5/10-ST-5,08
Spring cage terminals block (option)	Phoenix Contact FKC 2,5/10-STF-5,08

Maximum cross section (solid or stranded wire)	2.5 mm ²
--	---------------------

8.1.3.4 Point sensor arc protection module

Table. 8.1.3.4 - 372. Technical data for the point sensor arc protection module.

General information		
Hardware configuration code	D	
Connections		
Input arc point sensor channels	S1, S2, S3, S4 (pressure and light, or light only)	
Sensors per channel	3	
Maximum cable length	200 m	
Performance		
Pick-up light intensity	8, 25 or 50 kLx (the sensor is selectable in the order code)	
Point sensor detection radius	180 degrees	
Start and instant operating time (light only)	Typically <5 ms with dedicated semiconductor outputs (HSO) Typically <10 ms regular output relays	

Table. 8.1.3.4 - 373. High-Speed Outputs (HSO1...2)

Rated values	
Rated auxiliary voltage	250 VDC
Continuous carry	2 A
Make and carry 0.5 s Make and carry 3 s	15 A 6 A
Breaking capacity, DC (L/R = 40 ms)	1 A/110 W
Control rate	5 ms
Operation delay	<1 ms
Polarity	Normally Off
Contact material	Semiconductor

Table. 8.1.3.4 - 374. Binary input channel

Rated values	
Voltage withstand	265 VDC

Nominal voltage Pick-up threshold Release threshold	24 VDC ≥16 VDC ≤15 VDC
Scanning rate	5 ms
Polarity	Normally Off
Current drain	3 mA

Table. 8.1.3.4 - 375. Terminal block connections

Arc point sensor terminal block connections		
Spring cage terminal block	Phoenix Contact DFMC 1,5/6-STF-3,5	
Maximum cross section (Solid or stranded wire)	1.5 mm ²	
Binary input and HSO terminal block connections		
Screw connection terminal block (standard)	Phoenix Contact MSTB 2,5/5-ST-5,08	
Spring cage terminals block (option)	Phoenix Contact FKC 2,5/10-STF-5,08	
Maximum cross section (solid or stranded wire)	2.5 mm ²	



NOTICE!

The polarity must be correct!

8.1.3.5 RTD input module

Table. 8.1.3.5 - 376. Technical data for the RTD input module.

General information	
Hardware configuration code	F
Channels 1-8	
2/3/4-wire RTD	
Pt100 or Pt1000	
Terminal block connection	
Spring cage terminals block	Phoenix Contact DFMC 1,5/ 16-STF-3,5
Maximum cross section (solid or stranded wire)	1.5 mm ²

8.1.3.6 Double RJ-45 Ethernet & IRIG-B communication module

Table. 8.1.3.6 - 377. Technical data for the double RJ-45 Ethernet communication module.

\sim		
General	Intor	mation
Ochlera		пацоп

Hardware configuration code	G
Ethernet connector features	
Protocols	IEC 61850 IEC 104 Modbus/TCP DNP3 FTP
Data transfer rate	100 MB/s
System integration	Can be used for system protocols and for local programming
Number of ports	2
Communication ports	Copper Ethernet RJ-45
IRIG-B Connector	
Screw connection terminal block	Phoenix Contact MC 1,5/ 2-ST-3,5 BD:1-2
Maximum cross section (solid or stranded wire)	1.5 mm ²

8.1.3.7 Double ST Ethernet & IRIG-B communication module

Table. 8.1.3.7 - 378. Technical data for the double ST 100 Mbps Ethernet communication module.

General information	
Order code	Н
Protocols	
Protocols	IEC61850 DNP/TCP Modbus/TCP IEC104 FTP
ST connectors	
Connector type	Duplex ST connectors 62.5/125 μm or 50/125 μm multimode fiber 100BASE-FX
Number of connectors	2
Transmitter wavelength	12601360 nm (nominal: 1310 nm)
Receiver wavelength	11001600 nm
Maximum distance	2 km
Data transfer rate	100 MB/s
IRIG-B Connector	
Screw connection terminal block	Phoenix Contact MC 1,5/ 2-ST-3,5 BD:1-2

Maximum cross section (solid or stranded wire)	1.5 mm ²
--	---------------------

8.1.3.8 Double LC (HSR/PRP) Ethernet communication module

Table. 8.1.3.8 - 379. Technical data for the double LC 100 Mbps Ethernet communication module.

General information	
Hardware configuration code	J
Protocols	
Protocols	IEC 61850 IEC 104 Modbus/TCP DNP3 FTP
Redundancy	HSR and PRP
Data transfer rate	100 MB/s
System integration	Can be used for system protocols and for local programming
Ports	
Number of fiber ports	2
Communication port	LC fiber connector Wavelength 1300 nm
Fiber cable	50/125 μm or 62.5/125 μm multimode (glass)

8.1.3.9 Double RJ-45 (HSR/PRP) Ethernet communication module

Table. 8.1.3.9 - 380. Technical data for the double RJ-45 100 Mbps Ethernet communication module.

General information	
Hardware configuration code	К
Features	
Protocols	IEC 61850 IEC 104 Modbus/TCP DNP3 FTP
Redundancy	HSR and PRP
Data transfer rate	100 MB/s
System integration	Can be used for system protocols and for local programming
Ports	

Number of ports	2
Communication port	Copper Ethernet RJ-45

8.1.3.10 RS-232 & serial fiber communication module

Table. 8.1.3.10 - 381. Technical data for the RS-232 & serial fiber communication module.

General information		
PP Hardware configuration code	L	
PG Hardware configuration code	М	
GP Hardware configuration code	N	
GG Hardware configuration code	0	
Serial fiber connections		
Connection types	Plastic - PlasticPlastic - GlassGlass - PlasticGlass - Glass	
Wavelength	660 nm	
Cable type	1 mm plastic fiber	
RS-232 terminal block connections		
Spring cage terminals block	Phoenix Contact DFMC 1,5/ 6-STF-3,5	
Maximum cross section (solid or stranded wire)	1.5 mm ²	

8.1.4 Display

Table. 8.1.4 - 382. Technical data for the HMI LCD display.

Dimensions and resolution		
Number of dots/resolution	320 x 160	
Size	84.78 × 49.90 mm (3.34 × 1.96 in)	
Display		
Type of display	LCD	
Color	Monochrome	

8.2 Functions

8.2.1 Protection functions

8.2.1.1 Non-directional overcurrent protection (I>; 50/51)

Table. 8.2.1.1 - 383. Technical data for the non-directional overcurrent function.

Management in out	
Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input magnitudes	RMS phase currents TRMS phase currents Peak-to-peak phase currents
Pick-up	
Pick-up current setting	$0.1050.00 \times I_n$, setting step $0.01 \times I_n$
Inrush 2nd harmonic blocking	0.1050.00 %I _{fund} , setting step 0.01 %I _{fund}
Inaccuracy: - Current - 2 nd harmonic blocking	$\pm 0.5~\%$ l _{set} or $\pm 15~\text{mA}~(0.104.0 \times l_{set})$ $\pm 1.0~\%$ -unit of the 2 nd harmonic setting
Operation time	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy: - Definite time: I _m /I _{set} ratio > 3 - Definite time: I _m /I _{set} ratio = 1.053	±1.0 % or ±20 ms ±1.0 % or ±30 ms
IDMT setting parameters: - k Time dial setting for IDMT - A IDMT constant - B IDMT constant - C IDMT constant	0.0125.00, step 0.01 0250.0000, step 0.0001 0250.0000, step 0.0001 0250.0000, step 0.0001
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±20 ms ±20 ms
Retardation time (overshoot)	<30 ms
Instant operation time	
Start time and instant operation time (trip): - I _m /I _{set} ratio > 3 - I _m /I _{set} ratio = 1.053	<35 ms (typically 25 ms) <50 ms
Reset	
Reset ratio	97 % of the pick-up current setting
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±50 ms

Instant reset time and start-up reset	<50 ms
---------------------------------------	--------



NOTICE!

The release delay does **not** apply to phase-specific tripping!

8.2.1.2 Non-directional earth fault protection (I0>; 50N/51N)

Table. 8.2.1.2 - 384. Technical data for the non-directional earth fault function.

Measurement inputs	
Current input (selectable)	Residual current channel I ₀₁ (Coarse) Residual current channel I ₀₂ (Fine) Calculated residual current: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input magnitudes	RMS residual current (I ₀₁ , I ₀₂ or calculated I ₀) TRMS residual current (I ₀₁ or I ₀₂) Peak-to-peak residual current (I ₀₁ or I ₀₂)
Pick-up	
Used magnitude	Measured residual current I01 (1 A) Measured residual current I02 (0.2 A) Calculated residual current I0Calc (5 A)
Pick-up current setting	$0.000140.00 \times I_n$, setting step $0.0001 \times I_n$
Inaccuracy: - Starting I01 (1 A) - Starting I02 (0.2 A) - Starting I0Calc (5 A)	±0.5 %I0 _{set} or ±3 mA (0.00510.0 × I _{set}) ±1.5 %I0 _{set} or ±1.0 mA (0.00525.0 × I _{set}) ±1.0 %I0 _{set} or ±15 mA (0.0054.0 × I _{set})
Operating time	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy: - Definite time: I _m /I _{set} ratio > 3 - Definite time: I _m /I _{set} ratio = 1.053	±1.0 % or ±20 ms ±1.0 % or ±30 ms
IDMT setting parameters: - k Time dial setting for IDMT - A, B, C IDMT constants	0.0125.00, step 0.01 0250.0000, step 0.0001
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±20 ms ±20 ms
Retardation time (overshoot)	<30 ms
Instant operation time	
Start time and instant operation time (trip): - I _m /I _{set} ratio > 3.5 - I _m /I _{set} ratio = 1.053.5	<50 ms (typically 35 ms) <55 ms
Reset	

Reset ratio	97 % of the pick-up current setting
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±50 ms
Instant reset time and start-up reset	<50 ms

NOTICE!

The operation and reset time accuracy does <u>not</u> apply when the measured secondary current in I02 is 1...20 mA. The pick-up is tuned to be more sensitive, and the operation times vary because of this.

8.2.1.3 Directional overcurrent protection (ldir>; 67)

Table. 8.2.1.3 - 385. Technical data for the directional overcurrent function.

Input signals	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input magnitudes	RMS phase currents TRMS phase currents Peak-to-peak phase currents
Current input calculations	Positive sequence current angle
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} + U0
Voltage input calculations	Positive sequence voltage angle
Pick-up	
Characteristic direction	Directional, non-directional
Operating sector center	-180.0180.0 deg, setting step 0.1 deg
Operating sector size (+/-)	1.00170.00 deg, setting step 0.10 deg
Pick-up current setting	$0.1040.00 \times I_n$, setting step $0.01 \times I_n$
Inaccuracy: - Current - U1/I1 angle (U > 15 V) - U1/I1 angle (U = 115 V)	±0.5 %I _{set} or ±15 mA (0.104.0 × I _{set}) ±0.20° ±1.5°
Operation time	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy: - Definite time: I _m /I _{set} ratio > 3 - Definite time: I _m /I _{set} ratio = 1.053	±1.0 % or ±20 ms ±1.0 % or ±35 ms
IDMT setting parameters: - k Time dial setting for IDMT - A IDMT constant - B IDMT constant - C IDMT constant	0.0125.00, step 0.01 0250.0000, step 0.0001 0250.0000, step 0.0001 0250.0000, step 0.0001

Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±20 ms ±20 ms	
Instant operation time		
Start time and instant operation time (trip): - I _m /I _{set} ratio > 3 - I _m /I _{set} ratio = 1.053	<40 ms (typically 30 ms) <50 ms	
Reset		
Reset ratio: - Current - U1/I1 angle	97 % of the pick-up current setting 2.0°	
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±50 ms	
Instant reset time and start-up reset	<50 ms	



NOTICE!

The minimum voltage for direction solving is 1.0 V secondary. During three-phase short-circuits the angle memory is active for 0.5 seconds in case the voltage drops below 1.0 V.

8.2.1.4 Directional earth fault protection (I0dir>; 67N/32N)

Table. 8.2.1.4 - 386. Technical data for the directional earth fault function.

Measurement inputs	
Current input (selectable)	Residual current channel I ₀₁ (Coarse) Residual current channel I ₀₂ (Fine) Calculated residual current: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input magnitudes	RMS residual current (I ₀₁ , I ₀₂ or calculated I ₀) TRMS residual current (I ₀₁ or I ₀₂) Peak-to-peak residual current (I ₀₁ or I ₀₂)
Voltage input (selectable)	Residual voltage from U3 or U4 voltage channel Residual voltage calculated from U _{L1} , U _{L2} , U _{L3}
Voltage input magnitudes	RMS residual voltage U ₀ Calculated RMS residual voltage U ₀
Pick-up	
Characteristic direction	Unearthed (Varmetric 90°) Petersen coil GND (Wattmetric 180°) Earthed (Adjustable sector)
When the <i>earthed</i> mode is active: - Tripping area center - Tripping area size (+/-)	0.00360.00 deg, setting step 0.10 deg 45.00135.00 deg, setting step 0.10 deg
Pick-up current setting Pick-up voltage setting	$\begin{array}{c} 0.00540.00 \times I_{n} \text{, setting step } 0.001 \times I_{n} \\ 1.0075.00 \%\text{U0}_{n} \text{, setting step } 0.01 \%\text{U0}_{n} \end{array}$

Inaccuracy: - Starting I01 (1 A) - Starting I02 (0.2 A) - Starting I0Calc (5 A) - Voltage U0 and U0Calc - U0/I0 angle (U > 15 V) - U0/I0 angle (U = 115 V)	±0.5 %I0 _{set} or ±3 mA (0.00510.0 × I _{set}) ±1.5 %I0 _{set} or ±1.0 mA (0.00525.0 × I _{set}) ±1.5 %I0 _{set} or ±15 mA (0.0054.0 × I _{set}) ±1.0 %U0 _{set} or ±30 mV ±0.2° (I0Calc ±1.0°) ±1.0°
Operation time	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy: - Definite time (I _m /I _{set} ratio 1.05→)	±1.0 % or ±45 ms
IDMT setting parameters: - k Time dial setting for IDMT - A IDMT constant - B IDMT constant - C IDMT constant	0.0125.00, step 0.01 0250.0000, step 0.0001 0250.0000, step 0.0001 0250.0000, step 0.0001
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±25 ms ±20 ms
Instant operation time	
Start time and instant operation time (trip): - I _m /I _{set} ratio > 3 - I _m /I _{set} ratio = 1.053	<55 ms (typically 45 ms) <65 ms
Reset	
Current and voltage reset U0/I0 angle	97 % of the pick-up current and voltage setting 2.0°
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±45 ms
Instant reset time and start-up reset	<50 ms

8.2.1.5 Negative sequence overcurrent/ phase current reversal/ current unbalance protection (I2>; 46/46R/46L)

Table. 8.2.1.5 - 387. Technical data for the current unbalance function.

Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input calculations	Positive sequence current (I1) Negative sequence current (I2)
Pick-up	
Used magnitude	Negative sequence component I2pu Relative unbalance I2/I1

	,
Pick-up setting	0.0140.00 × I _n , setting step 0.01 × I _n (I2pu) 1.00200.00 %, setting step 0.01 % (I2/I1)
Minimum phase current (at least one phase above)	$0.012.00 \times I_n$, setting step $0.01 \times I_n$
Inaccuracy: - Starting I2pu - Starting I2/I1	± 1.0 %-unit or ± 100 mA $(0.104.0 \times I_n)$ ± 1.0 %-unit or ± 100 mA $(0.104.0 \times I_n)$
Operating time	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy: - Definite time (I _m /I _{set} ratio > 1.05)	±1.5 % or ±60 ms
IDMT setting parameters: - k Time dial setting for IDMT - A IDMT Constant - B IDMT Constant - C IDMT Constant	0.0125.00, step 0.01 0250.0000, step 0.0001 0250.0000, step 0.0001 0250.0000, step 0.0001
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±2.0 % or ±30 ms ±20 ms
Retardation time (overshoot)	<5 ms
Instant operation time	
Start time and instant operation time (trip): - Im/Iset ratio > 1.05	<70 ms
Reset	
Reset ratio	97 % of the pick-up setting
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.5 % or ±60 ms
Instant reset time and start-up reset	<55 ms

8.2.1.6 Harmonic overcurrent protection (Ih>; 50H/51H/68H)

Table. 8.2.1.6 - 388. Technical data for the harmonic overcurrent function.

Measurement inputs		
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C) Residual current channel I ₀₁ (Coarse) Residual current channel I ₀₂ (Fine)	
Pick-up		
Harmonic selection	2 nd , 3 rd , 4 th , 5 th , 6 th 7 th , 9 th , 11 th , 13 th , 15 th , 17 th or 19 th	
Used magnitude	Harmonic per unit (× I _N) Harmonic relative (Ih/IL)	

Pick-up setting	0.052.00 × I _N , setting step 0.01 × I _N (× I _N) 5.00200.00 %, setting step 0.01 % (Ih/IL)	
Inaccuracy: - Starting × I _N - Starting × Ih/IL	$<0.03 \times I_N (2^{nd}, 3^{rd}, 5^{th})$ $<0.03 \times I_N \text{ tolerance to Ih } (2^{nd}, 3^{rd}, 5^{th})$	
Operation time		
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s	
Inaccuracy: - Definite time (I _M /I _{SET} ratio >1.05)	±1.0 % or ±35 ms	
IDMT setting parameters: k Time dial setting for IDMT A IDMT constant B IDMT constant C IDMT constant	0.0125.00, step 0.01 0250.0000, step 0.0001 0250.0000, step 0.0001 0250.0000, step 0.0001	
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±20 ms ±20 ms	
Instant operation time		
Start time and instant operation time (trip): IM/ISET ratio >1.05	<50 ms	
Reset		
Reset ratio	95 % of the pick-up setting	
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±35 ms	
Instant reset time and start-up reset	<50 ms	

NOTICE!

Harmonics generally: The amplitude of the harmonic content $\underline{\text{must}}$ be least $0.02 \times I_N$ when the relative mode (Ih/IL) is used!



Blocking: To achieve fast activation for blocking purposes with the harmonic overcurrent stage, note that the harmonic stage may be activated by a rapid load change or fault situation. An intentional activation lasts for approximately 20 ms if a harmonic component is not present. The harmonic stage stays active if the harmonic content is above the pick-up limit.

Tripping: When using the harmonic overcurrent stage for tripping, please ensure that the operation time is set to 20 ms (DT) or longer to avoid nuisance tripping caused by the above-mentioned reasons.

8.2.1.7 Circuit breaker failure protection (CBFP; 50BF/52BF)

Table. 8.2.1.7 - 389. Technical data for the circuit breaker failure protection function.

Measurement inputs

Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C) Residual current channel I ₀₁ (Coarse) Residual current channel I ₀₂ (Fine)
Current input magnitudes	RMS phase currents RMS residual current (I ₀₁ , I ₀₂ or calculated I ₀)
Pick-up	
Monitored signals	Digital input status, digital output status, logical signals
Pick-up current setting: - IL1IL3 - I01, I02, I0Calc	$0.1040.00 \times I_N \text{, setting step } 0.01 \times I_N$ $0.00540.00 \times I_N \text{, setting step } 0.005 \times I_N$
Inaccuracy: - Starting phase current (5A) - Starting I01 (1 A) - Starting I02 (0.2 A) - Starting I0Calc (5 A)	±0.5 %I _{SET} or ±15 mA (0.104.0 × I _{SET}) ±0.5 %I _{OSET} or ±3 mA (0.00510.0 × I _{SET}) ±1.5 %I _{OSET} or ±1.0 mA (0.00525.0 × I _{SET}) ±1.0 %I _{OSET} or ±15 mA (0.0054.0 × I _{SET})
Operation time	
Definite time function operating time setting	0.0501800.000 s, setting step 0.005 s
Inaccuracy: - Current criteria (IM/ISET ratio 1.05→) - DO or DI only	±1.0 % or ±55 ms ±15 ms
Reset	
Reset ratio	97 % of the pick-up current setting
Reset time	<50 ms

8.2.1.8 Low-impedance or high-impedance restricted earth fault/ cable end differential protection (I0d>; 87N)

Table. 8.2.1.8 - 390. Technical data for the restricted earth fault/cable end differential function.

Measurement inputs		
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C) Residual current channel I ₀₁ (Coarse) Residual current channel I ₀₂ (Fine)	
Current input calculations	Calculated bias and residual differential currents	
Pick-up		
Operating modes	Restricted earth fault Cable end differential	
Characteristics	Biased differential with 3 settable sections and 2 slopes	
Pick-up current sensitivity setting Slope 1 Slope 2 Bias (Turnpoint 1 & 2)	0.0150.00 % (I _N), setting step 0.01 % 0.00150.00 %, setting step 0.01 % 0.00250.00 %, setting step 0.01 % 0.0150.00 × I _N , setting step 0.01 × I _N	

Inaccuracy - Starting	$\pm 3\%$ of the set pick-up value > 0.5 × I _N setting. ± 5 mA < 0.5 × I _N setting
Operation time	
Instant operation time 1.05 x I _{SET}	<30 ms
Reset	
Reset ratio	No hysteresis
Reset time	<40 ms

8.2.1.9 Overvoltage protection (U>; 59)

Table. 8.2.1.9 - 391. Technical data for the overvoltage function.

Measurement inputs	
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} (+ U ₀)
Voltage input magnitudes	RMS line-to-line or line-to-neutral voltages
Pick-up	
Pick-up terms	1 voltage 2 voltages 3 voltages
Pick-up setting	50.00150.00 %U _N , setting step 0.01 %U _N
Inaccuracy: - Voltage	±1.5 %U _{SET}
Operating time	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy: - Definite time (U _M /U _{SET} ratio 1.05→)	±1.0 % or ±35 ms
IDMT setting parameters: - k Time dial setting for IDMT - IDMT Multiplier	0.0160.00, step0.01 025.00, step 0.01
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±20 ms ±20 ms
Instant operation time	
Start time and instant operation time (trip): - U _M /U _{SET} ratio 1.05→	<50 ms
Reset	
Reset ratio	97 % of the pick-up voltage setting

	0.000150.000 s, step 0.005 s ±1.0 % or ±45 ms
Instant reset time and start-up reset	<50 ms

8.2.1.10 Undervoltage protection (U<; 27)

Table. 8.2.1.10 - 392. Technical data for the undervoltage function.

Measurement inputs	
Voltage inputs	U _{L1} , U _{L2} , U _{L3}
- Stage inpute	UL12, UL23, UL31 (+ U0)
Voltage input magnitudes	RMS line-to-line or line-to-neutral voltages
Pick-up	
Pick-up terms	1 voltage 2 voltages 3 voltages
Pick-up setting	0.00120.00 %U _N , setting step 0.01 %U _N
Inaccuracy: - Voltage	±1.5 %Uset or ±30 mV
Low voltage block	
Pick-up setting	0.0080.00 %U _N , setting step 0.01 %U _N
Inaccuracy: - Voltage	±1.5 %U _{SET} or ±30 mV
Operation time	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Definite time function operating time setting Inaccuracy: - Definite time (U _M /U _{SET} ratio 1.05→)	0.0001800.000 s, setting step 0.005 s ±1.0 % or ±35 ms
Inaccuracy:	
Inaccuracy: - Definite time (U _M /U _{SET} ratio 1.05→) IDMT setting parameters: - k Time dial setting for IDMT	±1.0 % or ±35 ms 0.0160.00, step 0.01
Inaccuracy: - Definite time (U _M /U _{SET} ratio 1.05→) IDMT setting parameters: - k Time dial setting for IDMT - IDMT Multiplier Inaccuracy: - IDMT operating time	±1.0 % or ±35 ms 0.0160.00, step 0.01 025.00, step 0.01 ±1.5 % or ±20 ms
Inaccuracy: - Definite time (U _M /U _{SET} ratio 1.05→) IDMT setting parameters: - k Time dial setting for IDMT - IDMT Multiplier Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.0 % or ±35 ms 0.0160.00, step 0.01 025.00, step 0.01 ±1.5 % or ±20 ms
Inaccuracy: - Definite time (UM/USET ratio 1.05→) IDMT setting parameters: - k Time dial setting for IDMT - IDMT Multiplier Inaccuracy: - IDMT operating time - IDMT minimum operating time Instant operation time Start time and instant operation time (trip):	±1.0 % or ±35 ms 0.0160.00, step 0.01 025.00, step 0.01 ±1.5 % or ±20 ms ±20 ms
Inaccuracy: - Definite time (U _M /U _{SET} ratio 1.05→) IDMT setting parameters: - k Time dial setting for IDMT - IDMT Multiplier Inaccuracy: - IDMT operating time - IDMT minimum operating time Instant operation time Start time and instant operation time (trip): - U _M /U _{SET} ratio 1.05→	±1.0 % or ±35 ms 0.0160.00, step 0.01 025.00, step 0.01 ±1.5 % or ±20 ms ±20 ms <65 ms

Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±45 ms
Instant reset time and start-up reset	<50 ms

i

NOTICE!

The low-voltage block is not in use when its pick-up setting is set to 0 %. The undervoltage function trip signal is active when the LV block is disabled, and the device has no voltage injection.



NOTICE!

After the low voltage blocking condition, the undervoltage stage does not trip unless the voltage exceeds the pick-up setting first.

8.2.1.11 Neutral overvoltage protection (U0>; 59N)

Table. 8.2.1.11 - 393. Technical data for the neutral overvoltage function.

Measurement inputs		
Voltage input (selectable)	Residual voltage from U3 or U4 voltage channel Residual voltage calculated from U _{L1} , U _{L2} , U _{L3}	
Voltage input magnitudes	RMS residual voltage U ₀ Calculated RMS residual voltage U ₀	
Pick-up		
Pick-up voltage setting	1.0050.00 % U0 _N , setting step 0.01 × I _N	
Inaccuracy: - Voltage U0 - Voltage U0Calc	±1.5 %U0 _{SET} or ±30 mV ±150 mV	
Operation time		
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s	
Inaccuracy: - Definite time (U0 _M /U0 _{SET} ratio 1.05→)	±1.0 % or ±45 ms	
IDMT setting parameters: - k Time dial setting for IDMT - IDMT Multiplier	0.0160.00, step 0.01 025.00, step 0.01	
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±20 ms ±20 ms	
Instant operation time		
Start time and instant operation time (trip): - U0 _M /U0 _{SET} ratio 1.05→	<50 ms	
Reset		
Reset ratio	97 % of the pick-up voltage setting	

Reset time setting Inaccuracy: Reset time	0.000 150.000 s, step 0.005 s ±1.0 % or ±50 ms
Instant reset time and start-up reset	<50 ms

8.2.1.12 Sequence voltage protection (U1/U2>/<; 47/27P/59NP)

Table. 8.2.1.12 - 394. Technical data for the sequence voltage function.

Measurement inputs	
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} (+ U ₀)
Voltage input calculations	Positive sequence voltage (I1) Negative sequence voltage (I2)
Pick-up	
Pick-up setting	5.00150.00 %U _N , setting step 0.01 %U _N
Inaccuracy: - Voltage	±1.5 %UseT or ±30 mV
Low voltage block	
Pick-up setting	1.0080.00 %U _N , setting step 0.01 %U _N
Inaccuracy: -Voltage	±1.5 %U _{SET} or ±30 mV
Operation time	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy -Definite Time (U _M /U _{SET} ratio 1.05→)	±1.0 % or ±35 ms
IDMT setting parameters: - k Time dial setting for IDMT - IDMT Multiplier	0.0160.00, step 0.01 025.00, step 0.01
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±20 ms ±20 ms
Instant operation time	
Start time and instant operation time (trip): - U _M /U _{SET} ratio <0.95/1.05→	<65 ms
Reset	
Reset ratio	97 or 103 % of the pick-up voltage setting
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±35 ms
Instant reset time and start-up reset	<50 ms

8.2.1.13 Overfrequency and underfrequency protection (f>/<; 81O/81U)

Table. 8.2.1.13 - 395. Technical data for the overfrequency and underfrequency function.

Input signals		
Sampling mode	Fixed Tracking	
Frequency reference 1 Frequency reference 2 Frequency reference 3	CT1IL1, CT2IL1, VT1U1, VT2U1 CT1IL2, CT2IL2, VT1U2, VT2U2 CT1IL3, CT2IL3, VT1U3, VT2U3	
Pick-up		
f> pick-up setting f< pick-up setting	10.0070.00 Hz, setting step 0.01 Hz 7.0065.00 Hz, setting step 0.01 Hz	
Inaccuracy (sampling mode): - Fixed - Tracking	±20 mHz (50/60 Hz fixed frequency) ±20 mHz (U > 30 V secondary) ±20 mHz (I > 30 % of rated secondary)	
Operation time		
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s	
Inaccuracy: - Definite time (I _M /I _{SET} ratio +/- 50 mHz)	±1.5 % or ±50 ms (max. step size: 100 mHz)	
Instant operation time		
Start time and instant operation time (trip): - IM/ISET ratio +/- 50 mHz (Fixed) - IM/ISET ratio +/- 50 mHz (Tracking)	<70 ms (max. step size: 100 mHz) <3 cycles or <60 ms (max. step size: 100 mHz)	
Reset		
Reset ratio	0.020 Hz	
Instant reset time and start-up reset: - I _M /I _{SET} ratio +/- 50 mHz (Fixed) - I _M /I _{SET} ratio +/- 50 mHz (Tracking)	<110 ms (max. step size: 100 mHz) <3 cycles or <70 ms (max. step size: 100 mHz)	



NOTICE!

Measuring frequency requires that the secondary voltage exceeds 2 volts, or the current exceeds 0.25 amperes (peak-to peak).



NOTICE!

The frequency is measured two seconds after a signal is received.

8.2.1.14 Rate-of-change of frequency protection (df/dt>/<; 81R)

Table. 8.2.1.14 - 396. Technical data of the rate-of-change of frequency function.

In	pu		Or	20	
	4141	- 5	LVII		ы

	,	
Sampling mode	Fixed Tracking	
Frequency reference 1 Frequency reference 2 Frequency reference 3	CT1IL1, CT2IL1, VT1U1, VT2U1 CT1IL2, CT2IL2, VT1U2, VT2U2 CT1IL3, CT2IL3, VT1U3, VT2U3	
Pick-up		
Df/dt>/< pick-up setting	0.151.00 Hz/s, setting step 0.01 Hz	
f> limit	10.0070.00 Hz, setting step 0.01 Hz	
f< limit	7.0065.00 Hz, setting step 0.01 Hz	
Pick-up inaccuracy		
Df/dt	±5.0 %lset or ±20 mHz/s	
Frequency	±15 mHz (U > 30 V secondary) ±20 mHz (I > 30 % of rated secondary)	
Operation time		
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s	
Inaccuracy: - Definite time (I _M /I _{SET} ratio +/- 50 mHz)	±1.5 % or ±110 ms (max. step size: 100 mHz)	
Start time and instant operation time (trip):		
f _M /f _{SET} ratio +/- 20 mHz (overreach)	<180 ms	
f _M /f _{SET} ratio +/- 200 mHz (overreach)	<90 ms	
Reset		
Reset ratio (frequency limit)	0.020 Hz	
Instant reset time and start-up reset - f _M /f _{SET} ratio +/- 50 mHz	<2 cycles or <60 ms (max. step size: 100 mHz)	



NOTICE!

The frequency is measured two seconds after a signal is received.

8.2.1.15 Power protection (P, Q, S>/<; 32)

Table. 8.2.1.15 - 397. Technical data for the power protection function.

Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} (+ U ₀)
Calculated measurements	Three-phase active, reactive or apparent power (P, Q or S) value based on the chosen or set nominal amplitude.

Pick-up		
Comparator selection	> or <	
> or <	-500.000500.000 %/MVA _N , setting step 0.005 %/MVA _N	
Inaccuracy: - Active, reactive, or apparent power	Typically <1.0 %P _{SET}	
Operation time		
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s	
Inaccuracy: - Definite time (P _M /P _{SET} ratio 1.05→)	±1.0 % or ±35 ms	
Instant operation time		
Start time and instant operation time (trip): - PQS _M /PQS _{SET} ratio 1.05→	<40 ms	
Reset		
Reset ratio	97 or 103 %P _{SET}	
Instant reset time and start-up reset	<40 ms	

8.2.1.16 Machine thermal overload protection (TM>; 49M)

Table. 8.2.1.16 - 398. Technical data for the machine thermal overload protection function.

Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input magnitudes	TRMS phase currents (up to the 31 st harmonic)
Pick-up (Heating)	
NPS bias factor (unbalance effect) Pick-up current setting Thermal alarm and trip level setting range Motor service factor	0.110.0, setting step $0.10.1040.00 \times I_N, setting step 0.01 \times I_N0.0150.0$ %, setting step 0.1 % $0.015.00 \times I_N$, setting step $0.01 \times I_N$
Cold condition: - Long heat T const (cold) - Short heat T const (cold)	0.0500.0 min, setting step 0.1 min 0.0500.0 min, setting step 0.1 min
Hot condition: - Long heat T const (hot) - Short heat T const (hot) - Hot condition theta limit (Cold → Hot spot)	0.0500.0 min, setting step 0.1 min 0.0500.0 min, setting step 0.1 min 0.00100.00 %, setting step 0.01 %
Reset (Cooling)	

Reset ratio (pick-up and alarms)	99 %
Stop condition: - Long cool T const (stop) - Short cool T const (stop) - Short cool T in use time	0.0500.0 min, setting step 0.1 min 0.0500.0 min, setting step 0.1 min 0.03000.0 min, setting step 0.1 min
Run condition: - Long cool T const (stop)	0.0500.0 min, setting step 0.1 min
Operation time	
Definite time function operating time setting	0.03600.0 s, setting step 0.1 s
Inaccuracy: - Pick-up and reset	±1.0 % or ±500 ms
Environmental settings	
Thermal replica temperature estimates	Selectable between °C and °F
Ambient temperature effect k min. and max. range Ambient temperature min. and max. range	Linear or manually set curve 0.015.00 × I _N , setting step 0.01 × I _N –60500 deg, setting step 1 deg
Thermal model biasing (ambient): - Set ambient temperature - RTD	-60500 deg, setting step 1 deg Used measured ambient value

8.2.1.17 Underimpedance protection (Z<; 21U)

Table. 8.2.1.17 - 399. Technical data for the underimpedance function.

Measurement inputs		
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)	
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} + U ₀	
Calculated impedances	Phase-to-phase impedances Phase-to-ground impedances Positive sequence impedance	
Pick-up		
Pick-up setting	$0.1150.0~\Omega$, setting step $0.1~\Omega$	
Inaccuracy: - Impedance calculation	Typically <1.0 %Z _{SET}	
Operation time		
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s	
Inaccuracy: - Definite time (Z _M /Z _{SET} ratio <0.95)	±1.0 % or ±25 ms	
Instant operation time		

Start time and instant operation time (trip): - Z _M /Z _{SET} ratio <0.95	<45 ms
Reset	
Reset ratio	103 %Zset
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±25 ms
Instant reset time and start-up reset	<45 ms

8.2.1.18 Voltage-restrained overcurrent protection (Iv>; 51V)

Table. 8.2.1.18 - 400. Technical data for the voltage-restrained overcurrent protection function.

Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)
Current input magnitudes	RMS phase currents
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} + U ₀
Voltage input calculation	Positive sequence voltage
Pick-up	
Pick-up current setting (point 1 & 2)	$0.1040.00 \times I_N$, setting step $0.01 \times I_N$
Pick-up voltage setting (point 1 & 2)	0.05150.00 %U _N , setting step 0.01 %U _N
Inaccuracy: - Current - Voltage	±0.5 %IseT or ±15 mA (0.104.0 × IseT) ±1.5 %UseT or ±30 mV
Operation time	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy: - Definite time (I _M /I _{SET} ratio 1.05→)	±1.0 % or ±25 ms
IDMT setting parameters: k Time dial setting for IDMT A IDMT constant B IDMT constant C IDMT constant	0.0125.00, step 0.01 0250.0000, step 0.0001 0250.0000, step 0.0001 0250.0000, step 0.0001
Inaccuracy: - IDMT operating time - IDMT minimum operating time	±1.5 % or ±20 ms ±20 ms
Instant operation time	
Start time and instant operation time (trip): - I _M /I _{SET} ratio 1.05→	<40 ms
Reset	

Reset ratio: - Current	97 % of the pick-up current setting
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±25 ms
Instant reset time and start-up reset	<45 ms

8.2.1.19 100 % stator earth fault protection (U03rd>; 64S)

Table. 8.2.1.19 - 401. Technical data for the 100 % stator earth fault protection function.

Measurement updates			
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)		
Current input calculation	Positive sequence current (I1)		
Voltage inputs	Residual voltage from U3 or U4 voltage channel		
Voltage input magnitude	Zero sequence voltage third harmonic		
Pick-up			
Pick-up voltage setting	1.0095.00 %U0 _N , setting step 0.01 %U0 _N		
Inaccuracy: - U0 3rd harmonic	±1.0 %U0 _{SET} or ±50 mV		
Low-current blocking			
"No load" current setting	$0.001.00 \times I_N$, setting step $0.01 \times I_N$		
Inaccuracy: - Starting (I1)	± 1.0 %I1SET or ± 100 mA $(0.104.0 \times I_N)$		
Operation time			
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s		
Inaccuracy: - Definite time (I _M /I _{SET} ratio 0.95)	±1.0 % or ±30 ms		
Instant operation time			
Start time and instant operation time (trip): - U _M /U _{SET} ratio <0.95	<60 ms		
Reset			
Reset ratio	103 % of the pick-up voltage setting		
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±30 ms		
Instant reset time and start-up reset <45 ms			



NOTICE!

"No load" current setting: The "No load" current setting value of $0.00 \times I_N$ is only for commissioning purpose. When using the device under normal conditions always use the value $0.01 \times I_N$ or greater.

8.2.1.20 Power factor protection (PF<; 55)

Table. 8.2.1.20 - 402. Technical data for the power factor protection function.

Measurement inputs			
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)		
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} (+ U ₀)		
Calculated measurement	Three-phase power factor		
Pick-up			
Pick-up setting	0.000.99, setting step 0.01		
Inaccuracy: - power factor (when U > 1.0 V and I > 0.1 A)	±0.001		
Operation time			
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s		
Inaccuracy: - Definite time (at least 0.01 below the setting)	±1.0 % or ±30 ms		
Instant operation time			
Start time and instant operation time (trip): - at least 0.01 below the setting	<50 ms		
Reset			
Reset ratio	1.03 of the power factor setting		
Reset time	<50 ms		



NOTICE!

The minimum voltage for the power factor calculation is $1.0\ V$ secondary and the minimum current is $0.1\ A$ secondary.

8.2.1.21 Volts-per-hertz overexcitation protection (V/Hz>; 24)

Table. 8.2.1.21 - 403. Technical data for the volts-per-hertz overexcitation protection function.

Measurement inputs		
Voltage input	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31}	

Voltage input magnitude Maximum line-to-line voltage		
Frequency reference 1 Frequency reference 2 Frequency reference 3	CT1IL1, CT2IL1, VT1U1, VT2U1 CT1IL2, CT2IL2, VT1U2, VT2U2 CT1IL3, CT2IL3, VT1U3, VT2U3	
Pick-up		
Pick-up setting 0.0175.00 %, setting step 0.01 %		
Inaccuracy: - V/Hz ±1.0 %		
Operation time		
Definite time function operating time setting 0.0001800.000 s, setting step 0.005		
Inaccuracy: - Definite time (VHZ _M /VHZ _{SET} ratio 1.05)	±1.0 % or ±25 ms	
Instant operation time		
Start time and instant operation time (trip): - VHZ _M /VHZ _{SET} ratio 1.05)	<40 ms	
Reset		
Reset ratio	97 % of the pick-up setting	
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±25 ms	
Instant reset time and start-up reset	<40 ms	

8.2.1.22 Underexcitation protection (Q<; 40)

Table. 8.2.1.22 - 404. Technical data for the underexcitation protection function.

Measurement inputs			
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C)		
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} + U ₀		
Calclucated measurements	Three-phase reactive power		
Pick-up			
Pick-up setting	-1 000 000.000.00 kVar, setting step 0.01 kVar		
Inaccuracy: - Reactive power	Typically <1.0 %Qset		
Operation time			
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s		
Inaccuracy: - Definite time (Q _M /Q _{SET} ratio 1.05→)	±1.0 % or ±35 ms		

Instant operation time		
Start time and instant operation time (trip): - Q _M /Q _{SET} ratio <0.95	<50 ms	
Reset		
Reset ratio	97 % of the set pick-up value	
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±1.0 % or ±35 ms	
Instant reset time and start-up reset	<50 ms	



NOTICE!

Voltage measurement starts from $0.5~\rm V$ and current measurement from $50~\rm mA$. If either or both are missing the reactive power measurement is $0~\rm kVar$.

8.2.1.23 Resistance temperature detectors (RTD)

Table. 8.2.1.23 - 405. Technical data of the resistance temperature detectors.

Inputs			
Resistance input magnitudes	Measured temperatures measured by RTD sensors		
RTD channels	12 individual RTD channels		
Settable alarms	24 alarms available (two per each RTD channel)		
Pick-up			
Alarm setting range Inaccuracy Reset ratio	101.002000.00 deg, setting step 0.1 deg (either < or > setting) ±3 % of the set pick-up value 97 % of the pick-up setting		
Operation			
Operating time	Typically <500 ms		

8.2.1.24 Arc fault protection (IArc>/I0Arc>; 50Arc/50NArc) (optional)

Table. 8.2.1.24 - 406. Technical data for the arc fault protection function.

Measurement inputs			
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C) Residual current channel I ₀₁ (Coarse) Residual current channel I ₀₂ (Fine)		
Current input magnitudes	Sample-based phase current measurement Sample-based residual current measurement		
Arc point sensor inputs	Channels S1, S2, S3, S4 (pressure and light sensor, or light-only sensor) Up to three (3) sensors per channel		

System frequency operating range	6.0075.00 Hz		
Pick-up			
Pick-up current setting (phase current) Pick-up current setting (residual current) Pick-up light intensity	$\begin{array}{l} 0.0540.00 \times I_N \text{, setting step } 0.01 \times I_N \\ 0.0540.00 \times I_N \text{, setting step } 0.01 \times I_N \\ 8, 25 \text{ or } 50 \text{ kLx (the sensor is selected in the order code)} \end{array}$		
Starting inaccuracy (IArc> and I0Arc>)	± 3 % of the set pick-up value > 0.5 × IN setting. 5 mA < 0.5 × IN setting.		
Point sensor detection radius	180 degrees		
Operation time			
Light only: - Semiconductor outputs HSO1 and HSO2 - Regular relay outputs	Typically 7 ms (312 ms) Typically 10 ms (6.515 ms)		
Light + current criteria (zone 14): - Semiconductor outputs HSO1 and HSO2 - Regular relay outputs	Typically 10 ms (6.514 ms) Typically 14 ms (1018 ms)		
Arc BI only: - Semiconductor outputs HSO1 and HSO2 - Regular relay outputs	Typically 7 ms (212 ms) Typically 10 ms (6.515 ms)		

8.2.2 Control functions

8.2.2.1 Setting group selection

Table. 8.2.2.1 - 407. Technical data for the setting group selection function.

Settings and control modes			
Setting groups	8 independent, control-prioritized setting groups		
Control scale	Common for all installed functions which support setting groups		
Control mode			
Local	Any binary signal available in the device		
Remote	Force change overrule of local controls either from the setting tool, HMI or SCADA		
Operation time			
Reaction time	<5 ms from receiving the control signal		

8.2.2.2 Object control and monitoring

Table. 8.2.2.2 - 408. Technical data for the object control and monitoring function.

G	\mathbf{a}	T)	\sim	~~
v	U		v	а

Number of objects	5
Supported object types	Circuit breaker Circuit breaker with withdrawable cart Disconnector (MC) Disconnector (GND)
Signals	
Input signals	Digital inputs Software signals
Output signals	Close command output Open command output
Operation time	
Breaker traverse time setting	0.02500.00 s, setting step 0.02 s
Max. close/open command pulse length	0.02500.00 s, setting step 0.02 s
Control termination time out setting	0.02500.00 s, setting step 0.02 s
Inaccuracy: - Definite time operating time	±0.5 % or ±10 ms
Breaker control operation time	
External object control time	<75 ms
Object control during auto-reclosing	See the technical sheet for the auto-reclosing function.

8.2.2.3 Indicator object monitoring

Table. 8.2.2.3 - 409. Technical data for the indicator object monitoring function.

General	
Number of objects	5
Supported object types	Disconnector (GND)
Signals	
Input signals	Digital inputs Software signals

8.2.2.4 Vector jump ($\Delta \varphi$; 78)

Table. 8.2.2.4 - 410. Technical data for the vector jump protection function.

Measurement inputs	
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31} + U ₀

Monitored voltages	Any or all system line-to-line voltage(s) Any or all system line-to-neutral voltage(s) Specifically chosen line-to-line or line-to-neutral voltage U4 channel voltage
Pick-up	
Pick-up setting	0.0530.00°, setting step 0.01°
Inaccuracy: - Voltage angle	±30% overreach or 1.00 °
Low-voltage blocking	
Pick-up setting	0.01100.00 %U _N , setting step 0.01 %U _N
Inaccuracy: - Voltage	±1.5 %U _{SET} or ±30 mV
Instant operation time	
Alarm and trip operation time: - (Im/Iset ratio > ±30% overreach or 1.00 °)	<40 ms (typically 30 ms) 50/60 Hz <50 ms (typically 40 ms) 16.67 Hz
Reset	
Trip pulse	~5-10ms

8.2.2.5 Synchrocheck ($\Delta V/\Delta a/\Delta f$; 25)

Table. 8.2.2.5 - 411. Technical data for the synchrocheck function.

Input signals		
Voltage inputs	U1, U2, U3 or U4 voltage channel	
Voltage input magnitudes	RMS line-to-line or line-to-neutral voltages U3 or U4 voltage channel RMS	
Pick-up		
U diff < setting	2.0050.00 %U _N , setting step 0.01 %U _N	
Angle diff < setting	3.090.0 deg, setting step 0.10 deg	
Freq diff < setting	0.050.50 Hz, setting step 0.01 Hz	
Inaccuracy: - Voltage - Frequency - Angle	±3.0 %U _{SET} or ±0.3 %U _N ±25 mHz (U> 30 V secondary) ±1.5° (U> 30 V secondary)	
Reset		
Reset ratio: - Voltage - Frequency - Angle	99 % of the pick-up voltage setting 20 mHz ±2.0°	

Activation time		
Activation (to LD/DL/DD) Activation (to Live Live)	<35 ms <60 ms	
Reset	<40 ms	
Bypass modes		
Voltage check mode (excluding LL)	LL+LD, LL+DL, LL+DD, LL+LD+DL, LL+LD+DD, LL+DL+DD, bypass	
U live > limit U dead < limit	0.10100.00 %U _N , setting step 0.01 %U _N 0.00100.00 %U _N , setting step 0.01 %U _N	



NOTICE!

The minimum voltage for direction and frequency solving is 20.0 $\% U_{N}.$

8.2.3 Monitoring functions

8.2.3.1 Current transformer supervision

Table. 8.2.3.1 - 412. Technical data for the current transformer supervision function.

Measurement inputs	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C) Residual current channel I ₀₁ (Coarse) (optional) Residual current channel I ₀₂ (Fine) (optional)
Current input magnitudes	RMS phase currents RMS residual current (I ₀₁ , I ₀₂) (optional)
Pick-up	
Pick-up current settings: - ISET high limit - ISET low limit - ISUM difference - ISET ratio - I2/I1 ratio	$\begin{array}{c} 0.1040.00 \times I_{N}, \ setting \ step \ 0.01 \times I_{N} \\ 0.1040.00 \times I_{N}, \ setting \ step \ 0.01 \times I_{N} \\ 0.1040.00 \times I_{N}, \ setting \ step \ 0.01 \times I_{N} \\ 0.01100.00 \ \%, \ setting \ step \ 0.01 \ \% \\ 0.01100.00 \ \%, \ setting \ step \ 0.01 \ \% \\ \end{array}$
Inaccuracy: - Starting IL1, IL2, IL3 - Starting I2/I1 - Starting I01 (1 A) - Starting I02 (0.2 A)	±0.5 %I _{SET} or ±15 mA (0.104.0 × I _{SET}) ±1.0 %I ₂ SET / I1 _{SET} or ±100 mA (0.104.0 × I _N) ±0.5 %I ₀ SET or ±3 mA (0.00510.0 × I _{SET}) ±1.5 %I ₀ SET or ±1.0 mA (0.00525.0 × I _{SET})
Time delay for alarm	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy Definite time (I _M /I _{SET} ratio > 1.05)	±2.0 % or ±80 ms
Instant operation time (alarm): - I _M /I _{SET} ratio > 1.05	<80 ms

Reset	
Reset ratio	97/103 % of the pick-up current setting
Instant reset time and start-up reset	<80 ms

8.2.3.2 Voltage transformer supervision (60)

Table. 8.2.3.2 - 413. Technical data for the voltage transformer supervision function.

Measurement inputs	
Voltage inputs	U _{L1} , U _{L2} , U _{L3} U _{L12} , U _{L23} , U _{L31}
Voltage input magnitudes	RMS line-to-line or line-to-neutral voltages
Pick-up	
Pick-up settings: - Voltage (low pick-up) - Voltage (high pick-up) - Angle shift limit	$0.050.50 \times U_N$, setting step $0.01 \times U_N$ $0.501.10 \times U_N$, setting step $0.01 \times U_N$ 2.0090.00 deg, setting step 0.10 deg
Inaccuracy: - Voltage - U angle (U> 1 V)	±1.5 %U _{SET} ±1.5°
External line/bus side pick-up (optional)	0 → 1
Time delay for alarm	
Definite time function operating time setting	0.0001800.000 s, setting step 0.005 s
Inaccuracy: - Definite time (U _M /U _{SET} ratio > 1.05/0.95)	±1.0 % or ±35 ms
Instant operation time (alarm): - U _M /U _{SET} ratio > 1.05/0.95	<80 ms
VTS MCB trip bus/line (external input)	<50 ms
Reset	
Reset ratio	97/103 % of the pick-up voltage setting
Reset time setting Inaccuracy: Reset time	0.000150.000 s, step 0.005 s ±2.0 % or ±80 ms
Instant reset time and start-up reset	<50 ms
VTS MCB trip bus/line (external input)	<50 ms



NOTICE!

When turning on the auxiliary power of a device, the normal condition of a stage has to be fulfilled before tripping.

8.2.3.3 Circuit breaker wear monitoring

Table. 8.2.3.3 - 414. Technical data for the circuit breaker wear monitoring function.

Pick-up	
Breaker characteristics settings: - Nominal breaking current - Maximum breaking current - Operations with nominal current - Operations with maximum breaking current	0.00100.00 kA, setting step 0.001 kA 0.00100.00 kA, setting step 0.001 kA 0200 000 operations, setting step 1 operation 0200 000 operations, setting step 1 operation
Pick-up setting for Alarm 1 and Alarm 2	0200 000 operations, setting step 1 operation
Inaccuracy	
Inaccuracy for current/operations counter: - Current measurement element - Operation counter	0.1× I_N > I < 2 × I_N ±0.2 % of the measured current, rest 0.5 % ±0.5 % of operations deducted

8.2.3.4 Current total harmonic distortion

Table. 8.2.3.4 - 415. Technical data for the total harmonic distortion function.

Input signals	
Current inputs	Phase current inputs: I _{L1} (A), I _{L2} (B), I _{L3} (C) Residual current channel I ₀₁ (Coarse) Residual current channel I ₀₂ (Fine)
Current input magnitudes	Current measurement channels (FFT result) up to the 31 st harmonic component.
Pick-up	
Operating modes	Power THD Amplitude THD
Pick-up setting for all comparators	0.10200.00 % , setting step 0.01 %
Inaccuracy	± 3 % of the set pick-up value > 0.5 × IN setting; 5 mA < 0.5 × IN setting.
Time delay	
Definite time function operating time setting for all timers	0.0001800.000 s, setting step 0.005 s
Inaccuracy: - Definite time operating time - Instant operating time, when I _M /I _{SET} ratio > 3 - Instant operating time, when I _M /I _{SET} ratio 1.05 < I _M /I _{SET} < 3	±0.5 % or ±10 ms Typically <20ms Typically <25 ms
Reset	
Reset time	Typically <10 ms

Reset ratio	97 %

8.2.3.5 Event logger

Table. 8.2.3.5 - 416. Technical data for the event logger function.

General information	
Event history capacity	15 000 events
Event timestamp resolution	1 ms

8.2.3.6 Disturbance recorder

Table. 8.2.3.6 - 417. Technical data for the disturbance recorder function.

Recorded values		
Recorder analog channels	020 channels Freely selectable	
Recorder digital channels	096 channels Freely selectable analog and binary signals 5 ms sample rate (FFT)	
Performance		
Sample rate	8, 16, 32 or 64 samples/cycle	
Recording length	0.0001800.000 s, setting step 0.001 s The maximum length is determined by the chosen signals.	
Number of recordings	0100, 60 MB of shared flash memory reserved The maximum number of recordings according to the chosen signals and operation time setting combined	

8.3 Tests and environmental

Electrical environment compatibility

Table. 8.3 - 418. Disturbance tests.

All tests CE-approved and tested according to EN 60255-26		
Emissions		
Conducted emissions: EN 60255-26 Ch. 5.2, CISPR 22	150 kHz30 MHz	
Radiated emissions: EN 60255-26 Ch. 5.1, CISPR 11	301 000 MHz	
Immunity		

Electrostatic discharge (ESD): EN 60255-26, IEC 61000-4-2	Air discharge 15 kV Contact discharge 8 kV
Electrical fast transients (EFT): EN 60255-26, IEC 61000-4-4	Power supply input 4 kV, 5/50 ns, 5 kHz Other inputs and outputs 4 kV, 5/50 ns, 5 kHz
Surge: EN 60255-26, IEC 61000-4-5	Between wires 2 kV, 1.2/50 μs Between wire and earth 4 kV, 1.2/50 μs
Radiated RF electromagnetic field: EN 60255-26, IEC 61000-4-3	f = 801 000 MHz, 10 V/m
Conducted RF field: EN 60255-26, IEC 61000-4-6	f = 150 kHz80 MHz, 10 V (RMS)

Table. 8.3 - 419. Voltage tests.

Dielectric voltage test		
EN 60255-27, IEC 60255-5, EN 60255-1 2 kV (AC), 50 Hz, 1 min		
Impulse voltage test		
EN 60255-27, IEC 60255-5	5 kV, 1.2/50 μs, 0.5 J	

Physical environment compatibility

Table. 8.3 - 420. Mechanical tests.

Vibration test		
EN 60255-1, EN 60255-27, IEC 60255-21-1 Class 1	213.2 Hz, ± 3.5 mm 13.2100 Hz, ± 1.0 g	
Shock and bump test		
EN 60255-1,EN 60255-27, IEC 60255-21-2 Class 1	20 g, 1 000 bumps/direction.	

Table. 8.3 - 421. Environmental tests.

Damp heat (cyclic)		
EN 60255-1, IEC 60068-2-30 Operational: +25+55 °C, 9397 % (RH), 12+12h		
Dry heat		
EN 60255-1, IEC 60068-2-2	Storage: +70 °C, 16 h Operational: +55 °C, 16 h	
Cold test		
EN 60255-1, IEC 60068-2-1	Storage: –40 °C, 16 h Operational: –20 °C, 16 h	

Table. 8.3 - 422. Environmental conditions.

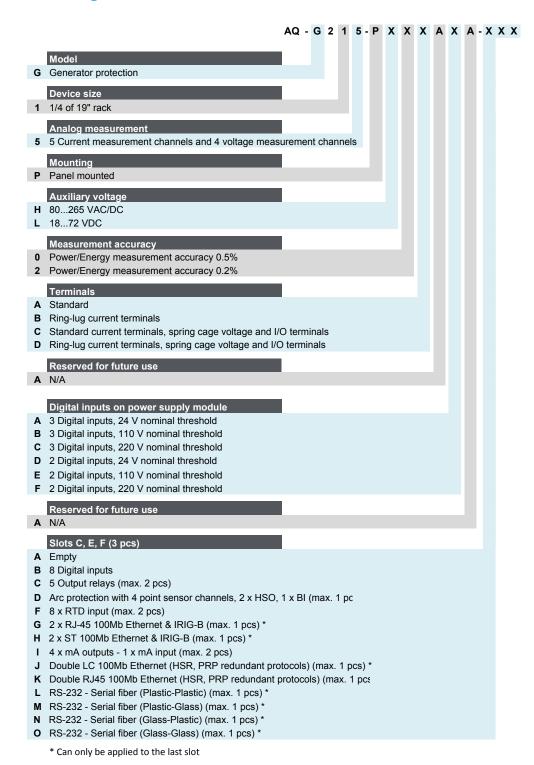
IP classes		
Casing protection class	IP54 (front) IP21 (rear)	
Temperature ranges		
Ambient service temperature range	–35+70 °C	
Transport and storage temperature range	-40+70 °C	
Other		
Altitude	<2000 m	
Overvoltage category	III	
Pollution degree	2	

Casing and package

Table. 8.3 - 423. Dimensions and weight.

Without packaging (net)		
Dimensions	Height: 117 mm (4U) Width: 127 mm (¼ rack) Depth: 174 mm (no cards & connectors)	
Weight	Appr. 1.75 kg	
With packaging (gross)		
Dimensions	Height: 170 mm Width: 242 mm Depth: 219 mm	
Weight	Appr. 2.25 kg	

9 Ordering information



Accessories

Order code	Description	Note
code		

AX007	External 6-channel 2 or 3 wires RTD Input module, preconfigured	Requires an external 24 VDC supply.
AX008	External 8-ch Thermocouple mA Input module, pre- configured	Requires an external 24 VDC supply.
AQX009	Raising frame 87 mm	-
AX010	Raising frame 40 mm	-
AQX011	AQ-210 series combiflex frame	-
AQX012	AQ-210 series wall mounting bracket	-
AQ-01A	Light point sensor unit (8,000 lux threshold)	Max. cable length 200 m
AQ-01B	Light point sensor unit (25,000 lux threshold)	Max. cable length 200 m
AQ-01C	Light point sensor unit (50,000 lux threshold)	Max. cable length 200 m
AQ-02A	Pressure and light point sensor unit (8,000 lux threshold)	Max. cable length 200 m
AQ-02B	Pressure and light point sensor unit (25,000 lux threshold)	Max. cable length 200 m
AQ-02C	Pressure and light point sensor unit (50,000 lux threshold)	Max. cable length 200 m

10 Contact and reference information

Manufacturer

Arcteq Relays Ltd.

Visiting and postal address

Kvartsikatu 2 A 1 65300 Vaasa, Finland

Contacts

Phone: +358 10 3221 370

Website: arcteq.com

Technical support: <u>arcteq.com/support-login</u>

+358 10 3221 388 (EET 9:00 - 17.00)

E-mail (sales): sales@arcteq.fi